

Power Transistor and Darlington

Data Manual

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INTRODUCTION

The 1995 POWER TRANSISTOR and DARLINGTON DATA MANUAL from Texas Instruments includes complete detailed specifications on the bipolar junction transistor product line. The general purpose NPN and PNP power transistors are suitable for use in both analogue applications such as linear series regulators and switching applications such as inverters and relay drivers. The general purpose NPN and PNP Darlington have high gain and low drive current which means that these devices are extensively used in the output stages of analogue power amplifiers and for logic driven power switches. The high voltage planar switching transistors are an excellent choice for use in off-line switch mode power supplies and inverter applications.

The data book is divided into 7 chapters. Below you will find a brief description of each chapter.

Chapter 1. Alphanumeric Index - A list by device name with the relevant page number for the detailed specification.

Chapter 2. Selection Guide - An easy-to-use reference guide that includes specific device information. Page numbers are shown for easy access to the detailed specifications.

Chapter 3. Glossary - Defines terms and standards used throughout the book.

Chapters 4 - 6. Product specifications for over 90 Transistors and Darlington are given in these sections.

Chapter 7. Mechanical Data - Detailed package drawings and specifications are shown in this section.

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				Minimum	@I _C (A)			
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BD744C		100					BD743C	
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BD746B		80					BD745B	
BD746C		100					BD745C	
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BD250C		100					BD249C	
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TIP36B		80					TIP35B	
TIP36C		100					TIP35C	

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BD895 BD897 BD899 BD901	8	45 60 80 100	70	750	3	TO-200	BD896 BD898 BD900 BD902	5-11
BD895A BD897A BD899A	8	45 60 80	70	750	4	TO-220	BD896A BD898A BD900A	5-15
BDW73 BDW73A BDW73B BDW73C BDW73D	8	45 60 80 100 120	80	100	8	TO-220	BDW74 BDW74A BDW74B BDW74C BDW74D	5-67
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TIP102		100					TIP107	
TIP130	8	60	70	1000	4	TO-220	TIP135	5-135
TIP131		80					TIP136	
TIP132		100					TIP137	
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BDX33B		80		BDX34B				
BDX33C		100		BDX34C				
BDX33D		120		BDX34D				
TIP140	10	60	125	500	10	SOT-93	TIP145	5-143
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TIP142		100					TIP147	
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BDV65B		100					BDV64B	
BDV65C		120					BDV64C	
BDW93	12	45	80	100	10	TO-220	BDW94	5-83
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BDW93B		80					BDW94B	
BDW93C		100					BDW94C	
BDW83	15	45	150	100	15	SOT-93	BDW84	5-75
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BDW83B		80					BDW84B	
BDW83C		100					BDW84C	
BDW83D		120					BDW84D	

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Device Number	I _C Continuous (A)	V _{CEO} (V)	P _{tot} T _C = 25°C (W)	h _{FE}		Package	Complementary	Page
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TIPP117		100					TIPP112	
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BDT60B		100					BDT61B	
BDT60C		120					BDT61C	
BDW54	4	45	40	100	4	TO-220	BDW53	5-55
BDW54A		60					BDW53A	
BDW54B		80					BDW53B	
BDW54C		100					BDW53C	
BDW54D		120					BDW43D	
TIP115	4	60	50	500	2	TO-220	TIP110	5-123
TIP116		80					TIP111	
TIP117		100					TIP112	
TIP125	5	60	65	1000	3	TO-220	TIP120	5-131
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TIP127		100					TIP122	
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BDW24B		80					BDW23B	
BDW24C		100					BDW23C	
BDW64	6	45	60	100	6	TO-220	BDW63	5-63
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BDW64B		80					BDW63B	
BDW64C		100					BDW63C	
BDW64D		120					BDW63D	
BD646	8	60	62.5	750	3	TO-220	BD645	5-7
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BD650		100					BD649	
BD652		120					BD651	
BD896	8	45	70	750	3	TO-220	BD895	5-19
BD898		60					BD897	
BD900		80					BD899	
BD902		100					BD901	
BD896A	8	45	70	750	4	TO-220	BD895A	5-23
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BD900A		80					BD899A	
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BDW74B		80					BDW73B	
BDW74C		100					BDW73C	
BDW74D		120					BDW73D	
BDX54	8	45	60	750	3	TO-220	BDX53	5-107
BDX54A		60					BDX53A	
BDX54B		80					BDX53B	
BDX54C		100					BDX53C	

SELECTION GUIDE

GENERAL PURPOSE PNP DARLINGTONS (continued)

Device Number	I _C Continuous (A)	V _{CEO} (V)	P _{tot} T _C = 25°C (W)	h _{FE}		Package	Complementary	Page
				Minimum	@I _C (A)			
TIP105 TIP106 TIP107	8	60 80 100	80	200	8	TO-220	TIP100 TIP101 TIP102	5-115
TIP135 TIP136 TIP137	8	60 80 100	70	1000	4	TO-220	TIP130 TIP131 TIP132	5-139
BDX34 BDX34A BDX34B BDX34C BDX34D	10	45 60 80 100 120	70	750 750	4 3	TO-220	BDX33 BDX33A BDX33B BDX33C BDX33D	5-97
TIP145 TIP146 TIP147	10	60 80 100	125	500	10	SOT-93	TIP140 TIP141 TIP142	5-147
BDV64 BDV64A BDV64B BDV64C	12	60 80 100 120	125	1000	5	SOT-93	BDV65 BDV65A BDV65B BDV65C	5-35
BDW94 BDW94A BDW94B BDW94C	12	45 60 80 100	80	100	10	TO-220	BDW93 BDW93A BDW93B BDW93C	5-87
BDW84 BDW84A BDW84B BDW84C BDW84D	15	45 60 80 100 120	150	100	15	SOT-93	BDW83 BDW83A BDW83B BDW83C BDW83D	5-79

NPN SWITCHING TRANSISTORS

Device Number	I _C Continuous (A)	V _{CEO} (V)	V _{CB0} (V)	V _{CE(sat)}		Resistive-load switching t _f		Inductive-load switching t _{fi}		Package	Page
				Max (V)	@I _C (A)	Max (ns)	@I _C (A)	Max (ns)	@I _C (A)		
TIP47 TIP48 TIP49 TIP50	1	250 300 350 400	350 400 450 500	1	1					TO-220	6-43
BUX84	2	400	800	1	1	200 (typical)	1			TO-220	6-31
BUX85	2	450	1000	1	1	200 (typical)	1			TO-220	6-37
TIPL770	2.5	400	850	2.5	2.5			200	2.5	TO-220	6-97
TIPL760 TIPL760A	4	400 450	850 1000	2.5	4			250	4	TO-220	6-61
TIPL760B TIPL760C	4	500 550	1100 1200	2.5	3			250	3	TO-220	6-67
TIPL761 TIPL761A	4	400 450	850 1000	2.5	4			250	4	SOT-93	6-73
TIPL761B TIPL761C	4	500 550	1100 1200	2.5	3			250	3	SOT-93	6-79
TIPL791 TIPL791A	4	400 450	850 1000	2.5	4			100	4	TO-220	6-109
BUT11	5	400	850	1.5	3			150	3	TO-220	6-15
BU426 BU426A	6	375 400	800 900	3	4	150 (typical)	2.5			SOT-93	6-9
TIPL762 TIPL762A	6	400 450	850 1000	2.5	6			150	6	SOT-93	6-85
BU406 BU407	7	200 150	400 330	1	5					TO-220	6-3
TIP150 TIP151 TIP152	7	300 350 400	300 350 400	2	5					TO-220	6-49
BUV47 BUV47A	9	400 450	850 1000	3	8	800	5	400	5	SOT-93	6-19
TIP160 TIP161 TIP162	10	320 350 380	320 350 380	2.9	10	2600	6.5			SOT-93	6-55
TIPL765 TIPL765A	10	400 450	850 1000	2.5	10			200	10	SOT-93	6-91
TIPL790 TIPL790A	10	120 150	150 200	2	10			400	10	TO-220	6-103
BUV48 BUV48A	15	400 450	850 1000	5	15	800	10	400	10	SOT-93	6-25

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PART 1 - POWER TRANSISTOR SAFETY CONSIDERATIONS

The designer, maker, and user of electrical equipment containing power transistors should give attention to the following points relative to the safety of personnel that may operate the equipment.

The electrical potentials of the collector, emitter, and base terminals on the transistor present an electrical shock hazard when the equipment is energized.

The normal operating case temperature of energized transistors is often high enough to present burn hazards to both operating personnel and flammable material touching the transistor.

If the transistor is falsely turned "on" or fails, power will be applied to the equipment load. Operator safety may be affected by an unexpected energizing of the load.

In the event that an equipment output short or internal fault condition develops, very high surge current can be passed through the transistor. If this condition exceeds transistor ratings for magnitude and duration, the transistor may be damaged; and if the surge is severe enough, internal heating can cause the transistor to rupture and perhaps sustain an arc.

PART 2 - POWER TRANSISTOR STANDARDS

Following are sources of standard material relating to Power Transistors:

EIA and JEDEC Standards

Electronics Industries Association
2500 Wilson Boulevard
Arlington, Virginia, 22201 - 3834
Telephone: 703 907-7500

EIA Standard RS-313-B: Thermal Resistance Measurements of Conduction Cooled Power Transistors.

JEDEC Standard 77: Terms, Definitions, and Letter Symbols for Discrete Semiconductor and Optoelectronic Devices.

JEDEC Publication 65: Test Procedures for Verification of Maximum Ratings of Power Transistors.

JEDEC Publication 74: Standard List of Values to be used in Power Transistor Device Registration and Minimum Differences for Discreteness of Registration.

JEDEC Publication 104: Reference Guide to Letter Symbols for Semiconductor Devices.

JC-25 Power Transistor Registration Formats RDF-1 to RDF-6

International Electrotechnical Commission Standards

American National Standards Institute, Inc.
1430 Broadway
New York, N.Y. 10018
Telephone: 212 868-1220

IEC Publication 747: Semiconductor Devices. Discrete Devices.

IEC Publication 749: Semiconductor Devices. Mechanical and Climatic Test Methods.

PART 3 - POWER TRANSISTOR TERMS AND DEFINITIONS

INTRODUCTION

Most of the information concerning letter symbols, abbreviations, terms, and definitions commonly used with Power transistors was obtained from JEDEC Standard 77 (JESD77-A, February 1992). This document and the JC-25 registration formats have overriding authority where any conflict occurs.

Base (B, b)*

A region which lies between an emitter and collector of a transistor and into which minority carriers are injected. (Ref. IEEE Std. 100).

Breakdown

A phenomenon occurring in a reverse-biased semiconductor junction, whose initiation is observed as a transition from a region of high small-signal resistance to a region of substantially lower small-signal resistance for an increasing magnitude of reverse current. (Ref. RS-282-A).

Breakdown Region

A region of the volt-ampere characteristic beyond the initiation of breakdown for an increasing magnitude of reverse current. (Ref. RS-282-A).

Breakdown Voltage

The voltage measured at a specified current in a breakdown region. (Ref. MIL-S-19500).

Collector (C, c)*

A region through which a primary flow of charge carriers leaves the base. (Ref. IEEE Std. 100).

Darlington Transistor

A compound semiconductor device consisting of two transistors, in which the collectors are connected together, and the emitter of the first transistor is connected to the base of the second transistor.

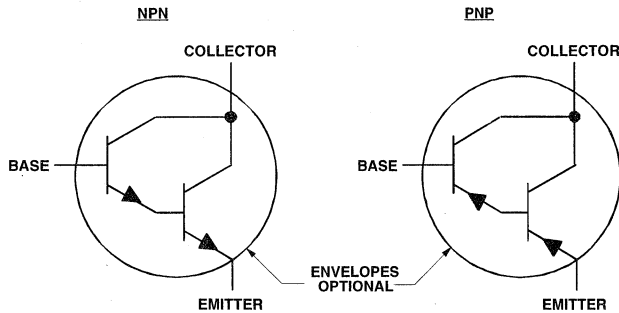
NOTE 1: This connection of two transistors can be regarded as a compound transistor with three terminals.

NOTE 2: The circuit may include a biasing network.

NOTE 3: The presence of a terminal to provide direct access to the base of the second transistor is optional.

* References to base, collector, and emitter symbolism (B, b, C, c, E, and e) refer to the device terminals connected to those regions.

Graphic symbols. (Ref. IEEE Std. 315):



Emitter (E, e)*

A region from which charge carriers that are minority carriers in the base are injected into the base. (Ref. IEEE Std.100).

Forward Direction (in a p-n junction)

The direction of current that results when the p-type semiconductor region is at a positive potential relative to the n-type region. (Ref. IEEE Std. 253).

Junction, Collector

A semiconductor junction normally biased in the reverse direction, the current through which can be controlled by the introduction of minority carriers into the base. (Ref. IEEE Std. 100).

Junction, Emitter

A semiconductor junction normally biased in the forward direction to inject minority carriers into the base. (Ref. IEEE Std.100).

Open-circuit

A circuit in which halving the magnitude of the terminating impedance does not produce a change in the parameter being measured greater than the required accuracy of the measurement (Ref. MIL-S-19500).

Reverse Current

The current that flows through a semiconductor junction in the reverse direction.

Reverse Direction (in a p-n junction)

The direction of current flow that results when the n-type semiconductor region is at a positive potential relative to the p-type region.

Saturation

A base-current and a collector-current condition resulting in a forward-biased collector junction.

* References to base, collector, and emitter symbolism (B, b, C, c, E, and e) refer to the device terminal connected to those regions.

Second Breakdown

A condition of the transistor, resulting from a lateral current instability, in which the electrical characteristics are determined principally by the spreading resistance of a thermally maintained current constriction. The initiation of second breakdown is observed as a decrease in the voltage sustained by the collector.

NOTE: Second breakdown differs from thermal failure in that its initiation cannot be predicted from low-voltage thermal resistance measurements.

Unless the current and duration in second breakdown are limited, the high junction temperature at the current constriction will result in failure, usually as a collector-to-emitter short-circuit.

Second breakdown can occur at positive, negative, or zero base current.

Semiconductor Junction

A region of transition between semiconductor regions of different electrical properties (e.g., n-n+, p-n, p-p+ semiconductors), or between a metal and a semiconductor. (Ref. RS-282).

Short-circuit

A circuit in which doubling the magnitude of the terminating impedance does not produce a change in the parameter being measured that is greater than the required accuracy of the measurement. (Ref. MIL-S-19500).

Small-signal

A signal that when doubled in magnitude does not produce a change in the parameter being measured that is greater than the required accuracy of the measurement. (Ref. MIL-S-19500).

Static-value

A non varying value or quantity of measurement at a specified fixed point, or the slope of the line from the origin to the operating point on the appropriate characteristic curve. (Ref. IEEE 255).

Terminal

An externally available point of connection. (Ref. IEC 747-1).

Thermal Resistance, (Steady-State)

The temperature difference between two specified points or regions divided by the power dissipation under conditions of thermal equilibrium. (Ref. IEEE 100).

Transient Thermal Impedance

The change of temperature difference between two specified points or regions at the end of a time interval divided by the step-function change in power dissipation, at the beginning of the same time interval that causes the change of temperature difference. (Ref. EIA-282-A).

Transistor

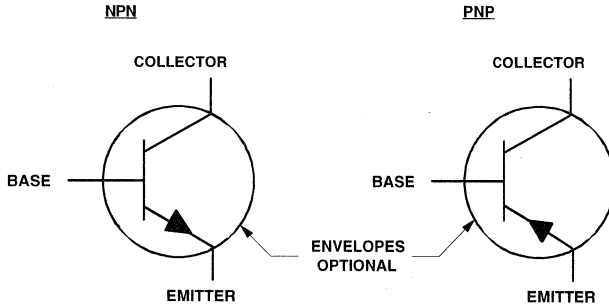
A semiconductor device capable of providing power amplification and having three or more electrodes. (Ref. IEC 747-1).

Transistor, Junction, Multijunction Type

A transistor having a base and two or more junctions.

Graphic symbols for triode transistors. (Ref. IEEE Std. 315):

NOTE: In the graphic symbols, the envelope is optional if no element is connected to the envelope.



PART 4 - SYMBOLS, TERMS AND DEFINITIONS

SYMBOL	TERM	DEFINITION
C_{obo}	Common-base open-circuit output capacitance	The capacitance measured across the output terminals (collector and base) with the input open-circuited to ac.
f_{hfe}	Common-emitter small-signal short-circuit forward current transfer ratio cut off frequency	The lowest frequency at which the magnitude of the small-signal short-circuit forward current transfer ratio is 0.707 of its value at a specified low frequency (usually 1 kHz or less).
f_T	Common-emitter transition frequency or frequency at which small-signal forward current transfer ratio extrapolates to unity	The product of the modulus (magnitude) of the common-emitter small-signal short-circuit forward current transfer ratio, h_{fe} , and the frequency of measurement when this frequency is sufficiently high so that the modulus (magnitude) of h_{fe} is decreasing with a slope of approximately 6 dB per octave.
h_{FE}	Common-emitter static forward current transfer ratio	The ratio of the dc output current to the dc input current (Ref. MIL-S-19500).
h_{fe}	Common-emitter small-signal short-circuit forward current transfer ratio	The ratio of the ac rms output current to the small-signal ac rms input current with the output ac short-circuited to the common terminal. (Ref. MIL-S-19500).
I_B, I_C, I_E	current, dc (base-terminal, collector-terminal, emitter-terminal)	The value of the dc current into the terminal indicated by the subscript.
i_b, i_c, i_e	current, rms value of alternating component (base-terminal, collector-terminal, emitter-terminal)	The root-mean-square value of alternating current into the terminal indicated by the subscript.
i_B, i_C, i_E	current, instantaneous total value (base-terminal, collector-terminal, emitter-terminal)	The instantaneous total value of alternating current into the terminal indicated by the subscript.

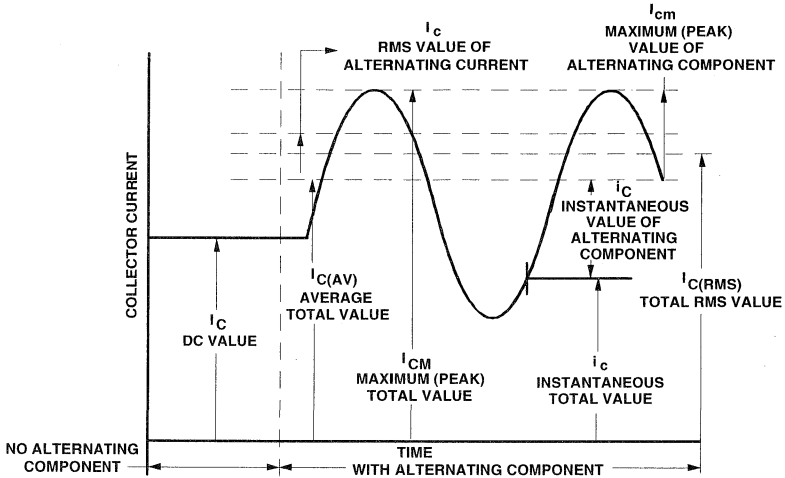


DIAGRAM ILLUSTRATING FOREGOING CURRENTS (REF. IEEE 255)

I_{CBO}	collector cut-off current, emitter open	The current into the collector terminal when it is biased in the reverse direction with respect to the base terminal and the emitter terminal is open-circuited.
I_{CEO}	base open	The current into the collector terminal when it is biased in the reverse direction* with respect to the emitter terminal and the base terminal is (as indicated by the first subscript letter as follows): O = open-circuited. R = returned to the emitter terminal through a specified resistance. S = short circuited to the emitter terminal. V = returned to the emitter terminal through a specified voltage. X = returned to the emitter terminal through a specified circuit.
I_{CER}	resistance between base and emitter,	
I_{CES}	base short circuited to emitter,	
I_{CEV}	voltage between base and emitter,	
I_{CEX}	circuit between base and emitter,	
I_{EBO}	emitter cut-off current, collector open	The current into the emitter terminal when it is biased in the reverse direction with respect to the base terminal and the collector terminal is open-circuited. (Ref. IEEE 255).

* For these parameters, the collector terminal is considered to be biased in the reverse direction when it is made positive for N-P-N transistors or negative for P-N-P transistors with respect to the emitter terminal.

SYMBOL	TERM	DEFINITION
P_T	total dc power input to all terminals	The sum of the products of the dc input currents and voltages, i.e. $V_{BE} \cdot I_B + V_{CE} \cdot I_C$ or $V_{BE} \cdot I_E + V_{CB} \cdot I_C$
R_{θ} , R_{th} (formerly θ)	thermal resistance	Refer to thermal resistance (steady state)
$R_{\theta CA}$, $R_{th CA}$	case-to-ambient thermal resistance	The thermal resistance (steady-state) from the device case to the ambient.
$R_{\theta JA}$, $R_{th JA}$ (formerly $\theta J-A$)	junction-to-ambient thermal resistance	The thermal resistance (steady-state) from the semiconductor junction (s) to the ambient.
$R_{\theta JC}$, $R_{th JC}$ (formerly $\theta J-C$)	junction-to-case thermal resistance	The thermal resistance (steady-state) from the semiconductor junction(s) to the case.
$R_{\theta JM}$, $R_{th JM}$	junction-to-mounting surface thermal resistance	The thermal resistance (steady-state) from the semiconductor junction(s) to the mounting surface.
T_A	ambient temperature or free-air temperature	The air temperature measured below a device, in an environment of substantially uniform temperature, cooled only by natural air convection and not materially affected by reflective and radiant surfaces. (Ref. MIL-S-19500).
T_C	case temperature	The temperature measured at a specified location on the case of a device. (Ref. MIL-S.19500).
T_J , T_{VJ}	virtual-junction temperature	A temperature representing the temperature of the junction(s) calculated on the basis of a simplified model of the thermal and electrical behaviour of the semiconductor device. NOTE: This term (and its definition) is taken from IEC standards. It is particularly applicable to multi-junction semi-conductors and is used in this publication to denote the temperature of the active semiconductor element when required in specifications and test methods. The term "junction temperature" is used interchangeably with the term "virtual-junction temperature" in this publication.
T_{stg}	storage temperature	The temperature at which the device, without any power applied, is stored. (Ref. MIL-S-19500).
t_c	turn-off crossover time (for reserve symbol, see t_{xo})	The time interval during which collector voltage rises from 10% of its peak off-state value and collector current falls to 10% of its peak on-state value, in both cases ignoring spikes that are not charge-carrier induced.
t_d	delay time	Synonym for current delay time (see note following t_{xo}).

* For these parameters, the collector terminal is considered to be biased in the reverse direction when it is made positive for N-P-N transistors or negative for P-N-P transistors with respect to the emitter terminal.

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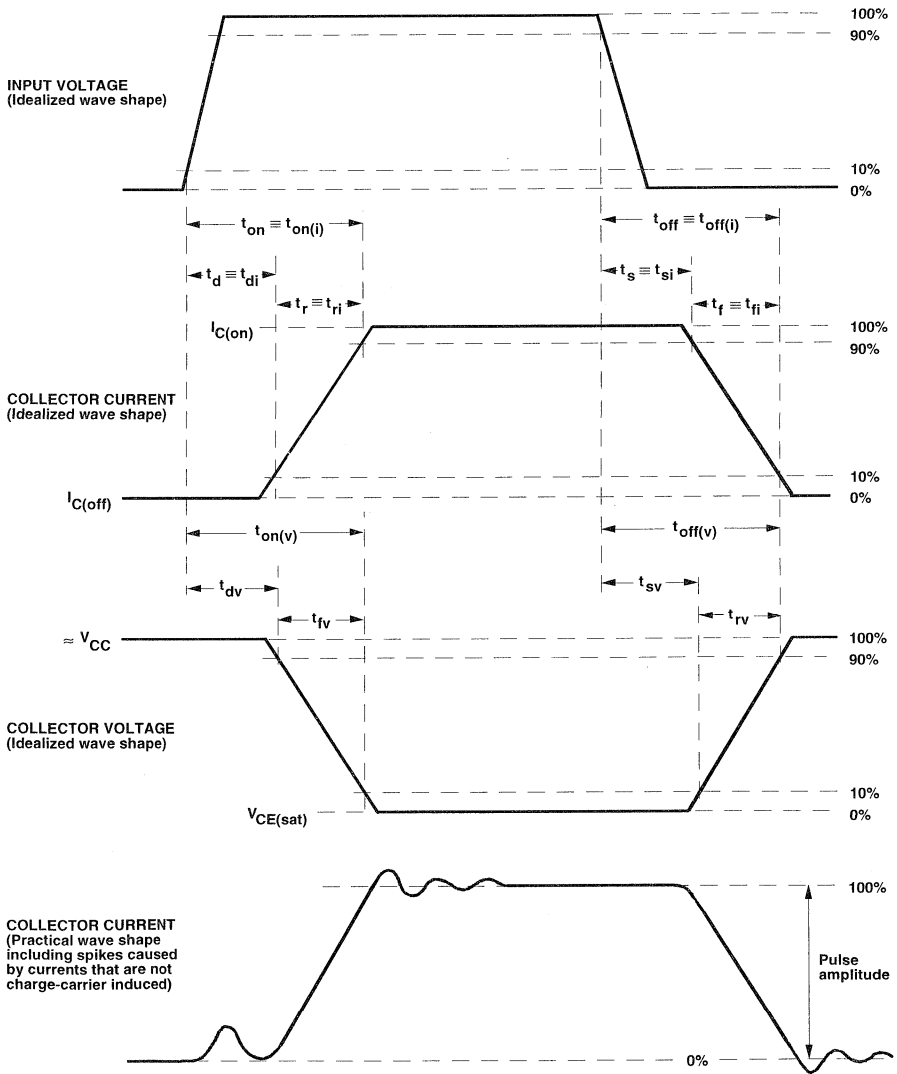
SYMBOL	TERM	DEFINITION
t_{di}	current delay time	The time interval during which an input pulse that is switching the transistor from a nonconducting to a conducting state rises from 10% of its peak amplitude and the collector current waveform rises to 10% of its on-state amplitude, ignoring spikes that are not charge-carrier induced.
t_{dv}	voltage delay time	The time interval during which an input pulse that is switching the transistor from a nonconducting to a conducting state rises from 10% of its peak amplitude and the collector voltage waveform falls to 90% of its off-state amplitude, ignoring spikes that are not charge-carrier induced.
t_f	fall time	Synonym for current fall time (see note following t_{xo}).
t_{fi}	current fall time	The time interval during which the collector current changes from 90% to 10% of its peak on-state value, ignoring spikes that are not charge-carrier induced.
t_{fv}	voltage fall time	The time interval during which the collector voltage changes from 90% to 10% of its peak off-state value, ignoring spikes that are not charge-carrier induced.
t_{off}	turn-off time	Synonym for current turn-off time (see note following t_{xo}).
$t_{off(i)}$	current turn-off time	The sum of current storage time and current fall time, i.e., $t_{sj} + t_{fi}$.
$t_{off(v)}$	voltage turn-off time	The sum of voltage storage time and voltage rise time, i.e., $t_{sv} + t_{fv}$.
t_{on}	turn-on time	Synonym for current turn-on time (see note following t_{xo}).
$t_{on(i)}$	current turn-on time	The sum of current delay time and current rise time, i.e., $t_{di} + t_{ri}$.
$t_{on(v)}$	voltage turn-on time	The sum of voltage delay time and voltage fall time, i.e., $t_{dv} + t_{fv}$.
t_p	pulse duration (formerly pulse time)	The time interval between a reference point on the leading edge of a pulse waveform and a reference point on the trailing edge of the same waveform.
		NOTE: The two reference points are usually 90% of the steady-state amplitude of the waveform existing after the leading edge, measured with respect to the steady-state amplitude existing before the leading edge. If the reference points are 50% points, the symbol t_w and term average pulse duration should be used.
t_r	rise time	Synonym for current rise time (see note following t_{xo}).
t_{ri}	current rise time	The time interval during which the collector current changes from 10% to 90% of its peak on-state value, ignoring spikes that are not charge-carrier induced.

SYMBOL	TERM	DEFINITION
t_{rv}	voltage rise time	The time interval during which the collector voltage changes from 10% to 90% of its peak off-state value, ignoring spikes that are not charge-carrier induced.
t_s	storage time	Synonym for current storage time (see footnote).
t_{si}	current storage time	The time interval during which an input pulse that is switching the transistor from a conducting to a non-conducting state falls from 90% of its peak amplitude and the collector current waveform falls to 90% of its on-state amplitude, ignoring spikes that are not charge-carrier induced.
t_{sv}	voltage storage time	The time interval during which an input pulse that is switching the transistor from a conducting to a non-conducting state falls from 90% of its peak amplitude and the collector voltage waveform rises to 10% of its off-state amplitude, ignoring spikes that are not charge carrier induced.
t_{ti}	current tail time	The time interval following current fall time during which the collector current changes from 10% to 2% of its peak on-state value, ignoring spikes that are not charge-carrier induced.
t_{xo}	turn-off crossover time	For definition, see t_c (t_{xo} is a reserve symbol to be used if use of t_c will cause confusion).
t_p	average pulse duration (formerly pulse average time)	The time interval between a reference point on the leading edge of a pulse waveform and a reference point on the trailing edge of the same waveform, with both reference points being 50% of the steady-state amplitude of the waveform existing after the leading edge, measured with respect to the steady-state amplitude existing before the leading edge.

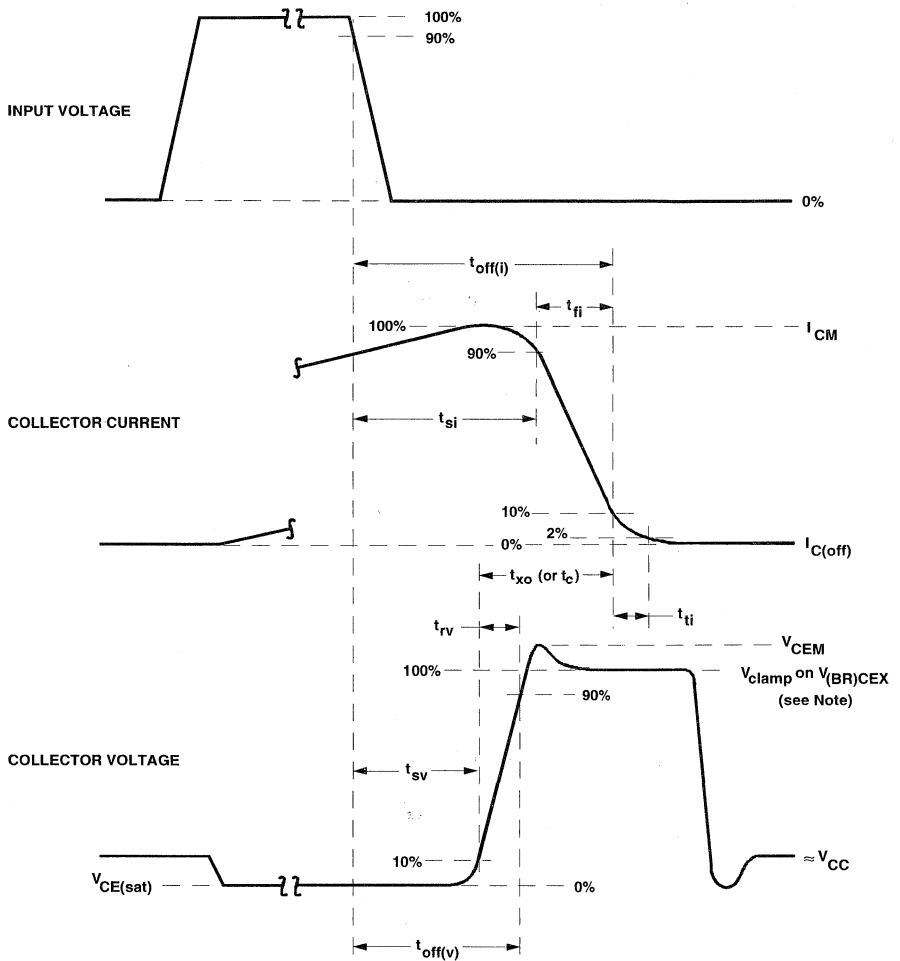
NOTE: If the reference points are not 50% points, the symbol t_p and term pulse duration should be used.

NOTE: As names of time intervals for characterizing switching transistors, the terms 'fall time' and 'rise time' always refer to the change that is taking place in the magnitude of the output current even though measurements may be made using voltage waveforms. In a purely resistive circuit, the (current) rise time may be considered equal and coincident to the voltage fall time, and the (current) fall time may be considered equal and coincident to the voltage rise time. The delay times for current and voltage will be equal and coincident, as will the storage times. When significant amounts of inductance are present in a circuit, these equalities and coincidences no longer exist, and use of the unmodified terms delay time, fall time, rise time, and storage time must be avoided.

GLOSSARY



WAVEFORMS FOR RESISTIVE-LOAD SWITCHING



NOTE: V_{clamp} (in a clamped inductive-load switching circuit) or $V_{(BR)CEX}$ (in an unclamped circuit) is the peak off-state voltage excluding spikes

WAVEFORMS FOR INDUCTIVE-LOAD SWITCHING, TURN-OFF

GLOSSARY

SYMBOL	TERM	DEFINITION
$V_{(BR)CBO}$ (formerly BV_{CBO})	collector-to-base breakdown voltage, emitter open	The breakdown voltage between the collector terminal and the base terminal when the collector terminal is biased in the reverse direction with respect to the base terminal and the emitter terminal is open-circuited.
$V_{(BR)CEO}$ (formerly BV_{CEO})	collector-to-emitter breakdown voltage (under conditions specified below): (base open,	The breakdown voltage between the collector terminal and the emitter terminal when the collector terminal is biased in the reverse direction* with respect to the emitter terminal and the base terminal is (as indicated by the last subscript letter) as follows: O = open circuited.
$V_{(BR)CER}$ (formerly BV_{CER})	resistance between base and emitter,	R = returned to the emitter terminal through a specified resistance.
$V_{(BR)CES}$ (formerly BV_{CES})	base short circuited to emitter,	S = short circuited to the emitter terminal.
$V_{(BR)CEV}$ (formerly BV_{CEV})	voltage between base and emitter,	V = returned to the emitter terminal through a specified voltage.
$V_{(BR)CEX}$ (formerly BV_{CEX})	circuit between base and emitter)	X = returned to the emitter terminal through a specified circuit.
$V_{(BR)EBO}$ (formerly BV_{EBO})	emitter-to-base breakdown voltage, collector open	The breakdown voltage between the emitter and base terminals when the emitter terminal is biased in the reverse direction with respect to the base terminal and the collector terminal is open-circuited.
V_{BB} , V_{CC} , V_{EE}	supply voltage, dc, base, collector, emitter	The dc supply voltage applied to a circuit connected to the base, collector, or emitter respectively.
V_{BC} , V_{BE}	base-to-collector voltage, dc or average base-to-emitter voltage, dc	The dc voltage between the terminal indicated by the first subscript and the reference terminal (stated in terms of the polarity at the terminal indicated by the first subscript).
V_{CB} , V_{CE}	collector-to-base voltage, dc collector-to-emitter voltage, dc	
V_{EB} , V_{EC}	emitter-to-base voltage, dc emitter-to-collector voltage, dc)	
$V_{BE(sat)}$	base-to-emitter saturation voltage	The voltage between the base and emitter terminals for specified base-current and collector-current conditions which are intended to ensure that the collector junction is forward-biased.
V_{CBO}^*	collector-to-base voltage, emitter open	The voltage between the collector terminal and the base terminal when the emitter terminal is open-circuited.

* For these parameters, the collector terminal is considered to be biased in the reverse direction when it is made positive for NPN transistors, or negative for PNP transistors, with respect to the emitter terminal.

SYMBOL	TERM	DEFINITION
$V_{CE(sat)}$	saturation voltage, dc, collector-to-emitter	The voltage between the collector and the emitter terminals under conditions of base-emitter voltage beyond which the collector current remains essentially constant as the base current or voltage is increased
	collector-to-emitter voltage	The voltage between the collector terminal and the emitter terminal when the base terminal is (as indicated by the last subscript letter) as follows:
V_{CEO}	base open	O = open circuited.
V_{CER}	resistance between base and emitter	R = returned to the emitter terminal through a specified resistance.
V_{CES}	base short circuited to emitter	S = short circuited to the emitter terminal.
V_{CEV}	voltage between base and emitter	V = returned to the emitter terminal through a specified voltage.
V_{CEX}	circuit between base and emitter	X = returned to the emitter terminal through a specified circuit.
	collector-to-emitter sustaining voltage	The collector-to-emitter breakdown voltage at relatively high values of collector current where the breakdown voltage is relatively insensitive to changes in collector current. The base terminal is (as indicated by the third subscript letter) as follows:
$V_{CEO(sus)}$	base open	O = open-circuited.
$V_{CER(sus)}$	resistance between base and emitter	R = returned to the emitter terminal through a specified resistance.
$V_{CES(sus)}$	base short circuited to emitter	S = short circuited to the emitter terminal.
$V_{CEV(sus)}$	voltage between base and emitter	V = returned to the emitter terminal through a specified voltage.
$V_{CEX(sus)}$	circuit between base and emitter	X = returned to the emitter terminal through a specified circuit.
		NOTE: This would be the transient voltage between the collector and emitter terminals during switching with an inductive load from a forward-biased base-emitter to an external condition described by the third subscript letter.
V_{EBO}	emitter-to-base voltage, collector open	The voltage between the emitter terminal and the base terminal with the collector terminal open circuited.

GLOSSARY

SYMBOL	TERM	DEFINITION
V_{EC}	forward (diode) voltage	The dc voltage across a semiconductor diode associated with forward current. NOTE: In this book this is specified as a parameter of an integrated diode across the collector and emitter of certain power transistors Refer to transient thermal impedance.
Z_{θ}, Z_{th} (formerly $\theta(t)$)	transient thermal impedance	Refer to transient thermal impedance.
$Z_{\theta JA}, Z_{th JA}$ (formerly $\theta J-A(t)$)	junction-to-ambient transient thermal impedance	The transient thermal impedance from the semiconductor junction(s) to the ambient.
$Z_{\theta JC}, Z_{th JC}$ (formerly $\theta JC(t)$)	junction-to-case transient thermal impedance	The transient thermal impedance from the semiconductor junction(s) to a stated location on the case.

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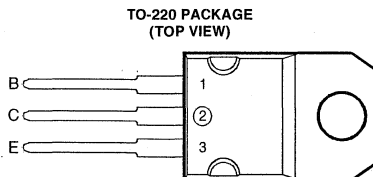
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BD239, BD239A, BD239B, BD239C NPN SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

- Designed for Complementary Use with the BD240 Series
- 30 W at 25°C Case Temperature
- 2 A Continuous Collector Current
- 4 A Peak Collector Current
- Customer-Specified Selections Available



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-emitter voltage ($R_{BE} = 100 \Omega$)	BD239	V_{CEr}	55	V
	BD239A		70	
	BD239B		90	
	BD239C		115	
Collector-emitter voltage ($I_C = 30 \text{ mA}$)	BD239	V_{CE0}	45	V
	BD239A		60	
	BD239B		80	
	BD239C		100	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	2	A
Peak collector current (see Note 1)		I_{CM}	4	A
Continuous base current		I_B	0.6	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	30	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	32	mJ
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	250	°C

NOTES: 1. This value applies for $t_p \leq 0.3 \text{ ms}$, duty cycle $\leq 10\%$.

2. Derate linearly to 150°C case temperature at the rate of 0.24 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20 \text{ mH}$, $I_{B(on)} = 0.4 \text{ A}$, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = 20 \text{ V}$.

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BD239, BD239A, BD239B, BD239C

NPN SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$ (see Note 5)	$I_B = 0$	BD239	45			V
				BD239A	60			
				BD239B	80			
				BD239C	100			
I_{CES}	Collector-emitter cut-off current			BD239			0.2	mA
				BD239A			0.2	
				BD239B			0.2	
				BD239C			0.2	
I_{CEO}	Collector cut-off current		$I_B = 0$	BD239/239A			0.3	mA
				BD239B/239C			0.3	
I_{EBO}	Emitter cut-off current		$I_C = 0$				1	mA
h_{FE}	Forward current transfer ratio		$I_C = 0.2 \text{ A}$	(see Notes 5 and 6)	40			
					15			
$V_{CE(sat)}$	Collector-emitter saturation voltage		$I_C = 1 \text{ A}$	(see Notes 5 and 6)			0.7	V
V_{BE}	Base-emitter voltage		$I_C = 1 \text{ A}$	(see Notes 5 and 6)			1.3	V
h_{fe}	Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.2 \text{ A}$	$f = 1 \text{ kHz}$	20			
$ h_{fe} $	Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.2 \text{ A}$	$f = 1 \text{ MHz}$	3			

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			4.17	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = 200 \text{ mA}$	$I_{B(on)} = 20 \text{ mA}$		0.3		μs
t_{off}	Turn-off time	$V_{BE(off)} = -3.4 \text{ V}$	$R_L = 150 \Omega$		0.8		μs
							$I_{B(off)} = -20 \text{ mA}$ $t_p = 20 \mu\text{s}$, dc $\leq 2\%$

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

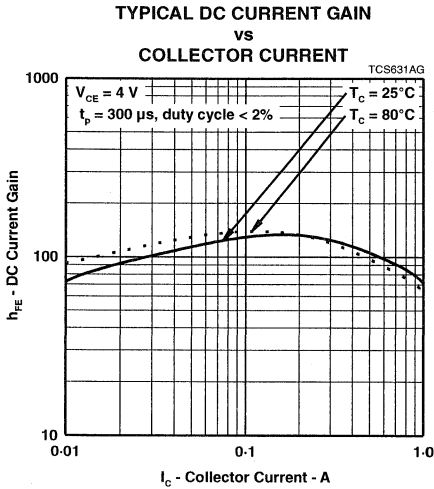


Figure 1.

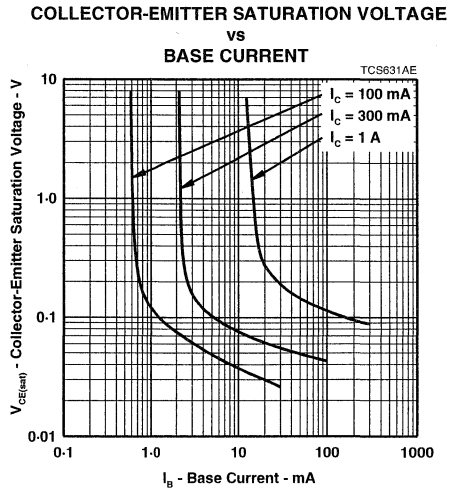


Figure 2.

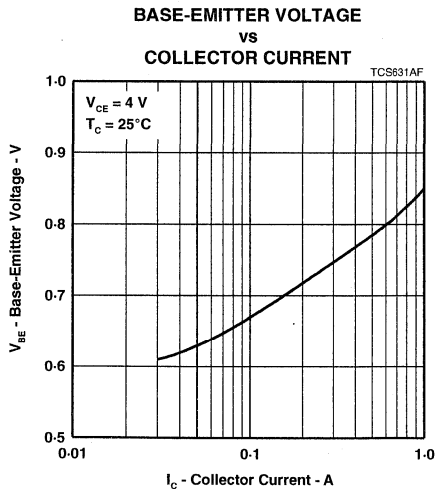


Figure 3.

BD239, BD239A, BD239B, BD239C
NPN SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

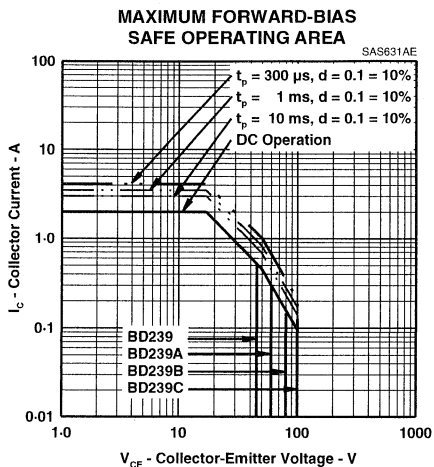


Figure 4.

THERMAL INFORMATION

**MAXIMUM POWER DISSIPATION
VS
CASE TEMPERATURE**

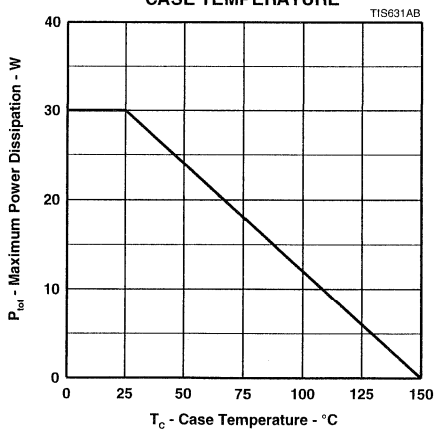


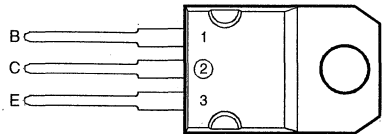
Figure 5.

BD239D, BD239E, BD239F NPN SILICON POWER TRANSISTORS

SEPTEMBER 1981 - REVISED MAY 1995

- 30 W at 25°C Case Temperature
- 2 A Continuous Collector Current
- 4 A Peak Collector Current
- Customer-Specified Selections Available

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-emitter voltage ($R_{BE} = 100 \Omega$)	BD239D	V_{CER}	160	V
	BD239E		180	
	BD239F		200	
Collector-emitter voltage ($I_B = 0$)	BD239D	V_{CEO}	120	V
	BD239E		140	
	BD239F		160	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	2	A
Peak collector current (see Note 1)		I_{CM}	4	A
Continuous base current		I_B	0.6	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	30	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	32	mJ
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	250	°C

NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.

2. Derate linearly to 150°C case temperature at the rate of 0.24 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = 0.4$ A, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = 20$ V.

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BD239D, BD239E, BD239F

NPN SILICON POWER TRANSISTORS

SEPTEMBER 1981 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$ (see Note 5)	$I_B = 0$	BD239D	120			V
				BD239E	140			
				BD239F	160			
I_{CES}	Collector-emitter cut-off current	$V_{CE} = 160 \text{ V}$ $V_{CE} = 180 \text{ V}$ $V_{CE} = 200 \text{ V}$	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	BD239D			0.2	mA
				BD239E			0.2	
				BD239F			0.2	
I_{CEO}	Collector cut-off current	$V_{CE} = 90 \text{ V}$	$I_B = 0$				0.3	mA
I_{EBO}	Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$				1	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = 4 \text{ V}$ $V_{CE} = 4 \text{ V}$	$I_C = 0.2 \text{ A}$ $I_C = 1 \text{ A}$	(see Notes 5 and 6)	40			
					15			
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = 0.2 \text{ A}$	$I_C = 1 \text{ A}$	(see Notes 5 and 6)			0.7	V
V_{BE}	Base-emitter voltage	$V_{CE} = 4 \text{ V}$	$I_C = 1 \text{ A}$	(see Notes 5 and 6)			1.3	V
h_{ie}	Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.2 \text{ A}$	$f = 1 \text{ kHz}$	20			
$ h_{ie} $	Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.2 \text{ A}$	$f = 1 \text{ MHz}$	3			

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			4.17	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = 200 \text{ mA}$	$I_{B(on)} = 20 \text{ mA}$	$I_{B(off)} = -20 \text{ mA}$		0.3		μs
t_{off}	Turn-off time				$V_{BE(off)} = -3.4 \text{ V}$	$R_L = 150 \Omega$	$t_p = 20 \mu\text{s}$, dc $\leq 2\%$	0.8

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
vs
COLLECTOR CURRENT

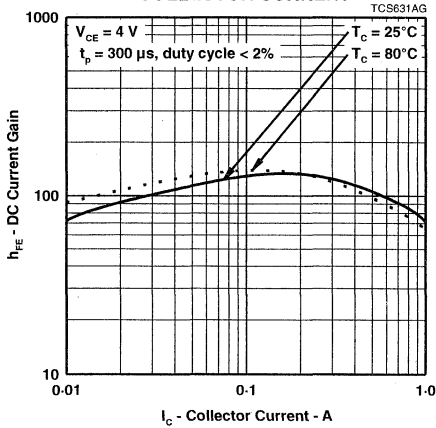


Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE
vs
BASE CURRENT

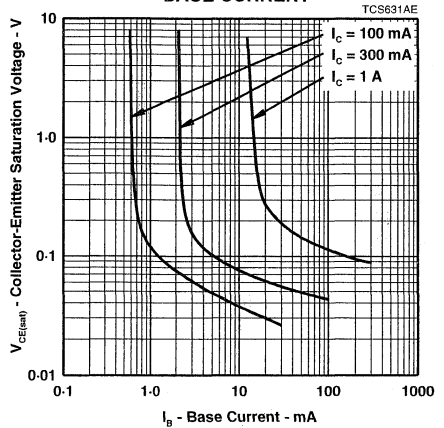


Figure 2.

BASE-EMITTER VOLTAGE
vs
COLLECTOR CURRENT

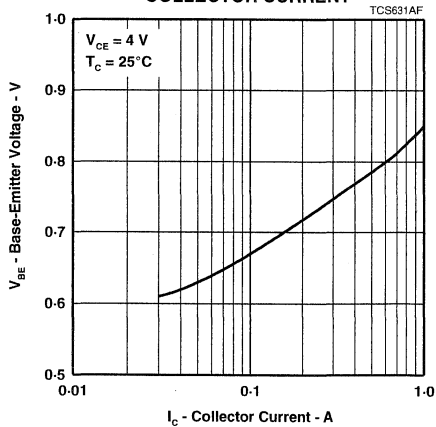


Figure 3.

BD239D, BD239E, BD239F
NPN SILICON POWER TRANSISTORS

SEPTEMBER 1981 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

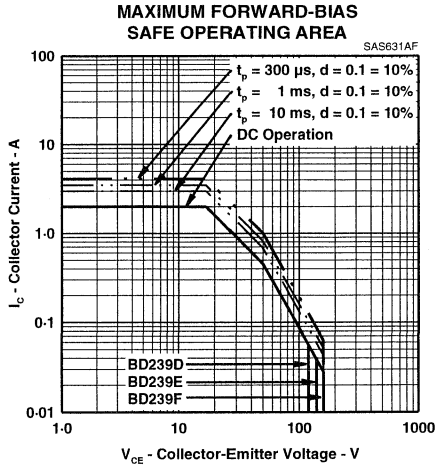


Figure 4.

THERMAL INFORMATION

**MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE**

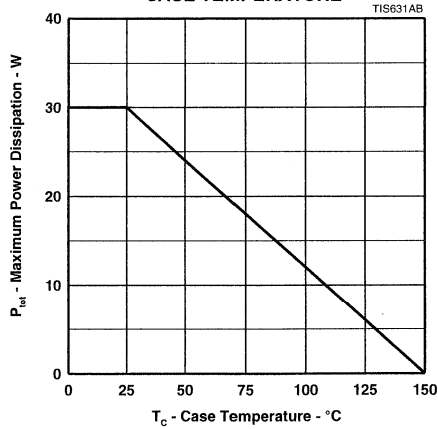
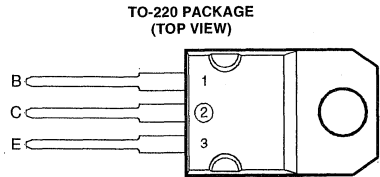


Figure 5.

BD240, BD240A, BD240B, BD240C PNP SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

- Designed for Complementary Use with the BD241 Series
- 30 W at 25°C Case Temperature
- 2 A Continuous Collector Current
- 4 A Peak Collector Current
- Customer-Specified Selections Available



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-emitter voltage ($R_{BE} = 100 \Omega$)	BD240	V_{CER}	-55	V
	BD240A		-70	
	BD240B		-90	
	BD240C		-115	
Collector-emitter voltage ($I_C = -30 \text{ mA}$)	BD240	V_{CEO}	-45	V
	BD240A		-60	
	BD240B		-80	
	BD240C		-100	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-2	A
Peak collector current (see Note 1)		I_{CM}	-4	A
Continuous base current		I_B	-0.6	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	30	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	32	mJ
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	250	°C

NOTES: 1. This value applies for $t_p \leq 0.3 \text{ ms}$, duty cycle $\leq 10\%$.

2. Derate linearly to 150°C case temperature at the rate of 0.24 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20 \text{ mH}$, $I_{B(on)} = -0.4 \text{ A}$, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = -20 \text{ V}$.

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BD240, BD240A, BD240B, BD240C

PNP SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = -30 \text{ mA}$ (see Note 5)	$I_B = 0$	BD240	-45			V
				BD240A	-60			
				BD240B	-80			
				BD240C	-100			
I_{CES}	Collector-emitter cut-off current	$V_{CE} = -55 \text{ V}$ $V_{CE} = -70 \text{ V}$ $V_{CE} = -90 \text{ V}$ $V_{CE} = -115 \text{ V}$	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	BD240			-0.2	mA
				BD240A			-0.2	
				BD240B			-0.2	
				BD240C			-0.2	
I_{CEO}	Collector cut-off current	$V_{CE} = -30 \text{ V}$ $V_{CE} = -60 \text{ V}$	$I_B = 0$ $I_B = 0$	BD240/240A			-0.3	mA
				BD240B/240C			-0.3	
I_{EBO}	Emitter cut-off current	$V_{EB} = -5 \text{ V}$	$I_C = 0$				-1	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = -4 \text{ V}$ $V_{CE} = -4 \text{ V}$	$I_C = -0.2 \text{ A}$ $I_C = -1 \text{ A}$	(see Notes 5 and 6)	40			
					15			
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = -0.2 \text{ A}$	$I_C = -1 \text{ A}$	(see Notes 5 and 6)			-0.7	V
V_{BE}	Base-emitter voltage	$V_{CE} = -4 \text{ V}$	$I_C = -1 \text{ A}$	(see Notes 5 and 6)			-1.3	V
h_{fe}	Small signal forward current transfer ratio	$V_{CE} = -10 \text{ V}$	$I_C = -0.2 \text{ A}$	$f = 1 \text{ kHz}$	20			
$ h_{fe} $	Small signal forward current transfer ratio	$V_{CE} = -10 \text{ V}$	$I_C = -0.2 \text{ A}$	$f = 1 \text{ MHz}$	3			

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			4.17	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = -200 \text{ mA}$	$I_{B(on)} = -20 \text{ mA}$	$I_{B(off)} = 20 \text{ mA}$		0.2		μs
t_{off}	Turn-off time	$V_{BE(off)} = 3.4 \text{ V}$	$R_L = 150 \Omega$	$t_p = 20 \mu\text{s}$, dc $\leq 2\%$		0.4		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

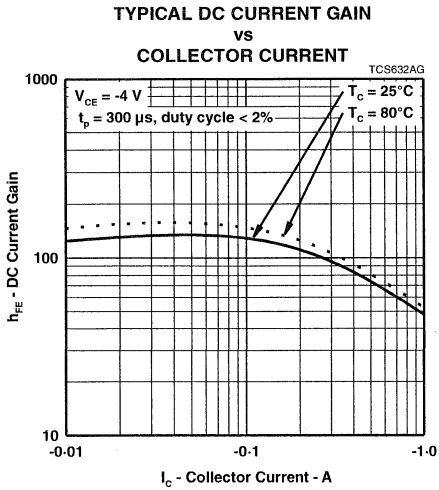


Figure 1.

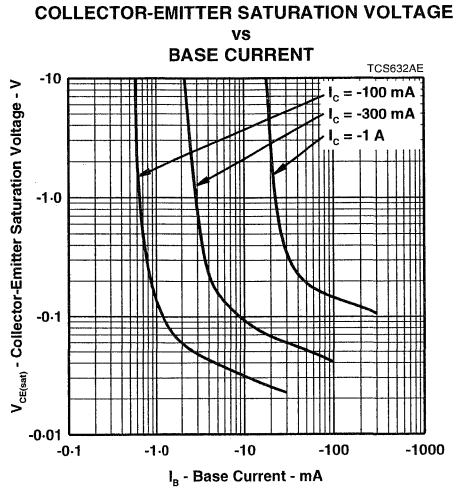


Figure 2.

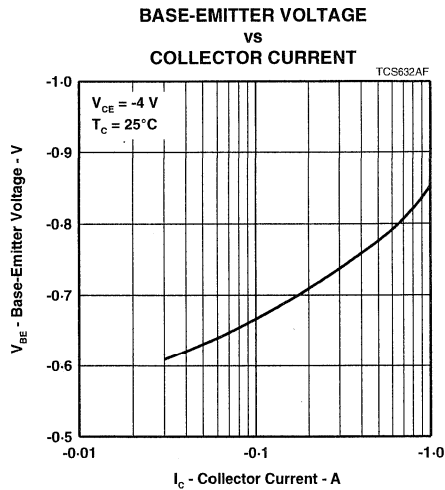


Figure 3.

BD240, BD240A, BD240B, BD240C
PNP SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

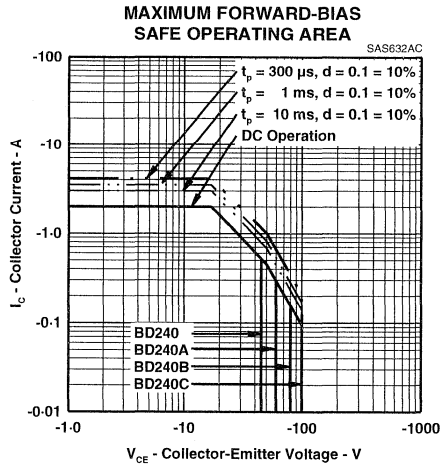


Figure 4.

THERMAL INFORMATION

**MAXIMUM POWER DISSIPATION
VS
CASE TEMPERATURE**

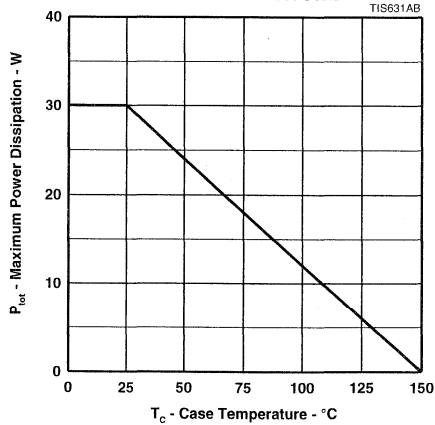


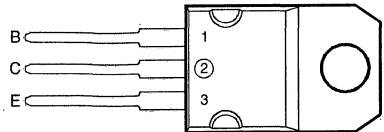
Figure 5.

BD241, BD241A, BD241B, BD241C NPN SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

- Designed for Complementary Use with the BD242 Series
- 40 W/ at 25°C Case Temperature
- 3 A Continuous Collector Current
- 5 A Peak Collector Current
- Customer-Specified Selections Available

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-emitter voltage ($I_{BE} = 100 \Omega$)	BD241	V_{CEr}	55	V
	BD241A		70	
	BD241B		90	
	BD241C		115	
Collector-emitter voltage ($I_C = 30 \text{ mA}$)	BD241	V_{CE0}	45	V
	BD241A		60	
	BD241B		80	
	BD241C		100	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	3	A
Peak collector current (see Note 1)		I_{CM}	5	A
Continuous base current		I_B	1	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	40	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	32	mJ
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	250	°C

- NOTES: 1. This value applies for $t_{on} \leq 0.3 \text{ ms}$, duty cycle $\leq 10\%$.
 2. Derate linearly to 150°C case temperature at the rate of 0.32 W/°C.
 3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.
 4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20 \text{ mH}$, $I_{B(on)} = 0.4 \text{ A}$, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = 20 \text{ V}$.

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BD241, BD241A, BD241B, BD241C

NPN SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$ (see Note 5)	$I_B = 0$	BD241	45			V
				BD241A	60			
				BD241B	80			
				BD241C	100			
I_{CES}	Collector-emitter cut-off current	$V_{CE} = 55 \text{ V}$ $V_{CE} = 70 \text{ V}$ $V_{CE} = 90 \text{ V}$ $V_{CE} = 115 \text{ V}$	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	BD241			0.2	mA
				BD241A			0.2	
				BD241B			0.2	
				BD241C			0.2	
I_{CEO}	Collector cut-off current	$V_{CE} = 30 \text{ V}$ $V_{CE} = 60 \text{ V}$	$I_B = 0$ $I_B = 0$	BD241/241A			0.3	mA
				BD241B/241C			0.3	
I_{EBO}	Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$				1	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = 4 \text{ V}$ $V_{CE} = 4 \text{ V}$	$I_C = 1 \text{ A}$ $I_C = 3 \text{ A}$	(see Notes 5 and 6)	25			
					10			
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = 0.6 \text{ A}$	$I_C = 3 \text{ A}$	(see Notes 5 and 6)			1.2	V
V_{BE}	Base-emitter voltage	$V_{CE} = 4 \text{ V}$	$I_C = 3 \text{ A}$	(see Notes 5 and 6)			1.8	V
h_{fe}	Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ kHz}$	20			
$ h_{fe} $	Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ MHz}$	3			

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			3.125	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = 1 \text{ A}$	$I_{B(on)} = 0.1 \text{ A}$	$I_{B(off)} = -0.1 \text{ A}$		0.3		μs
t_{off}	Turn-off time	$V_{BE(off)} = -3.7 \text{ V}$	$R_L = 20 \Omega$	$t_p = 20 \mu\text{s}$, $d_c \leq 2\%$		1		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
vs
COLLECTOR CURRENT

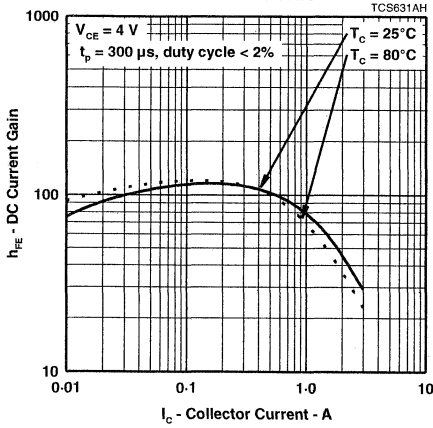


Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE
vs
BASE CURRENT

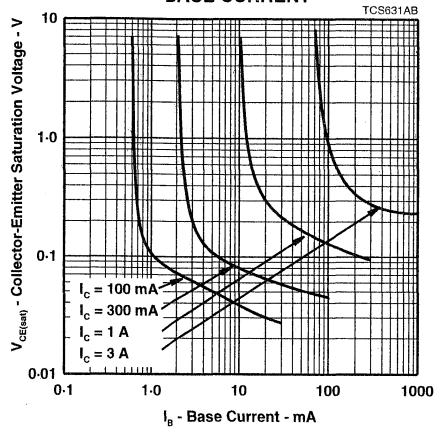


Figure 2.

BASE-EMITTER VOLTAGE
vs
COLLECTOR CURRENT

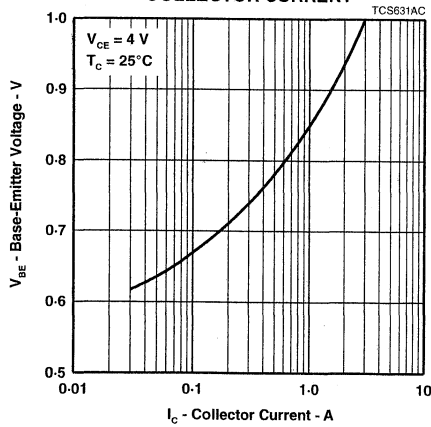


Figure 3.

**BD241, BD241A, BD241B, BD241C
NPN SILICON POWER TRANSISTORS**

JUNE 1973 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

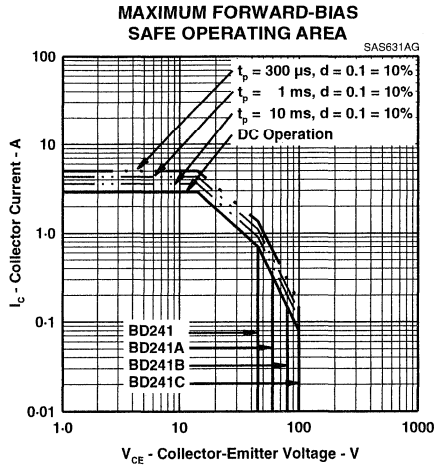


Figure 4.

THERMAL INFORMATION

**MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE**

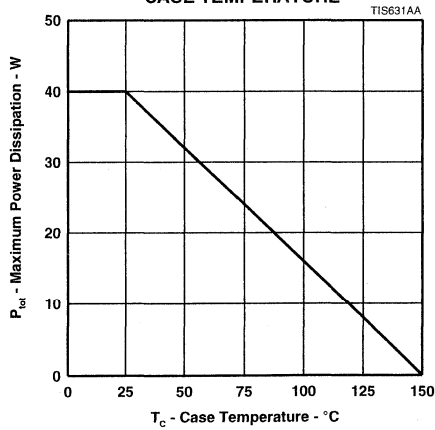
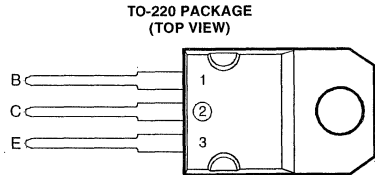


Figure 5.

BD241D, BD241E, BD241F NPN SILICON POWER TRANSISTORS

SEPTEMBER 1981 - REVISED MAY 1995

- 40 W at 25°C Case Temperature
- 3 A Continuous Collector Current
- 5 A Peak Collector Current
- Customer-Specified Selections Available



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-emitter voltage ($R_{BE} = 100 \Omega$)	BD241D	V_{CEr}	160	V
	BD241E		180	
	BD241F		200	
Collector-emitter voltage ($I_B = 0$)	BD241D	V_{CE0}	120	V
	BD241E		140	
	BD241F		160	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	3	A
Peak collector current (see Note 1)		I_{CM}	5	A
Continuous base current		I_B	1	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	40	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	32	mJ
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	250	°C

- NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.
2. Derate linearly to 150°C case temperature at the rate of 0.32 W/°C.
3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.
4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = 0.4$ A, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = 20$ V.

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BD241D, BD241E, BD241F

NPN SILICON POWER TRANSISTORS

SEPTEMBER 1981 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$ Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$ $I_B = 0$ (see Note 5)	BD241D	120		V
		BD241E	140		
		BD241F	160		
I_{CES} Collector-emitter cut-off current	$V_{CE} = 160 \text{ V}$ $V_{BE} = 0$ $V_{CE} = 180 \text{ V}$ $V_{BE} = 0$ $V_{CE} = 200 \text{ V}$ $V_{BE} = 0$	BD241D		0.2	mA
		BD241E		0.2	
		BD241F		0.2	
I_{CEO} Collector cut-off current	$V_{CE} = 90 \text{ V}$ $I_B = 0$			0.3	mA
I_{EBO} Emitter cut-off current	$V_{EB} = 5 \text{ V}$ $I_C = 0$			1	mA
h_{FE} Forward current transfer ratio	$V_{CE} = 4 \text{ V}$ $I_C = 1 \text{ A}$ $V_{CE} = 4 \text{ V}$ $I_C = 3 \text{ A}$	(see Notes 5 and 6)	25		
			5		
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 750 \text{ mA}$ $I_C = 3 \text{ A}$	(see Notes 5 and 6)		2.5	V
V_{BE} Base-emitter voltage	$V_{CE} = 4 \text{ V}$ $I_C = 3 \text{ A}$	(see Notes 5 and 6)		1.8	V
h_{ie} Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$ $I_C = 0.5 \text{ A}$	$f = 1 \text{ kHz}$	20		
$ h_{ie} $ Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$ $I_C = 0.5 \text{ A}$	$f = 1 \text{ MHz}$	3		

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			3.125	°C/W
$R_{\theta JA}$ Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †	MIN	TYP	MAX	UNIT
t_{on} Turn-on time	$I_C = 1 \text{ A}$ $I_{B(on)} = 0.1 \text{ A}$ $I_{B(off)} = -0.1 \text{ A}$		0.3		μs
t_{off} Turn-off time	$V_{BE(off)} = -3.7 \text{ V}$ $R_L = 20 \Omega$ $t_p = 20 \mu\text{s}$, dc $\leq 2\%$		1		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
vs
COLLECTOR CURRENT

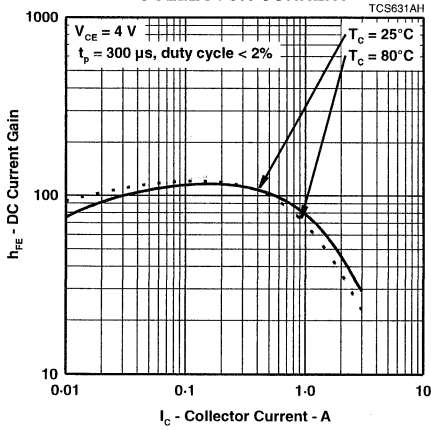


Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE
vs
BASE CURRENT

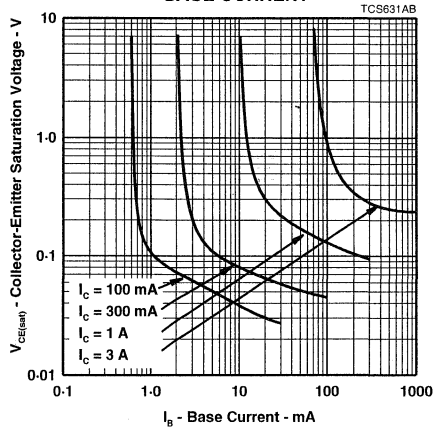


Figure 2.

BASE-EMITTER VOLTAGE
vs
COLLECTOR CURRENT

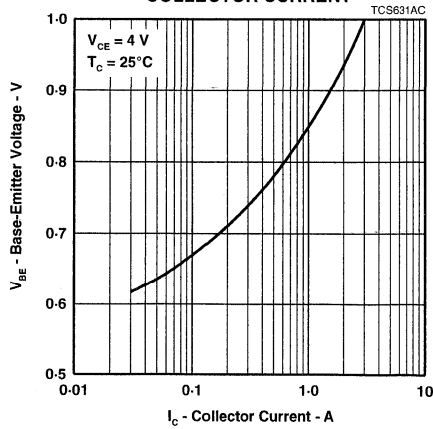


Figure 3.

BD241D, BD241E, BD241F
NPN SILICON POWER TRANSISTORS

SEPTEMBER 1981 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

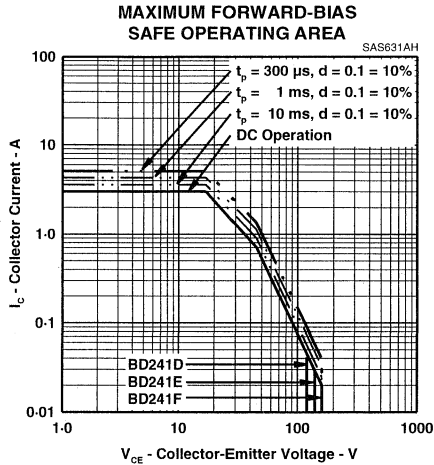


Figure 4.

THERMAL INFORMATION

**MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE**

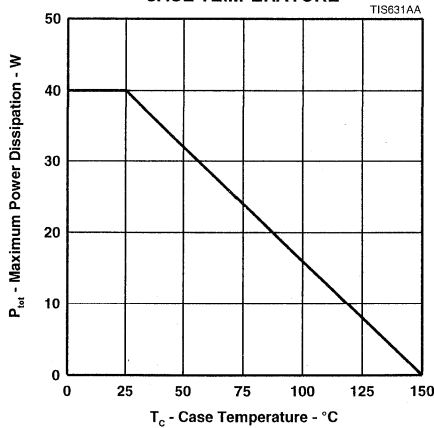
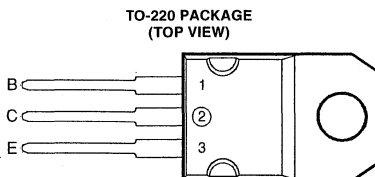


Figure 5.

BD242, BD242A, BD242B, BD242C PNP SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

- Designed for Complementary Use with the BD241 Series
- 40 W at 25°C Case Temperature
- 3 A Continuous Collector Current
- 5 A Peak Collector Current
- Customer-Specified Selections Available



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-emitter voltage ($R_{BE} = 100 \Omega$)	BD242	V_{CER}	-55	V
	BD242A		-70	
	BD242B		-90	
	BD242C		-115	
Collector-emitter voltage ($I_C = -30 \text{ mA}$)	BD242	V_{CEO}	-45	V
	BD242A		-60	
	BD242B		-80	
	BD242C		-100	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-3	A
Peak collector current (see Note 1)		I_{CM}	-5	A
Continuous base current		I_B	-1	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	40	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	32	mJ
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	250	°C

NOTES: 1. This value applies for $t_p \leq 0.3 \text{ ms}$, duty cycle $\leq 10\%$.

2. Derate linearly to 150°C case temperature at the rate of 0.32 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20 \text{ mH}$, $I_{B(on)} = -0.4 \text{ A}$, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = -20 \text{ V}$.

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BD242, BD242A, BD242B, BD242C

PNP SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT	
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = -30$ mA (see Note 5)	$I_B = 0$	BD242	-45			V	
				BD242A	-60				
				BD242B	-80				
				BD242C	-100				
I_{CES}	Collector-emitter cut-off current			BD242			-0.2	mA	
				BD242A			-0.2		
				BD242B			-0.2		
				BD242C			-0.2		
I_{CEO}	Collector cut-off current		$I_B = 0$	BD242/242A			-0.3	mA	
				BD242B/242C			-0.3		
I_{EBO}	Emitter cut-off current		$I_C = 0$				-1	mA	
h_{FE}	Forward current transfer ratio		$I_C = -1$ A		25				
									$I_C = -3$ A
$V_{CE(sat)}$	Collector-emitter saturation voltage		$I_B = -0.6$ A	$I_C = -3$ A				-1.2	V
V_{BE}	Base-emitter voltage		$I_C = -3$ A					-1.8	V
h_{fe}	Small signal forward current transfer ratio		$I_C = -0.5$ A		20				
$ h_{ie} $	Small signal forward current transfer ratio		$I_C = -0.5$ A		3				

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300$ μ s, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			3.125	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = -1$ A	$I_{B(on)} = -0.1$ A	$I_{B(off)} = 0.1$ A		0.2		μ s
t_{off}	Turn-off time	$V_{BE(off)} = 3.7$ V	$R_L = 20$ Ω	$t_p = 20$ μ s, dc $\leq 2\%$		0.3		μ s

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

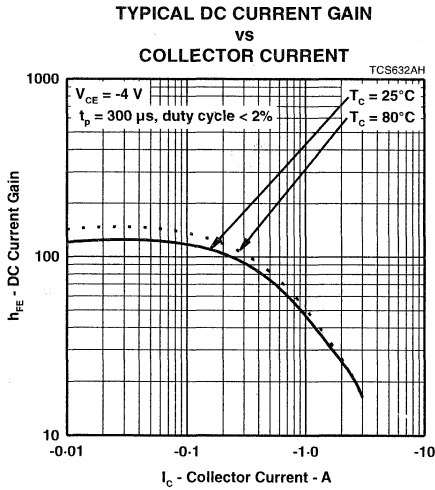


Figure 1.

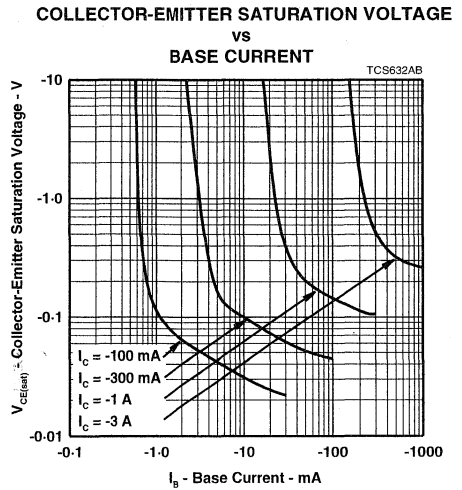


Figure 2.

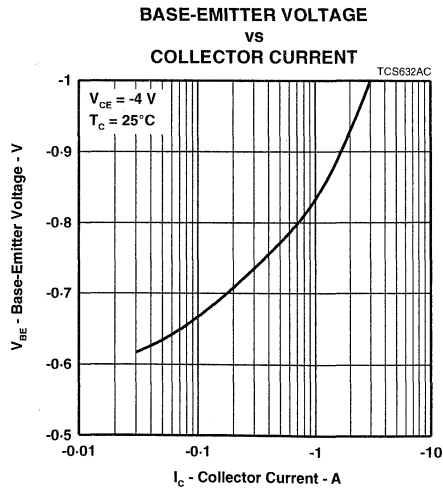


Figure 3.

BD242, BD242A, BD242B, BD242C
PNP SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

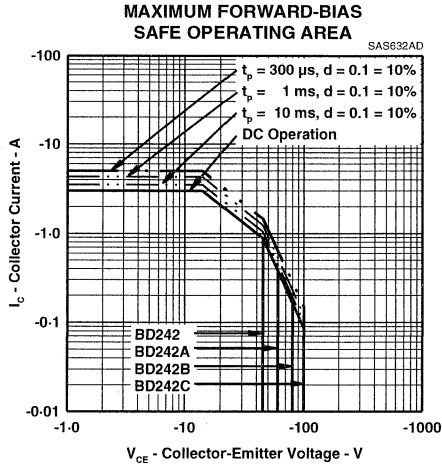


Figure 4.

THERMAL INFORMATION

**MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE**

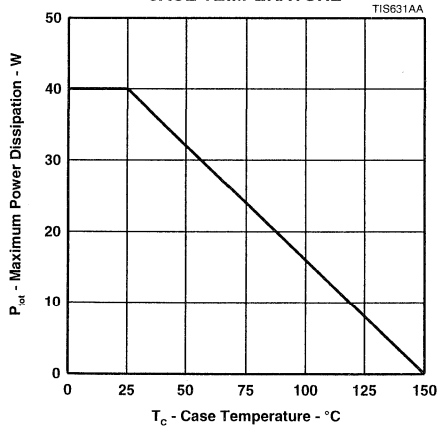
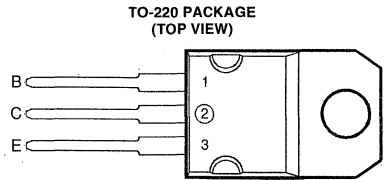


Figure 5.

BD243, BD243A, BD243B, BD243C NPN SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

- Designed for Complementary Use with the BD244 Series
- 65 W at 25°C Case Temperature
- 6 A Continuous Collector Current
- 10 A Peak Collector Current
- Customer-Specified Selections Available



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-emitter voltage ($R_{BE} = 100 \Omega$)	BD243	V_{CE}	55	V
	BD243A		70	
	BD243B		90	
	BD243C		115	
Collector-emitter voltage ($I_C = 30 \text{ mA}$)	BD243	V_{CEO}	45	V
	BD243A		60	
	BD243B		80	
	BD243C		100	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	6	A
Peak collector current (see Note 1)		I_{CM}	10	A
Continuous base current		I_B	3	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	65	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	62.5	mJ
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	250	°C

NOTES: 1. This value applies for $t_p \leq 0.3 \text{ ms}$, duty cycle $\leq 10\%$.

2. Derate linearly to 150°C case temperature at the rate of 0.52 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20 \text{ mH}$, $I_{B(on)} = 0.4 \text{ A}$, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = 20 \text{ V}$.

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BD243, BD243A, BD243B, BD243C

NPN SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$ Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$ $I_B = 0$ (see Note 5)		BD243	45			V
			BD243A	60			
			BD243B	80			
			BD243C	100			
I_{CES} Collector-emitter cut-off current	$V_{CE} = 55 \text{ V}$ $V_{CE} = 70 \text{ V}$ $V_{CE} = 90 \text{ V}$ $V_{CE} = 115 \text{ V}$	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	BD243			0.4	mA
			BD243A			0.4	
			BD243B			0.4	
			BD243C			0.4	
I_{CEO} Collector cut-off current	$V_{CE} = 30 \text{ V}$ $V_{CE} = 60 \text{ V}$	$I_B = 0$ $I_B = 0$	BD243/243A			0.7	mA
			BD243B/243C			0.7	
I_{EBO} Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$				1	mA
h_{FE} Forward current transfer ratio	$V_{CE} = 4 \text{ V}$ $V_{CE} = 4 \text{ V}$	$I_C = 0.3 \text{ A}$ $I_C = 3 \text{ A}$	(see Notes 5 and 6)	30			
				15			
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 1 \text{ A}$	$I_C = 6 \text{ A}$	(see Notes 5 and 6)			1.5	V
V_{BE} Base-emitter voltage	$V_{CE} = 4 \text{ V}$	$I_C = 6 \text{ A}$	(see Notes 5 and 6)			2	V
h_{fe} Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ kHz}$	20			
$ h_{fe} $ Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ MHz}$	3			

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1.92	°C/W
$R_{\theta JA}$ Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on} Turn-on time	$I_C = 1 \text{ A}$	$I_{B(on)} = 0.1 \text{ A}$	$I_{B(off)} = -0.1 \text{ A}$		0.3		μs
t_{off} Turn-off time	$V_{BE(off)} = -3.7 \text{ V}$	$R_L = 20 \Omega$	$t_p = 20 \mu\text{s}$, $dc \leq 2\%$		1		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
VS
COLLECTOR CURRENT

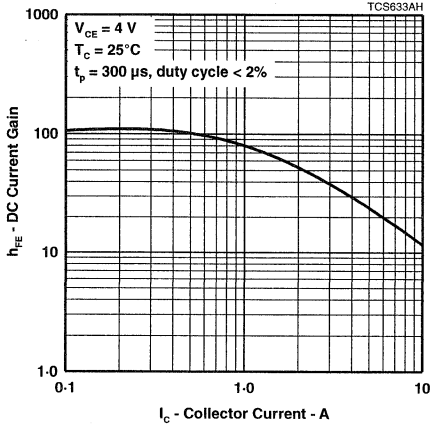


Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE
VS
BASE CURRENT

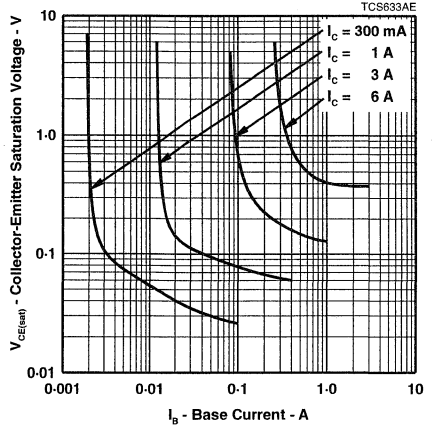


Figure 2.

BASE-EMITTER VOLTAGE
VS
COLLECTOR CURRENT

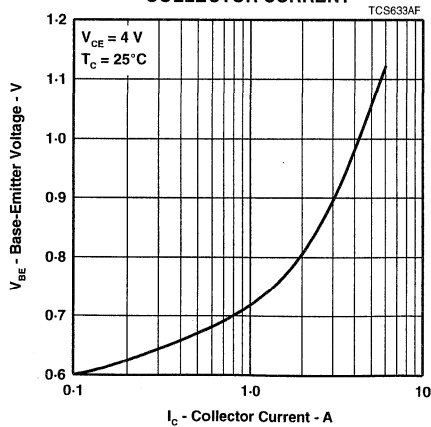


Figure 3.

BD243, BD243A, BD243B, BD243C
NPN SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

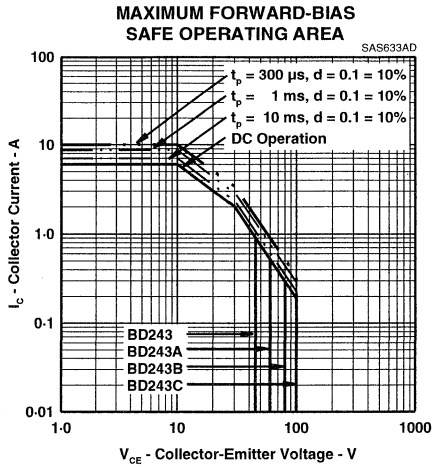


Figure 4.

THERMAL INFORMATION

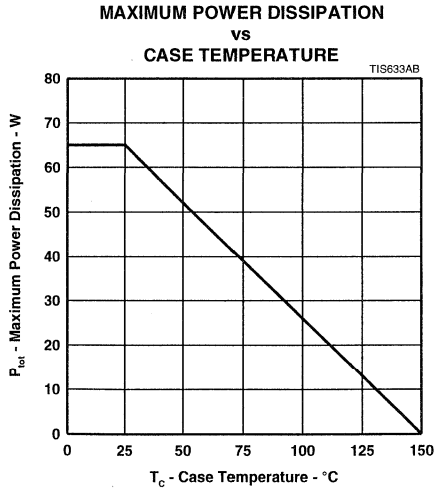
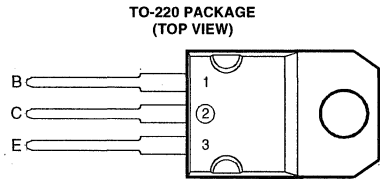


Figure 5.

BD244, BD244A, BD244B, BD244C PNP SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

- Designed for Complementary Use with the BD243 Series
- 65 W at 25°C Case Temperature
- 6 A Continuous Collector Current
- 10 A Peak Collector Current
- Customer-Specified Selections Available



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-emitter voltage ($R_{BE} = 100 \Omega$)	BD244	V_{CER}	-55	V
	BD244A		-70	
	BD244B		-90	
	BD244C		-115	
Collector-emitter voltage ($I_C = -30 \text{ mA}$)	BD244	V_{CEO}	-45	V
	BD244A		-60	
	BD244B		-80	
	BD244C		-100	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-6	A
Peak collector current (see Note 1)		I_{CM}	-10	A
Continuous base current		I_B	-3	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	65	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	62.5	mJ
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	250	°C

NOTES: 1. This value applies for $t_p \leq 0.3 \text{ ms}$, duty cycle $\leq 10\%$.

2. Derate linearly to 150°C case temperature at the rate of 0.52 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20 \text{ mH}$, $I_{B(on)} = -0.4 \text{ A}$, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = -20 \text{ V}$.

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 **TEXAS
INSTRUMENTS**

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BD244, BD244A, BD244B, BD244C

PNP SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = -30$ mA (see Note 5)	$I_B = 0$	BD244	-45			V
				BD244A	-60			
				BD244B	-80			
				BD244C	-100			
I_{CES}	Collector-emitter cut-off current	$V_{CE} = -55$ V $V_{CE} = -70$ V $V_{CE} = -90$ V $V_{CE} = -115$ V	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	BD244			-0.4	mA
				BD244A			-0.4	
				BD244B			-0.4	
				BD244C			-0.4	
I_{CEO}	Collector cut-off current	$V_{CE} = -30$ V $V_{CE} = -60$ V	$I_B = 0$ $I_B = 0$	BD244/244A			-0.7	mA
				BD244B/244C			-0.7	
I_{EBO}	Emitter cut-off current	$V_{EB} = -5$ V	$I_C = 0$				-1	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = -4$ V $V_{CE} = -4$ V	$I_C = -0.3$ A $I_C = -3$ A	(see Notes 5 and 6)	30			
					15			
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = -1$ A	$I_C = -6$ A	(see Notes 5 and 6)			-1.5	V
V_{BE}	Base-emitter voltage	$V_{CE} = -4$ V	$I_C = -6$ A	(see Notes 5 and 6)			-2	V
h_{fe}	Small signal forward current transfer ratio	$V_{CE} = -10$ V	$I_C = -0.5$ A	$f = 1$ kHz	20			
$ h_{fe} $	Small signal forward current transfer ratio	$V_{CE} = -10$ V	$I_C = -0.5$ A	$f = 1$ MHz	3			

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300$ μ s, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.92	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = -1$ A	$I_{B(on)} = -0.1$ A	$I_{B(off)} = 0.1$ A		0.3		μ s
t_{off}	Turn-off time	$V_{BE(off)} = 3.7$ V	$R_L = 20$ Ω	$t_p = 20$ μ s, $d_c \leq 2\%$		1		μ s

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
VS
COLLECTOR CURRENT

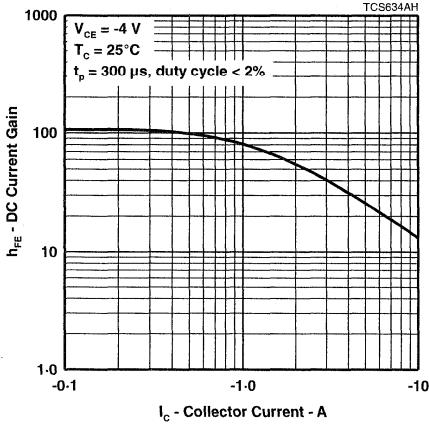


Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE
VS
BASE CURRENT

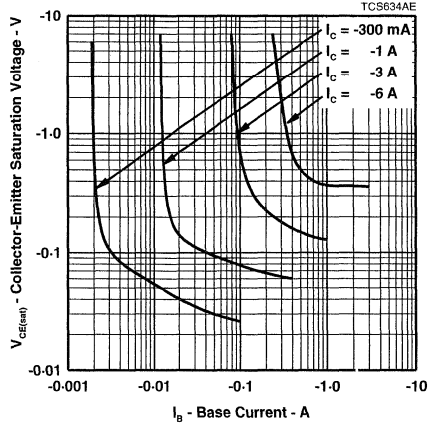


Figure 2.

BASE-EMITTER VOLTAGE
VS
COLLECTOR CURRENT

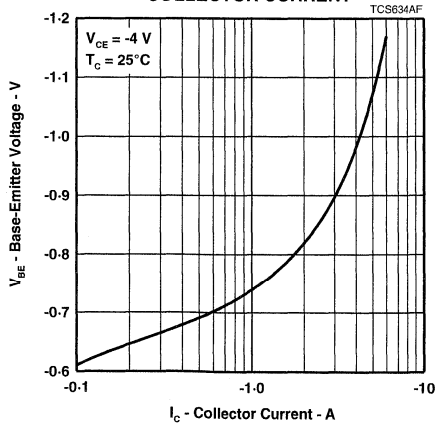
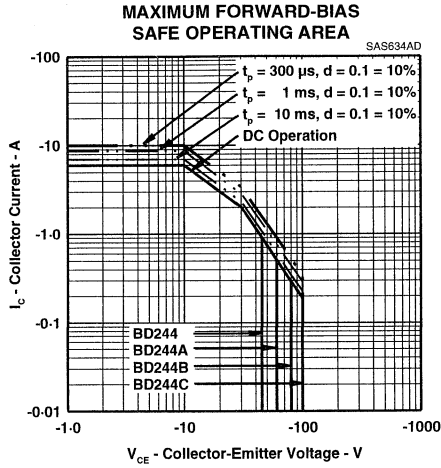


Figure 3.

BD244, BD244A, BD244B, BD244C
PNP SILICON POWER TRANSISTORS

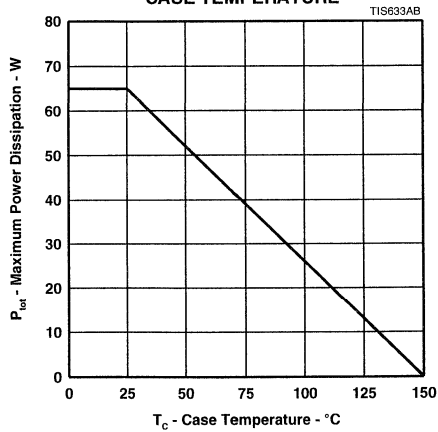
JUNE 1973 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS



THERMAL INFORMATION

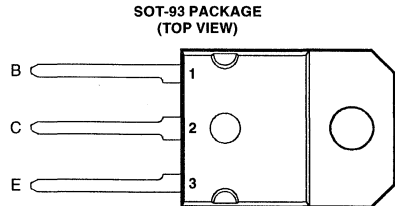
**MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE**



BD245, BD245A, BD245B, BD245C NPN SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

- Designed for Complementary Use with the BD246 Series
- 80 W at 25°C Case Temperature
- 10 A Continuous Collector Current
- 15 A Peak Collector Current
- Customer-Specified Selections Available



Pin 2 is in electrical contact with the mounting base.

MDTRAA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-emitter voltage ($R_{BE} = 100 \Omega$)	BD245	V_{CER}	55	V
	BD245A		70	
	BD245B		90	
	BD245C		115	
Collector-emitter voltage ($I_C = 30 \text{ mA}$)	BD245	V_{CEO}	45	V
	BD245A		60	
	BD245B		80	
	BD245C		100	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	10	A
Peak collector current (see Note 1)		I_{CM}	15	A
Continuous base current		I_B	3	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	80	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	3	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	62.5	mJ
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	250	°C

NOTES: 1. This value applies for $t_p \leq 0.3 \text{ ms}$, duty cycle $\leq 10\%$.

2. Derate linearly to 150°C case temperature at the rate of 0.64 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 24 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20 \text{ mH}$, $I_{B(on)} = 0.4 \text{ A}$, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = 20 \text{ V}$.

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TEXAS
INSTRUMENTS

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BD245, BD245A, BD245B, BD245C

NPN SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$ (see Note 5)	$I_B = 0$	BD245	45			V
				BD245A	60			
				BD245B	80			
				BD245C	100			
I_{CES}	Collector-emitter cut-off current	$V_{CE} = 55 \text{ V}$ $V_{CE} = 70 \text{ V}$ $V_{CE} = 90 \text{ V}$ $V_{CE} = 115 \text{ V}$	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	BD245			0.4	mA
				BD245A			0.4	
				BD245B			0.4	
				BD245C			0.4	
I_{CEO}	Collector cut-off current	$V_{CE} = 30 \text{ V}$ $V_{CE} = 60 \text{ V}$	$I_B = 0$ $I_B = 0$	BD245/245A			0.7	mA
				BD245B/245C			0.7	
I_{EBO}	Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$				1	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = 4 \text{ V}$ $V_{CE} = 4 \text{ V}$ $V_{CE} = 4 \text{ V}$	$I_C = 1 \text{ A}$		40			
			$I_C = 3 \text{ A}$	(see Notes 5 and 6)	20			
			$I_C = 10 \text{ A}$		4			
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = 0.3 \text{ A}$ $I_B = 2.5 \text{ A}$	$I_C = 3 \text{ A}$	(see Notes 5 and 6)			1	V
			$I_C = 10 \text{ A}$			4		
V_{BE}	Base-emitter voltage	$V_{CE} = 4 \text{ V}$ $V_{CE} = 4 \text{ V}$	$I_C = 3 \text{ A}$	(see Notes 5 and 6)			1.6	V
			$I_C = 10 \text{ A}$			3		
h_{fe}	Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ kHz}$	20			
$ h_{fe} $	Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ MHz}$	3			

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.56	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			42	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = 1 \text{ A}$	$I_{B(on)} = 0.1 \text{ A}$	$I_{B(off)} = -0.1 \text{ A}$		0.3		μs
t_{off}	Turn-off time				$V_{BE(off)} = -3.7 \text{ V}$	$R_L = 20 \Omega$	$t_p = 20 \mu\text{s}$, dc $\leq 2\%$	

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

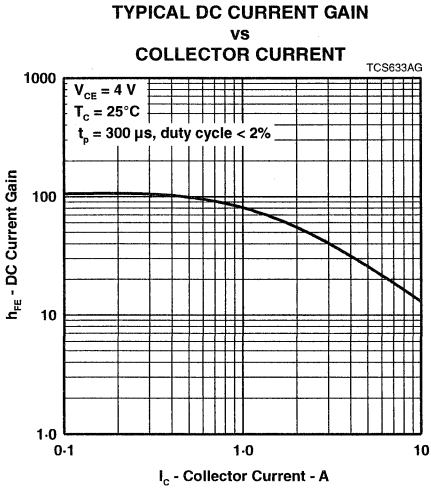


Figure 1.

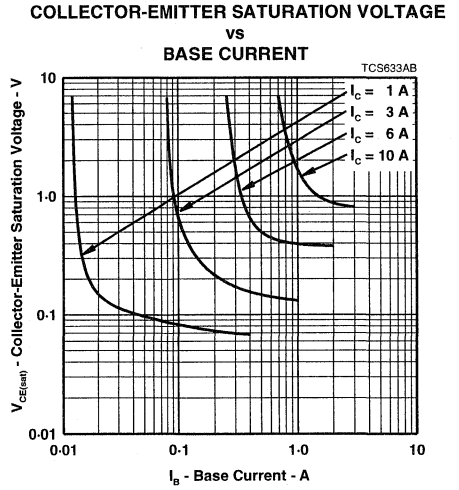


Figure 2.

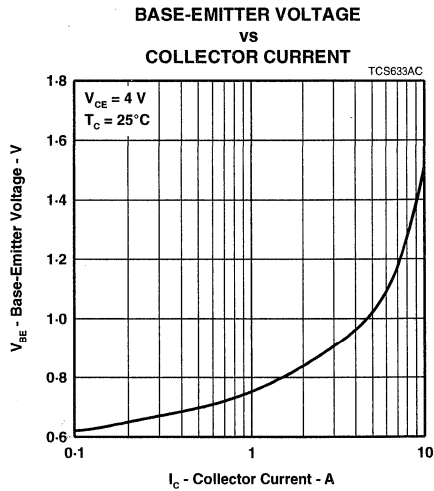


Figure 3.

BD245, BD245A, BD245B, BD245C
NPN SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

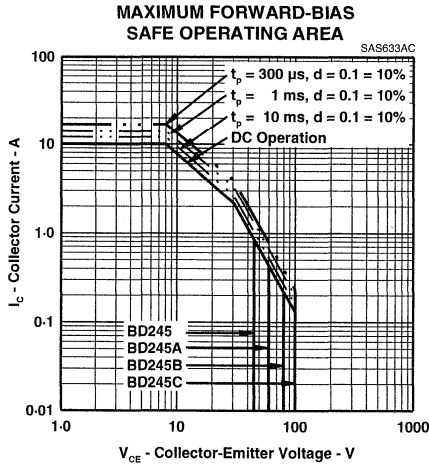


Figure 4.

THERMAL INFORMATION

**MAXIMUM POWER DISSIPATION
VS
CASE TEMPERATURE**

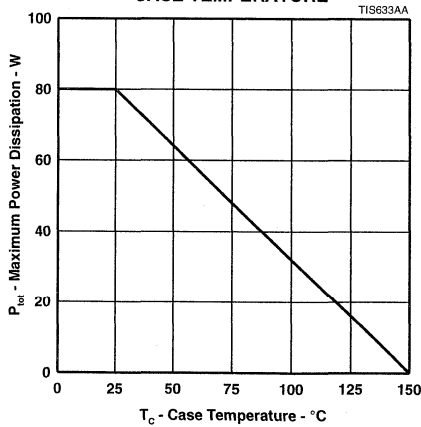
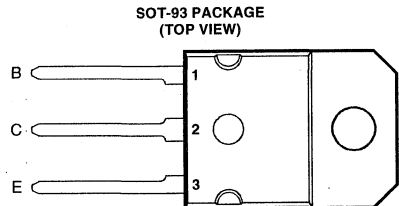


Figure 5.

BD246, BD246A, BD246B, BD246C PNP SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

- Designed for Complementary Use with the BD245 Series
- 80 W at 25°C Case Temperature
- 10 A Continuous Collector Current
- 15 A Peak Collector Current
- Customer-Specified Selections Available



Pin 2 is in electrical contact with the mounting base.

MDTRAA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-emitter voltage ($R_{BE} = 100 \Omega$)	BD246	V_{CER}	-55	V
	BD246A		-70	
	BD246B		-90	
	BD246C		-115	
Collector-emitter voltage ($I_C = -30 \text{ mA}$)	BD246	V_{CEO}	-45	V
	BD246A		-60	
	BD246B		-80	
	BD246C		-100	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-10	A
Peak collector current (see Note 1)		I_{CM}	-15	A
Continuous base current		I_B	-3	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	80	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	3	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	62.5	mJ
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	250	°C

- NOTES: 1. This value applies for $t_p \leq 0.3 \text{ ms}$, duty cycle $\leq 10\%$.
 2. Derate linearly to 150°C case temperature at the rate of 0.64 W/°C.
 3. Derate linearly to 150°C free air temperature at the rate of 24 mW/°C.
 4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20 \text{ mH}$, $I_{B(on)} = -0.4 \text{ A}$, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = -20 \text{ V}$.

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BD246, BD246A, BD246B, BD246C

PNP SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT	
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = -30$ mA (see Note 5)	$I_B = 0$	BD246	-45			V	
				BD246A	-60				
				BD246B	-80				
				BD246C	-100				
I_{CES}	Collector-emitter cut-off current	$V_{CE} = -55$ V $V_{CE} = -70$ V $V_{CE} = -90$ V $V_{CE} = -115$ V	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	BD246			-0.4	mA	
				BD246A			-0.4		
				BD246B			-0.4		
				BD246C			-0.4		
I_{CEO}	Collector cut-off current	$V_{CE} = -30$ V $V_{CE} = -60$ V	$I_B = 0$ $I_B = 0$	BD246/246A			-0.7	mA	
				BD246B/246C			-0.7		
I_{EBO}	Emitter cut-off current	$V_{EB} = -5$ V	$I_C = 0$				-1	mA	
h_{FE}	Forward current transfer ratio	$V_{CE} = -4$ V $V_{CE} = -4$ V $V_{CE} = -4$ V	$I_C = -1$ A $I_C = -3$ A $I_C = -10$ A	(see Notes 5 and 6)	40				
					20				
					4				
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = -0.3$ A $I_B = -2.5$ A	$I_C = -3$ A $I_C = -10$ A	(see Notes 5 and 6)			-1	V	
							-4		
V_{BE}	Base-emitter voltage	$V_{CE} = -4$ V $V_{CE} = -4$ V	$I_C = -3$ A $I_C = -10$ A	(see Notes 5 and 6)			-1.6	V	
							-3		
h_{fe}	Small signal forward current transfer ratio	$V_{CE} = -10$ V	$I_C = -0.5$ A	$f = 1$ kHz	20				
$ h_{fe} $	Small signal forward current transfer ratio	$V_{CE} = -10$ V	$I_C = -0.5$ A	$f = 1$ MHz	3				

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300$ μ s, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.56	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			42	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = -1$ A	$I_{B(on)} = -0.1$ A	$I_{B(off)} = 0.1$ A		0.2		μ s
t_{off}	Turn-off time	$V_{BE(off)} = -3.7$ V	$R_L = 20$ Ω	$t_p = 20$ μ s, dc $\leq 2\%$		0.8		μ s

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
vs
COLLECTOR CURRENT

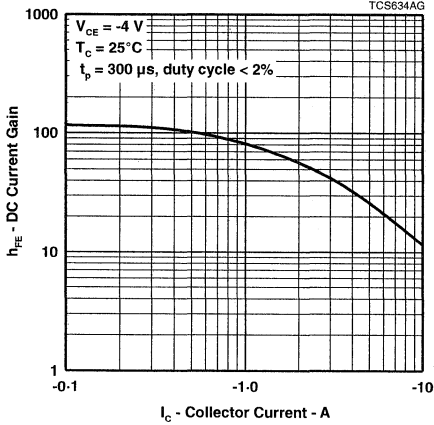


Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE
vs
BASE CURRENT

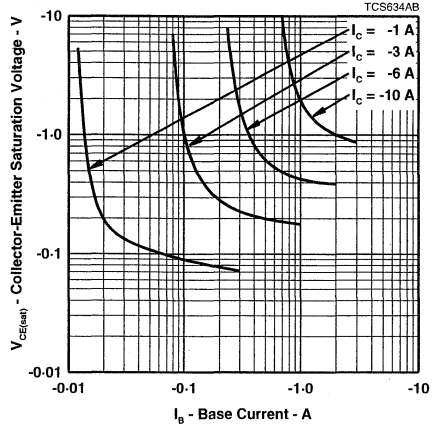


Figure 2.

BASE-EMITTER VOLTAGE
vs
COLLECTOR CURRENT

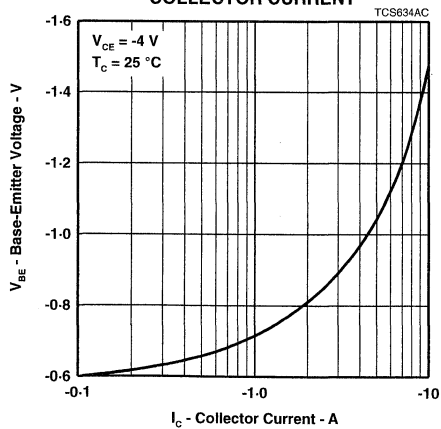
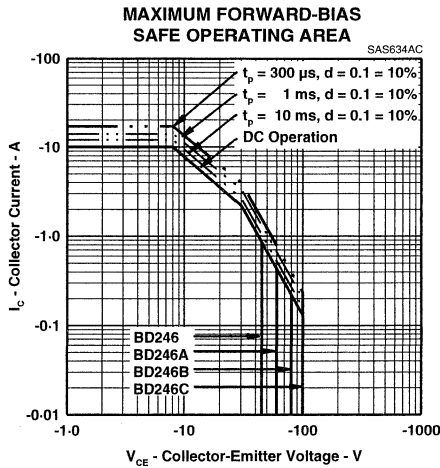


Figure 3.

BD246, BD246A, BD246B, BD246C
PNP SILICON POWER TRANSISTORS

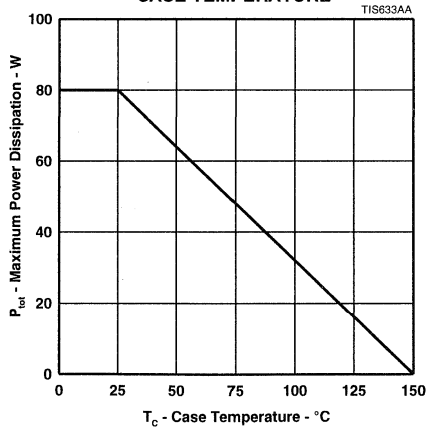
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MAXIMUM SAFE OPERATING REGIONS



THERMAL INFORMATION

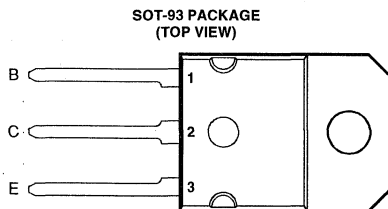
**MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE**



BD249, BD249A, BD249B, BD249C NPN SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

- Designed for Complementary Use with the BD250 Series
- 125 W at 25°C Case Temperature
- 25 A Continuous Collector Current
- 40 A Peak Collector Current
- Customer-Specified Selections Available



Pin 2 is in electrical contact with the mounting base.

MDTRAA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-emitter voltage ($R_{BE} = 100 \Omega$)	BD249	V_{CER}	55	V
	BD249A		70	
	BD249B		90	
	BD249C		115	
Collector-emitter voltage ($I_C = 30 \text{ mA}$)	BD249	V_{CEO}	45	V
	BD249A		60	
	BD249B		80	
	BD249C		100	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	25	A
Peak collector current (see Note 1)		I_{CM}	40	A
Continuous base current		I_B	5	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	125	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	3	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	90	mJ
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	250	°C

- NOTES: 1. This value applies for $t_p \leq 0.3 \text{ ms}$, duty cycle $\leq 10\%$.
 2. Derate linearly to 150°C case temperature at the rate of 1 W/°C.
 3. Derate linearly to 150°C free air temperature at the rate of 24 mW/°C.
 4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20 \text{ mH}$, $I_{B(on)} = 0.4 \text{ A}$, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = 20 \text{ V}$.

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**TEXAS
INSTRUMENTS**

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BD249, BD249A, BD249B, BD249C

NPN SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$ Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$ $I_B = 0$ (see Note 5)		BD249	45			V
			BD249A	60			
			BD249B	80			
			BD249C	100			
I_{CES} Collector-emitter cut-off current	$V_{CE} = 55 \text{ V}$ $V_{CE} = 70 \text{ V}$ $V_{CE} = 90 \text{ V}$ $V_{CE} = 115 \text{ V}$	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	BD249			0.7	mA
			BD249A			0.7	
			BD249B			0.7	
			BD249C			0.7	
I_{CEO} Collector cut-off current	$V_{CE} = 30 \text{ V}$ $V_{CE} = 60 \text{ V}$	$I_B = 0$ $I_B = 0$	BD249/249A			1	mA
			BD249B/249C			1	
I_{EBO} Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$				1	mA
h_{FE} Forward current transfer ratio	$V_{CE} = 4 \text{ V}$ $V_{CE} = 4 \text{ V}$ $V_{CE} = 4 \text{ V}$	$I_C = 1.5 \text{ A}$ $I_C = 15 \text{ A}$ $I_C = 25 \text{ A}$	(see Notes 5 and 6)	25			
				10			
				5			
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 1.5 \text{ A}$ $I_B = 5 \text{ A}$	$I_C = 15 \text{ A}$ $I_C = 25 \text{ A}$	(see Notes 5 and 6)			1.8	V
						4	
V_{BE} Base-emitter voltage	$V_{CE} = 4 \text{ V}$ $V_{CE} = 4 \text{ V}$	$I_C = 15 \text{ A}$ $I_C = 25 \text{ A}$	(see Notes 5 and 6)			2	V
						4	
h_{fe} Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 1 \text{ A}$	$f = 1 \text{ kHz}$	25			
$ h_{fe} $ Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 1 \text{ A}$	$f = 1 \text{ MHz}$	3			

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1	°C/W
$R_{\theta JA}$ Junction to free air thermal resistance			42	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on} Turn-on time	$I_C = 5 \text{ A}$ $V_{BE(off)} = -5 \text{ V}$	$I_{B(on)} = 0.5 \text{ A}$ $R_L = 5 \Omega$	$I_{B(off)} = -0.5 \text{ A}$ $t_p = 20 \mu\text{s}$, dc $\leq 2\%$		0.3		μs
t_{off} Turn-off time					0.9		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
VS
COLLECTOR CURRENT

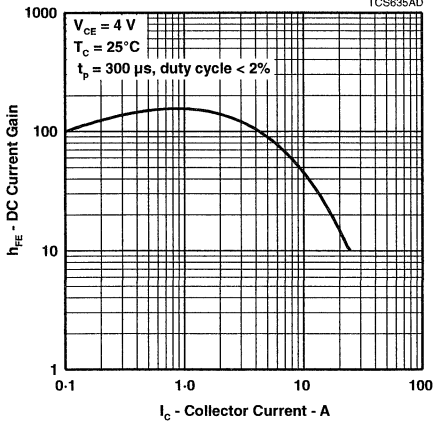


Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE
VS
BASE CURRENT

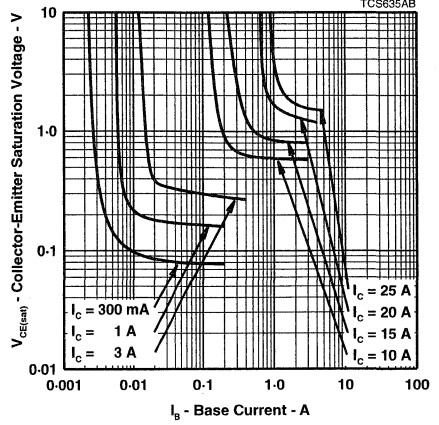


Figure 2.

BASE-EMITTER VOLTAGE
VS
COLLECTOR CURRENT

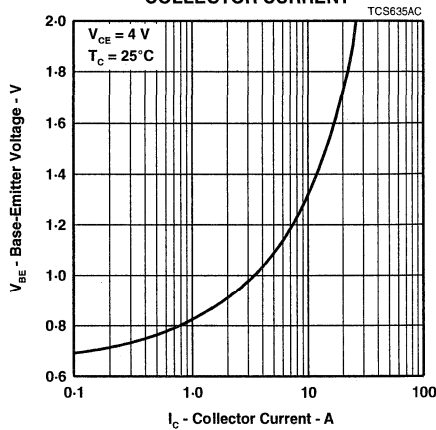


Figure 3.

BD249, BD249A, BD249B, BD249C
NPN SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

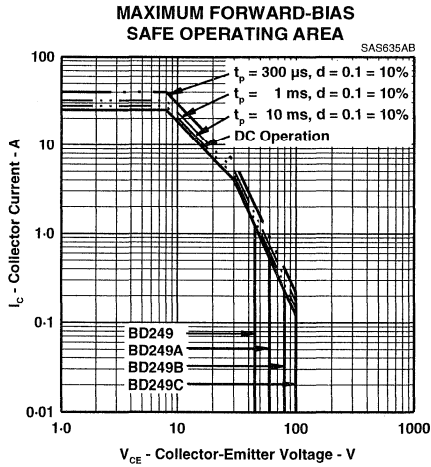


Figure 4.

THERMAL INFORMATION

**MAXIMUM POWER DISSIPATION
 vs
 CASE TEMPERATURE**

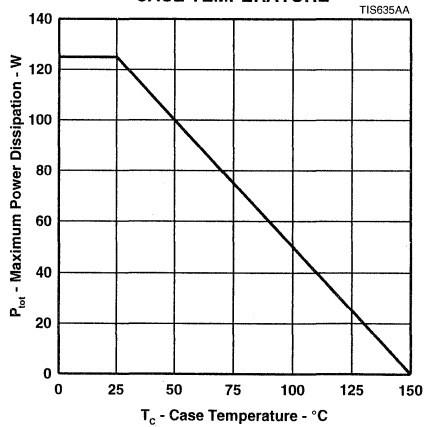


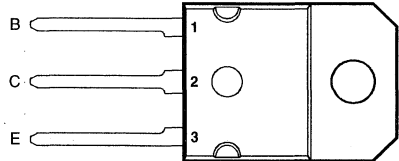
Figure 5.

BD250, BD250A, BD250B, BD250C PNP SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

- Designed for Complementary Use with the BD249 Series
- 125 W at 25°C Case Temperature
- 25 A Continuous Collector Current
- 40 A Peak Collector Current
- Customer-Specified Selections Available

SOT-93 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-emitter voltage ($R_{BE} = 100 \Omega$)	BD250	V_{CER}	-55	V
	BD250A		-70	
	BD250B		-90	
	BD250C		-115	
Collector-emitter voltage ($I_C = -30 \text{ mA}$)	BD250	V_{CEO}	-45	V
	BD250A		-60	
	BD250B		-80	
	BD250C		-100	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-25	A
Peak collector current (see Note 1)		I_{CM}	-40	A
Continuous base current		I_B	-5	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	125	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	3	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	90	mJ
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	250	°C

- NOTES: 1. This value applies for $t_p \leq 0.3 \text{ ms}$, duty cycle $\leq 10\%$.
 2. Derate linearly to 150°C case temperature at the rate of 1 W/°C.
 3. Derate linearly to 150°C free air temperature at the rate of 24 mW/°C.
 4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20 \text{ mH}$, $I_{B(on)} = -0.4 \text{ A}$, $R_{BE} = 100 \Omega$, $V_{BE(Off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = -20 \text{ V}$.

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BD250, BD250A, BD250B, BD250C

PNP SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT	
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = -30 \text{ mA}$ (see Note 5)	$I_B = 0$	BD250	-45			V	
				BD250A	-60				
				BD250B	-80				
				BD250C	-100				
I_{CES}	Collector-emitter cut-off current	$V_{CE} = -55 \text{ V}$ $V_{CE} = -70 \text{ V}$ $V_{CE} = -90 \text{ V}$ $V_{CE} = -115 \text{ V}$	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	BD250			-0.7	mA	
				BD250A			-0.7		
				BD250B			-0.7		
				BD250C			-0.7		
I_{CEO}	Collector cut-off current	$V_{CE} = -30 \text{ V}$ $V_{CE} = -60 \text{ V}$	$I_B = 0$ $I_B = 0$	BD250/250A			-1	mA	
				BD250B/250C			-1		
I_{EBO}	Emitter cut-off current	$V_{EB} = -5 \text{ V}$	$I_C = 0$				-1	mA	
h_{FE}	Forward current transfer ratio	$V_{CE} = -4 \text{ V}$ $V_{CE} = -4 \text{ V}$ $V_{CE} = -4 \text{ V}$	$I_C = -1.5 \text{ A}$ $I_C = -15 \text{ A}$ $I_C = -25 \text{ A}$	(see Notes 5 and 6)	25				
					10				
					5				
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = -1.5 \text{ A}$ $I_B = -5 \text{ A}$	$I_C = -15 \text{ A}$ $I_C = -25 \text{ A}$	(see Notes 5 and 6)			-1.8	V	
							-4		
V_{BE}	Base-emitter voltage	$V_{CE} = -4 \text{ V}$ $V_{CE} = -4 \text{ V}$	$I_C = -15 \text{ A}$ $I_C = -25 \text{ A}$	(see Notes 5 and 6)			-2	V	
							-4		
h_{fe}	Small signal forward current transfer ratio	$V_{CE} = -10 \text{ V}$	$I_C = -1 \text{ A}$	$f = 1 \text{ kHz}$	25				
$ h_{fe} $	Small signal forward current transfer ratio	$V_{CE} = -10 \text{ V}$	$I_C = -1 \text{ A}$	$f = 1 \text{ MHz}$	3				

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			42	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = -5 \text{ A}$	$I_{B(on)} = -0.5 \text{ A}$	$I_{B(off)} = 0.5 \text{ A}$		0.2		μs
t_{off}	Turn-off time	$V_{BE(off)} = 5 \text{ V}$	$R_L = 5 \Omega$	$t_p = 20 \mu\text{s}$, $dc \leq 2\%$		0.4		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

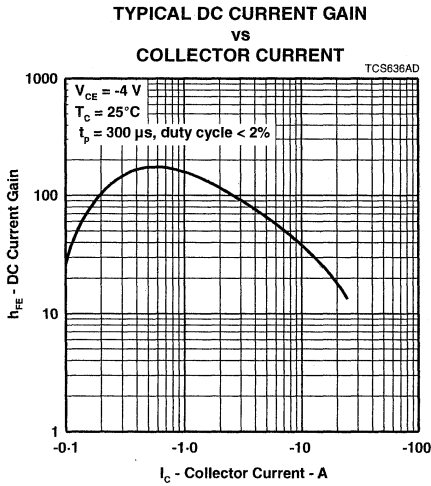


Figure 1.

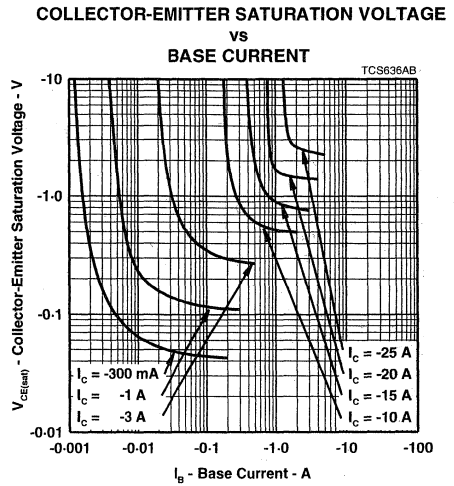


Figure 2.

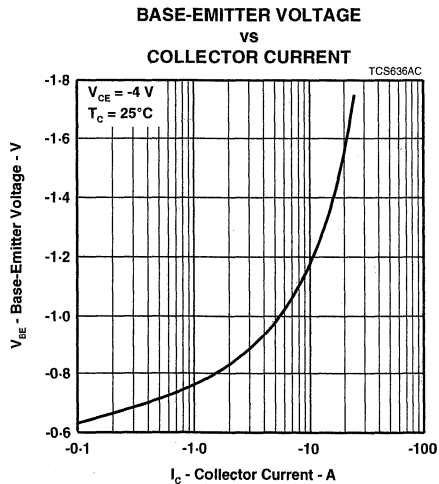


Figure 3.

BD250, BD250A, BD250B, BD250C
PNP SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

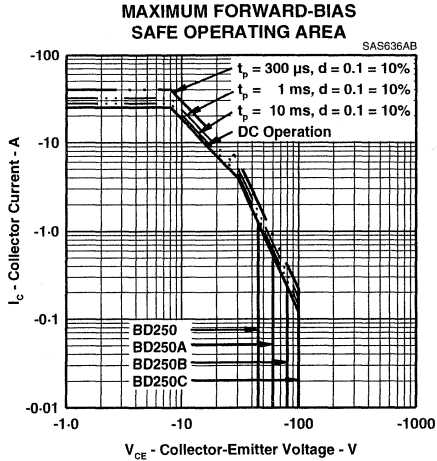


Figure 4.

THERMAL INFORMATION

**MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE**

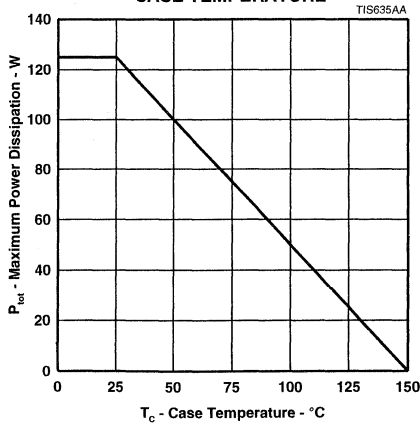
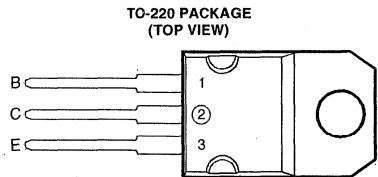


Figure 5.

BD539, BD539A, BD539B, BD539C, BD539D NPN SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

- Designed for Complementary Use with the BD540 Series
- 45 W at 25°C Case Temperature
- 5 A Continuous Collector Current
- Up to 120 V V_{CEO} rating



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage	BD539	V_{CBO}	40	V
	BD539A		60	
	BD539B		80	
	BD539C		100	
	BD539D		120	
Collector-emitter voltage (see Note 1)	BD539	V_{CEO}	40	V
	BD539A		60	
	BD539B		80	
	BD539C		100	
	BD539D		120	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	5	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	45	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Operating free air temperature range		T_A	-65 to +150	°C
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

- NOTES: 1. These values apply when the base-emitter diode is open circuited.
 2. Derate linearly to 150°C case temperature at the rate of 0.36 W/°C.
 3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

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 **TEXAS
INSTRUMENTS**

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BD539, BD539A, BD539B, BD539C, BD539D

NPN SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$ Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$ (see Note 4)	$I_B = 0$	BD539 BD539A BD539B BD539C BD539D	40 60 80 100 120			V
I_{CES} Collector-emitter cut-off current	$V_{CE} = 40 \text{ V}$ $V_{CE} = 60 \text{ V}$ $V_{CE} = 80 \text{ V}$ $V_{CE} = 100 \text{ V}$ $V_{CE} = 120 \text{ V}$	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	BD539 BD539A BD539B BD539C BD539D			0.2 0.2 0.2 0.2 0.2	mA
I_{CEO} Collector cut-off current	$V_{CE} = 30 \text{ V}$ $V_{CE} = 60 \text{ V}$ $V_{CE} = 90 \text{ V}$	$I_B = 0$ $I_B = 0$ $I_B = 0$	BD539/539A BD539B/539C BD539D			0.3 0.3 0.3	mA
I_{EBO} Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$				1	mA
h_{FE} Forward current transfer ratio	$V_{CE} = 4 \text{ V}$ $V_{CE} = 4 \text{ V}$ $V_{CE} = 4 \text{ V}$	$I_C = 0.5 \text{ A}$ $I_C = 1 \text{ A}$ $I_C = 3 \text{ A}$	(see Notes 4 and 5)	40 30 12			
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 125 \text{ mA}$ $I_B = 375 \text{ mA}$ $I_B = 1 \text{ A}$	$I_C = 1 \text{ A}$ $I_C = 3 \text{ A}$ $I_C = 5 \text{ A}$	(see Notes 4 and 5)			0.25 0.8 1.5	V
$V_{BE(on)}$ Base-emitter voltage	$V_{CE} = 4 \text{ V}$	$I_C = 3 \text{ A}$	(see Notes 4 and 5)			1.25	V
h_{fe} Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ kHz}$	20			
$ h_{fe} $ Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ MHz}$	3			

NOTES: 4. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

5. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			2.78	°C/W
$R_{\theta JA}$ Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on} Turn-on time	$I_C = 1 \text{ A}$	$I_{B(on)} = 0.1 \text{ A}$	$I_{B(off)} = -0.1 \text{ A}$		0.5		μs
t_{off} Turn-off time	$V_{BE(off)} = -4.3 \text{ V}$	$R_L = 30 \Omega$	$t_p = 20 \mu\text{s}$, $dc \leq 2\%$		2		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
vs
COLLECTOR CURRENT

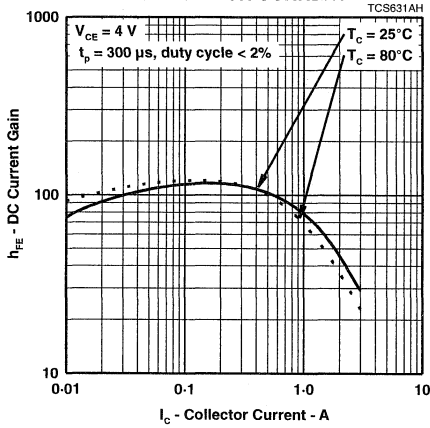


Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE
vs
BASE CURRENT

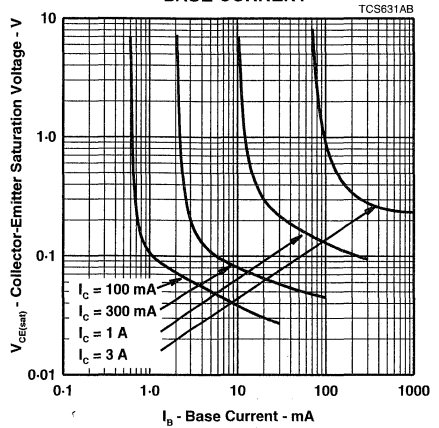


Figure 2.

BASE-EMITTER VOLTAGE
vs
COLLECTOR CURRENT

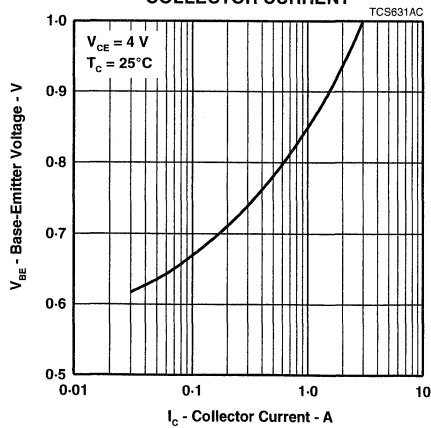


Figure 3.

BD539, BD539A, BD539B, BD539C, BD539D
NPN SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

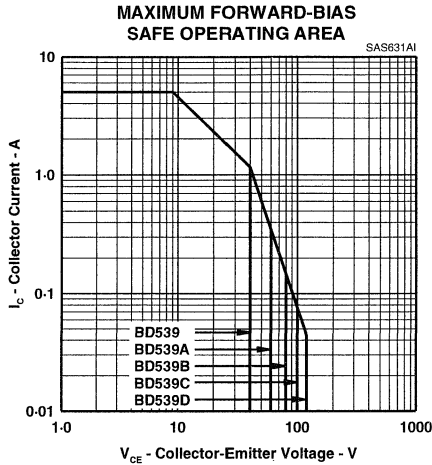


Figure 4.

THERMAL INFORMATION

**MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE**

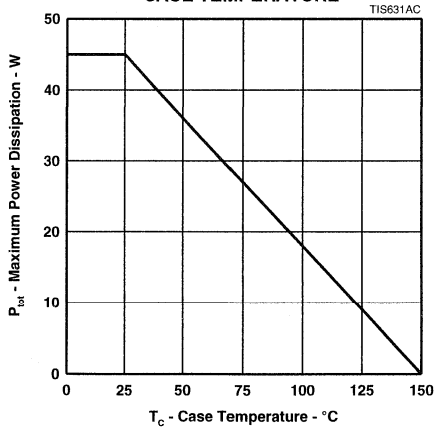
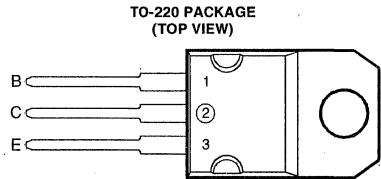


Figure 5.

BD540, BD540A, BD540B, BD540C PNP SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

- Designed for Complementary Use with the BD539 Series
- 45 W at 25°C Case Temperature
- 5 A Continuous Collector Current
- Customer-Specified Selections Available



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BD540	V_{CBO}	-40	V
	BD540A		-60	
	BD540B		-80	
	BD540C		-100	
Collector-emitter voltage ($I_B = 0$) (see Note 1)	BD540	V_{CEO}	-40	V
	BD540A		-60	
	BD540B		-80	
	BD540C		-100	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-5	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	45	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Operating free air temperature range		T_A	-65 to +150	°C
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{slg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

- NOTES: 1. These values apply when the base-emitter diode is open circuited.
 2. Derate linearly to 150°C case temperature at the rate of 0.36 W/°C.
 3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

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BD540, BD540A, BD540B, BD540C

PNP SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT		
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = -30 \text{ mA}$ $I_B = 0$ (see Note 4)		BD540	-40			V		
				BD540A	-60					
				BD540B	-80					
				BD540C	-100					
I_{CES}	Collector-emitter cut-off current			BD540			-0.2	mA		
				BD540A			-0.2			
				BD540B			-0.2			
				BD540C			-0.2			
I_{CEO}	Collector cut-off current			BD540/540A			-0.3	mA		
				BD540B/540C			-0.3			
I_{EBO}	Emitter cut-off current						-1	mA		
h_{FE}	Forward current transfer ratio			(see Notes 4 and 5)	$V_{CE} = -4 \text{ V}$	$I_C = -0.5 \text{ A}$		40		
					$V_{CE} = -4 \text{ V}$	$I_C = -1 \text{ A}$		30		
					$V_{CE} = -4 \text{ V}$	$I_C = -3 \text{ A}$		12		
$V_{CE(sat)}$	Collector-emitter saturation voltage			(see Notes 4 and 5)	$I_B = -125 \text{ mA}$	$I_C = -1 \text{ A}$		-0.25	V	
					$I_B = -375 \text{ mA}$	$I_C = -3 \text{ A}$		-0.8		
					$I_B = -1 \text{ A}$	$I_C = -5 \text{ A}$		-1.5		
V_{BE}	Base-emitter voltage				$V_{CE} = -4 \text{ V}$	$I_C = -3 \text{ A}$	(see Notes 4 and 5)		-1.25	V
h_{fe}	Small signal forward current transfer ratio				$V_{CE} = -10 \text{ V}$	$I_C = -0.5 \text{ A}$	$f = 1 \text{ kHz}$	20		
$ h_{fe} $	Small signal forward current transfer ratio				$V_{CE} = -10 \text{ V}$	$I_C = -0.5 \text{ A}$	$f = 1 \text{ MHz}$	3		

NOTES: 4. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

5. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			2.78	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = -1 \text{ A}$	$I_{B(on)} = -0.1 \text{ A}$		0.3		$I_{B(off)} = 0.1 \text{ A}$ μs
t_{off}	Turn-off time	$V_{BE(off)} = 4.3 \text{ V}$	$R_L = 30 \Omega$		1		$t_p = 20 \mu\text{s}$, dc $\leq 2\%$ μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
vs
COLLECTOR CURRENT

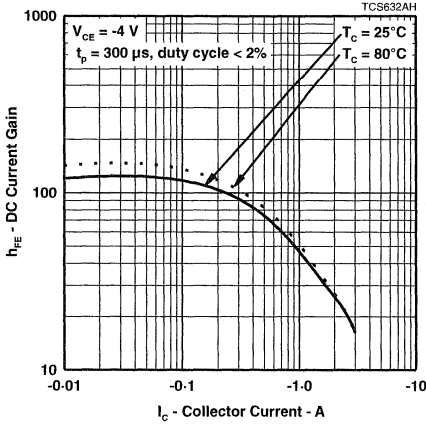


Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE
vs
BASE CURRENT

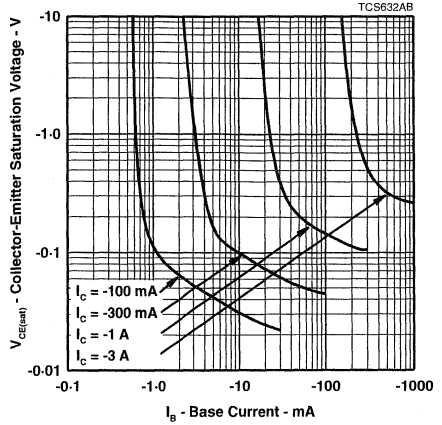


Figure 2.

BASE-EMITTER VOLTAGE
vs
COLLECTOR CURRENT

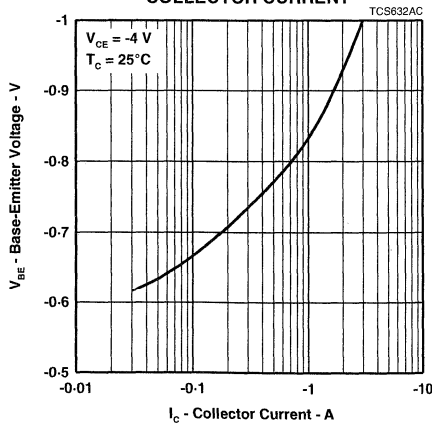
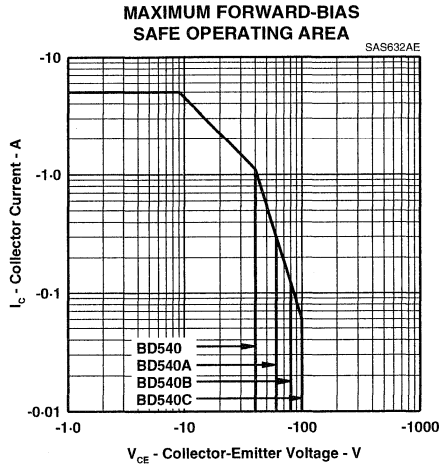


Figure 3.

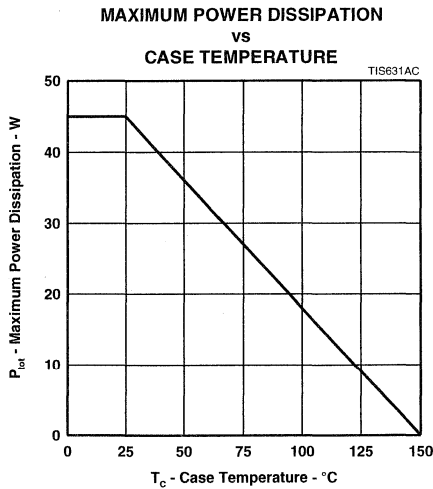
BD540, BD540A, BD540B, BD540C PNP SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS



THERMAL INFORMATION

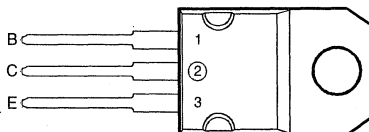


BD543, BD543A, BD543B, BD543C NPN SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

- Designed for Complementary Use with the BD544 Series
- 70 W at 25°C Case Temperature
- 8 A Continuous Collector Current
- 10 A Peak Collector Current
- Customer-Specified Selections Available

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BD543	V_{CBO}	40	V
	BD543A		60	
	BD543B		80	
	BD543C		100	
Collector-emitter voltage ($I_B = 0$)	BD543	V_{CEO}	40	V
	BD543A		60	
	BD543B		80	
	BD543C		100	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	8	A
Peak collector current (see Note 1)		I_{CM}	10	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	70	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Operating free air temperature range		T_A	-65 to +150	°C
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

- NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.
 2. Derate linearly to 150°C case temperature at the rate of 0.56 W/°C.
 3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

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BD543, BD543A, BD543B, BD543C

NPN SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$ Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$ $I_B = 0$ (see Note 4)		BD543	40			V
			BD543A	60			
			BD543B	80			
			BD543C	100			
I_{CES} Collector-emitter cut-off current	$V_{CE} = 40 \text{ V}$ $V_{CE} = 60 \text{ V}$ $V_{CE} = 80 \text{ V}$ $V_{CE} = 100 \text{ V}$	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	BD543			0.4	mA
			BD543A			0.4	
			BD543B			0.4	
			BD543C			0.4	
I_{CEO} Collector cut-off current	$V_{CE} = 30 \text{ V}$ $V_{CE} = 60 \text{ V}$	$I_B = 0$ $I_B = 0$	BD543/543A			0.7	mA
			BD543B/543C			0.7	
I_{EBO} Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$				1	mA
h_{FE} Forward current transfer ratio	$V_{CE} = 4 \text{ V}$ $V_{CE} = 4 \text{ V}$ $V_{CE} = 4 \text{ V}$	$I_C = 1 \text{ A}$ $I_C = 3 \text{ A}$ $I_C = 5 \text{ A}$	(see Notes 4 and 5)	60			
				40			
				15			
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 0.3 \text{ A}$ $I_B = 1 \text{ A}$ $I_B = 1.6 \text{ A}$	$I_C = 3 \text{ A}$ $I_C = 5 \text{ A}$ $I_C = 8 \text{ A}$	(see Notes 4 and 5)			0.5	V
						0.5	
						1	
V_{BE} Base-emitter voltage	$V_{CE} = 4 \text{ V}$	$I_C = 5 \text{ A}$	(see Notes 4 and 5)			1.4	V
h_{fe} Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ kHz}$	20			
$ h_{fe} $ Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ MHz}$	3			

NOTES: 4. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

5. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1.79	°C/W
$R_{\theta JA}$ Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on} Turn-on time	$I_C = 6 \text{ A}$	$I_{B(on)} = 0.6 \text{ A}$	$I_{B(off)} = -0.6 \text{ A}$		0.6		μs
t_{off} Turn-off time	$V_{BE(off)} = -4 \text{ V}$	$R_L = 5 \Omega$	$t_p = 20 \mu\text{s}$, dc $\leq 2\%$		1		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

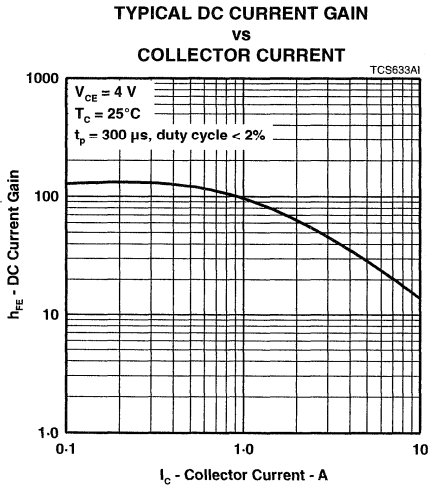


Figure 1.

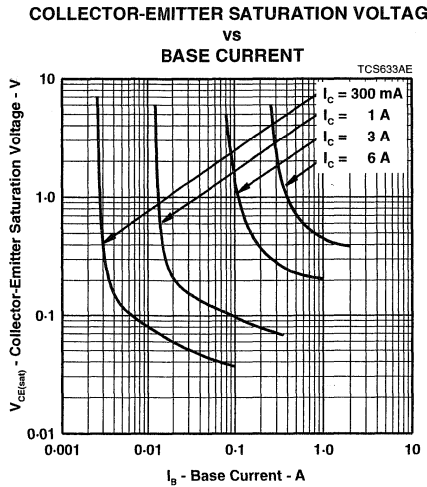


Figure 2.

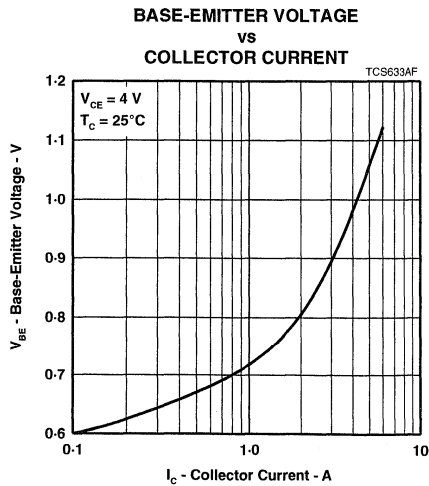


Figure 3.

BD543, BD543A, BD543B, BD543C NPN SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

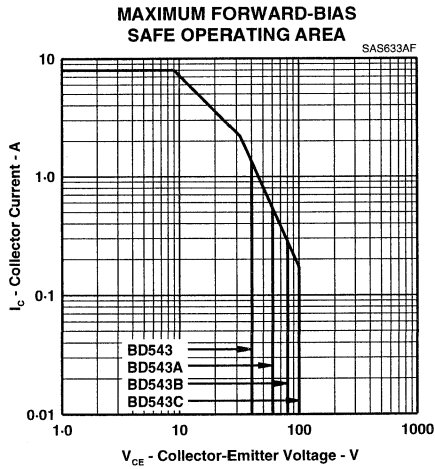


Figure 4.

THERMAL INFORMATION

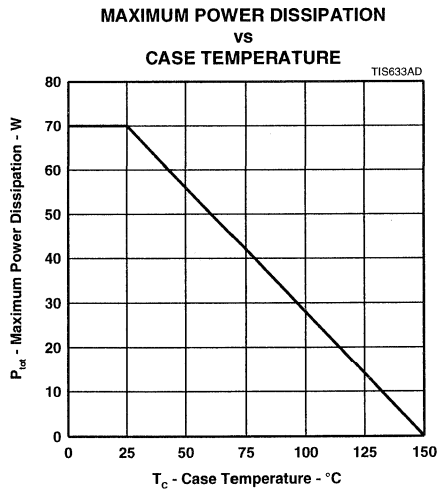
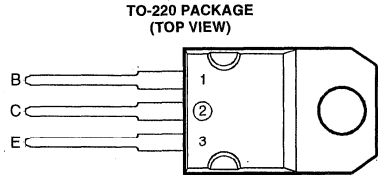


Figure 5.

BD544, BD544A, BD544B, BD544C PNP SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

- Designed for Complementary Use with the BD543 Series
- 70 W at 25°C Case Temperature
- 8 A Continuous Collector Current
- 10 A Peak Collector Current
- Customer-Specified Selections Available



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BD544	V_{CBO}	-40	V
	BD544A		-60	
	BD544B		-80	
	BD544C		-100	
Collector-emitter voltage ($I_B = 0$)	BD544	V_{CEO}	-40	V
	BD544A		-60	
	BD544B		-80	
	BD544C		-100	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-8	A
Peak collector current (see Note 1)		I_{CM}	-10	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	70	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Operating free air temperature range		T_A	-65 to +150	°C
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

- NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.
 2. Derate linearly to 150°C case temperature at the rate of 0.56 W/°C.
 3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

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BD544, BD544A, BD544B, BD544C

PNP SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT	
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = -30$ mA (see Note 4)	$I_B = 0$	BD544	-40			V	
				BD544A	-60				
				BD544B	-80				
				BD544C	-100				
I_{CES}	Collector-emitter cut-off current	$V_{CE} = -40$ V $V_{CE} = -60$ V $V_{CE} = -80$ V $V_{CE} = -100$ V	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	BD544			-0.4	mA	
				BD544A			-0.4		
				BD544B			-0.4		
				BD544C			-0.4		
I_{CEO}	Collector cut-off current	$V_{CE} = -30$ V $V_{CE} = -60$ V	$I_B = 0$ $I_B = 0$	BD544/544A			-0.7	mA	
				BD544B/544C			-0.7		
I_{EBO}	Emitter cut-off current	$V_{EB} = -5$ V	$I_C = 0$				-1	mA	
h_{FE}	Forward current transfer ratio	$V_{CE} = -4$ V $V_{CE} = -4$ V $V_{CE} = -4$ V	$I_C = -1$ A $I_C = -3$ A $I_C = -5$ A	(see Notes 4 and 5)	60				
					40				
					15				
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = -0.3$ A $I_B = -1$ A $I_B = -1.6$ A	$I_C = -3$ A $I_C = -5$ A $I_C = -8$ A	(see Notes 4 and 5)				-0.5	V
								-0.5	
								-1	
V_{BE}	Base-emitter voltage	$V_{CE} = -4$ V	$I_C = -5$ A	(see Notes 4 and 5)			-1.4	V	
h_{fe}	Small signal forward current transfer ratio	$V_{CE} = -10$ V	$I_C = -0.5$ A	$f = 1$ kHz	20				
$ h_{fe} $	Small signal forward current transfer ratio	$V_{CE} = -10$ V	$I_C = -0.5$ A	$f = 1$ MHz	3				

NOTES: 4. These parameters must be measured using pulse techniques, $t_p = 300$ μ s, duty cycle $\leq 2\%$.

5. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.79	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = -6$ A	$I_{B(on)} = -0.6$ A	$I_{B(off)} = 0.6$ A		0.4		μ s
t_{off}	Turn-off time	$V_{BE(off)} = 4$ V	$R_L = 5$ Ω	$t_p = 20$ μ s, $d_c \leq 2\%$		0.7		μ s

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

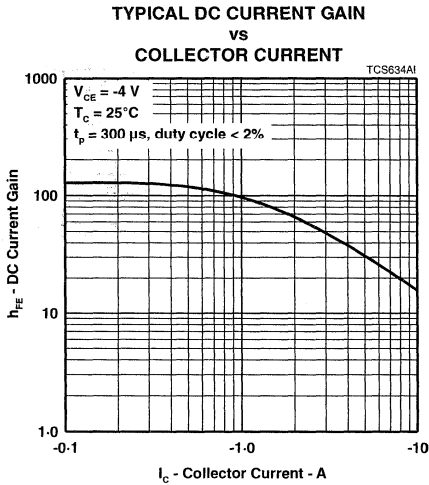


Figure 1.

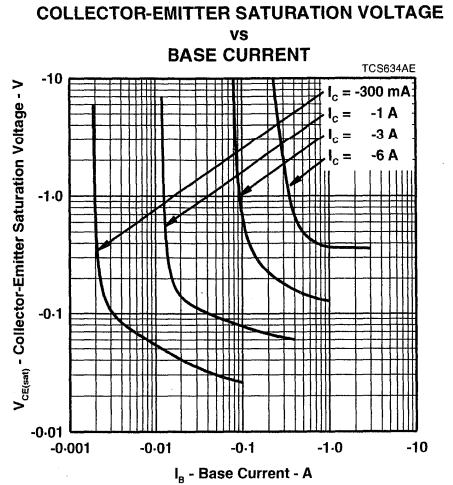


Figure 2.

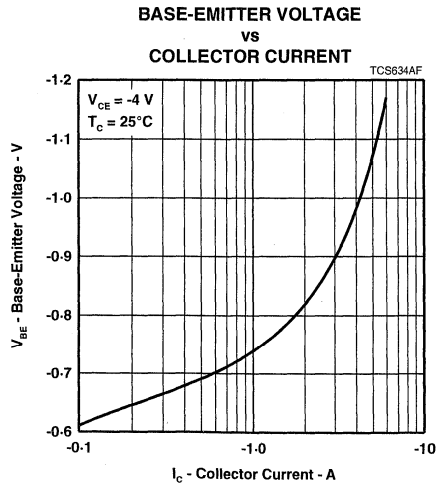


Figure 3.

BD544, BD544A, BD544B, BD544C PNP SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

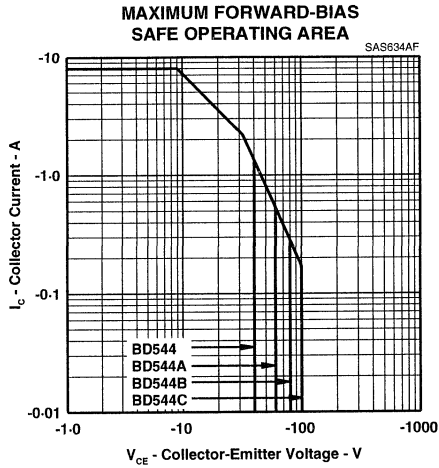


Figure 4.

THERMAL INFORMATION

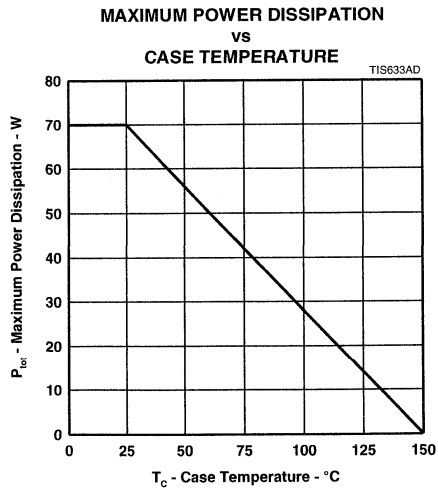
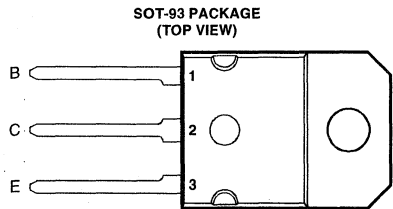


Figure 5.

BD545, BD545A, BD545B, BD545C NPN SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

- Designed for Complementary Use with the BD546 Series
- 85 W at 25°C Case Temperature
- 15 A Continuous Collector Current
- Customer-Specified Selections Available



Pin 2 is in electrical contact with the mounting base.

MDTRAA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BD545	V_{CBO}	40	V
	BD545A		60	
	BD545B		80	
	BD545C		100	
Collector-emitter voltage ($I_B = 0$) (see Note 1)	BD545	V_{CEO}	40	V
	BD545A		60	
	BD545B		80	
	BD545C		100	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	15	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	85	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	3.5	W
Operating free air temperature range		T_A	-65 to +150	°C
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

- NOTES: 1. These values apply when the base-emitter diode is open circuited.
 2. Derate linearly to 150°C case temperature at the rate of 0.68 W/°C.
 3. Derate linearly to 150°C free air temperature at the rate of 28 mW/°C.

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BD545, BD545A, BD545B, BD545C

NPN SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$ (see Note 4)	$I_B = 0$	BD545	40			V
				BD545A	60			
				BD545B	80			
				BD545C	100			
I_{CES}	Collector-emitter cut-off current	$V_{CE} = 40 \text{ V}$ $V_{CE} = 60 \text{ V}$ $V_{CE} = 80 \text{ V}$ $V_{CE} = 100 \text{ V}$	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	BD545		0.4	mA	
				BD545A		0.4		
				BD545B		0.4		
				BD545C		0.4		
I_{CEO}	Collector cut-off current	$V_{CE} = 30 \text{ V}$ $V_{CE} = 60 \text{ V}$	$I_B = 0$ $I_B = 0$	BD545/545A		0.7	mA	
				BD545B/545C		0.7		
I_{EBO}	Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$			1	mA	
h_{FE}	Forward current transfer ratio	$V_{CE} = 4 \text{ V}$ $V_{CE} = 4 \text{ V}$ $V_{CE} = 4 \text{ V}$	$I_C = 1 \text{ A}$		60			
			$I_C = 5 \text{ A}$	(see Notes 4 and 5)	25			
			$I_C = 10 \text{ A}$		10			
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = 625 \text{ mA}$ $I_B = 2 \text{ A}$	$I_C = 5 \text{ A}$	(see Notes 4 and 5)		0.8	V	
			$I_C = 10 \text{ A}$			1		
V_{BE}	Base-emitter voltage	$V_{CE} = 4 \text{ V}$	$I_C = 10 \text{ A}$	(see Notes 4 and 5)		1.8	V	
h_{fe}	Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ kHz}$	20			
$ h_{fe} $	Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ MHz}$	3			

NOTES: 4. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

5. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.47	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			35.7	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = 6 \text{ A}$	$I_{B(on)} = 0.6 \text{ A}$	$I_{B(off)} = -0.6 \text{ A}$		0.6		μs
t_{off}	Turn-off time	$V_{BE(off)} = -4 \text{ V}$	$R_L = 5 \Omega$	$t_p = 20 \mu\text{s}$, $dc \leq 2\%$		1		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
vs
COLLECTOR CURRENT

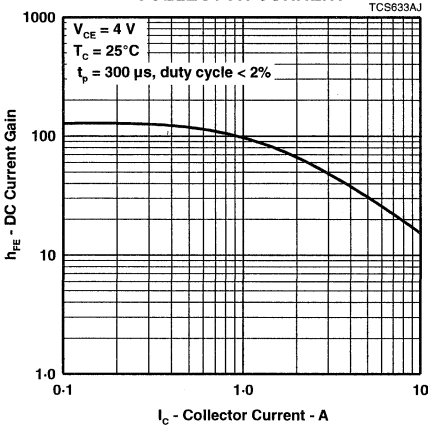


Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE
vs
BASE CURRENT

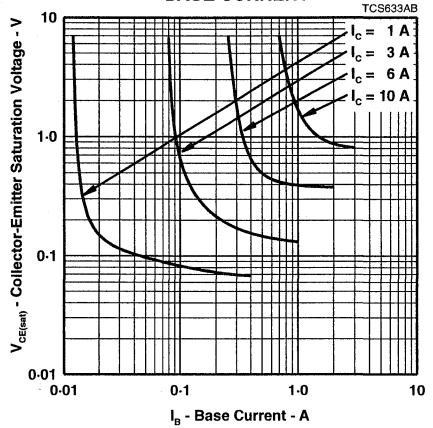


Figure 2.

BASE-EMITTER VOLTAGE
vs
COLLECTOR CURRENT

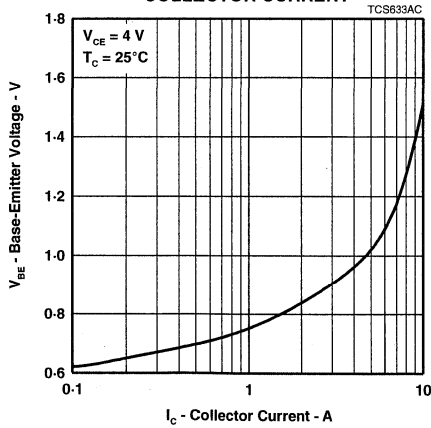


Figure 3.

BD545, BD545A, BD545B, BD545C
NPN SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

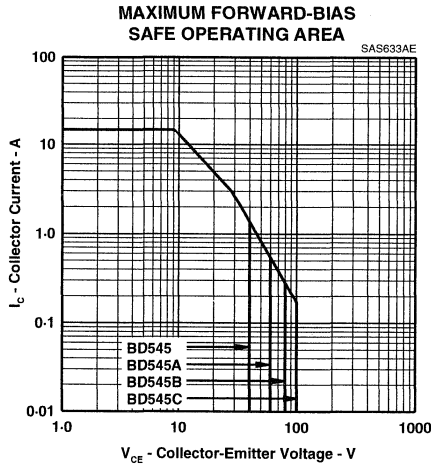


Figure 4.

THERMAL INFORMATION

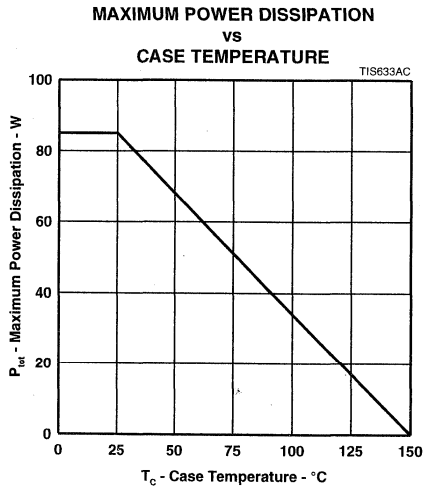
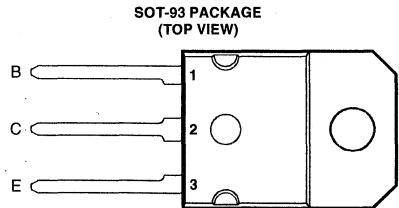


Figure 5.

BD546, BD546A, BD546B, BD546C PNP SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

- Designed for Complementary Use with the BD545 Series
- 85 W at 25°C Case Temperature
- 15 A Continuous Collector Current
- Customer-Specified Selections Available



Pin 2 is in electrical contact with the mounting base.

MDTRAA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BD546	V_{CBO}	-40	V
	BD546A		-60	
	BD546B		-80	
	BD546C		-100	
Collector-emitter voltage ($I_B = 0$) (see Note 1)	BD546	V_{CEO}	-40	V
	BD546A		-60	
	BD546B		-80	
	BD546C		-100	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-15	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	85	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	3.5	W
Operating free air temperature range		T_A	-65 to +150	°C
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

- NOTES: 1. These values apply when the base-emitter diode is open circuited.
 2. Derate linearly to 150°C case temperature at the rate of 0.68 W/°C.
 3. Derate linearly to 150°C free air temperature at the rate of 28 mW/°C.

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 **TEXAS
INSTRUMENTS**

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BD546, BD546A, BD546B, BD546C

PNP SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = -30$ mA (see Note 4)	$I_B = 0$	BD546	-40			V
				BD546A	-60			
				BD546B	-80			
				BD546C	-100			
I_{CES}	Collector-emitter cut-off current	$V_{CE} = -40$ V $V_{CE} = -60$ V $V_{CE} = -80$ V $V_{CE} = -100$ V	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	BD546			-0.4	mA
				BD546A			-0.4	
				BD546B			-0.4	
				BD546C			-0.4	
I_{CEO}	Collector cut-off current	$V_{CE} = -30$ V $V_{CE} = -60$ V	$I_B = 0$ $I_B = 0$	BD546/546A			-0.7	mA
				BD546B/546C			-0.7	
I_{EBO}	Emitter cut-off current	$V_{EB} = -5$ V	$I_C = 0$				-1	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = -4$ V $V_{CE} = -4$ V $V_{CE} = -4$ V	$I_C = -1$ A	(see Notes 4 and 5)	60			
			$I_C = -5$ A		25			
			$I_C = -10$ A		10			
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = -625$ mA $I_B = -2$ A	$I_C = -5$ A	(see Notes 4 and 5)			-0.8	V
			$I_C = -10$ A				-1	
V_{BE}	Base-emitter voltage	$V_{CE} = -4$ V	$I_C = -10$ A	(see Notes 4 and 5)			-1.8	V
h_{fe}	Small signal forward current transfer ratio	$V_{CE} = -10$ V	$I_C = -0.5$ A	$f = 1$ kHz	20			
$ h_{fe} $	Small signal forward current transfer ratio	$V_{CE} = -10$ V	$I_C = -0.5$ A	$f = 1$ MHz	3			

NOTES: 4. These parameters must be measured using pulse techniques, $t_p = 300$ μ s, duty cycle $\leq 2\%$.

5. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1.47	°C/W
$R_{\theta JA}$ Junction to free air thermal resistance			35.7	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on} Turn-on time	$I_C = -6$ A $V_{BE(off)} = 4$ V	$I_{B(on)} = -0.6$ A	$I_{B(off)} = 0.6$ A		0.4		μ s
t_{off} Turn-off time		$R_L = 5$ Ω	$t_p = 20$ μ s, dc $\leq 2\%$			0.7	

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
vs
COLLECTOR CURRENT

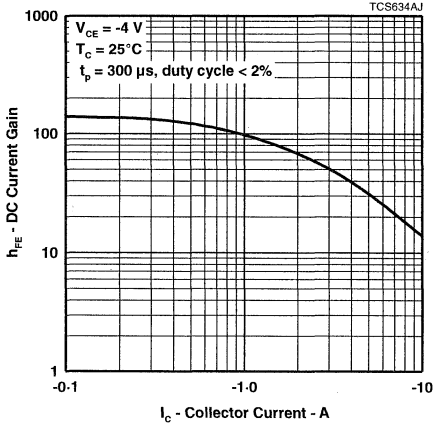


Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE
vs
BASE CURRENT

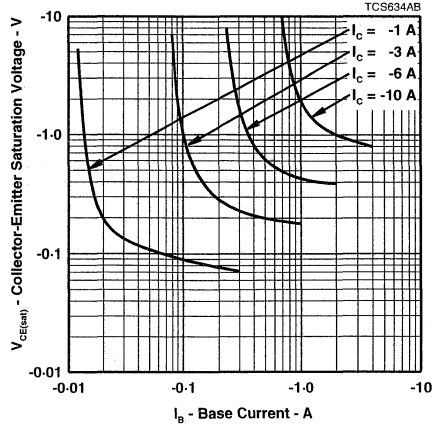


Figure 2.

BASE-EMITTER VOLTAGE
vs
COLLECTOR CURRENT

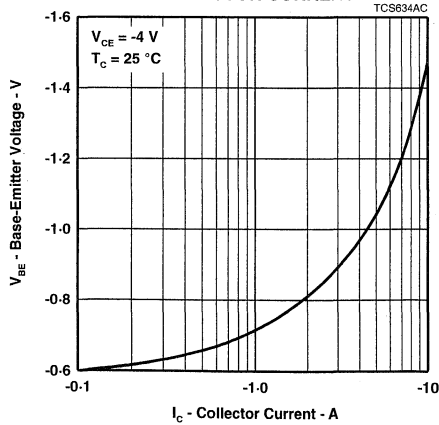


Figure 3.

BD546, BD546A, BD546B, BD546C PNP SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

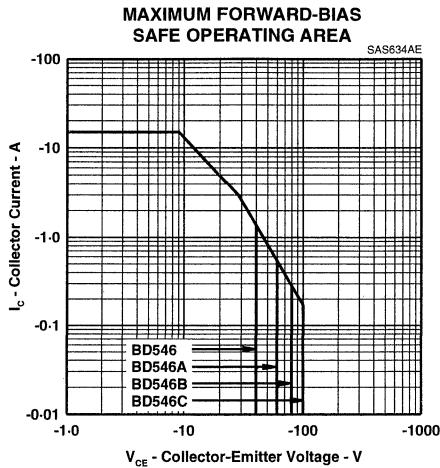


Figure 4.

THERMAL INFORMATION

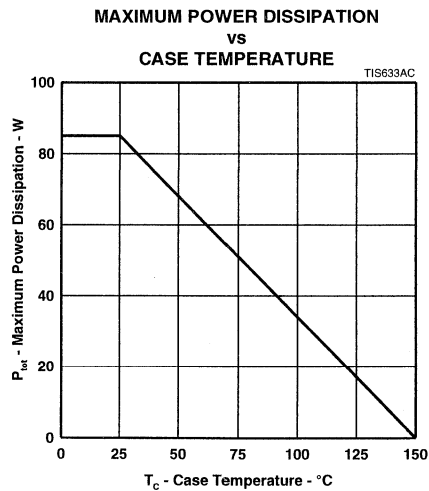
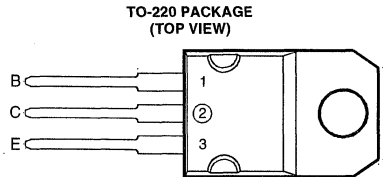


Figure 5.

BD743, BD743A, BD743B, BD743C NPN SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

- Designed for Complementary Use with the BD744 Series
- 90 W at 25°C Case Temperature
- 15 A Continuous Collector Current
- 20 A Peak Collector Current
- Customer-Specified Selections Available



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BD743	V_{CBO}	50	V
	BD743A		70	
	BD743B		90	
	BD743C		110	
Collector-emitter voltage ($I_B = 0$)	BD743	V_{CEO}	45	V
	BD743A		60	
	BD743B		80	
	BD743C		100	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	15	A
Peak collector current (see Note 1)		I_{CM}	20	A
Continuous base current		I_B	5	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	90	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	90	mJ
Operating free air temperature range		T_A	-65 to +150	°C
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	250	°C

- NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.
 2. Derate linearly to 150°C case temperature at the rate of 0.72 W/°C.
 3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.
 4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = 0.4$ A, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = 20$ V.

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BD743, BD743A, BD743B, BD743C

NPN SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$	$I_B = 0$	(see Note 5)	BD743			45
					BD743A			60
					BD743B			80
					BD743C			100
I_{CBO}	Collector cut-off current	$V_{CE} = 50 \text{ V}$	$V_{BE} = 0$	$T_C = 125^\circ\text{C}$	BD743			0.1
					BD743A			0.1
					BD743B			0.1
					BD743C			0.1
					BD743			5
					BD743A			5
					BD743B			5
I_{CEO}	Collector cut-off current	$V_{CE} = 30 \text{ V}$	$I_B = 0$		BD743/743A			0.1
		$V_{CE} = 60 \text{ V}$	$I_B = 0$		BD743B/743C			0.1
I_{EBO}	Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$					0.5
h_{FE}	Forward current transfer ratio	$V_{CE} = 4 \text{ V}$	$I_C = 1 \text{ A}$	(see Notes 5 and 6)				40
								20
								5
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = 0.5 \text{ A}$	$I_C = 5 \text{ A}$	(see Notes 5 and 6)				1
								3
V_{BE}	Base-emitter voltage	$V_{CE} = 4 \text{ V}$	$I_C = 5 \text{ A}$	(see Notes 5 and 6)				1
								3
h_{fe}	Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 1 \text{ A}$	$f = 1 \text{ kHz}$				25
$ h_{fe} $	Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 1 \text{ A}$	$f = 1 \text{ MHz}$				5

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.4	$^\circ\text{C/W}$
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	$^\circ\text{C/W}$

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT		
t_d	Delay time	$I_C = 5 \text{ A}$	$I_{B(on)} = 0.5 \text{ A}$	$I_{B(off)} = -0.5 \text{ A}$		20		ns		
t_r	Rise time					350		ns		
t_s	Storage time				$V_{BE(off)} = -4.2 \text{ V}$	$R_L = 6 \Omega$	$t_p = 20 \mu\text{s}$, $d_c \leq 2\%$	500		ns
t_f	Fall time							400		ns

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

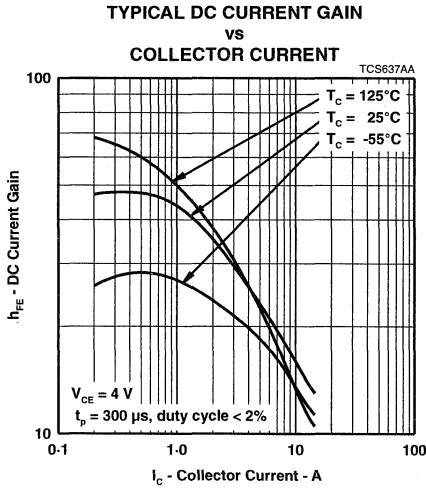


Figure 1.

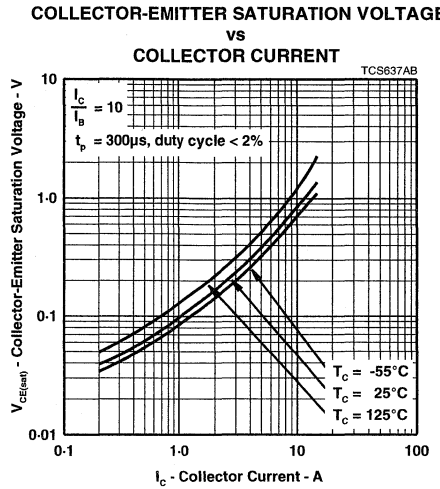


Figure 2.

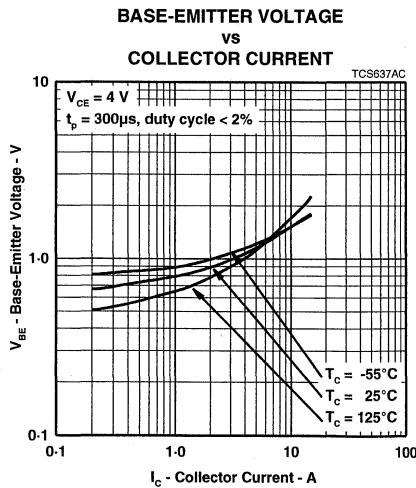


Figure 3.

BD743, BD743A, BD743B, BD743C
NPN SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

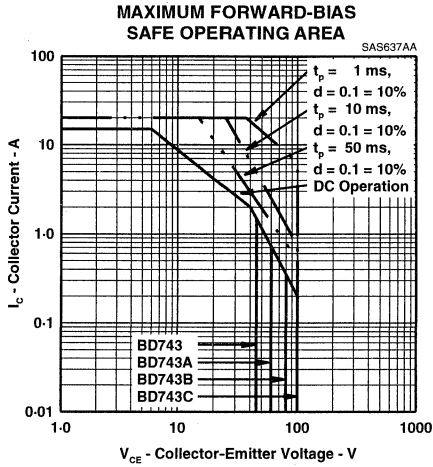


Figure 4.

THERMAL INFORMATION

**MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE**

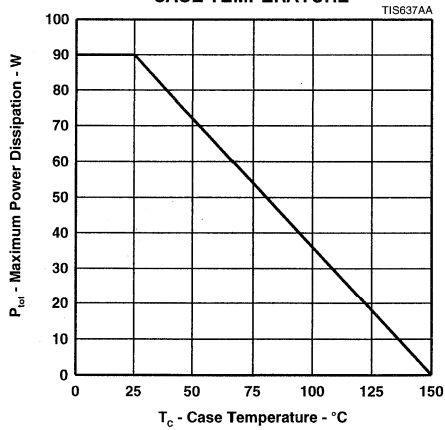


Figure 5.

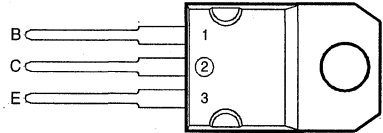


BD744, BD744A, BD744B, BD744C PNP SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

- Designed for Complementary Use with the BD743 Series
- 90 W at 25°C Case Temperature
- 15 A Continuous Collector Current
- 20 A Peak Collector Current
- Customer-Specified Selections Available

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BD744	V_{CBO}	-50	V
	BD744A		-70	
	BD744B		-90	
	BD744C		-110	
Collector-emitter voltage ($I_B = 0$)	BD744	V_{CEO}	-45	V
	BD744A		-60	
	BD744B		-80	
	BD744C		-100	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-15	A
Peak collector current (see Note 1)		I_{CM}	-20	A
Continuous base current		I_B	-5	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	90	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	90	mJ
Operating free air temperature range		T_A	-65 to +150	°C
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

- NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.
 2. Derate linearly to 150°C case temperature at the rate of 0.72 W/°C.
 3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.
 4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = -0.4$ A, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = -20$ V.

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BD744, BD744A, BD744B, BD744C

PNP SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$ Collector-emitter breakdown voltage	$I_C = -30 \text{ mA}$ $I_B = 0$ (see Note 5)	BD744 BD744A BD744B BD744C	-45 -60 -80 -100		V
I_{CBO} Collector cut-off current	$V_{CE} = -50 \text{ V}$ $V_{BE} = 0$ $V_{CE} = -70 \text{ V}$ $V_{BE} = 0$ $V_{CE} = -90 \text{ V}$ $V_{BE} = 0$ $V_{CE} = -110 \text{ V}$ $V_{BE} = 0$ $V_{CE} = -50 \text{ V}$ $V_{BE} = 0$ $T_C = 125^\circ\text{C}$ $V_{CE} = -70 \text{ V}$ $V_{BE} = 0$ $T_C = 125^\circ\text{C}$ $V_{CE} = -90 \text{ V}$ $V_{BE} = 0$ $T_C = 125^\circ\text{C}$ $V_{CE} = -110 \text{ V}$ $V_{BE} = 0$ $T_C = 125^\circ\text{C}$	BD744 BD744A BD744B BD744C BD744 BD744A BD744B BD744C		-0.1 -0.1 -0.1 -0.1 -5 -5 -5 -5	mA
I_{CEO} Collector cut-off current	$V_{CE} = -30 \text{ V}$ $I_B = 0$ $V_{CE} = -60 \text{ V}$ $I_B = 0$	BD744/744A BD744B/744C		-0.1 -0.1	mA
I_{EBO} Emitter cut-off current	$V_{EB} = -5 \text{ V}$ $I_C = 0$			-0.5	mA
h_{FE} Forward current transfer ratio	$V_{CE} = -4 \text{ V}$ $I_C = -1 \text{ A}$ $V_{CE} = -4 \text{ V}$ $I_C = -5 \text{ A}$ (see Notes 5 and 6) $V_{CE} = -4 \text{ V}$ $I_C = -15 \text{ A}$		40 20 5	150	
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = -0.5 \text{ A}$ $I_C = -5 \text{ A}$ $I_B = -5 \text{ A}$ $I_C = -15 \text{ A}$ (see Notes 5 and 6)			-1 -3	V
V_{BE} Base-emitter voltage	$V_{CE} = -4 \text{ V}$ $I_C = -5 \text{ A}$ $V_{CE} = -4 \text{ V}$ $I_C = -15 \text{ A}$ (see Notes 5 and 6)			-1 -3	V
h_{fe} Small signal forward current transfer ratio	$V_{CE} = -10 \text{ V}$ $I_C = -1 \text{ A}$ $f = 1 \text{ kHz}$		25		
$ h_{fe} $ Small signal forward current transfer ratio	$V_{CE} = -10 \text{ V}$ $I_C = -1 \text{ A}$ $f = 1 \text{ MHz}$		5		

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1.4	$^\circ\text{C/W}$
$R_{\theta JA}$ Junction to free air thermal resistance			62.5	$^\circ\text{C/W}$

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †	MIN	TYP	MAX	UNIT
t_d Delay time			20		ns
t_r Rise time			120		ns
t_s Storage time	$I_C = -5 \text{ A}$ $I_{B(on)} = -0.5 \text{ A}$ $I_{B(off)} = 0.5 \text{ A}$ $V_{BE(off)} = 4.2 \text{ V}$ $R_L = 6 \Omega$ $t_p = 20 \mu\text{s}$, $d_c \leq 2\%$		600		ns
t_f Fall time			300		ns

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

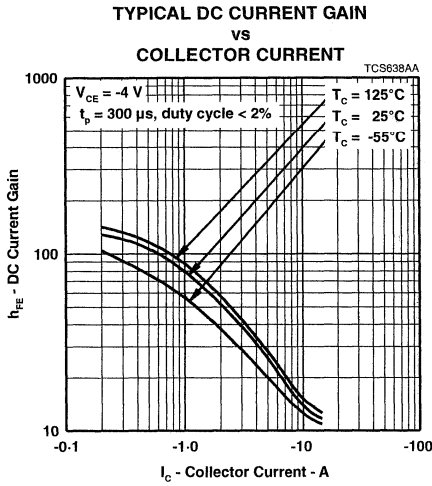


Figure 1.

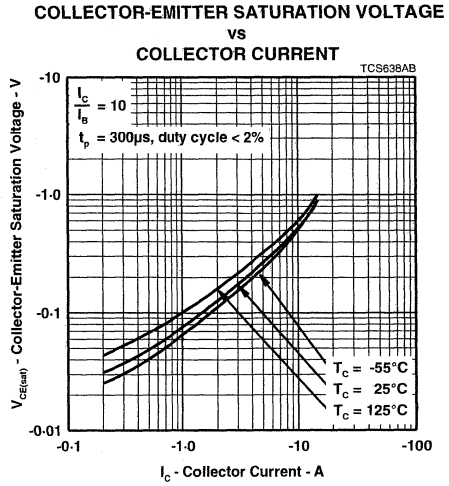


Figure 2.

MAXIMUM SAFE OPERATING REGIONS

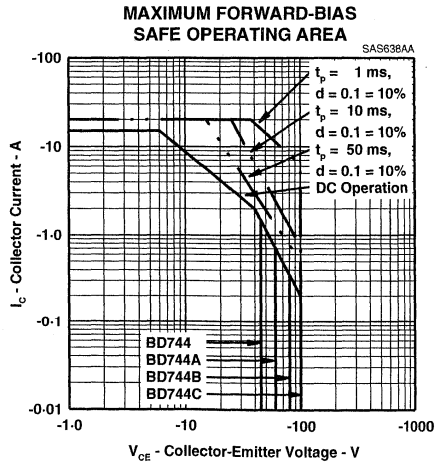


Figure 3.

BD744, BD744A, BD744B, BD744C
PNP SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

THERMAL INFORMATION

MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE

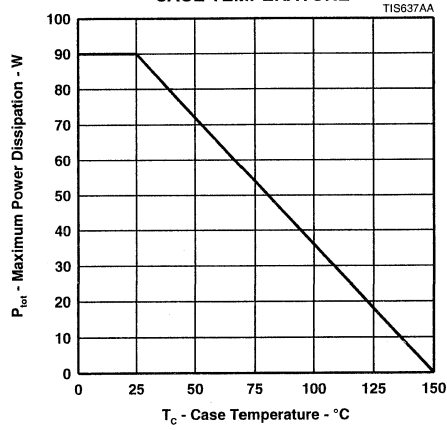
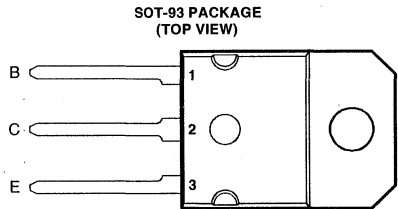


Figure 4.

BD745, BD745A, BD745B, BD745C NPN SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

- Designed for Complementary Use with the BD746 Series
- 115 W at 25°C Case Temperature
- 20 A Continuous Collector Current
- 25 A Peak Collector Current
- Customer-Specified Selections Available



Pin 2 is in electrical contact with the mounting base.

MDTRAA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BD745	V_{CBO}	50	V
	BD745A		70	
	BD745B		90	
	BD745C		110	
Collector-emitter voltage ($I_B = 0$)	BD745	V_{CEO}	45	V
	BD745A		60	
	BD745B		80	
	BD745C		100	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	20	A
Peak collector current (see Note 1)		I_{CM}	25	A
Continuous base current		I_B	7	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	115	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	3.5	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	90	mJ
Operating free air temperature range		T_A	-65 to +150	°C
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.

2. Derate linearly to 150°C case temperature at the rate of 0.92 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 28 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = 0.4$ A, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = 20$ V.

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 **TEXAS
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BD745, BD745A, BD745B, BD745C

NPN SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$	$I_B = 0$	(see Note 5)	BD745			45
					BD745A			60
					BD745B			80
					BD745C			100
I_{CBO}	Collector cut-off current				BD745		0.1	mA
					BD745A		0.1	
					BD745B		0.1	
					BD745C		0.1	
					BD745	$T_C = 125^\circ\text{C}$	5	
					BD745A	$T_C = 125^\circ\text{C}$	5	
					BD745B	$T_C = 125^\circ\text{C}$	5	
I_{CEO}	Collector cut-off current	$V_{CE} = 30 \text{ V}$	$I_B = 0$		BD745/745A		0.1	mA
		$V_{CE} = 60 \text{ V}$	$I_B = 0$		BD745B/745C		0.1	
I_{EBO}	Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$				0.5	mA
h_{FE}	Forward current transfer ratio			(see Notes 5 and 6)	$V_{CE} = 4 \text{ V}$	$I_C = 1 \text{ A}$		40
					$V_{CE} = 4 \text{ V}$	$I_C = 5 \text{ A}$		20
					$V_{CE} = 4 \text{ V}$	$I_C = 20 \text{ A}$		5
$V_{CE(sat)}$	Collector-emitter saturation voltage			(see Notes 5 and 6)	$I_B = 0.5 \text{ A}$	$I_C = 5 \text{ A}$		1
					$I_B = 5 \text{ A}$	$I_C = 20 \text{ A}$		3
V_{BE}	Base-emitter voltage			(see Notes 5 and 6)	$V_{CE} = 4 \text{ V}$	$I_C = 5 \text{ A}$		1
					$V_{CE} = 4 \text{ V}$	$I_C = 20 \text{ A}$		3
h_{fe}	Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 1 \text{ A}$	$f = 1 \text{ kHz}$			25	
$ h_{fe} $	Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 1 \text{ A}$	$f = 1 \text{ MHz}$			5	

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.1	$^\circ\text{C/W}$
$R_{\theta JA}$	Junction to free air thermal resistance			35.7	$^\circ\text{C/W}$

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT		
t_d	Delay time	$I_C = 5 \text{ A}$	$I_{B(on)} = 0.5 \text{ A}$	$I_{B(off)} = -0.5 \text{ A}$		20	ns		
t_r	Rise time					350	ns		
t_s	Storage time				$V_{BE(off)} = -4.2 \text{ V}$	$R_L = 6 \Omega$	$t_p = 20 \mu\text{s}$, dc $\leq 2\%$	500	ns
t_f	Fall time							400	ns

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

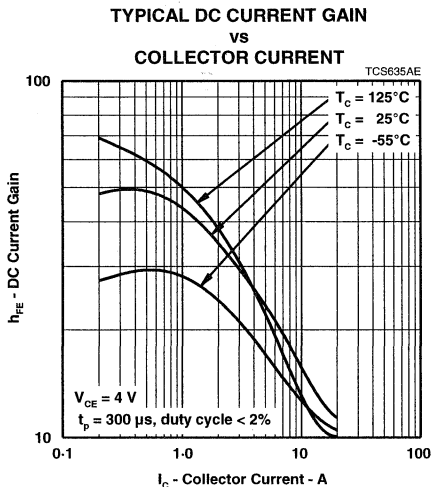


Figure 1.

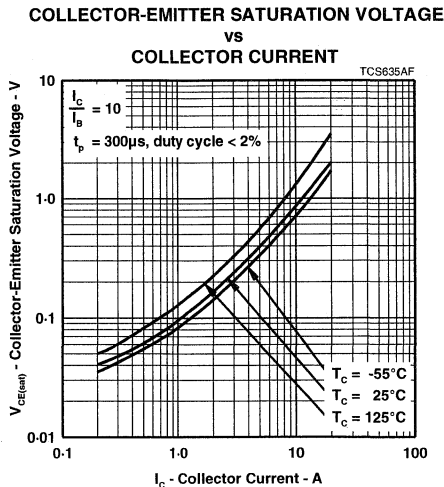


Figure 2.

MAXIMUM SAFE OPERATING REGIONS

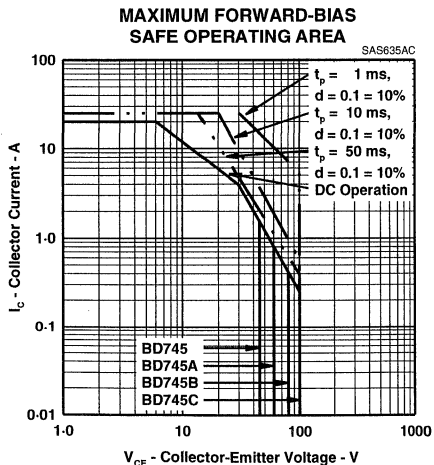


Figure 3.

BD745, BD745A, BD745B, BD745C NPN SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

THERMAL INFORMATION

MAXIMUM POWER DISSIPATION vs CASE TEMPERATURE

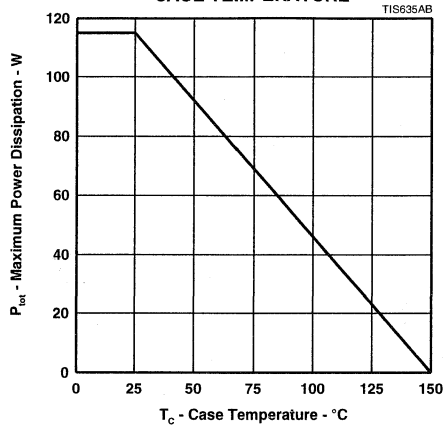
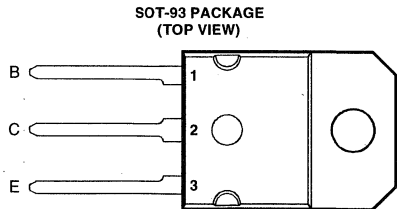


Figure 4.

BD746, BD746A, BD746B, BD746C PNP SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

- Designed for Complementary Use with the BD745 Series
- 115 W at 25°C Case Temperature
- 20 A Continuous Collector Current
- 25 A Peak Collector Current
- Customer-Specified Selections Available



Pin 2 is in electrical contact with the mounting base.

MDTRA4

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BD746	V_{CBO}	-50	V
	BD746A		-70	
	BD746B		-90	
	BD746C		-110	
Collector-emitter voltage ($I_B = 0$)	BD746	V_{CEO}	-45	V
	BD746A		-60	
	BD746B		-80	
	BD746C	-100		
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-20	A
Peak collector current (see Note 1)		I_{CM}	-25	A
Continuous base current		I_B	-7	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	115	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	3.5	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	90	mJ
Operating free air temperature range		T_A	-65 to +150	°C
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.

2. Derate linearly to 150°C case temperature at the rate of 0.92 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 28 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = -0.4$ A, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = -20$ V.

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BD746, BD746A, BD746B, BD746C

PNP SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$ Collector-emitter breakdown voltage	$I_C = -30 \text{ mA}$	$I_B = 0$	(see Note 5)	BD746 BD746A BD746B BD746C	-45 -60 -80 -100		V
I_{CBO} Collector cut-off current	$V_{CE} = -50 \text{ V}$ $V_{CE} = -70 \text{ V}$ $V_{CE} = -90 \text{ V}$ $V_{CE} = -110 \text{ V}$ $V_{CE} = -50 \text{ V}$ $V_{CE} = -70 \text{ V}$ $V_{CE} = -90 \text{ V}$ $V_{CE} = -110 \text{ V}$	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	$T_C = 125^\circ\text{C}$ $T_C = 125^\circ\text{C}$ $T_C = 125^\circ\text{C}$ $T_C = 125^\circ\text{C}$	BD746 BD746A BD746B BD746C BD746 BD746A BD746B BD746C		-0.1 -0.1 -0.1 -0.1 -5 -5 -5 -5	mA
I_{CEO} Collector cut-off current	$V_{CE} = -30 \text{ V}$ $V_{CE} = -60 \text{ V}$	$I_B = 0$ $I_B = 0$		BD746/746A BD746B/746C		-0.1 -0.1	mA
I_{EBO} Emitter cut-off current	$V_{EB} = -5 \text{ V}$	$I_C = 0$				-0.5	mA
h_{FE} Forward current transfer ratio	$V_{CE} = -4 \text{ V}$ $V_{CE} = -4 \text{ V}$ $V_{CE} = -4 \text{ V}$	$I_C = -1 \text{ A}$ $I_C = -5 \text{ A}$ $I_C = -20 \text{ A}$	(see Notes 5 and 6)		40 20 5	150	
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = -0.5 \text{ A}$ $I_B = -5 \text{ A}$	$I_C = -5 \text{ A}$ $I_C = -20 \text{ A}$	(see Notes 5 and 6)			-1 -3	V
V_{BE} Base-emitter voltage	$V_{CE} = -4 \text{ V}$ $V_{CE} = -4 \text{ V}$	$I_C = -5 \text{ A}$ $I_C = -20 \text{ A}$	(see Notes 5 and 6)			-1 -3	V
h_{fe} Small signal forward current transfer ratio	$V_{CE} = -10 \text{ V}$	$I_C = -1 \text{ A}$	$f = 1 \text{ kHz}$		25		
$ h_{fe} $ Small signal forward current transfer ratio	$V_{CE} = -10 \text{ V}$	$I_C = -1 \text{ A}$	$f = 1 \text{ MHz}$		5		

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1.1	$^\circ\text{C/W}$
$R_{\theta JA}$ Junction to free air thermal resistance			35.7	$^\circ\text{C/W}$

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_d Delay time					20		ns
t_r Rise time	$I_C = -5 \text{ A}$	$I_{B(on)} = -0.5 \text{ A}$	$I_{B(off)} = 0.5 \text{ A}$		120		ns
t_s Storage time	$V_{BE(off)} = 4.2 \text{ V}$	$R_L = 6 \Omega$	$t_p = 20 \mu\text{s}$, dc $\leq 2\%$		600		ns
t_f Fall time					300		ns

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.



TYPICAL CHARACTERISTICS

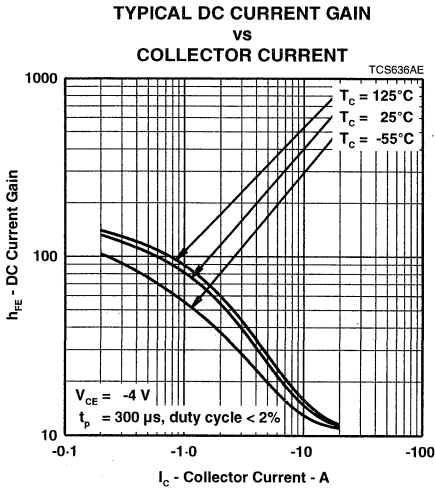


Figure 1.

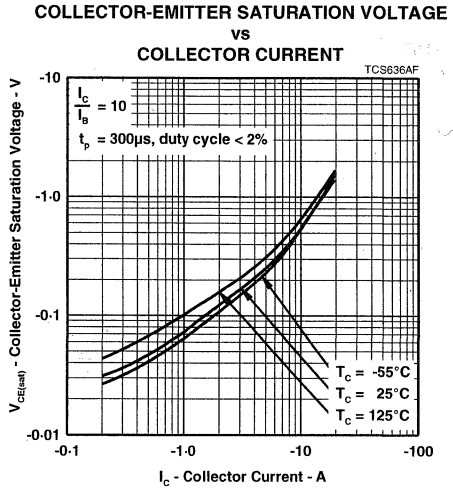


Figure 2.

MAXIMUM SAFE OPERATING REGIONS

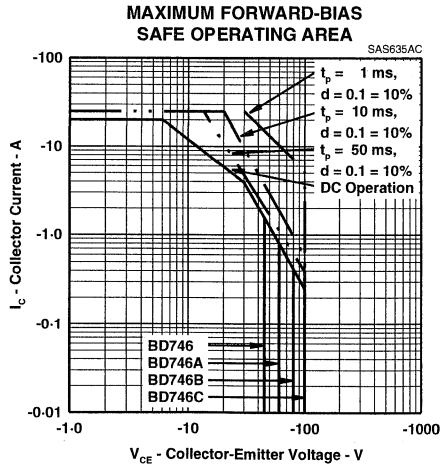


Figure 3.

BD746, BD746A, BD746B, BD746C
PNP SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

THERMAL INFORMATION

MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE

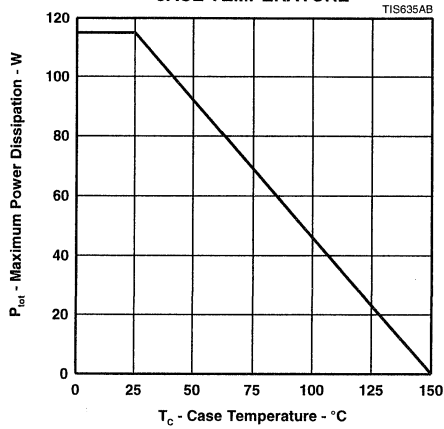
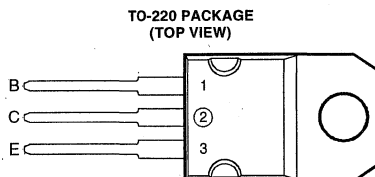


Figure 4.

TIP29, TIP29A, TIP29B, TIP29C NPN SILICON POWER TRANSISTORS

JULY 1968 - REVISED MAY 1995

- Designed for Complementary Use with the TIP30 Series
- 30 W at 25°C Case Temperature
- 1 A Continuous Collector Current
- 3 A Peak Collector Current
- Customer-Specified Selections Available



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIP29	V_{CBO}	80	V
	TIP29A		100	
	TIP29B		120	
	TIP29C		140	
Collector-emitter voltage ($I_B = 0$)	TIP29	V_{CEO}	40	V
	TIP29A		60	
	TIP29B		80	
	TIP29C		100	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	1	A
Peak collector current (see Note 1)		I_{CM}	3	A
Continuous base current		I_B	0.4	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	30	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	32	mJ
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	250	°C

NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.

2. Derate linearly to 150°C case temperature at the rate of 0.24 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = 0.4$ A, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = 20$ V.

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TIP29, TIP29A, TIP29B, TIP29C

NPN SILICON POWER TRANSISTORS

JULY 1968 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$ Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$ (see Note 5)	$I_B = 0$	TIP29 TIP29A TIP29B TIP29C	40 60 80 100			V
I_{CES} Collector-emitter cut-off current	$V_{CE} = 80 \text{ V}$ $V_{CE} = 100 \text{ V}$ $V_{CE} = 120 \text{ V}$ $V_{CE} = 140 \text{ V}$	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	TIP29 TIP29A TIP29B TIP29C			0.2 0.2 0.2 0.2	mA
I_{CEO} Collector cut-off current	$V_{CE} = 30 \text{ V}$ $V_{CE} = 60 \text{ V}$	$I_B = 0$ $I_B = 0$	TIP29/29A TIP29B/29C			0.3 0.3	mA
I_{EBO} Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$				1	mA
h_{FE} Forward current transfer ratio	$V_{CE} = 4 \text{ V}$ $V_{CE} = 4 \text{ V}$	$I_C = 0.2 \text{ A}$ $I_C = 1 \text{ A}$	(see Notes 5 and 6)	40 15		75	
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 125 \text{ mA}$	$I_C = 1 \text{ A}$	(see Notes 5 and 6)			0.7	V
V_{BE} Base-emitter voltage	$V_{CE} = 4 \text{ V}$	$I_C = 1 \text{ A}$	(see Notes 5 and 6)			1.3	V
h_{fe} Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.2 \text{ A}$	$f = 1 \text{ kHz}$	20			
$ h_{fe} $ Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.2 \text{ A}$	$f = 1 \text{ MHz}$	3			

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			4.17	°C/W
$R_{\theta JA}$ Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on} Turn-on time	$I_C = 1 \text{ A}$	$I_{B(on)} = 0.1 \text{ A}$	$I_{B(off)} = -0.1 \text{ A}$		0.5		μs
t_{off} Turn-off time	$V_{BE(off)} = -4.3 \text{ V}$	$R_L = 30 \Omega$	$t_p = 20 \mu\text{s}$, dc $\leq 2\%$		2		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

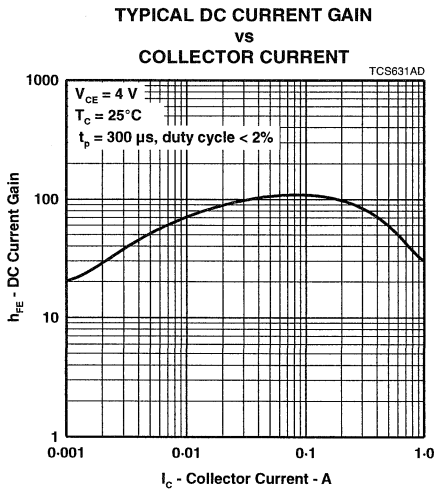


Figure 1.

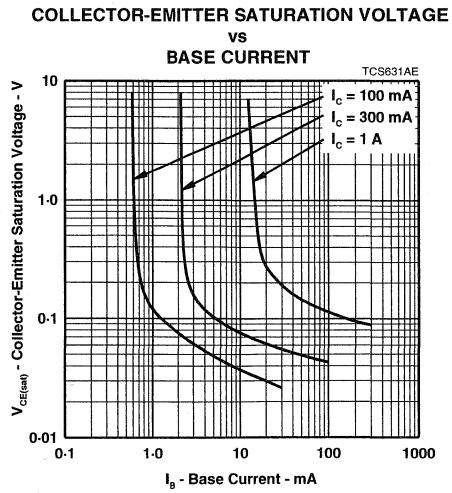


Figure 2.

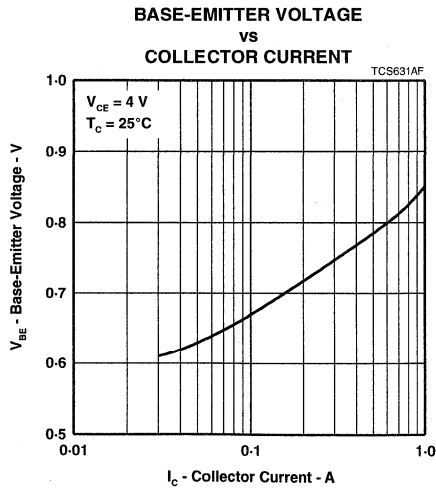


Figure 3.

TIP29, TIP29A, TIP29B, TIP29C
NPN SILICON POWER TRANSISTORS

JULY 1968 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

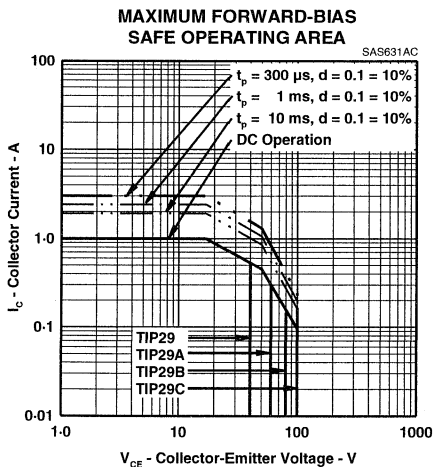


Figure 4.

THERMAL INFORMATION

MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE

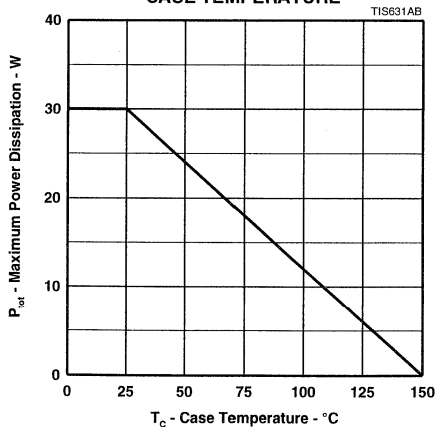


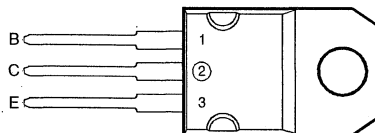
Figure 5.

TIP29D, TIP29E, TIP29F NPN SILICON POWER TRANSISTORS

JULY 1968 - REVISED MAY 1995

- 30 W at 25°C Case Temperature
- 1 A Continuous Collector Current
- 3 A Peak Collector Current
- Customer-Specified Selections Available

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIP29D	V_{CBO}	160	V
	TIP29E		180	
	TIP29F		200	
Collector-emitter voltage ($I_B = 0$)	TIP29D	V_{CEO}	120	V
	TIP29E		140	
	TIP29F		160	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	1	A
Peak collector current (see Note 1)		I_{CM}	3	A
Continuous base current		I_B	0.4	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	30	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	32	mJ
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	250	°C

- NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.
 2. Derate linearly to 150°C case temperature at the rate of 0.24 W/°C.
 3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.
 4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = 0.4$ A, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = 20$ V.

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TIP29D, TIP29E, TIP29F

NPN SILICON POWER TRANSISTORS

JULY 1968 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$ (see Note 5)	$I_B = 0$	TIP29D	120			V
				TIP29E	140			
				TIP29F	160			
I_{CES}	Collector-emitter cut-off current	$V_{CE} = 160 \text{ V}$ $V_{CE} = 180 \text{ V}$ $V_{CE} = 200 \text{ V}$	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	TIP29D		0.2		mA
				TIP29E		0.2		
				TIP29F		0.2		
I_{CEO}	Collector cut-off current	$V_{CE} = 90 \text{ V}$	$I_B = 0$			0.3		mA
I_{EBO}	Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$			1		mA
h_{FE}	Forward current transfer ratio	$V_{CE} = 4 \text{ V}$ $V_{CE} = 4 \text{ V}$	$I_C = 0.2 \text{ A}$ $I_C = 1 \text{ A}$	(see Notes 5 and 6)	40			
					15			
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = 125 \text{ mA}$	$I_C = 1 \text{ A}$	(see Notes 5 and 6)			0.7	V
V_{BE}	Base-emitter voltage				$V_{CE} = 4 \text{ V}$	$I_C = 1 \text{ A}$	(see Notes 5 and 6)	
h_{fe}	Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.2 \text{ A}$	$f = 1 \text{ kHz}$	20			
$ h_{fe} $	Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.2 \text{ A}$	$f = 1 \text{ MHz}$	3			

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			4.17	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = 1 \text{ A}$ $V_{BE(off)} = -4.3 \text{ V}$	$I_{B(on)} = 0.1 \text{ A}$ $R_L = 30 \Omega$	$I_{B(off)} = -0.1 \text{ A}$ $t_p = 20 \mu\text{s}$, dc $\leq 2\%$		0.5		μs
t_{off}	Turn-off time					2		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
vs
COLLECTOR CURRENT

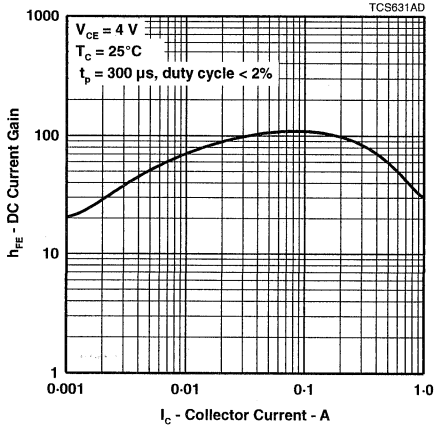


Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE
vs
BASE CURRENT

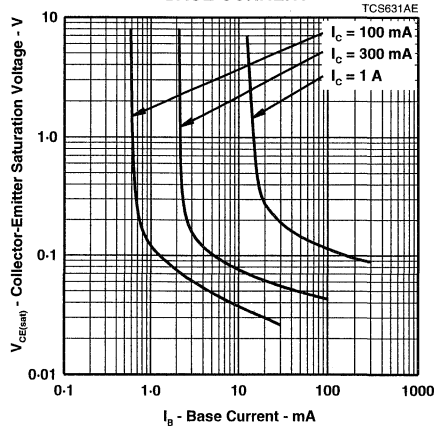


Figure 2.

BASE-EMITTER VOLTAGE
vs
COLLECTOR CURRENT

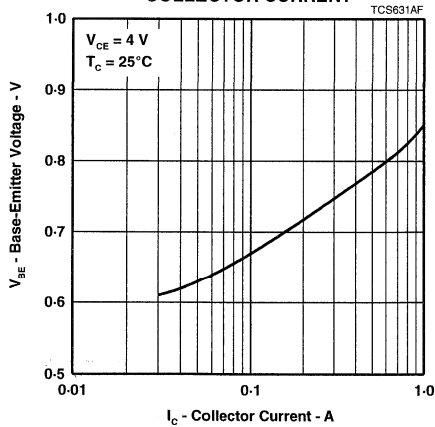


Figure 3.

TIP29D, TIP29E, TIP29F
 NPN SILICON POWER TRANSISTORS

JULY 1968 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

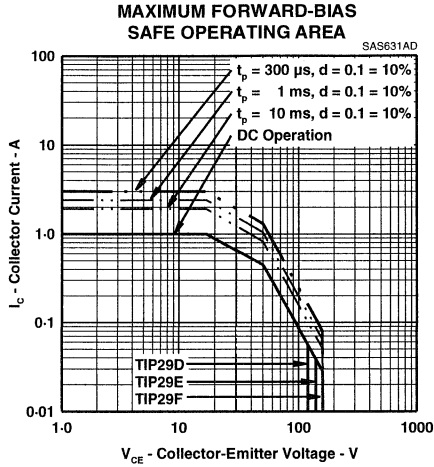


Figure 4.

THERMAL INFORMATION

MAXIMUM POWER DISSIPATION
 vs
 CASE TEMPERATURE

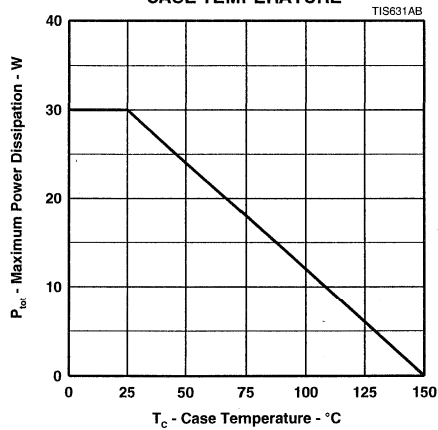


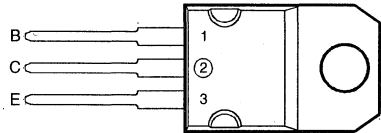
Figure 5.

TIP30, TIP30A, TIP30B, TIP30C PNP SILICON POWER TRANSISTORS

JULY 1968 - REVISED MAY 1995

- Designed for Complementary Use with the TIP29 Series
- 30 W at 25°C Case Temperature
- 1 A Continuous Collector Current
- 3 A Peak Collector Current
- Customer-Specified Selections Available

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIP30	V_{CBO}	-80	V
	TIP30A		-100	
	TIP30B		-120	
	TIP30C		-140	
Collector-emitter voltage ($I_B = 0$)	TIP30	V_{CEO}	-40	V
	TIP30A		-60	
	TIP30B		-80	
	TIP30C		-100	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-1	A
Peak collector current (see Note 1)		I_{CM}	-3	A
Continuous base current		I_B	-0.4	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	30	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	32	mJ
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	250	°C

NOTES: 1. This value applies for $t_b \leq 0.3$ ms, duty cycle $\leq 10\%$.

2. Derate linearly to 150°C case temperature at the rate of 0.24 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = -0.4$ A, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = -20$ V.

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TIP30, TIP30A, TIP30B, TIP30C

PNP SILICON POWER TRANSISTORS

JULY 1968 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = -30$ mA (see Note 5)	$I_B = 0$	TIP30	-40			V
				TIP30A	-60			
				TIP30B	-80			
				TIP30C	-100			
I_{CES}	Collector-emitter cut-off current	$V_{CE} = -80$ V $V_{CE} = -100$ V $V_{CE} = -120$ V $V_{CE} = -140$ V	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	TIP30			-0.2	mA
				TIP30A			-0.2	
				TIP30B			-0.2	
				TIP30C			-0.2	
I_{CEO}	Collector cut-off current	$V_{CE} = -30$ V $V_{CE} = -60$ V	$I_B = 0$ $I_B = 0$	TIP30/30A			-0.3	mA
				TIP30B/30C			-0.3	
I_{EBO}	Emitter cut-off current	$V_{EB} = -5$ V	$I_C = 0$				-1	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = -4$ V $V_{CE} = -4$ V	$I_C = -0.2$ A $I_C = -1$ A	(see Notes 5 and 6)	40			75
					15			
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = -125$ mA	$I_C = -1$ A	(see Notes 5 and 6)			-0.7	V
V_{BE}	Base-emitter voltage	$V_{CE} = -4$ V	$I_C = -1$ A	(see Notes 5 and 6)			-1.3	V
h_{fe}	Small signal forward current transfer ratio	$V_{CE} = -10$ V	$I_C = -0.2$ A	$f = 1$ kHz	20			
$ h_{fe} $	Small signal forward current transfer ratio	$V_{CE} = -10$ V	$I_C = -0.2$ A	$f = 1$ MHz	3			

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300$ μ s, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			4.17	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = -1$ A	$I_{B(on)} = -0.1$ A	$I_{B(off)} = 0.1$ A		0.3	μ s
t_{off}	Turn-off time	$V_{BE(off)} = 4.3$ V	$R_L = 30$ Ω	$t_p = 20$ μ s, dc $\leq 2\%$		1	μ s

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
vs
COLLECTOR CURRENT

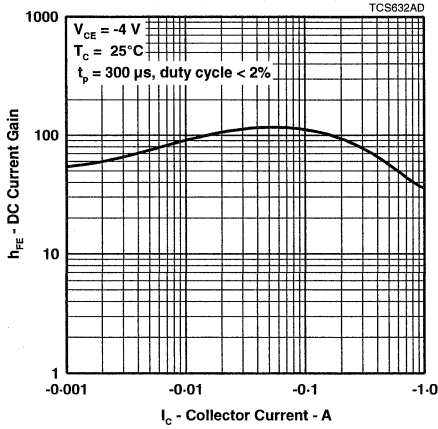


Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE
vs
BASE CURRENT

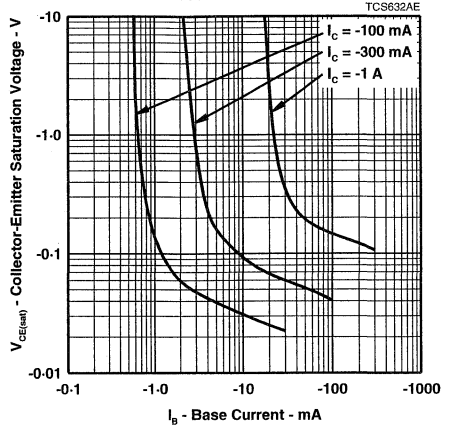


Figure 2.

BASE-EMITTER VOLTAGE
vs
COLLECTOR CURRENT

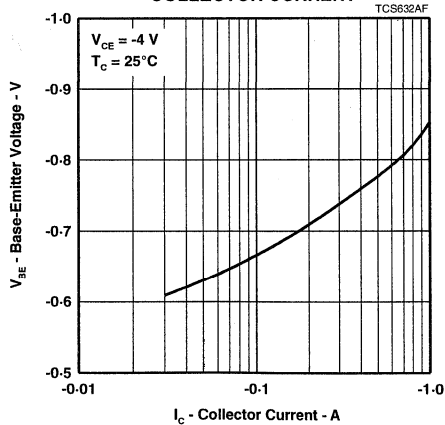


Figure 3.

TIP30, TIP30A, TIP30B, TIP30C
PNP SILICON POWER TRANSISTORS

JULY 1968 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

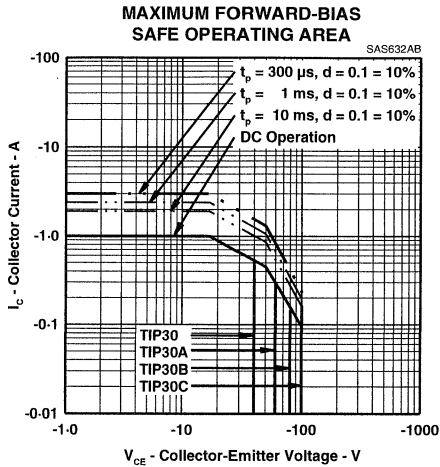


Figure 4.

THERMAL INFORMATION

MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE

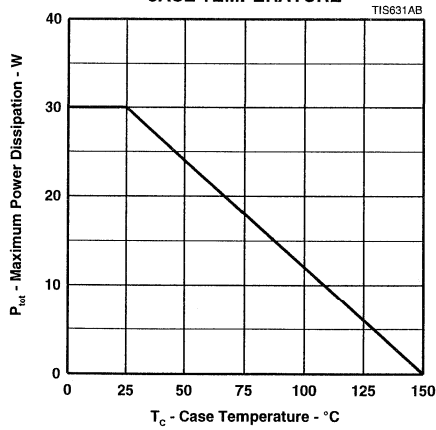
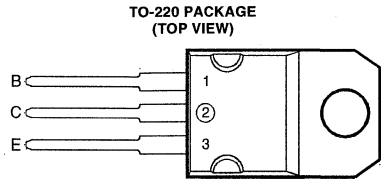


Figure 5.

TIP31, TIP31A, TIP31B, TIP31C NPN SILICON POWER TRANSISTORS

JULY 1968 - REVISED MAY 1995

- Designed for Complementary Use with the TIP32 Series
- 40 W at 25°C Case Temperature
- 3 A Continuous Collector Current
- 5 A Peak Collector Current
- Customer-Specified Selections Available



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIP31	V_{CBO}	80	V
	TIP31A		100	
	TIP31B		120	
	TIP31C		140	
Collector-emitter voltage ($I_B = 0$)	TIP31	V_{CEO}	40	V
	TIP31A		60	
	TIP31B		80	
	TIP31C		100	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	3	A
Peak collector current (see Note 1)		I_{CM}	5	A
Continuous base current		I_B	1	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	40	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	32	mJ
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	250	°C

NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.

2. Derate linearly to 150°C case temperature at the rate of 0.32 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = 0.4$ A, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = 20$ V.

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TIP31, TIP31A, TIP31B, TIP31C

NPN SILICON POWER TRANSISTORS

JULY 1968 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$ (see Note 5)	$I_B = 0$	TIP31	40			V
				TIP31A	60			
				TIP31B	80			
				TIP31C	100			
I_{CES}	Collector-emitter cut-off current	$V_{CE} = 80 \text{ V}$ $V_{CE} = 100 \text{ V}$ $V_{CE} = 120 \text{ V}$ $V_{CE} = 140 \text{ V}$	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	TIP31			0.2	mA
				TIP31A			0.2	
				TIP31B			0.2	
				TIP31C			0.2	
I_{CEO}	Collector cut-off current	$V_{CE} = 30 \text{ V}$ $V_{CE} = 60 \text{ V}$	$I_B = 0$ $I_B = 0$	TIP31/31A			0.3	mA
				TIP31B/31C			0.3	
I_{EBO}	Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$				1	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = 4 \text{ V}$ $V_{CE} = 4 \text{ V}$	$I_C = 1 \text{ A}$ $I_C = 3 \text{ A}$	(see Notes 5 and 6)	25			
					10		50	
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = 375 \text{ mA}$	$I_C = 3 \text{ A}$	(see Notes 5 and 6)			1.2	V
V_{BE}	Base-emitter voltage	$V_{CE} = 4 \text{ V}$	$I_C = 3 \text{ A}$	(see Notes 5 and 6)			1.8	V
h_{fe}	Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ kHz}$	20			
$ h_{fe} $	Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ MHz}$	3			

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			3.125	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = 1 \text{ A}$	$I_{B(on)} = 0.1 \text{ A}$		0.5		μs
t_{off}	Turn-off time	$V_{BE(off)} = -4.3 \text{ V}$	$R_L = 30 \Omega$	$I_{B(off)} = -0.1 \text{ A}$		2	μs
							$t_p = 20 \mu\text{s}$, $d_c \leq 2\%$

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
vs
COLLECTOR CURRENT

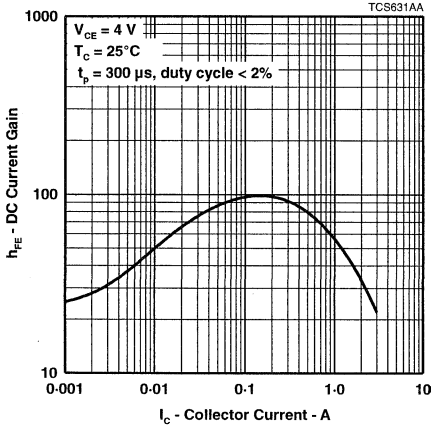


Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE
vs
BASE CURRENT

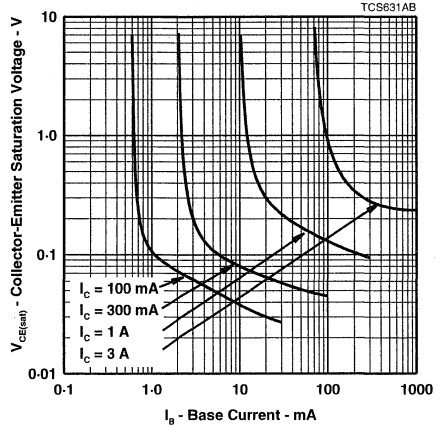


Figure 2.

BASE-EMITTER VOLTAGE
vs
COLLECTOR CURRENT

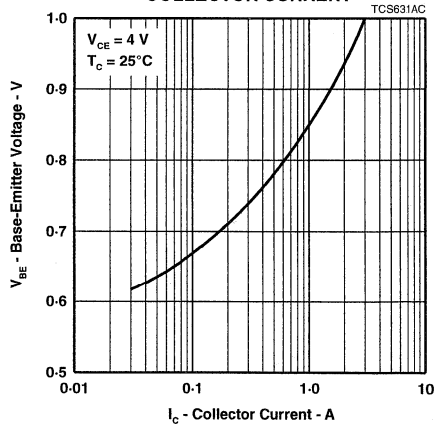


Figure 3.

TIP31, TIP31A, TIP31B, TIP31C
NPN SILICON POWER TRANSISTORS

JULY 1968 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

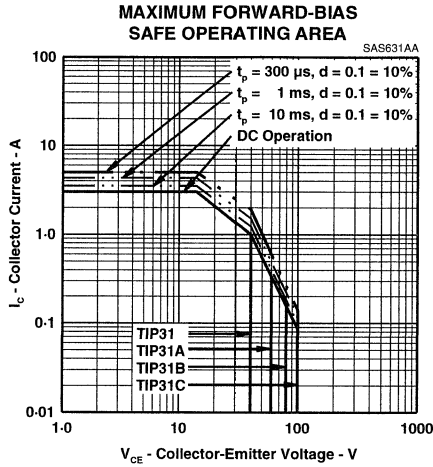


Figure 4.

THERMAL INFORMATION

**MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE**

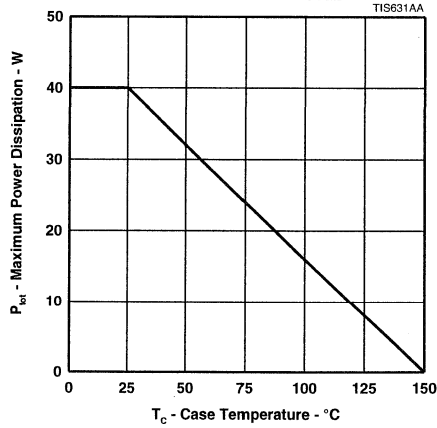
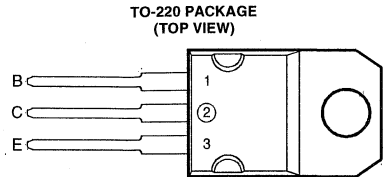


Figure 5.

TIP31D, TIP31E, TIP31F NPN SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

- 40 W at 25°C Case Temperature
- 3 A Continuous Collector Current
- 5 A Peak Collector Current
- Customer-Specified Selections Available



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIP31D	V_{CBO}	160	V
	TIP31E		180	
	TIP31F		200	
Collector-emitter voltage ($I_B = 0$)	TIP31D	V_{CEO}	120	V
	TIP31E		140	
	TIP31F		160	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	3	A
Peak collector current (see Note 1)		I_{CM}	5	A
Continuous base current		I_B	1	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	40	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	32	mJ
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	250	°C

- NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.
2. Derate linearly to 150°C case temperature at the rate of 0.32 W/°C.
3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.
4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = 0.4$ A, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = 20$ V.

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TIP31D, TIP31E, TIP31F

NPN SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$ Collector-emitter breakdown voltage	$I_C = .30$ mA (see Note 5)	$I_B = 0$	TIP31D	120			V
			TIP31E	140			
			TIP31F	160			
I_{CES} Collector-emitter cut-off current	$V_{CE} = 160$ V	$V_{BE} = 0$	TIP31D			0.2	mA
	$V_{CE} = 180$ V	$V_{BE} = 0$	TIP31E			0.2	
	$V_{CE} = 200$ V	$V_{BE} = 0$	TIP31F			0.2	
I_{CEO} Collector cut-off current	$V_{CE} = 90$ V	$I_B = 0$				0.3	mA
I_{EBO} Emitter cut-off current	$V_{EB} = 5$ V	$I_C = 0$				1	mA
h_{FE} Forward current transfer ratio	$V_{CE} = 4$ V	$I_C = 1$ A	(see Notes 5 and 6)	25			
	$V_{CE} = 4$ V	$I_C = 3$ A		5			
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 750$ mA	$I_C = 3$ A	(see Notes 5 and 6)			2.5	V
V_{BE} Base-emitter voltage	$V_{CE} = 4$ V	$I_C = 3$ A	(see Notes 5 and 6)			1.8	V
h_{fe} Small signal forward current transfer ratio	$V_{CE} = 10$ V	$I_C = 0.5$ A	$f = 1$ kHz	20			
$ h_{fe} $ Small signal forward current transfer ratio	$V_{CE} = 10$ V	$I_C = 0.5$ A	$f = 1$ MHz	3			

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300$ μ s, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			3.125	°C/W
$R_{\theta JA}$ Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on} Turn-on time	$I_C = 1$ A	$I_{B(on)} = 0.1$ A	$I_{B(off)} = -0.1$ A		0.5		μ s
t_{off} Turn-off time	$V_{BE(off)} = -4.3$ V	$R_L = 30$ Ω	$t_p = 20$ μ s, dc $\leq 2\%$		2		μ s

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
vs
COLLECTOR CURRENT

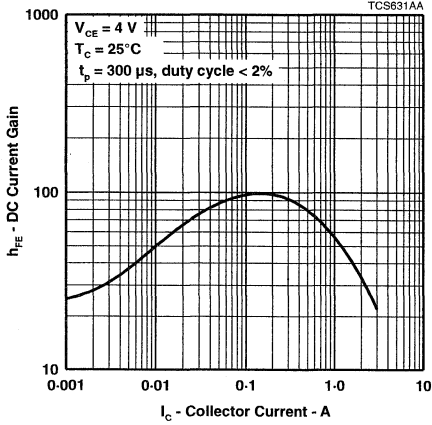


Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE
vs
BASE CURRENT

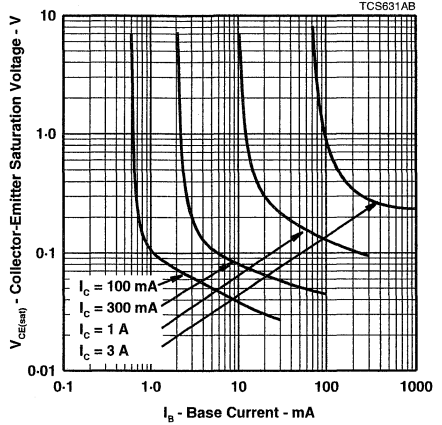


Figure 2.

BASE-EMITTER VOLTAGE
vs
COLLECTOR CURRENT

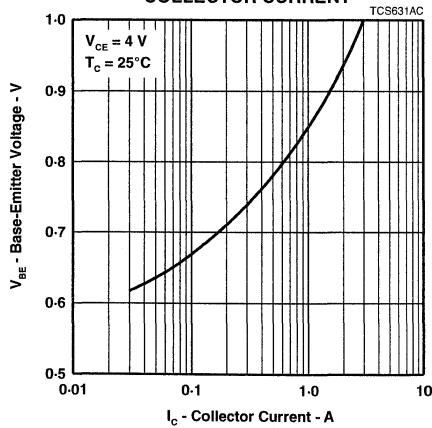


Figure 3.

TIP31D, TIP31E, TIP31F
 NPN SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

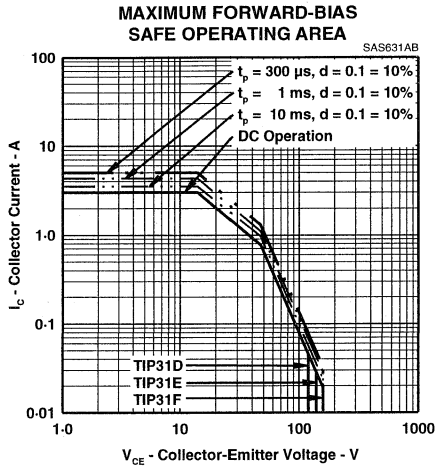


Figure 4.

THERMAL INFORMATION

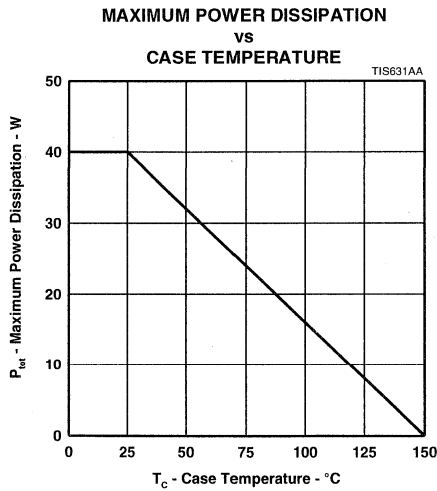


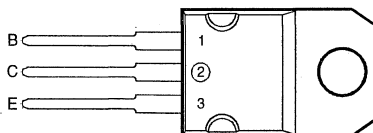
Figure 5.

TIP32, TIP32A, TIP32B, TIP32C PNP SILICON POWER TRANSISTORS

JULY 1968 - REVISED MAY 1995

- Designed for Complementary Use with the TIP31 Series
- 40 W at 25°C Case Temperature
- 3 A Continuous Collector Current
- 5 A Peak Collector Current
- Customer-Specified Selections Available

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIP32	V_{CBO}	-80	V
	TIP32A		-100	
	TIP32B		-120	
	TIP32C		-140	
Collector-emitter voltage ($I_B = 0$)	TIP32	V_{CEO}	-40	V
	TIP32A		-60	
	TIP32B		-80	
	TIP32C		-100	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-3	A
Peak collector current (see Note 1)		I_{CM}	-5	A
Continuous base current		I_B	-1	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	40	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	32	mJ
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	250	°C

NOTES: 1. This value applies for $t_b \leq 0.3$ ms, duty cycle $\leq 10\%$.

2. Derate linearly to 150°C case temperature at the rate of 0.32 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(ON)} = -0.4$ A, $R_{BE} = 100 \Omega$, $V_{BE(ON)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = -20$ V.

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TIP32, TIP32A, TIP32B, TIP32C

PNP SILICON POWER TRANSISTORS

JULY 1968 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = -30$ mA (see Note 5)	$I_B = 0$	TIP32 TIP32A TIP32B TIP32C	-40 -60 -80 -100			V
I_{CES}	Collector-emitter cut-off current	$V_{CE} = -80$ V $V_{CE} = -100$ V $V_{CE} = -120$ V $V_{CE} = -140$ V	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	TIP32 TIP32A TIP32B TIP32C			-0.2 -0.2 -0.2 -0.2	mA
I_{CEO}	Collector cut-off current	$V_{CE} = -30$ V $V_{CE} = -60$ V	$I_B = 0$ $I_B = 0$	TIP32/32A TIP32B/32C			-0.3 -0.3	mA
I_{EBO}	Emitter cut-off current	$V_{EB} = -5$ V	$I_C = 0$				-1	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = -4$ V $V_{CE} = -4$ V	$I_C = -1$ A $I_C = -3$ A	(see Notes 5 and 6)	25 10		50	
$V_{CE(sat)}$	Collector-emitter saturation voltage		$I_B = -375$ mA $I_C = -3$ A	(see Notes 5 and 6)			-1.2	V
V_{BE}	Base-emitter voltage	$V_{CE} = -4$ V	$I_C = -3$ A	(see Notes 5 and 6)			-1.8	V
h_{fe}	Small signal forward current transfer ratio	$V_{CE} = -10$ V	$I_C = -0.5$ A	$f = 1$ kHz	20			
$ h_{fe} $	Small signal forward current transfer ratio	$V_{CE} = -10$ V	$I_C = -0.5$ A	$f = 1$ MHz	3			

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300$ μ s, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			3.125	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = -1$ A	$I_{B(on)} = -0.1$ A	$I_{B(off)} = 0.1$ A		0.3		μ s
t_{off}	Turn-off time	$V_{BE(off)} = 4.3$ V	$R_L = 30$ Ω	$t_p = 20$ μ s, dc $\leq 2\%$		1		μ s

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

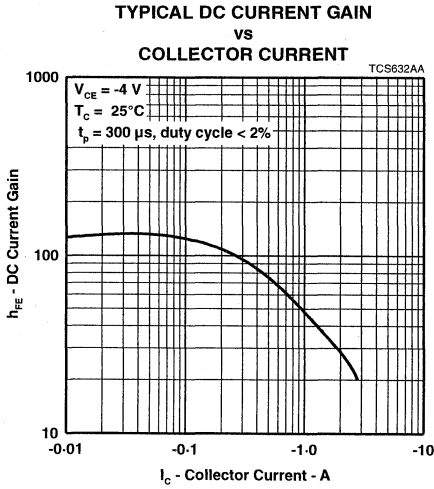


Figure 1.

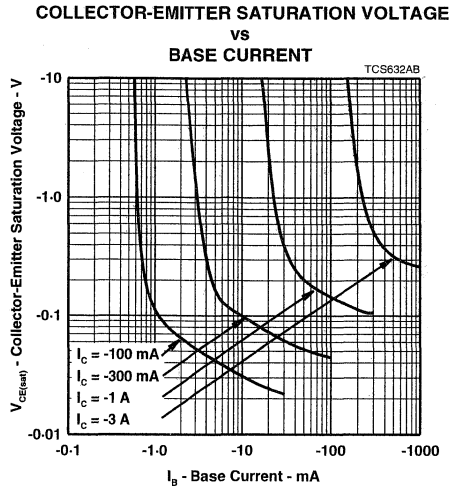


Figure 2.

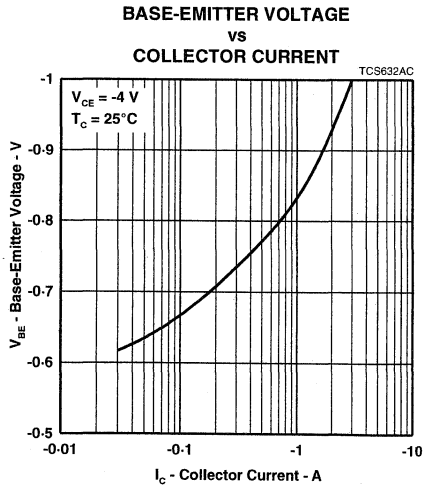


Figure 3.

TIP32, TIP32A, TIP32B, TIP32C
PNP SILICON POWER TRANSISTORS

JULY 1968 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

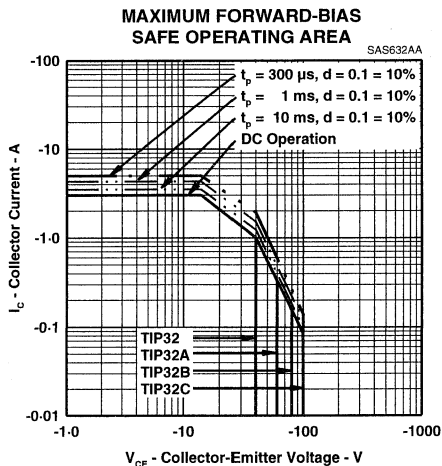


Figure 4.

THERMAL INFORMATION

MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE

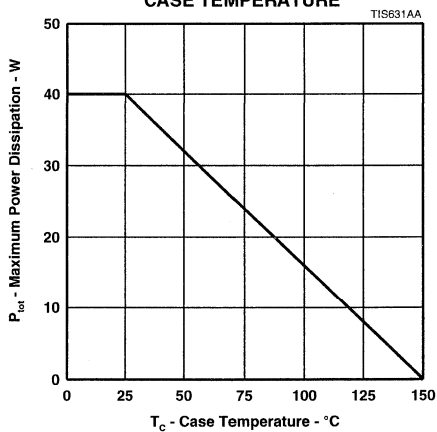
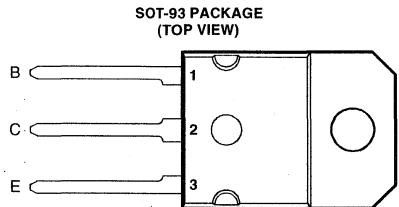


Figure 5.

TIP33, TIP33A, TIP33B, TIP33C NPN SILICON POWER TRANSISTORS

JULY 1968 - REVISED MAY 1995

- Designed for Complementary Use with the TIP34 Series
- 80 W at 25°C Case Temperature
- 10 A Continuous Collector Current
- 15 A Peak Collector Current
- Customer-Specified Selections Available



Pin 2 is in electrical contact with the mounting base.

MDTRAA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIP33	V_{CBO}	80	V
	TIP33A		100	
	TIP33B		120	
	TIP33C		140	
Collector-emitter voltage ($I_B = 0$)	TIP33	V_{CEO}	40	V
	TIP33A		60	
	TIP33B		80	
	TIP33C		100	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	10	A
Peak collector current (see Note 1)		I_{CM}	15	A
Continuous base current		I_B	3	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	80	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	3.5	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	62.5	mJ
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	250	°C

- NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.
 2. Derate linearly to 150°C case temperature at the rate of 0.64 W/°C.
 3. Derate linearly to 150°C free air temperature at the rate of 28 mW/°C.
 4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = 0.4$ A, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = 20$ V.

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TIP33, TIP33A, TIP33B, TIP33C

NPN SILICON POWER TRANSISTORS

JULY 1968 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	TIP33			40			V
		TIP33A			60			
		TIP33B			80			
		TIP33C			100			
I_{CES}	Collector-emitter cut-off current	$V_{CE} = 80\text{ V}$	$V_{BE} = 0$	TIP33		0.4	mA	
		$V_{CE} = 100\text{ V}$	$V_{BE} = 0$	TIP33A		0.4		
		$V_{CE} = 120\text{ V}$	$V_{BE} = 0$	TIP33B		0.4		
		$V_{CE} = 140\text{ V}$	$V_{BE} = 0$	TIP33C		0.4		
I_{CEO}	Collector cut-off current	$V_{CE} = 30\text{ V}$	$I_B = 0$	TIP33/33A		0.7	mA	
		$V_{CE} = 60\text{ V}$	$I_B = 0$	TIP33B/33C		0.7		
I_{EBO}	Emitter cut-off current	$V_{EB} = 5\text{ V}$	$I_C = 0$			1	mA	
h_{FE}	Forward current transfer ratio	$V_{CE} = 4\text{ V}$	$I_C = 1\text{ A}$	(see Notes 5 and 6)	40		100	
		$V_{CE} = 4\text{ V}$	$I_C = 3\text{ A}$		20			
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = 0.3\text{ A}$	$I_C = 3\text{ A}$	(see Notes 5 and 6)		1	V	
		$I_B = 2.5\text{ A}$	$I_C = 10\text{ A}$			4		
V_{BE}	Base-emitter voltage	$V_{CE} = 4\text{ V}$	$I_C = 3\text{ A}$	(see Notes 5 and 6)		1.6	V	
		$V_{CE} = 4\text{ V}$	$I_C = 10\text{ A}$			3		
h_{fe}	Small signal forward current transfer ratio	$V_{CE} = 10\text{ V}$	$I_C = 0.5\text{ A}$	$f = 1\text{ kHz}$	20			
$ h_{fe} $	Small signal forward current transfer ratio	$V_{CE} = 10\text{ V}$	$I_C = 0.5\text{ A}$	$f = 1\text{ MHz}$	3			

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.56	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			35.7	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = 6\text{ A}$	$I_{B(on)} = 0.6\text{ A}$	$I_{B(off)} = -0.6\text{ A}$		0.6	μs
t_{off}	Turn-off time	$V_{BE(off)} = -4\text{ V}$	$R_L = 5\text{ }\Omega$	$t_p = 20\text{ }\mu\text{s}$, dc $\leq 2\%$		1	μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
vs
COLLECTOR CURRENT

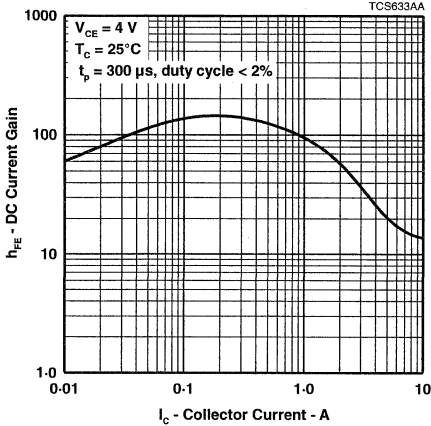


Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE
vs
BASE CURRENT

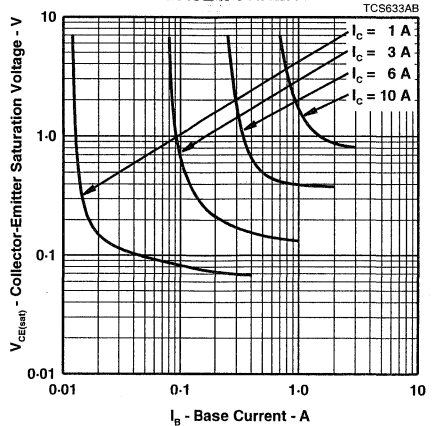


Figure 2.

BASE-EMITTER VOLTAGE
vs
COLLECTOR CURRENT

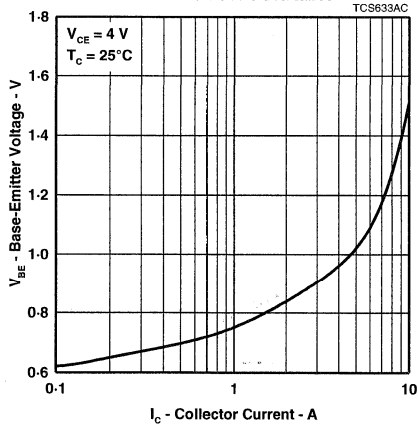


Figure 3.

TIP33, TIP33A, TIP33B, TIP33C
 NPN SILICON POWER TRANSISTORS

JULY 1968 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

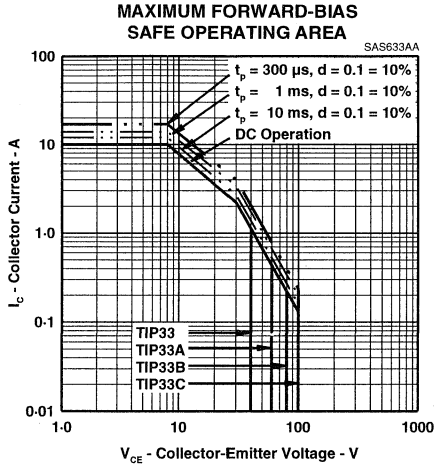


Figure 4.

THERMAL INFORMATION

MAXIMUM POWER DISSIPATION
 vs
 CASE TEMPERATURE

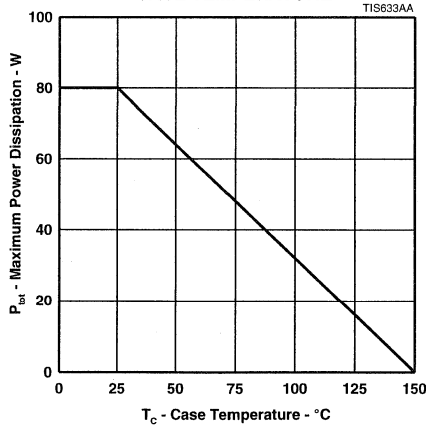
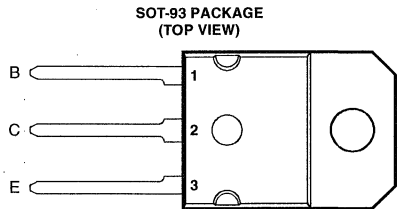


Figure 5.

TIP34, TIP34A, TIP34B, TIP34C PNP SILICON POWER TRANSISTORS

JULY 1968 - REVISED MAY 1995

- Designed for Complementary Use with the TIP33 Series
- 80 W at 25°C Case Temperature
- 10 A Continuous Collector Current
- 15 A Peak Collector Current
- Customer-Specified Selections Available



MDTRAA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIP34	V_{CBO}	-80	V
	TIP34A		-100	
	TIP34B		-120	
	TIP34C		-140	
Collector-emitter voltage ($I_B = 0$)	TIP34	V_{CEO}	-40	V
	TIP34A		-60	
	TIP34B		-80	
	TIP34C		-100	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-10	A
Peak collector current (see Note 1)		I_{CM}	-15	A
Continuous base current		I_B	-3	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	80	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	3.5	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	62.5	mJ
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	250	°C

- NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.
2. Derate linearly to 150°C case temperature at the rate of 0.64 W/°C.
3. Derate linearly to 150°C free air temperature at the rate of 28 mW/°C.
4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = -0.4$ A, $R_{BE} = 100$ Ω , $V_{BE(off)} = 0$, $R_S = 0.1$ Ω , $V_{CC} = -20$ V.

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TIP34, TIP34A, TIP34B, TIP34C

PNP SILICON POWER TRANSISTORS

JULY 1968 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = -30 \text{ mA}$ (see Note 5)	$I_B = 0$	TIP34	-40			V
				TIP34A	-60			
				TIP34B	-80			
				TIP34C	-100			
I_{CES}	Collector-emitter cut-off current	$V_{CE} = -80 \text{ V}$ $V_{CE} = -100 \text{ V}$ $V_{CE} = -120 \text{ V}$ $V_{CE} = -140 \text{ V}$	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	TIP34			-0.4	mA
				TIP34A			-0.4	
				TIP34B			-0.4	
				TIP34C			-0.4	
I_{CEO}	Collector cut-off current	$V_{CE} = -30 \text{ V}$ $V_{CE} = -60 \text{ V}$	$I_B = 0$ $I_B = 0$	TIP34/34A			-0.7	mA
				TIP34B/34C			-0.7	
I_{EBO}	Emitter cut-off current	$V_{EB} = -5 \text{ V}$	$I_C = 0$				-1	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = -4 \text{ V}$ $V_{CE} = -4 \text{ V}$	$I_C = -1 \text{ A}$ $I_C = -3 \text{ A}$	(see Notes 5 and 6)	40			
					20		100	
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = -0.3 \text{ A}$ $I_B = -2.5 \text{ A}$	$I_C = -3 \text{ A}$ $I_C = -10 \text{ A}$	(see Notes 5 and 6)			-1	V
							-4	
V_{BE}	Base-emitter voltage	$V_{CE} = -4 \text{ V}$ $V_{CE} = -4 \text{ V}$	$I_C = -3 \text{ A}$ $I_C = -10 \text{ A}$	(see Notes 5 and 6)			-1.6	V
							-3	
h_{fe}	Small signal forward current transfer ratio	$V_{CE} = -10 \text{ V}$	$I_C = -0.5 \text{ A}$	$f = 1 \text{ kHz}$	20			
$ h_{fe} $	Small signal forward current transfer ratio	$V_{CE} = -10 \text{ V}$	$I_C = -0.5 \text{ A}$	$f = 1 \text{ MHz}$	3			

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.56	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			35.7	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = -6 \text{ A}$	$I_{B(on)} = -0.6 \text{ A}$	$I_{B(off)} = 0.6 \text{ A}$		0.4		μs
t_{off}	Turn-off time				$V_{BE(off)} = 4 \text{ V}$	$R_L = 5 \Omega$	$t_p = 20 \mu\text{s}$, dc $\leq 2\%$	

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
VS
COLLECTOR CURRENT

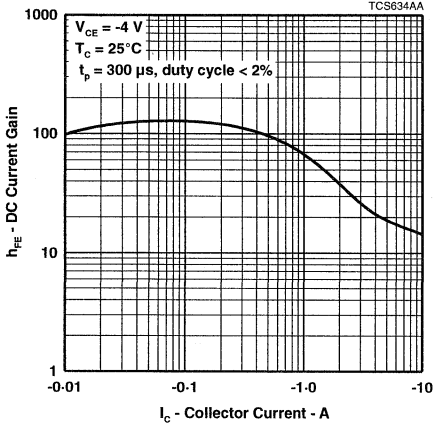


Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE
VS
BASE CURRENT

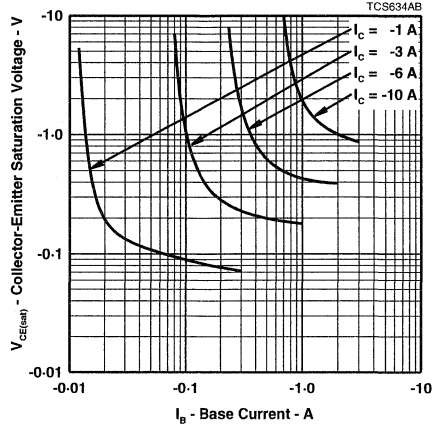


Figure 2.

BASE-EMITTER VOLTAGE
VS
COLLECTOR CURRENT

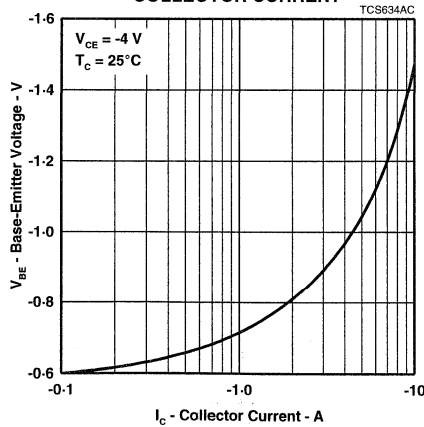


Figure 3.

TIP34, TIP34A, TIP34B, TIP34C
PNP SILICON POWER TRANSISTORS

JULY 1968 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

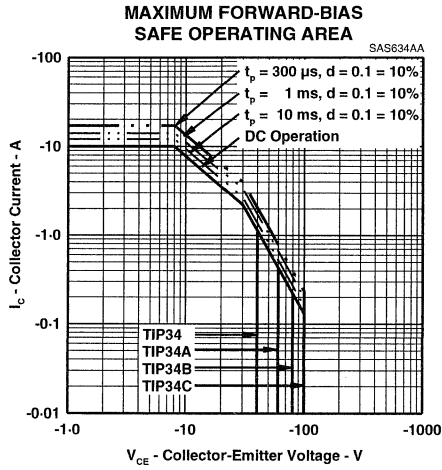


Figure 4.

THERMAL INFORMATION

MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE

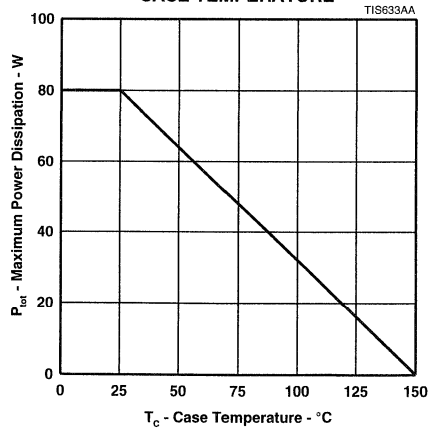
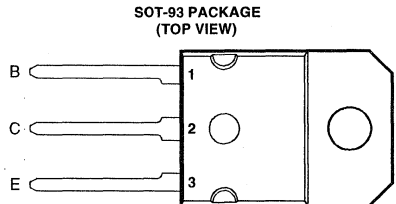


Figure 5.

TIP35, TIP35A, TIP35B, TIP35C NPN SILICON POWER TRANSISTORS

JULY 1968 - REVISED MAY 1995

- Designed for Complementary Use with the TIP36 Series
- 125 W at 25°C Case Temperature
- 25 A Continuous Collector Current
- 40 A Peak Collector Current
- Customer-Specified Selections Available



Pin 2 is in electrical contact with the mounting base.

MDTRAA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIP35	V_{CBO}	80	V
	TIP35A		100	
	TIP35B		120	
	TIP35C		140	
Collector-emitter voltage ($I_B = 0$)	TIP35	V_{CEO}	40	V
	TIP35A		60	
	TIP35B		80	
	TIP35C		100	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	25	A
Peak collector current (see Note 1)		I_{CM}	40	A
Continuous base current		I_B	5	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	125	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	3.5	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	90	mJ
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	250	°C

NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.

2. Derate linearly to 150°C case temperature at the rate of 1 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 28 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = 0.4$ A, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = 20$ V.

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TIP35, TIP35A, TIP35B, TIP35C

NPN SILICON POWER TRANSISTORS

JULY 1968 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$ Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$ $I_B = 0$ (see Note 5)			TIP35			V
				TIP35A	40		
				TIP35B	60		
				TIP35C	80		
I_{CES} Collector-emitter cut-off current	$V_{CE} = 80 \text{ V}$	$V_{BE} = 0$	TIP35			0.7	mA
	$V_{CE} = 100 \text{ V}$	$V_{BE} = 0$	TIP35A			0.7	
	$V_{CE} = 120 \text{ V}$	$V_{BE} = 0$	TIP35B			0.7	
	$V_{CE} = 140 \text{ V}$	$V_{BE} = 0$	TIP35C			0.7	
I_{CEO} Collector cut-off current	$V_{CE} = 30 \text{ V}$	$I_B = 0$	TIP35/35A			1	mA
	$V_{CE} = 60 \text{ V}$	$I_B = 0$	TIP35B/35C			1	
I_{EBO} Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$				1	mA
h_{FE} Forward current transfer ratio	$V_{CE} = 4 \text{ V}$	$I_C = 1.5 \text{ A}$	(see Notes 5 and 6)	25			
	$V_{CE} = 4 \text{ V}$	$I_C = 15 \text{ A}$		10		50	
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 1.5 \text{ A}$	$I_C = 15 \text{ A}$	(see Notes 5 and 6)			1.8	V
	$I_B = 5 \text{ A}$	$I_C = 25 \text{ A}$				4	
V_{BE} Base-emitter voltage	$V_{CE} = 4 \text{ V}$	$I_C = 15 \text{ A}$	(see Notes 5 and 6)			2	V
	$V_{CE} = 4 \text{ V}$	$I_C = 25 \text{ A}$				4	
h_{fe} Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 1 \text{ A}$	$f = 1 \text{ kHz}$	25			
$ h_{fe} $ Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 1 \text{ A}$	$f = 1 \text{ MHz}$	3			

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1	°C/W
$R_{\theta JA}$ Junction to free air thermal resistance			35.7	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on} Turn-on time	$I_C = 15 \text{ A}$	$I_{B(on)} = 1.5 \text{ A}$	$I_{B(off)} = -1.5 \text{ A}$		1.2		μs
t_{off} Turn-off time	$V_{BE(off)} = -4.15 \text{ V}$	$R_L = 2 \Omega$	$t_p = 20 \mu\text{s}$, $dc \leq 2\%$		0.9		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
VS
COLLECTOR CURRENT

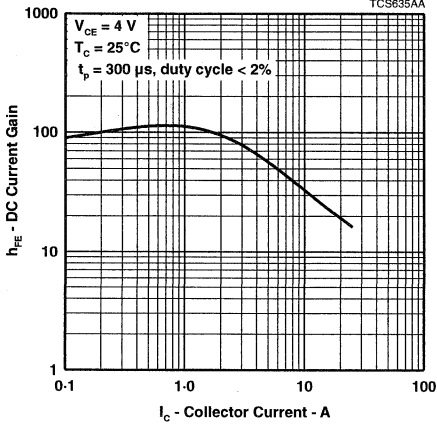


Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE
VS
BASE CURRENT

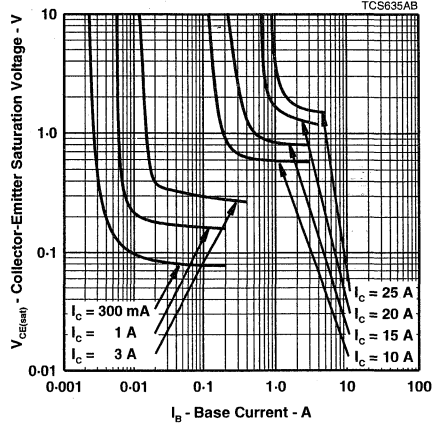


Figure 2.

BASE-EMITTER VOLTAGE
VS
COLLECTOR CURRENT

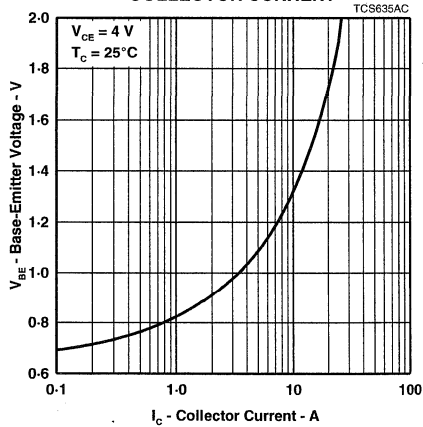
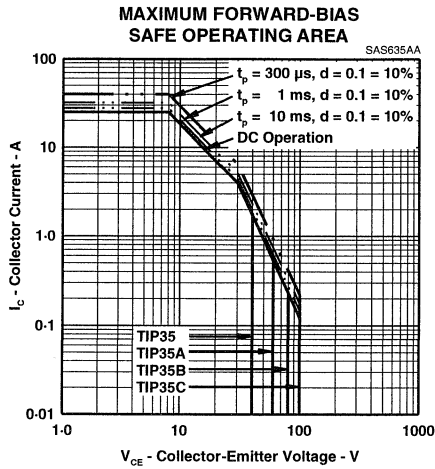


Figure 3.

TIP35, TIP35A, TIP35B, TIP35C
NPN SILICON POWER TRANSISTORS

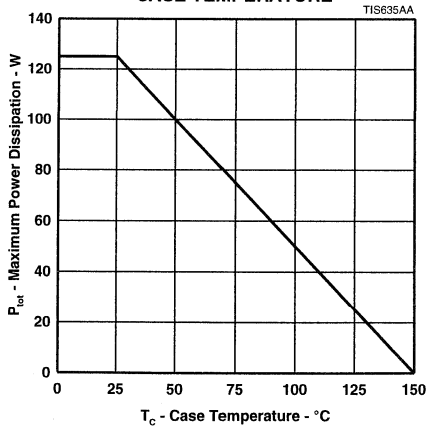
JULY 1968 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS



THERMAL INFORMATION

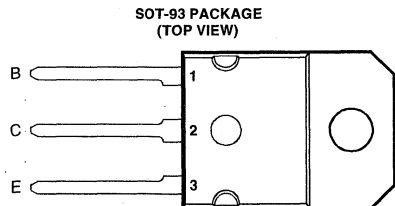
**MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE**



TIP36, TIP36A, TIP36B, TIP36C PNP SILICON POWER TRANSISTORS

JULY 1968 - REVISED MAY 1995

- Designed for Complementary Use with the TIP35 Series
- 125 W at 25°C Case Temperature
- 25 A Continuous Collector Current
- 40 A Peak Collector Current
- Customer-Specified Selections Available



Pin 2 is in electrical contact with the mounting base.

MDTRAA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIP36	V_{CBO}	-80	V
	TIP36A		-100	
	TIP36B		-120	
	TIP36C		-140	
Collector-emitter voltage ($I_B = 0$)	TIP36	V_{CEO}	-40	V
	TIP36A		-60	
	TIP36B		-80	
	TIP36C		-100	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-25	A
Peak collector current (see Note 1)		I_{CM}	-40	A
Continuous base current		I_B	-5	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	125	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	3.5	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	90	mJ
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	250	°C

NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.

2. Derate linearly to 150°C case temperature at the rate of 1 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 28 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = -0.4$ A, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = -20$ V.

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 **TEXAS
INSTRUMENTS**

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TIP36, TIP36A, TIP36B, TIP36C

PNP SILICON POWER TRANSISTORS

JULY 1968 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$ Collector-emitter breakdown voltage	$I_C = -30$ mA (see Note 5)	$I_B = 0$	TIP36 TIP36A TIP36B TIP36C	-40 -60 -80 -100			V
I_{CES} Collector-emitter cut-off current	$V_{CE} = -80$ V $V_{CE} = -100$ V $V_{CE} = -120$ V $V_{CE} = -140$ V	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	TIP36 TIP36A TIP36B TIP36C			-0.7 -0.7 -0.7 -0.7	mA
I_{CEO} Collector cut-off current	$V_{CE} = -30$ V $V_{CE} = -60$ V	$I_B = 0$ $I_B = 0$	TIP36/36A TIP36B/36C			-1 -1	mA
I_{EBO} Emitter cut-off current	$V_{EB} = -5$ V	$I_C = 0$				-1	mA
h_{FE} Forward current transfer ratio	$V_{CE} = -4$ V $V_{CE} = -4$ V	$I_C = -1.5$ A $I_C = -15$ A	(see Notes 5 and 6)	25 10		50	
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = -1.5$ A $I_B = -5$ A	$I_C = -15$ A $I_C = -25$ A	(see Notes 5 and 6)			-1.8 -4	V
V_{BE} Base-emitter voltage	$V_{CE} = -4$ V $V_{CE} = -4$ V	$I_C = -15$ A $I_C = -25$ A	(see Notes 5 and 6)			-2 -4	V
h_{fe} Small signal forward current transfer ratio	$V_{CE} = -10$ V	$I_C = -1$ A	$f = 1$ kHz	25			
$ h_{fe} $ Small signal forward current transfer ratio	$V_{CE} = -10$ V	$I_C = -1$ A	$f = 1$ MHz	3			

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300$ μ s, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1	°C/W
$R_{\theta JA}$ Junction to free air thermal resistance			35.7	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on} Turn-on time	$I_C = -15$ A	$I_{B(on)} = -1.5$ A	$I_{B(off)} = 1.5$ A		1.1		μ s
t_{off} Turn-off time	$V_{BE(off)} = 4.15$ V	$R_L = 2$ Ω	$t_p = 20$ μ s, dc $\leq 2\%$		0.8		μ s

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
vs
COLLECTOR CURRENT

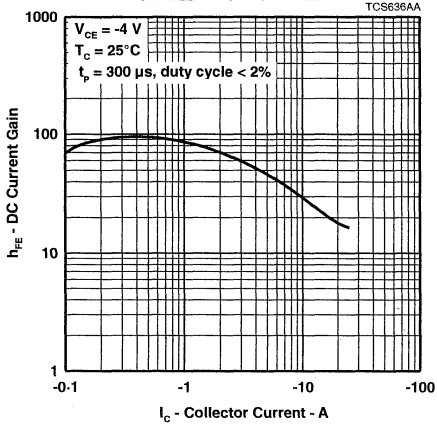


Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE
vs
BASE CURRENT

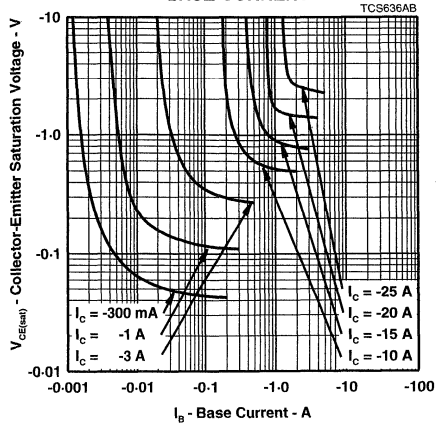


Figure 2.

BASE-EMITTER VOLTAGE
vs
COLLECTOR CURRENT

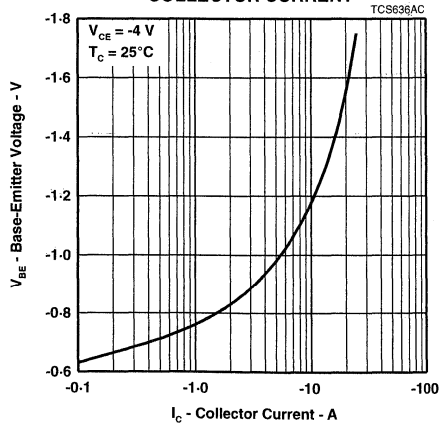


Figure 3.

TIP36, TIP36A, TIP36B, TIP36C
PNP SILICON POWER TRANSISTORS

JULY 1968 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

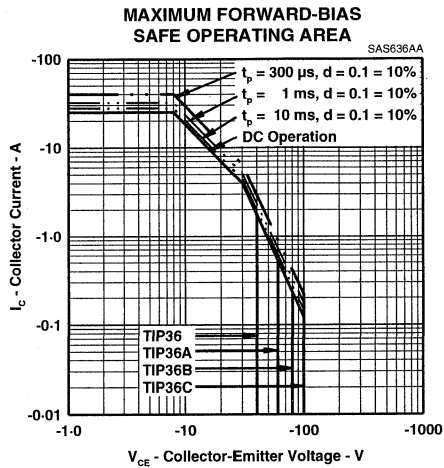


Figure 4.

THERMAL INFORMATION

MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE

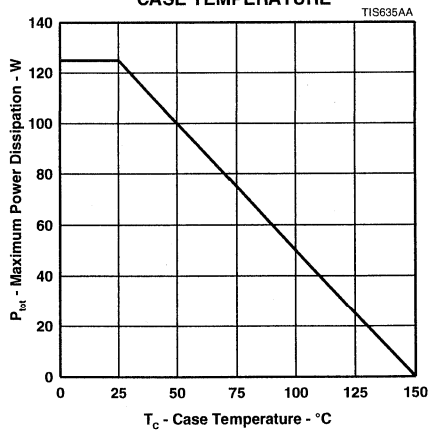
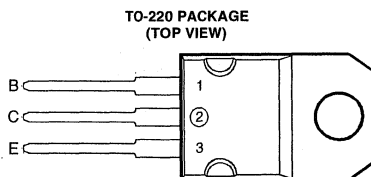


Figure 5.

TIP41, TIP41A, TIP41B, TIP41C NPN SILICON POWER TRANSISTORS

DECEMBER 1970 - REVISED MAY 1995

- Designed for Complementary Use with the TIP42 Series
- 65 W at 25°C Case Temperature
- 6 A Continuous Collector Current
- 10 A Peak Collector Current
- Customer-Specified Selections Available



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIP41	V_{CBO}	80	V
	TIP41A		100	
	TIP41B		120	
	TIP41C		140	
Collector-emitter voltage ($I_B = 0$)	TIP41	V_{CEO}	40	V
	TIP41A		60	
	TIP41B		80	
	TIP41C		100	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	6	A
Peak collector current (see Note 1)		I_{CM}	10	A
Continuous base current		I_B	3	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	65	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	62.5	mJ
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	250	°C

NOTES: 1. This value applies for $t_b \leq 0.3$ ms, duty cycle $\leq 10\%$.

2. Derate linearly to 150°C case temperature at the rate of 0.52 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = 0.4$ A, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = 20$ V.

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 **TEXAS
INSTRUMENTS**

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TIP41, TIP41A, TIP41B, TIP41C

NPN SILICON POWER TRANSISTORS

DECEMBER 1970 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$ (see Note 5)	$I_B = 0$	TIP41	40			V
				TIP41A	60			
				TIP41B	80			
				TIP41C	100			
I_{CES}	Collector-emitter cut-off current	$V_{CE} = 80 \text{ V}$ $V_{CE} = 100 \text{ V}$ $V_{CE} = 120 \text{ V}$ $V_{CE} = 140 \text{ V}$	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	TIP41			0.4	mA
				TIP41A			0.4	
				TIP41B			0.4	
				TIP41C			0.4	
I_{CEO}	Collector cut-off current	$V_{CE} = 30 \text{ V}$ $V_{CE} = 60 \text{ V}$	$I_B = 0$ $I_B = 0$	TIP41/41A			0.7	mA
				TIP41B/41C			0.7	
I_{EBO}	Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$				1	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = 4 \text{ V}$ $V_{CE} = 4 \text{ V}$	$I_C = 0.3 \text{ A}$ $I_C = 3 \text{ A}$	(see Notes 5 and 6)	30			
					15		75	
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = 0.6 \text{ A}$	$I_C = 6 \text{ A}$	(see Notes 5 and 6)			1.5	V
V_{BE}	Base-emitter voltage	$V_{CE} = 4 \text{ V}$	$I_C = 6 \text{ A}$	(see Notes 5 and 6)			2	V
h_{fe}	Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ kHz}$	20			
$ h_{fe} $	Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ MHz}$	3			

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.92	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = 6 \text{ A}$	$I_{B(on)} = 0.6 \text{ A}$	$I_{B(off)} = -0.6 \text{ A}$		0.6		μs
t_{off}	Turn-off time				$V_{BE(off)} = -4 \text{ V}$	$R_L = 5 \Omega$		1

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

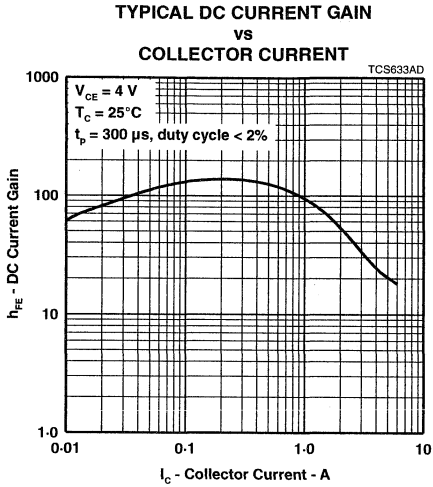


Figure 1.

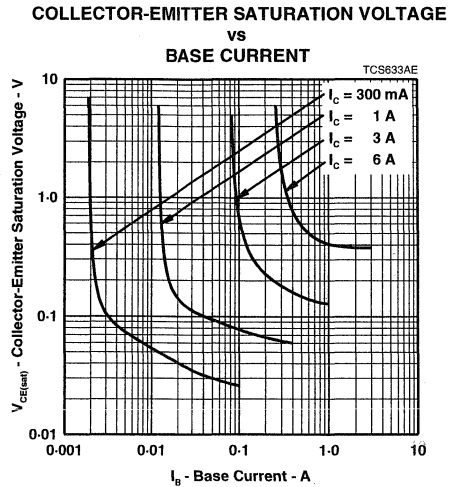


Figure 2.

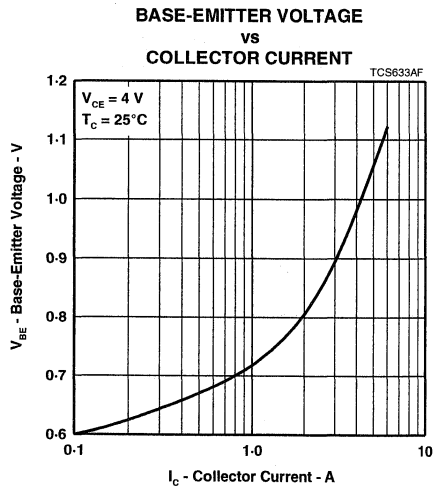
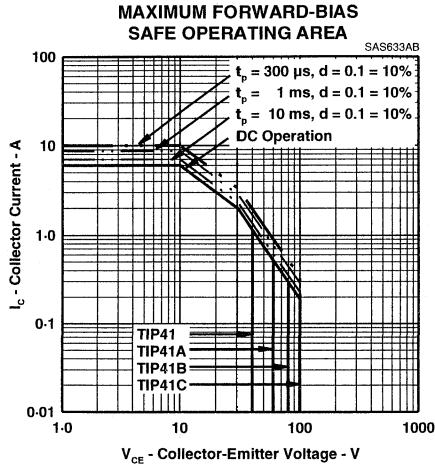


Figure 3.

TIP41, TIP41A, TIP41B, TIP41C
 NPN SILICON POWER TRANSISTORS

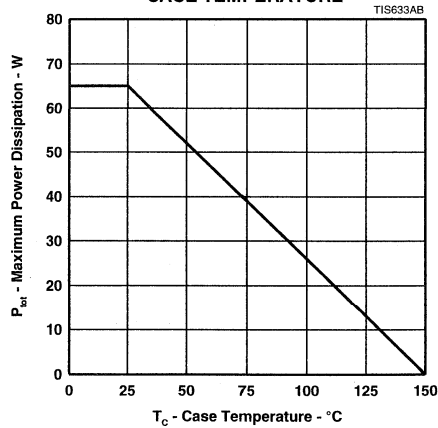
DECEMBER 1970 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS



THERMAL INFORMATION

MAXIMUM POWER DISSIPATION
 vs
 CASE TEMPERATURE

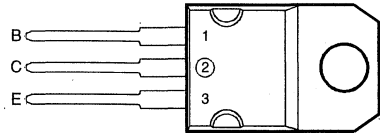


TIP42, TIP42A, TIP42B, TIP42C PNP SILICON POWER TRANSISTORS

DECEMBER 1970 - REVISED MAY 1995

- Designed for Complementary Use with the TIP41 Series
- 65 W at 25°C Case Temperature
- 6 A Continuous Collector Current
- 10 A Peak Collector Current
- Customer-Specified Selections Available

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIP42	V_{CBO}	-80	V
	TIP42A		-100	
	TIP42B		-120	
	TIP42C		-140	
Collector-emitter voltage ($I_B = 0$)	TIP42	V_{CEO}	-40	V
	TIP42A		-60	
	TIP42B		-80	
	TIP42C		-100	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-6	A
Peak collector current (see Note 1)		I_{CM}	-10	A
Continuous base current		I_B	-3	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	65	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	62.5	mJ
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	250	°C

- NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.
 2. Derate linearly to 150°C case temperature at the rate of 0.52 W/°C.
 3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.
 4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(ON)} = -0.4$ A, $R_{BE} = 100 \Omega$, $V_{BE(ON)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = -20$ V.

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TIP42, TIP42A, TIP42B, TIP42C

PNP SILICON POWER TRANSISTORS

DECEMBER 1970 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = -30$ mA (see Note 5)	$I_B = 0$	TIP42 TIP42A TIP42B TIP42C	-40 -60 -80 -100			V
I_{CES}	Collector-emitter cut-off current	$V_{CE} = -80$ V $V_{CE} = -100$ V $V_{CE} = -120$ V $V_{CE} = -140$ V	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	TIP42 TIP42A TIP42B TIP42C			-0.4 -0.4 -0.4 -0.4	mA
I_{CEO}	Collector cut-off current	$V_{CE} = -30$ V $V_{CE} = -60$ V	$I_B = 0$ $I_B = 0$	TIP42/42A TIP42B/42C			-0.7 -0.7	mA
I_{EBO}	Emitter cut-off current	$V_{EB} = -5$ V	$I_C = 0$				-1	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = -4$ V $V_{CE} = -4$ V	$I_C = -0.3$ A $I_C = -3$ A	(see Notes 5 and 6)	30 15		75	
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = -0.6$ A	$I_C = -6$ A	(see Notes 5 and 6)			-1.5	V
V_{BE}	Base-emitter voltage	$V_{CE} = -4$ V	$I_C = -6$ A	(see Notes 5 and 6)			-2	V
h_{fe}	Small signal forward current transfer ratio	$V_{CE} = -10$ V	$I_C = -0.5$ A	$f = 1$ kHz	20			
$ h_{fe} $	Small signal forward current transfer ratio	$V_{CE} = -10$ V	$I_C = -0.5$ A	$f = 1$ MHz	3			

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300$ μ s, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.92	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = -6$ A	$I_{B(on)} = -0.6$ A	$I_{B(off)} = 0.6$ A		0.4		μ s
t_{off}	Turn-off time	$V_{BE(off)} = 4$ V	$R_L = 5$ Ω	$t_p = 20$ μ s, dc $\leq 2\%$		0.7		μ s

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
vs
COLLECTOR CURRENT

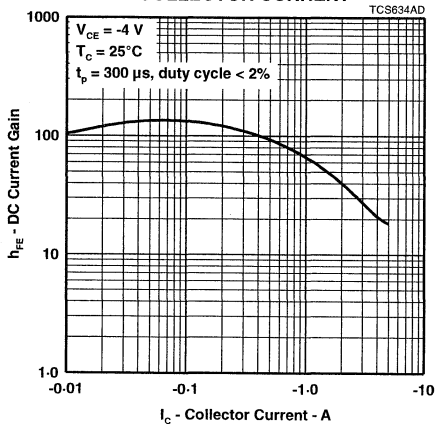


Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE
vs
BASE CURRENT

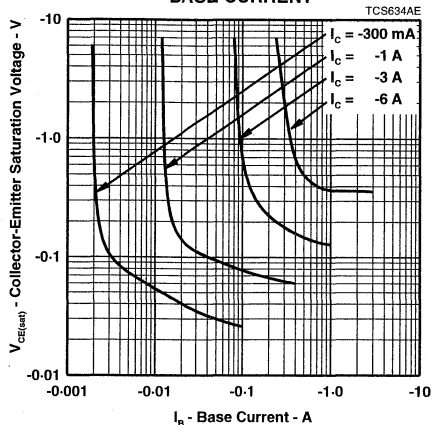


Figure 2.

BASE-EMITTER VOLTAGE
vs
COLLECTOR CURRENT

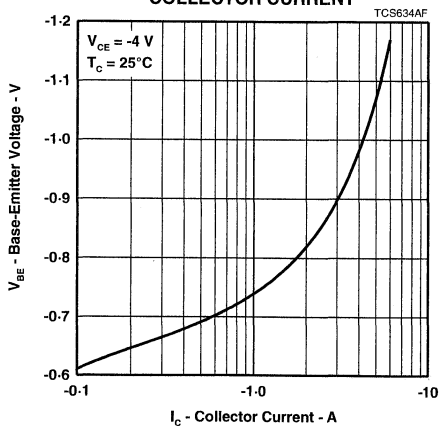


Figure 3.

TIP42, TIP42A, TIP42B, TIP42C
PNP SILICON POWER TRANSISTORS

DECEMBER 1970 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

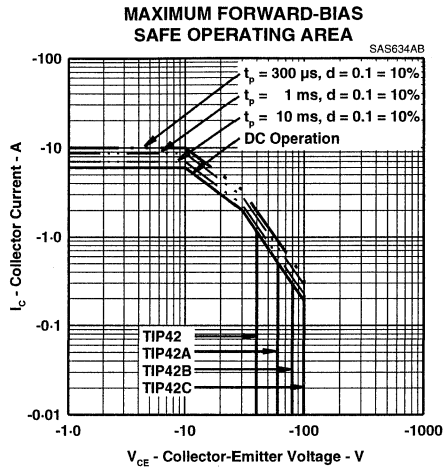


Figure 4.

THERMAL INFORMATION

**MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE**

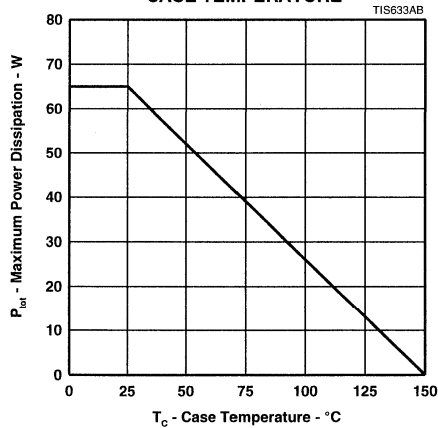
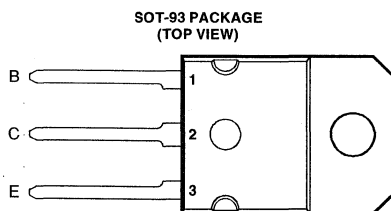


Figure 5.

TIP2955 PNP SILICON POWER TRANSISTOR

JANUARY 1972 - REVISED MAY 1995

- Designed for Complementary Use with the TIP3055 Series
- 90 W at 25°C Case Temperature
- 15 A Continuous Collector Current



Pin 2 is in electrical contact with the mounting base.

MDTRAA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING	SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	V_{CBO}	-100	V
Collector-emitter voltage ($I_B = 0$) (see Note 1)	V_{CER}	-70	V
Emitter-base voltage	V_{EBO}	-7	V
Continuous collector current	I_C	-15	A
Continuous base current	I_B	-7	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)	P_{tot}	90	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)	P_{tot}	3.5	W
Unclamped inductive load energy (see Note 4)	$\frac{1}{2}L I_C^2$	62.5	mJ
Operating junction temperature range	T_j	-65 to +150	°C
Storage temperature range	T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds	T_L	260	°C

- NOTES: 1. This value applies when the base-emitter resistance $R_{BE} = 100 \Omega$.
 2. Derate linearly to 150°C case temperature at the rate of 0.72 W/°C.
 3. Derate linearly to 150°C free air temperature at the rate of 28 mW/°C.
 4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20 \text{ mH}$, $I_{B(on)} = -0.4 \text{ A}$, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = -10 \text{ V}$.

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TIP2955

PNP SILICON POWER TRANSISTOR

JANUARY 1972 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = -30$ mA	$I_B = 0$	(see Note 5)	-60			V
I_{CEO}	Collector cut-off current	$V_{CE} = -30$ V	$I_B = 0$				-0.7	mA
I_{CEV}	Voltage between base and emitter	$V_{CE} = -100$ V	$V_{BE} = 1.5$ V				-5	mA
I_{EBO}	Emitter cut-off current	$V_{EB} = -7$ V	$I_C = 0$				-5	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = -4$ V $V_{CE} = -4$ V	$I_C = -4$ A $I_C = -10$ A	(see Notes 5 and 6)	20 5		70	
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = -0.4$ A $I_B = -3.3$ A	$I_C = -4$ A $I_C = -10$ A	(see Notes 5 and 6)			-1.1 -3	V
V_{BE}	Base-emitter voltage	$V_{CE} = -4$ V	$I_C = -4$ A	(see Notes 5 and 6)			-1.8	V
h_{fe}	Small signal forward current transfer ratio	$V_{CE} = -10$ V	$I_C = -0.5$ A	$f = 1$ kHz	20			
$ h_{fe} $	Small signal forward current transfer ratio	$V_{CE} = -10$ V	$I_C = -0.5$ A	$f = 1$ MHz	3			

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300$ μ s, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.39	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			35.7	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = -6$ A	$I_{B(on)} = -0.6$ A	$I_{B(off)} = 0.6$ A		0.4		μ s
t_{off}	Turn-off time	$V_{BE(off)} = 4$ V	$R_L = 5$ Ω	$t_p = 20$ μ s, dc $\leq 2\%$		0.7		μ s

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
vs
COLLECTOR CURRENT

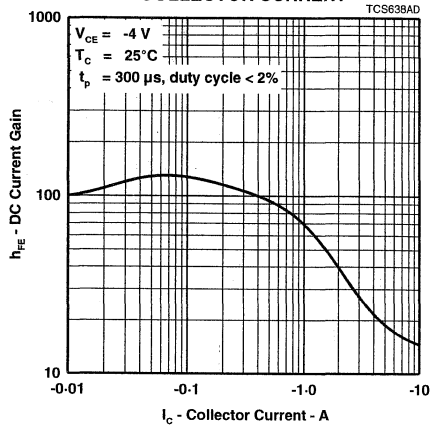


Figure 1.

MAXIMUM SAFE OPERATING REGIONS

MAXIMUM FORWARD-BIAS
SAFE OPERATING AREA

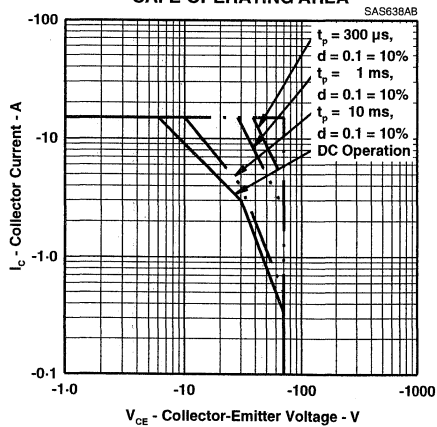


Figure 2.

TIP2955
PNP SILICON POWER TRANSISTOR

JANUARY 1972 - REVISED MAY 1995

THERMAL INFORMATION

MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE

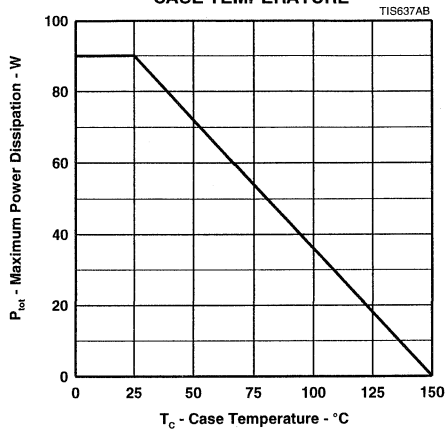


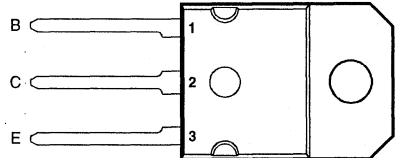
Figure 3.

TIP3055 NPN SILICON POWER TRANSISTOR

DECEMBER 1970 - REVISED MAY 1995

- Designed for Complementary Use with the TIP2955 Series
- 90 W at 25°C Case Temperature
- 15 A Continuous Collector Current

SOT-89 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING	SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	V_{CBO}	100	V
Collector-emitter voltage ($I_B = 0$) (see Note 1)	V_{CER}	70	V
Emitter-base voltage	V_{EBO}	7	V
Continuous collector current	I_C	15	A
Continuous base current	I_B	7	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)	P_{tot}	90	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)	P_{tot}	3.5	W
Unclamped inductive load energy (see Note 4)	$\frac{1}{2}LI_C^2$	62.5	mJ
Operating junction temperature range	T_j	-65 to +150	°C
Storage temperature range	T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds	T_L	260	°C

- NOTES: 1. This value applies when the base-emitter resistance $R_{BE} = 100 \Omega$.
 2. Derate linearly to 150°C case temperature at the rate of 0.72 W/°C.
 3. Derate linearly to 150°C free air temperature at the rate of 28 mW/°C.
 4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = 0.4$ A, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = 10$ V.

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TIP3055

NPN SILICON POWER TRANSISTOR

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electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$	$I_B = 0$	(see Note 5)	60			V
I_{CER}	Collector-emitter cut-off current	$V_{CE} = 70 \text{ V}$	$R_{BE} = 100 \Omega$				1	mA
I_{CEO}	Collector cut-off current	$V_{CE} = 30 \text{ V}$	$I_B = 0$				0.7	mA
I_{CEV}	Voltage between base and emitter	$V_{CE} = 100 \text{ V}$	$V_{BE} = -1.5 \text{ V}$				5	mA
I_{EBO}	Emitter cut-off current	$V_{EB} = 7 \text{ V}$	$I_C = 0$				5	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = 4 \text{ V}$ $V_{CE} = 4 \text{ V}$	$I_C = 4 \text{ A}$ $I_C = 10 \text{ A}$	(see Notes 5 and 6)	20 5		70	
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = 0.4 \text{ A}$ $I_B = 3.3 \text{ A}$	$I_C = 4 \text{ A}$ $I_C = 10 \text{ A}$	(see Notes 5 and 6)			1.1 3	V
V_{BE}	Base-emitter voltage	$V_{CE} = 4 \text{ V}$	$I_C = 4 \text{ A}$	(see Notes 5 and 6)			1.8	V
h_{fe}	Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ kHz}$	15			
$ h_{fe} $	Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ MHz}$	3			

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.39	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			35.7	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = 6 \text{ A}$	$I_{B(on)} = 0.6 \text{ A}$	$I_{B(off)} = -0.6 \text{ A}$		0.6		μs
t_{off}	Turn-off time	$V_{BE(off)} = -4 \text{ V}$	$R_L = 5 \Omega$	$t_p = 20 \mu\text{s}$, dc $\leq 2\%$		1		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
VS
COLLECTOR CURRENT

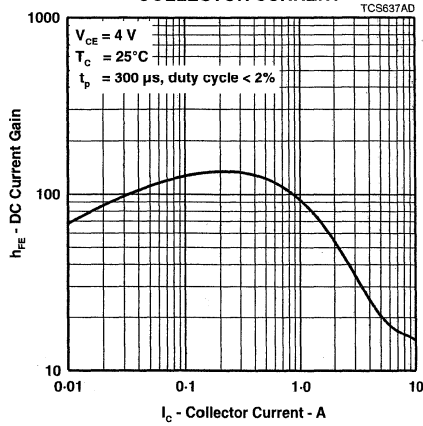


Figure 1.

MAXIMUM SAFE OPERATING REGIONS

MAXIMUM FORWARD-BIAS
SAFE OPERATING AREA

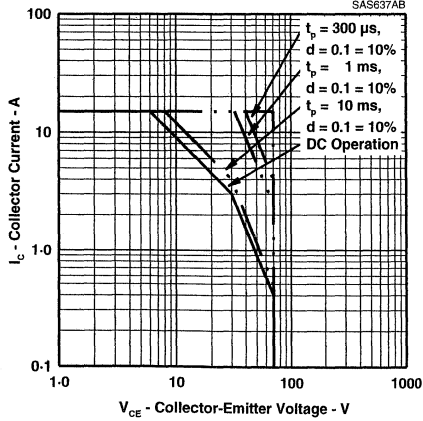


Figure 2.

TIP3055
NPN SILICON POWER TRANSISTOR

DECEMBER 1970 - REVISED MAY 1995

THERMAL INFORMATION

MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE

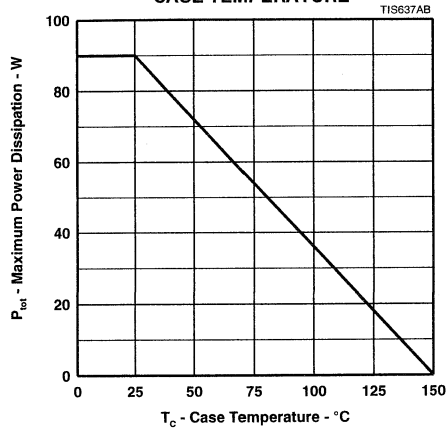


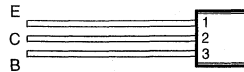
Figure 3.

TIPP31, TIPP31A, TIPP31B, TIPP31C NPN SILICON POWER TRANSISTORS

MAY 1989 - REVISED MAY 1995

- 20 W Pulsed Power Dissipation
- 100 V Capability
- 2 A Continuous Collector Current
- 4 A Peak Collector Current

LP PACKAGE
(TOP VIEW)



MDTRAB

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIPP31	V_{CBO}	40	V
	TIPP31A		60	
	TIPP31B		80	
	TIPP31C		100	
Collector-emitter voltage ($I_B = 0$)	TIPP31	V_{CEO}	40	V
	TIPP31A		60	
	TIPP31B		80	
	TIPP31C		100	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	2	A
Peak collector current (see Note 1)		I_{CM}	4	A
Continuous base current		I_B	1	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	0.8	W
Pulsed power dissipation (see Note 3)		P_T	20	W
Operating junction temperature range		T_J	-55 to +150	°C
Storage temperature range		T_{stg}	-55 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

- NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.
 2. Derate linearly to 150°C case temperature at the rate of 6.4 mW/°C.
 3. $V_{CE} = 20$ V, $I_C = 1$ A, $t_p = 10$ ms, duty cycle $\leq 2\%$.

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TIPP31, TIPP31A, TIPP31B, TIPP31C

NPN SILICON POWER TRANSISTORS

MAY 1989 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = 5 \text{ mA}$ (see Note 4)	$I_B = 0$	TIPP31 TIPP31A TIPP31B TIPP31C	40 60 80 100			V
I_{CES}	Collector-emitter cut-off current	$V_{CE} = 40 \text{ V}$ $V_{CE} = 60 \text{ V}$ $V_{CE} = 80 \text{ V}$ $V_{CE} = 100 \text{ V}$	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	TIPP31 TIPP31A TIPP31B TIPP31C			0.2 0.2 0.2 0.2	mA
I_{CEO}	Collector cut-off current	$V_{CE} = 30 \text{ V}$ $V_{CE} = 60 \text{ V}$	$I_B = 0$ $I_B = 0$	TIPP31/31A TIPP31B/31C			0.3 0.3	mA
I_{EBO}	Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$				1	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = 4 \text{ V}$ $V_{CE} = 4 \text{ V}$	$I_C = 1 \text{ A}$ $I_C = 2 \text{ A}$	(see Notes 4 and 5)	20 10			
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = 375 \text{ mA}$	$I_C = 2 \text{ A}$	(see Notes 4 and 5)			1	V
V_{BE}	Base-emitter voltage	$V_{CE} = 4 \text{ V}$	$I_C = 2 \text{ A}$	(see Notes 4 and 5)			1.5	V
h_{fe}	Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ kHz}$	20			
$ h_{fe} $	Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ MHz}$	3			

NOTES: 4. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

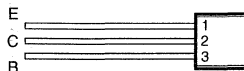
5. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

TIPP32, TIPP32A, TIPP32B, TIPP32C PNP SILICON POWER TRANSISTORS

MAY 1989 - REVISED MAY 1995

- 20 W Pulsed Power Dissipation
- 100 V Capability
- 2 A Continuous Collector Current
- 4 A Peak Collector Current

LP PACKAGE
(TOP VIEW)



MDTRAB

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIPP32	V_{CBO}	-40	V
	TIPP32A		-60	
	TIPP32B		-80	
	TIPP32C		-100	
Collector-emitter voltage ($I_B = 0$)	TIPP32	V_{CEO}	-40	V
	TIPP32A		-60	
	TIPP32B		-80	
	TIPP32C		-100	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-2	A
Peak collector current (see Note 1)		I_{CM}	-4	A
Continuous base current		I_B	-1	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	0.8	W
Pulsed power dissipation (see Note 3)		P_T	20	W
Operating junction temperature range		T_J	-55 to +150	°C
Storage temperature range		T_{stg}	-55 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

- NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.
 2. Derate linearly to 150°C case temperature at the rate of 6.4 mW/°C.
 3. $V_{CE} = 20$ V, $I_C = 1$ A, $t_p = 10$ ms, duty cycle $\leq 2\%$.

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 **TEXAS
INSTRUMENTS**

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TIPP32, TIPP32A, TIPP32B, TIPP32C

PNP SILICON POWER TRANSISTORS

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electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = -5 \text{ mA}$ (see Note 4)	$I_B = 0$	TIPP32	-40			V
				TIPP32A	-60			
				TIPP32B	-80			
				TIPP32C	-100			
I_{CES}	Collector-emitter cut-off current	$V_{CE} = -40 \text{ V}$ $V_{CE} = -60 \text{ V}$ $V_{CE} = -80 \text{ V}$ $V_{CE} = -100 \text{ V}$	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	TIPP32			-0.2	mA
				TIPP32A			-0.2	
				TIPP32B			-0.2	
				TIPP32C			-0.2	
I_{CEO}	Collector cut-off current	$V_{CE} = -30 \text{ V}$ $V_{CE} = -60 \text{ V}$	$I_B = 0$ $I_B = 0$	TIPP32/32A			-0.3	mA
				TIPP32B/32C			-0.3	
I_{EBO}	Emitter cut-off current	$V_{EB} = -5 \text{ V}$	$I_C = 0$				-1	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = -4 \text{ V}$ $V_{CE} = -4 \text{ V}$	$I_C = -1 \text{ A}$ $I_C = -2 \text{ A}$	(see Notes 4 and 5)	20			
					10			
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = -375 \text{ mA}$	$I_C = -2 \text{ A}$	(see Notes 4 and 5)			-1	V
V_{BE}	Base-emitter voltage	$V_{CE} = -4 \text{ V}$	$I_C = -2 \text{ A}$	(see Notes 4 and 5)			-1.5	V
h_{fe}	Small signal forward current transfer ratio	$V_{CE} = -10 \text{ V}$	$I_C = -0.5 \text{ A}$	$f = 1 \text{ kHz}$	20			
$ h_{fe} $	Small signal forward current transfer ratio	$V_{CE} = -10 \text{ V}$	$I_C = -0.5 \text{ A}$	$f = 1 \text{ MHz}$	3			

NOTES: 4. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

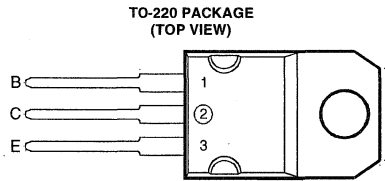
5. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

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BD645, BD647, BD649, BD651 NPN SILICON POWER DARLINGTONS

MAY 1993 - REVISED MAY 1995

- Designed for Complementary Use with BD646, BD648, BD650 and BD652
- 62.5 W at 25°C Case Temperature
- 8 A Continuous Collector Current
- Minimum h_{FE} of 750 at 3 V, 3 A



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BD645	V_{CBO}	80	V
	BD647		100	
	BD649		120	
	BD651		140	
Collector-emitter voltage ($I_B = 0$)	BD645	V_{CEO}	60	V
	BD647		80	
	BD649		100	
	BD651		120	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	8	A
Peak collector current (see Note 1)		I_{CM}	12	A
Continuous base current		I_B	0.3	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	62.5	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	50	mJ
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.

2. Derate linearly to 150°C case temperature at the rate of 0.4 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = 5$ mA, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = 20$ V.

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 **TEXAS
INSTRUMENTS**

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BD645, BD647, BD649, BD651

NPN SILICON POWER DARLINGTONS

MAY 1993 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT	
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$	$I_B = 0$	(see Note 5)	BD645	60		V	
					BD647	80			
					BD649	100			
					BD651	120			
I_{CEO}	Collector-emitter cut-off current				BD645		0.5	mA	
					BD647		0.5		
					BD649		0.5		
					BD651		0.5		
I_{CBO}	Collector cut-off current				BD645		0.2	mA	
					BD647		0.2		
					BD649		0.2		
					BD651		0.2		
					BD645		2.0		
					BD647		2.0		
					BD649		2.0		
					BD651		2.0		
I_{EBO}	Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$	(see Notes 5 and 6)			5	mA	
h_{FE}	Forward current transfer ratio	$V_{CE} = 3 \text{ V}$	$I_C = 3 \text{ A}$	(see Notes 5 and 6)	750				
$V_{CE(sat)}$	Collector-emitter saturation voltage			(see Notes 5 and 6)			2	V	
							2.5		
$V_{BE(sat)}$	Base-emitter saturation voltage	$I_B = 50 \text{ mA}$	$I_C = 5 \text{ A}$	(see Notes 5 and 6)			3	V	
$V_{BE(on)}$	Base-emitter voltage	$V_{CE} = 3 \text{ V}$	$I_C = 3 \text{ A}$	(see Notes 5 and 6)			2.5	V	

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			2.0	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

TYPICAL CHARACTERISTICS

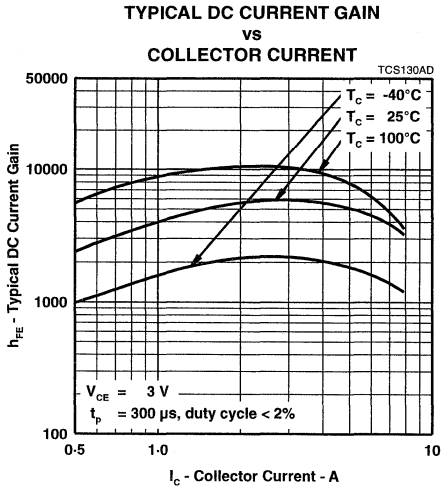


Figure 1.

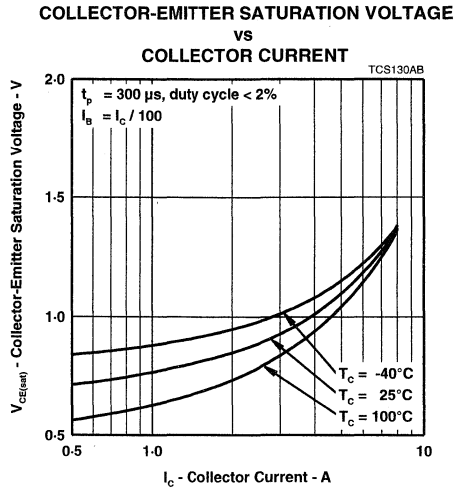


Figure 2.

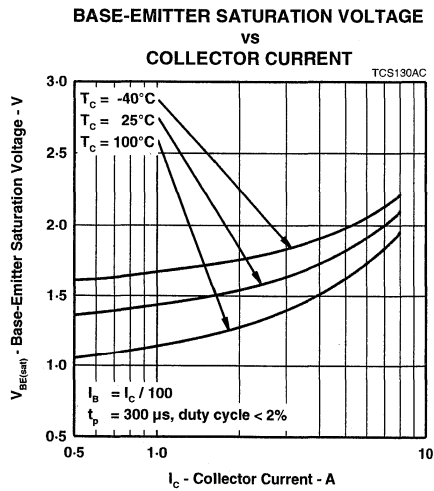


Figure 3.

BD645, BD647, BD649, BD651
NPN SILICON POWER DARLINGTONS

MAY 1993 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

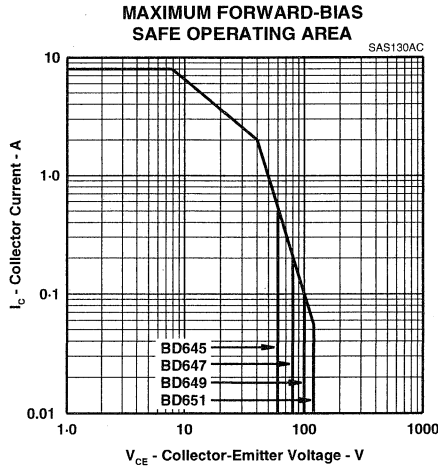


Figure 4.

THERMAL INFORMATION

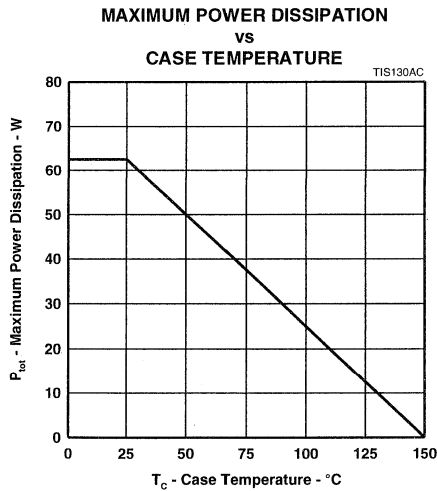


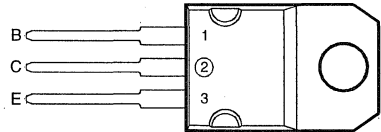
Figure 5.

BD646, BD648, BD650, BD652 PNP SILICON POWER DARLINGTONS

MAY 1993 - REVISED MAY 1995

- Designed for Complementary Use with BD645, BD647, BD649 and BD651
- 62.5 W at 25°C Case Temperature
- 8 A Continuous Collector Current
- Minimum h_{FE} of 750 at 3 V, 3 A

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BD646	V_{CBO}	-80	V
	BD648		-100	
	BD650		-120	
	BD652		-140	
Collector-emitter voltage ($I_B = 0$)	BD646	V_{CEO}	-60	V
	BD648		-80	
	BD650		-100	
	BD652		-120	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-8	A
Peak collector current (see Note 1)		I_{CM}	-12	A
Continuous base current		I_B	-0.3	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	62.5	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	50	mJ
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.

2. Derate linearly to 150°C case temperature at the rate of 0.4 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = -5$ mA, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = -20$ V.

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 **TEXAS
INSTRUMENTS**

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BD646, BD648, BD650, BD652

PNP SILICON POWER DARLINGTONS

MAY 1993 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = -30 \text{ mA}$	$I_B = 0$	(see Note 5)	BD646	-60	V
					BD648	-80	
					BD650	-100	
					BD652	-120	
I_{CEO}	Collector-emitter cut-off current				BD646	-0.5	mA
					BD648	-0.5	
					BD650	-0.5	
					BD652	-0.5	
I_{CBO}	Collector cut-off current				BD646	-0.2	mA
					BD648	-0.2	
					BD650	-0.2	
					BD652	-0.2	
					BD646	-2.0	
					BD648	-2.0	
					BD650	-2.0	
					BD652	-2.0	
		$T_C = 150^\circ\text{C}$	BD650	-2.0			
		$T_C = 150^\circ\text{C}$	BD652	-2.0			
I_{EBO}	Emitter cut-off current	$V_{EB} = -5 \text{ V}$	$I_C = 0$	(see Notes 5 and 6)		-5	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = -3 \text{ V}$	$I_C = -3 \text{ A}$	(see Notes 5 and 6)	750		
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = -12 \text{ mA}$	$I_C = -3 \text{ A}$	(see Notes 5 and 6)		-2	V
						$I_B = -50 \text{ mA}$	
$V_{BE(sat)}$	Base-emitter saturation voltage	$I_B = -50 \text{ mA}$	$I_C = -5 \text{ A}$	(see Notes 5 and 6)		-3	V
$V_{BE(on)}$	Base-emitter voltage	$V_{CE} = -3 \text{ V}$	$I_C = -3 \text{ A}$	(see Notes 5 and 6)		-2.5	V

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			2.0	$^\circ\text{C/W}$
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	$^\circ\text{C/W}$

TYPICAL CHARACTERISTICS

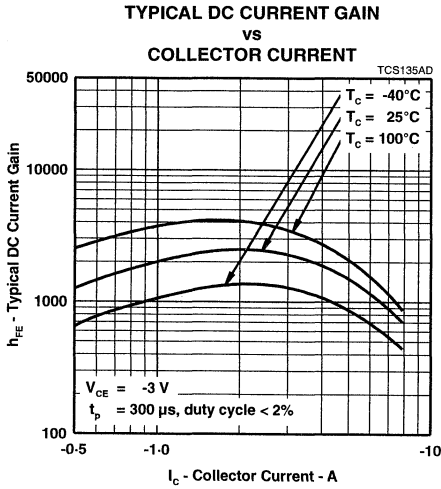


Figure 1.

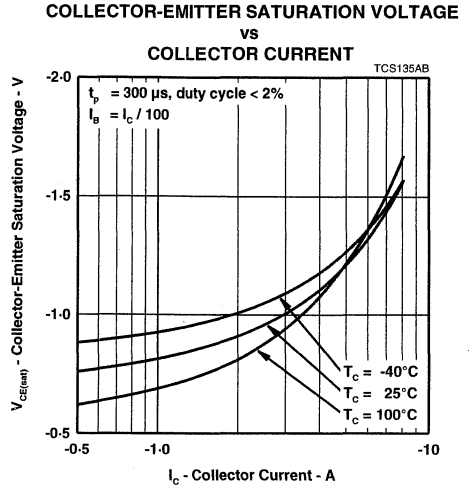


Figure 2.

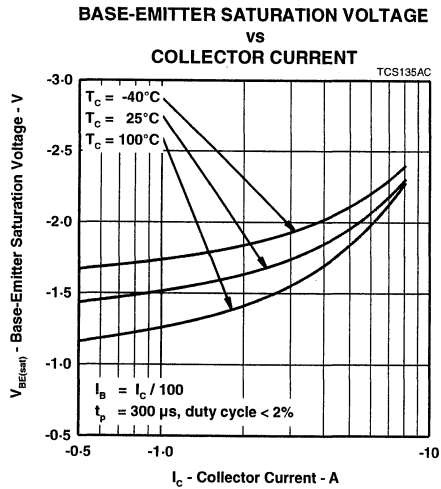


Figure 3.

BD646, BD648, BD650, BD652
PNP SILICON POWER DARLINGTONS

MAY 1993 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

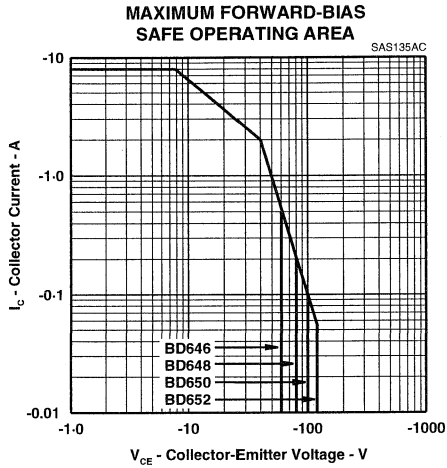


Figure 4.

THERMAL INFORMATION

**MAXIMUM POWER DISSIPATION
VS
CASE TEMPERATURE**

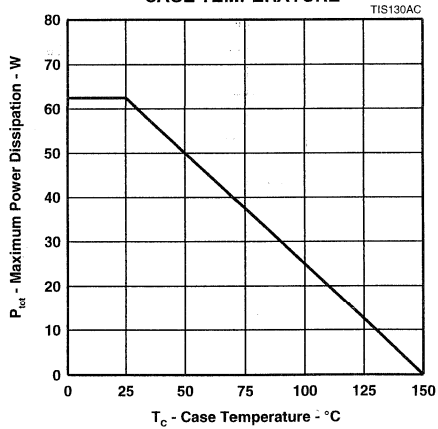
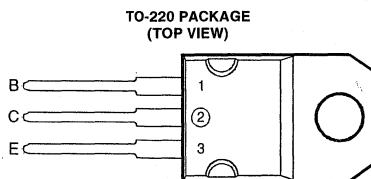


Figure 5.

BD895, BD897, BD899, BD901 NPN SILICON POWER DARLINGTONS

AUGUST 1993 - REVISED MAY 1995

- Designed for Complementary Use with BD896, BD898, BD900 and BD902
- 70 W at 25°C Case Temperature
- 8 A Continuous Collector Current
- Minimum h_{FE} of 750 at 3V, 3A



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BD895	V_{CBO}	45	V
	BD897		60	
	BD899		80	
	BD901		100	
Collector-emitter voltage ($I_B = 0$)	BD895	V_{CEO}	45	V
	BD897		60	
	BD899		80	
	BD901		100	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	8	A
Continuous base current		I_B	0.3	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 1)		P_{tot}	70	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 2)		P_{tot}	2	W
Operating free-air temperature range		T_A	-65 to +150	°C
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C

NOTES: 1. Derate linearly to 150°C case temperature at the rate of 0.56 W/°C.
 2. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

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BD895, BD897, BD899, BD901

NPN SILICON POWER DARLINGTONS

AUGUST 1993 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = 100 \text{ mA}$	$I_B = 0$	(see Note 3)	BD895	45		V
					BD897	60		
					BD899	80		
					BD901	100		
I_{CEO}	Collector-emitter cut-off current				BD895		0.5	mA
					BD897		0.5	
					BD899		0.5	
					BD901		0.5	
I_{CBO}	Collector cut-off current				BD895		0.2	mA
					BD897		0.2	
					BD899		0.2	
					BD901		0.2	
					BD895		2	
					BD897		2	
					BD899		2	
					BD901		2	
I_{EBO}	Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$	(see Notes 3 and 4)			2	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = 3 \text{ V}$	$I_C = 3 \text{ A}$	(see Notes 3 and 4)	750			
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = 12 \text{ mA}$	$I_C = 3 \text{ A}$	(see Notes 3 and 4)			2.5	V
$V_{BE(on)}$	Base-emitter voltage	$V_{CE} = 3 \text{ V}$	$I_C = 3 \text{ A}$	(see Notes 3 and 4)			2.5	V
V_{EC}	Parallel diode forward voltage	$I_E = 8 \text{ A}$	$I_B = 0$				3.5	V

NOTES: 3. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.79	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = 3 \text{ A}$	$I_{B(on)} = 12 \text{ mA}$	$I_{B(off)} = -12 \text{ mA}$		1		μs
t_{off}	Turn-off time	$V_{BE(off)} = -3.5 \text{ V}$	$R_L = 10 \Omega$	$t_p = 20 \mu\text{s}$, $d_c \leq 2\%$		5		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

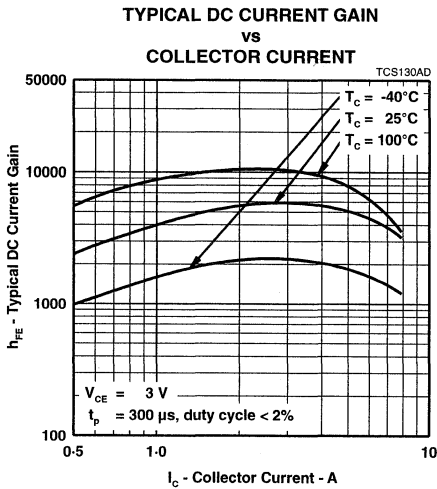


Figure 1.

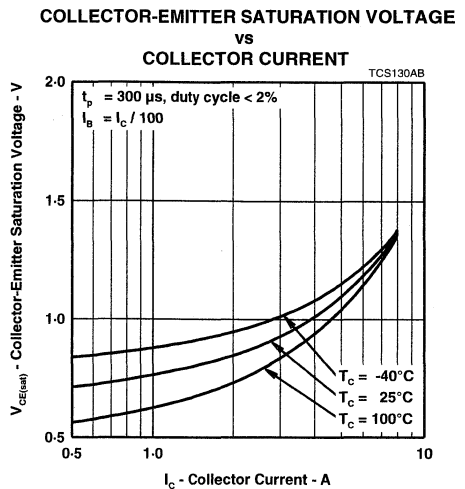


Figure 2.

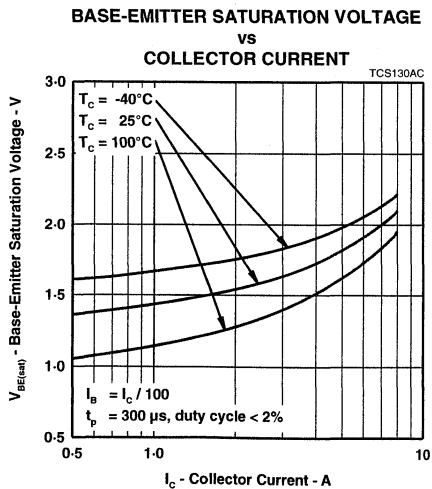


Figure 3.

BD895, BD897, BD899, BD901 NPN SILICON POWER DARLINGTONS

AUGUST 1993 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

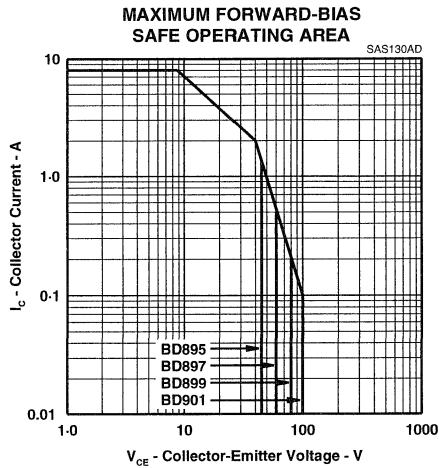


Figure 4.

THERMAL INFORMATION

MAXIMUM POWER DISSIPATION vs CASE TEMPERATURE

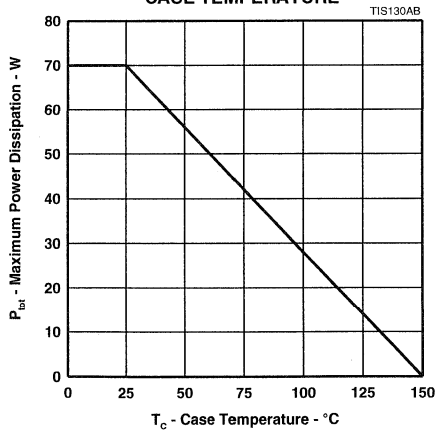
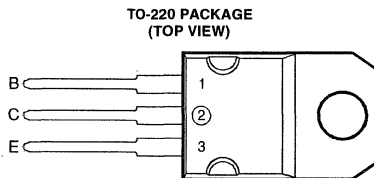


Figure 5.

BD895A, BD897A, BD899A NPN SILICON POWER DARLINGTONS

AUGUST 1993 - REVISED MAY 1995

- Designed for Complementary Use with BD896A, BD898A and BD900A
- 70 W at 25°C Case Temperature
- 8 A Continuous Collector Current
- Minimum h_{FE} of 750 at 3V, 3A



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BD895A	V_{CBO}	45	V
	BD897A		60	
	BD899A		80	
Collector-emitter voltage ($I_B = 0$)	BD895A	V_{CEO}	45	V
	BD897A		60	
	BD899A		80	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	8	A
Continuous base current		I_B	0.3	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 1)		P_{tot}	70	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 2)		P_{tot}	2	W
Operating free-air temperature range		T_A	-65 to +150	°C
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C

- NOTES: 1. Derate linearly to 150°C case temperature at the rate of 0.56 W/°C.
2. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

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BD895A, BD897A, BD899A

NPN SILICON POWER DARLINGTONS

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electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$ Collector-emitter breakdown voltage	$I_C = 100 \text{ mA}$ $I_B = 0$ (see Note 3)	BD895A 45 BD897A 60 BD899A 80			V
I_{CEO} Collector-emitter cut-off current	$V_{CE} = 30 \text{ V}$ $I_B = 0$ $V_{CE} = 30 \text{ V}$ $I_B = 0$ $V_{CE} = 40 \text{ V}$ $I_B = 0$	BD895A BD895A BD897A BD899A		0.5 0.5 0.5	mA
I_{CBO} Collector cut-off current	$V_{CB} = 45 \text{ V}$ $I_E = 0$ $V_{CB} = 60 \text{ V}$ $I_E = 0$ $V_{CB} = 80 \text{ V}$ $I_E = 0$ $V_{CB} = 45 \text{ V}$ $I_E = 0$ $V_{CB} = 60 \text{ V}$ $I_E = 0$ $V_{CB} = 80 \text{ V}$ $I_E = 0$	BD895A BD897A BD899A BD895A BD897A BD899A		0.2 0.2 0.2 2 2 2	mA
I_{EBO} Emitter cut-off current	$V_{EB} = 5 \text{ V}$ $I_C = 0$ (see Notes 3 and 4)			2	mA
h_{FE} Forward current transfer ratio	$V_{CE} = 3 \text{ V}$ $I_C = 4 \text{ A}$ (see Notes 3 and 4)	750			
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 16 \text{ mA}$ $I_C = 4 \text{ A}$ (see Notes 3 and 4)			2.8	V
$V_{BE(on)}$ Base-emitter voltage	$V_{CE} = 3 \text{ V}$ $I_C = 4 \text{ A}$ (see Notes 3 and 4)			2.5	V
V_{EC} Parallel diode forward voltage	$I_E = 8 \text{ A}$ $I_B = 0$			3.5	V

NOTES: 3. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1.79	°C/W
$R_{\theta JA}$ Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †	MIN	TYP	MAX	UNIT
t_{on} Turn-on time	$I_C = 3 \text{ A}$ $I_{B(on)} = 12 \text{ mA}$ $I_{B(off)} = -12 \text{ mA}$		1		μs
t_{off} Turn-off time	$V_{BE(off)} = -3.5 \text{ V}$ $R_L = 10 \Omega$ $t_p = 20 \mu\text{s}$, dc $\leq 2\%$		5		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

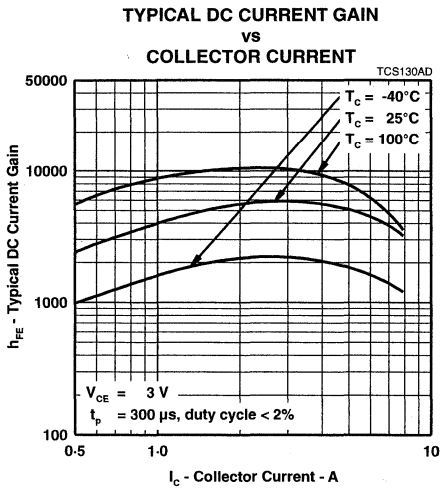


Figure 1.

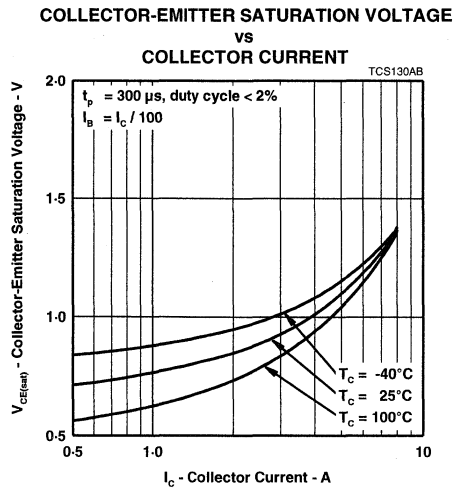


Figure 2.

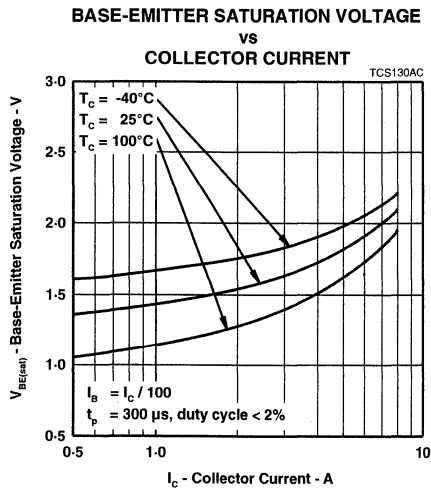


Figure 3.

BD895A, BD897A, BD899A NPN SILICON POWER DARLINGTONS

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MAXIMUM SAFE OPERATING REGIONS

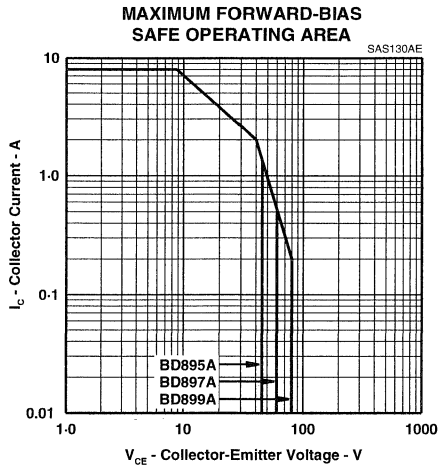


Figure 4.

THERMAL INFORMATION

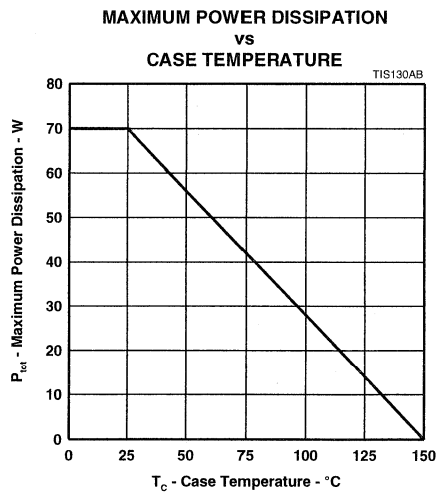


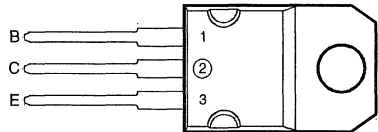
Figure 5.

BD896, BD898, BD900, BD902 PNP SILICON POWER DARLINGTONS

AUGUST 1993 - REVISED MAY 1995

- Designed for Complementary Use with BD895, BD897, BD899 and BD901
- 70 W at 25°C Case Temperature
- 8 A Continuous Collector Current
- Minimum h_{FE} of 750 at 3V, 3A

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BD896	V_{CBO}	-45	V
	BD898		-60	
	BD900		-80	
	BD902		-100	
Collector-emitter voltage ($I_B = 0$)	BD896	V_{CEO}	-45	V
	BD898		-60	
	BD900		-80	
	BD902		-100	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-8	A
Continuous base current		I_B	-0.3	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 1)		P_{tot}	70	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 2)		P_{tot}	2	W
Operating free-air temperature range		T_A	-65 to +150	°C
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C

NOTES: 1. Derate linearly to 150°C case temperature at the rate of 0.56 W/°C.
2. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

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BD896, BD898, BD900, BD902

PNP SILICON POWER DARLINGTONS

AUGUST 1993 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = -100 \text{ mA}$	$I_B = 0$	(see Note 3)	BD896	-45		V
					BD898	-60		
					BD900	-80		
					BD902	-100		
I_{CEO}	Collector-emitter cut-off current	$V_{CE} = -30 \text{ V}$	$I_B = 0$		BD896		-0.5	mA
					BD898		-0.5	
					BD900		-0.5	
					BD902		-0.5	
I_{CBO}	Collector cut-off current	$V_{CB} = -45 \text{ V}$	$I_E = 0$		BD896		-0.2	mA
					BD898		-0.2	
					BD900		-0.2	
					BD902		-0.2	
					BD896		-2	
					BD898		-2	
					BD900		-2	
					BD902		-2	
I_{EBO}	Emitter cut-off current	$V_{EB} = -5 \text{ V}$	$I_C = 0$	(see Notes 3 and 4)			-2	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = -3 \text{ V}$	$I_C = -3 \text{ A}$	(see Notes 3 and 4)	750			
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = -12 \text{ mA}$	$I_C = -3 \text{ A}$	(see Notes 3 and 4)			-2.5	V
$V_{BE(on)}$	Base-emitter voltage	$V_{CE} = -3 \text{ V}$	$I_C = -3 \text{ A}$	(see Notes 3 and 4)			-2.5	V
V_{EC}	Parallel diode forward voltage	$I_E = -8 \text{ A}$	$I_B = 0$				-3.5	V

NOTES: 3. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.79	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = -3 \text{ A}$	$I_{B(on)} = -12 \text{ mA}$	$I_{B(off)} = 12 \text{ mA}$		1		μs
t_{off}	Turn-off time	$V_{BE(off)} = 3.5 \text{ V}$	$R_L = 10 \Omega$	$t_p = 20 \mu\text{s}$, $dc \leq 2\%$		5		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
vs
COLLECTOR CURRENT

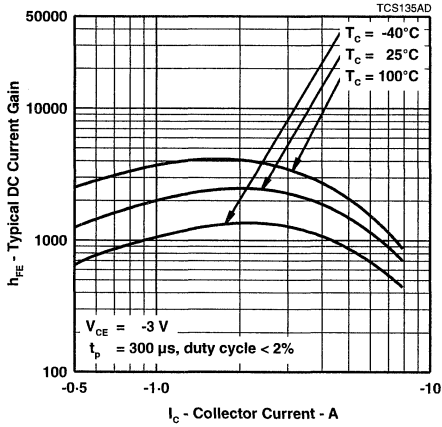


Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE
vs
COLLECTOR CURRENT

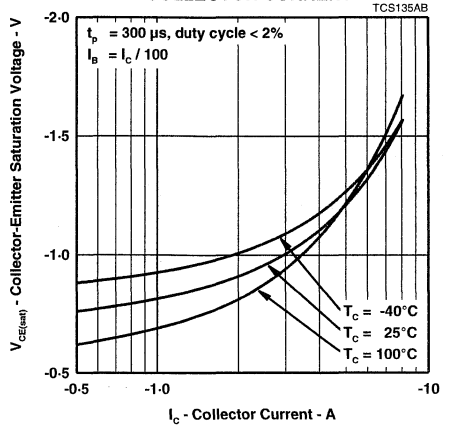


Figure 2.

BASE-EMITTER SATURATION VOLTAGE
vs
COLLECTOR CURRENT

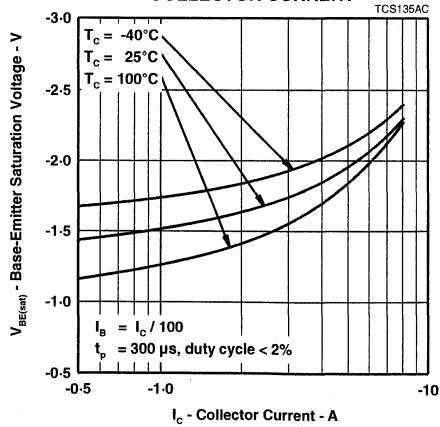


Figure 3.

BD896, BD898, BD900, BD902 PNP SILICON POWER DARLINGTONS

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MAXIMUM SAFE OPERATING REGIONS

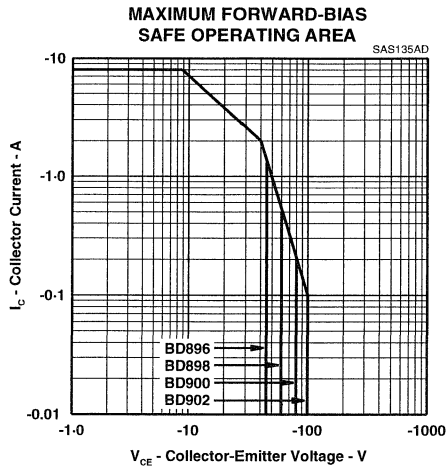


Figure 4.

THERMAL INFORMATION

MAXIMUM POWER DISSIPATION vs CASE TEMPERATURE

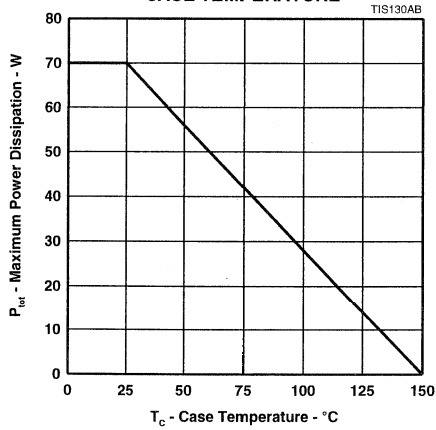


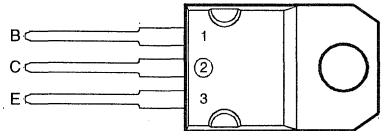
Figure 5.

BD896A, BD898A, BD900A PNP SILICON POWER DARLINGTONS

AUGUST 1993 - REVISED MAY 1995

- Designed for Complementary Use with BD895A, BD897A and BD899A
- 70 W at 25°C Case Temperature
- 8 A Continuous Collector Current
- Minimum h_{FE} of 750 at 3V, 3A

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BD896A	V_{CBO}	-45	V
	BD898A		-60	
	BD900A		-80	
Collector-emitter voltage ($I_B = 0$)	BD896A	V_{CEO}	-45	V
	BD898A		-60	
	BD900A		-80	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-8	A
Continuous base current		I_B	-0.3	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 1)		P_{tot}	70	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 2)		P_{tot}	2	W
Operating free-air temperature range		T_A	-65 to +150	°C
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C

- NOTES: 1. Derate linearly to 150°C case temperature at the rate of 0.56 W/°C.
2. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

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BD896A, BD898A, BD900A

PNP SILICON POWER DARLINGTONS

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electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT	
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = -100 \text{ mA}$	$I_B = 0$	(see Note 3)	BD896A	-45		V	
					BD898A	-60			
					BD900A	-80			
I_{CEO}	Collector-emitter cut-off current	$V_{CE} = -30 \text{ V}$	$I_B = 0$		BD896A		-0.5	mA	
					BD898A		-0.5		
					BD900A		-0.5		
I_{CBO}	Collector cut-off current	$V_{CB} = -45 \text{ V}$	$I_E = 0$		BD896A		-0.2	mA	
					BD898A		-0.2		
					BD900A		-0.2		
					$T_C = 100^\circ\text{C}$	BD896A			-2
					$T_C = 100^\circ\text{C}$	BD898A			-2
					$T_C = 100^\circ\text{C}$	BD900A			-2
I_{EBO}	Emitter cut-off current	$V_{EB} = -5 \text{ V}$	$I_C = 0$	(see Notes 3 and 4)			-2	mA	
h_{FE}	Forward current transfer ratio	$V_{CE} = -3 \text{ V}$	$I_C = -4 \text{ A}$	(see Notes 3 and 4)		750			
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = -16 \text{ mA}$	$I_C = -4 \text{ A}$	(see Notes 3 and 4)			-2.8	V	
$V_{BE(on)}$	Base-emitter voltage	$V_{CE} = -3 \text{ V}$	$I_C = -4 \text{ A}$	(see Notes 3 and 4)			-2.5	V	
V_{EC}	Parallel diode forward voltage	$I_E = -8 \text{ A}$	$I_B = 0$				-3.5	V	

NOTES: 3. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.79	$^\circ\text{C/W}$
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	$^\circ\text{C/W}$

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = -3 \text{ A}$	$I_{B(on)} = -12 \text{ mA}$	$I_{B(off)} = 12 \text{ mA}$		1		μs
t_{off}	Turn-off time		$V_{BE(off)} = 3.5 \text{ V}$	$R_L = 10 \Omega$	$t_p = 20 \mu\text{s}$, dc $\leq 2\%$		5	

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

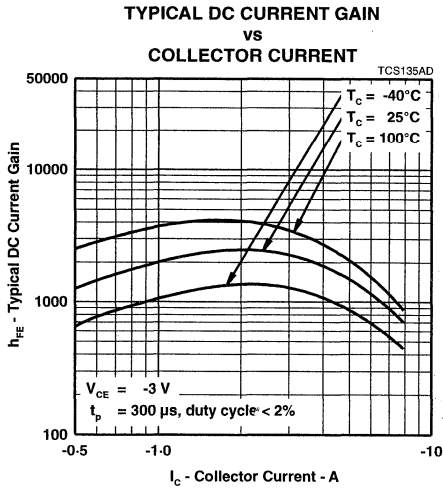


Figure 1.

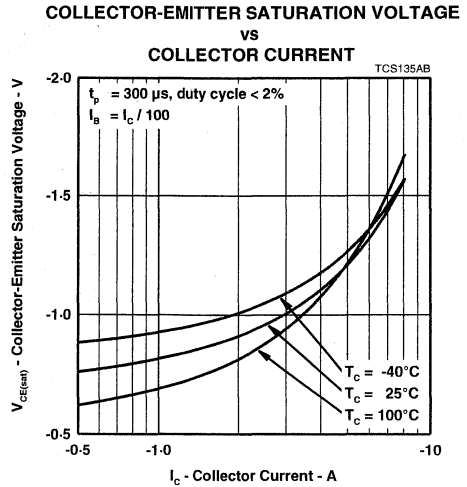


Figure 2.

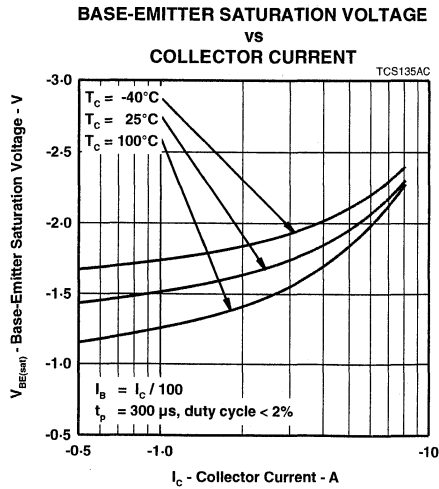


Figure 3.

BD896A, BD898A, BD900A PNP SILICON POWER DARLINGTONS

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MAXIMUM SAFE OPERATING REGIONS

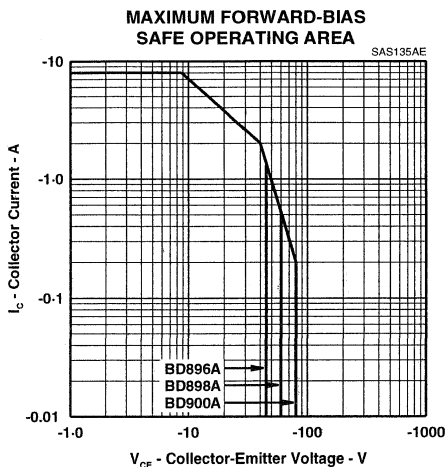


Figure 4.

THERMAL INFORMATION

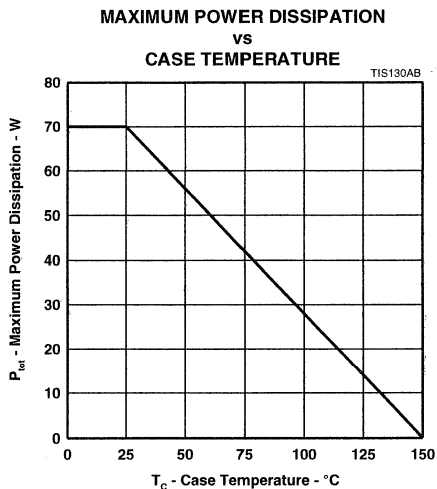
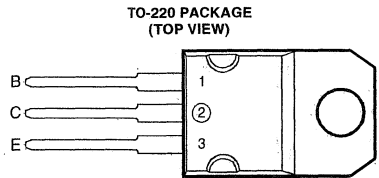


Figure 5.

BDT60, BDT60A, BDT60B, BDT60C PNP SILICON POWER DARLINGTONS

AUGUST 1993 - REVISED MAY 1995

- Designed for Complementary Use with BDT61, BDT61A, BDT61B and BDT61C
- 50 W at 25°C Case Temperature
- 4 A Continuous Collector Current
- Minimum h_{FE} of 750 at 1.5 V, 3 A



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BDT60	V_{CBO}	-60	V
	BDT60A		-80	
	BDT60B		-100	
	BDT60C		-120	
Collector-emitter voltage ($I_B = 0$)	BDT60	V_{CEO}	-60	V
	BDT60A		-80	
	BDT60B		-100	
	BDT60C		-120	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-4	A
Continuous base current		I_B	-0.1	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 1)		P_{tot}	50	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 2)		P_{tot}	2	W
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Operating free-air temperature range		T_A	-65 to +150	°C

NOTES: 1. Derate linearly to 150°C case temperature at the rate of 0.4 W/°C.

2. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

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BDT60, BDT60A, BDT60B, BDT60C

PNP SILICON POWER DARLINGTONS

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electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = -30 \text{ mA}$	$I_B = 0$	(see Note 3)	BDT60			
					BDT60A	-60		
					BDT60B	-80		
					BDT60C	-100		
I_{CEO}	Collector-emitter cut-off current	$V_{CE} = -30 \text{ V}$	$I_B = 0$	BDT60			-0.5	
				BDT60A			-0.5	
				BDT60B			-0.5	
				BDT60C			-0.5	
I_{CBO}	Collector cut-off current	$V_{CB} = -60 \text{ V}$	$I_E = 0$	BDT60			-0.2	
				BDT60A			-0.2	
				BDT60B			-0.2	
				BDT60C			-0.2	
				BDT60		$T_C = 150^\circ\text{C}$	-2.0	
				BDT60A		$T_C = 150^\circ\text{C}$	-2.0	
				BDT60B		$T_C = 150^\circ\text{C}$	-2.0	
				BDT60C		$T_C = 150^\circ\text{C}$	-2.0	
I_{EBO}	Emitter cut-off current	$V_{EB} = -5 \text{ V}$	$I_C = 0$				-5	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = -3 \text{ V}$	$I_C = -1.5 \text{ A}$	(see Notes 3 and 4)	750			
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = -6 \text{ mA}$	$I_C = -1.5 \text{ A}$	(see Notes 3 and 4)			-2.5	V
$V_{BE(on)}$	Base-emitter voltage	$V_{CE} = -3 \text{ V}$	$I_C = -1.5 \text{ A}$	(see Notes 3 and 4)			-2.5	V
V_{EC}	Parallel diode forward voltage	$I_E = -1.5 \text{ A}$	$I_B = 0$				-2.0	V

NOTES: 3. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			2.5	$^\circ\text{C/W}$
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	$^\circ\text{C/W}$

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = -2 \text{ A}$	$I_{B(on)} = -8 \text{ mA}$	$I_{B(off)} = 8 \text{ mA}$		1		μs
t_{off}	Turn-off time	$V_{BE(off)} = 5 \text{ V}$	$R_L = 20 \Omega$	$t_p = 20 \mu\text{s}$, $d_c \leq 2\%$		4.5		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

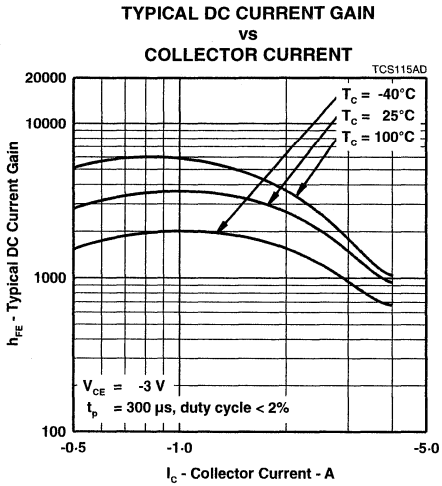


Figure 1.

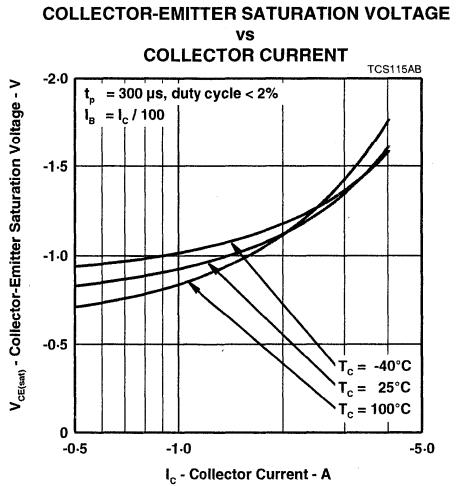


Figure 2.

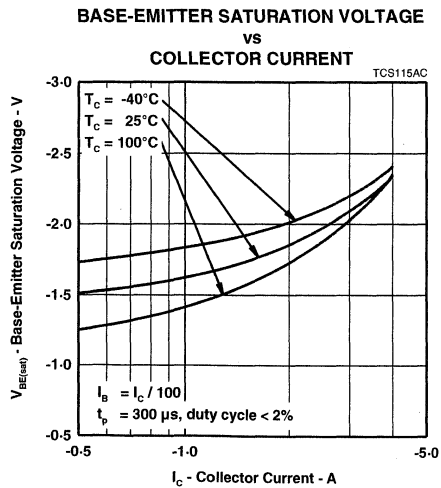


Figure 3.

BDT60, BDT60A, BDT60B, BDT60C
PNP SILICON POWER DARLINGTONS

AUGUST 1993 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

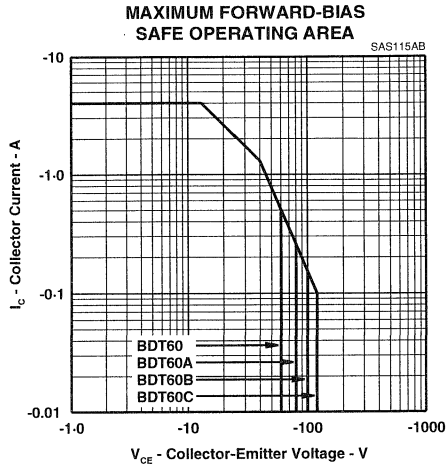


Figure 4.

THERMAL INFORMATION

**MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE**

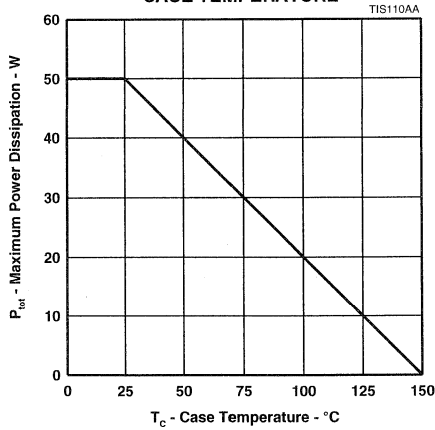
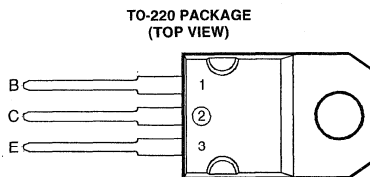


Figure 5.

BDT61, BDT61A, BDT61B, BDT61C NPN SILICON POWER DARLINGTONS

AUGUST 1993 - REVISED MAY 1995

- Designed for Complementary Use with BDT60, BDT60A, BDT60B and BDT60C
- 50 W at 25°C Case Temperature
- 4 A Continuous Collector Current
- Minimum h_{FE} of 750 at 1.5 V, 3 A



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BDT61	V_{CBO}	60	V
	BDT61A		80	
	BDT61B		100	
	BDT61C		120	
Collector-emitter voltage ($I_B = 0$)	BDT61	V_{CEO}	60	V
	BDT61A		80	
	BDT61B		100	
	BDT61C		120	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	4	A
Continuous base current		I_B	0.1	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 1)		P_{tot}	50	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 2)		P_{tot}	2	W
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Operating free-air temperature range		T_A	-65 to +150	°C

- NOTES: 1. Derate linearly to 150°C case temperature at the rate of 0.4 W/°C.
2. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

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BDT61, BDT61A, BDT61B, BDT61C

NPN SILICON POWER DARLINGTONS

AUGUST 1993 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT	
$V_{(BR)CEO}$ Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$ $I_B = 0$	(see Note 3)	BDT61	60			V	
			BDT61A	80				
			BDT61B	100				
			BDT61C	120				
I_{CEO} Collector-emitter cut-off current	$V_{CE} = 30 \text{ V}$ $I_B = 0$		BDT61			0.5	mA	
			BDT61A			0.5		
			BDT61B			0.5		
			BDT61C			0.5		
I_{CBO} Collector cut-off current	$V_{CB} = 60 \text{ V}$ $I_E = 0$		BDT61			0.2	mA	
			BDT61A			0.2		
			BDT61B			0.2		
			BDT61C			0.2		
			$T_C = 150^\circ\text{C}$	BDT61				2.0
				BDT61A				2.0
				BDT61B				2.0
				BDT61C				2.0
I_{EBO} Emitter cut-off current	$V_{EB} = 5 \text{ V}$ $I_C = 0$				5		mA	
h_{FE} Forward current transfer ratio	$V_{CE} = 3 \text{ V}$ $I_C = 1.5 \text{ A}$	(see Notes 3 and 4)	750					
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 6 \text{ mA}$ $I_C = 1.5 \text{ A}$	(see Notes 3 and 4)			2.5		V	
$V_{BE(on)}$ Base-emitter voltage	$V_{CE} = 3 \text{ V}$ $I_C = 1.5 \text{ A}$	(see Notes 3 and 4)			2.5		V	
V_{EC} Parallel diode forward voltage	$I_E = 1.5 \text{ A}$ $I_B = 0$				2		V	

NOTES: 3. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			2.5	$^\circ\text{C/W}$
$R_{\theta JA}$ Junction to free air thermal resistance			62.5	$^\circ\text{C/W}$

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on} Turn-on time	$I_C = 2 \text{ A}$	$I_{B(on)} = 8 \text{ mA}$	$I_{B(off)} = -8 \text{ mA}$		1		μs
t_{off} Turn-off time	$V_{BE(off)} = -5 \text{ V}$	$R_L = 20 \Omega$	$t_p = 20 \mu\text{s}$, $d_c \leq 2\%$		4.5		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
vs
COLLECTOR CURRENT

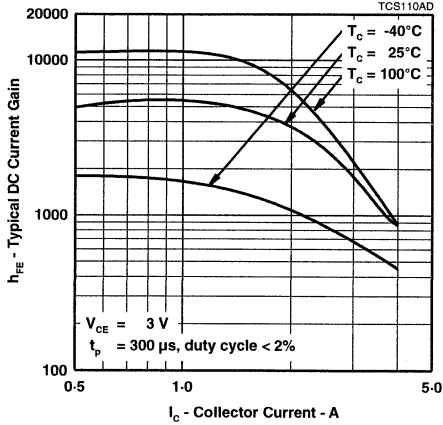


Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE
vs
COLLECTOR CURRENT

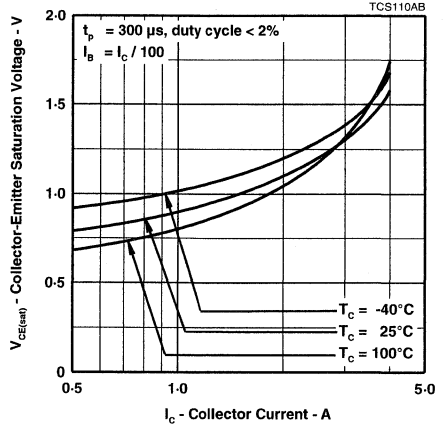


Figure 2.

BASE-EMITTER SATURATION VOLTAGE
vs
COLLECTOR CURRENT

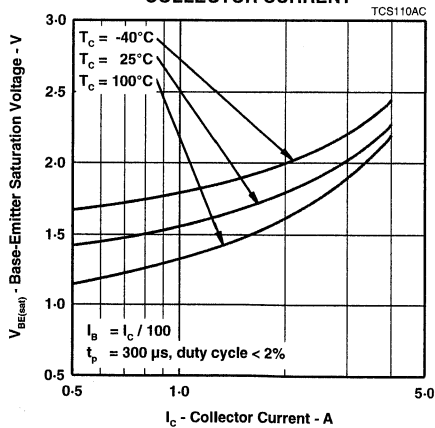


Figure 3.

BDT61, BDT61A, BDT61B, BDT61C NPN SILICON POWER DARLINGTONS

AUGUST 1993 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

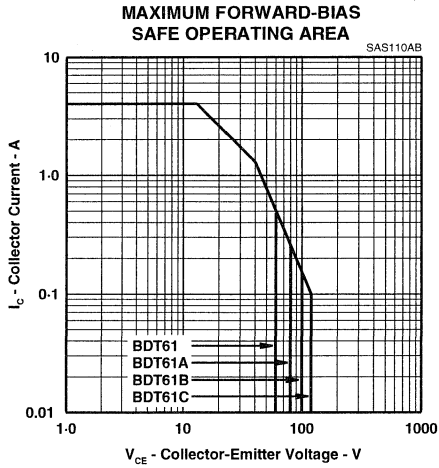


Figure 4.

THERMAL INFORMATION

MAXIMUM POWER DISSIPATION vs CASE TEMPERATURE

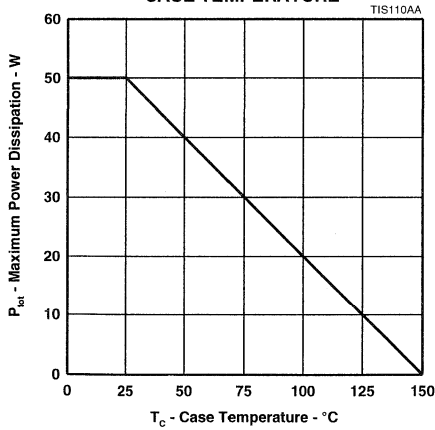
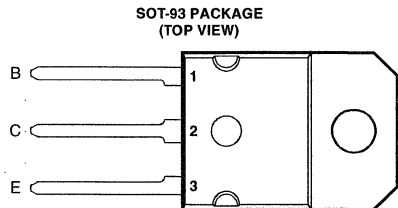


Figure 5.

BDV64, BDV64A, BDV64B, BDV64C PNP SILICON POWER DARLINGTONS

JUNE 1993 - REVISED MAY 1995

- Designed for Complementary Use with BDV65, BDV65A, BDV65B and BDV65C
- 125 W at 25°C Case Temperature
- 12 A Continuous Collector Current
- Minimum h_{FE} of 1000 at 4 V, 5 A



Pin 2 is in electrical contact with the mounting base.

MDTRAA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BDV64	V_{CBO}	-60	V
	BDV64A		-80	
	BDV64B		-100	
	BDV64C		-120	
Collector-emitter voltage ($I_B = 0$)	BDV64	V_{CEO}	-60	V
	BDV64A		-80	
	BDV64B		-100	
	BDV64C		-120	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-12	A
Peak collector current (see Note 1)		I_{CM}	-15	A
Continuous base current		I_B	-0.5	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	125	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	3.5	W
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

- NOTES: 1. This value applies for $t_p \leq 0.1$ ms, duty cycle $\leq 10\%$
 2. Derate linearly to 150°C case temperature at the rate of 0.56 W/°C.
 3. Derate linearly to 150°C free air temperature at the rate of 28 mW/°C.

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BDV64, BDV64A, BDV64B, BDV64C

PNP SILICON POWER DARLINGTONS

JUNE 1993 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$ Collector-emitter breakdown voltage	$I_C = -30 \text{ mA}$	$I_B = 0$	(see Note 4)	BDV64 BDV64A BDV64B BDV64C	-60 -80 -100 -120		V
I_{CEO} Collector-emitter cut-off current	$V_{CB} = -30 \text{ V}$ $V_{CB} = -40 \text{ V}$ $V_{CB} = -50 \text{ V}$ $V_{CB} = -60 \text{ V}$	$I_B = 0$ $I_B = 0$ $I_B = 0$ $I_B = 0$		BDV64 BDV64A BDV64B BDV64C		-2 -2 -2 -2	mA
I_{CBO} Collector cut-off current	$V_{CB} = -60 \text{ V}$ $V_{CB} = -80 \text{ V}$ $V_{CB} = -100 \text{ V}$ $V_{CB} = -120 \text{ V}$ $V_{CB} = -30 \text{ V}$ $V_{CB} = -40 \text{ V}$ $V_{CB} = -50 \text{ V}$ $V_{CB} = -60 \text{ V}$	$I_E = 0$ $I_E = 0$ $I_E = 0$ $I_E = 0$ $I_E = 0$ $I_E = 0$ $I_E = 0$ $I_E = 0$	$T_C = 150^\circ\text{C}$ $T_C = 150^\circ\text{C}$ $T_C = 150^\circ\text{C}$ $T_C = 150^\circ\text{C}$	BDV64 BDV64A BDV64B BDV64C BDV64 BDV64A BDV64B BDV64C		-0.4 -0.4 -0.4 -0.4 -2 -2 -2 -2	mA
I_{EBO} Emitter cut-off current	$V_{EB} = -5 \text{ V}$	$I_C = 0$				-5	mA
η_{FE} Forward current transfer ratio	$V_{CE} = -4 \text{ V}$	$I_C = -5 \text{ A}$	(see Notes 4 and 5)		1000		
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = -20 \text{ mA}$	$I_C = -5 \text{ A}$	(see Notes 4 and 5)			-2	V
V_{BE} Base-emitter voltage	$V_{CE} = -4 \text{ V}$	$I_C = -5 \text{ A}$	(see Notes 4 and 5)			-2.5	V
V_{EC} Parallel diode forward voltage	$I_E = -10 \text{ A}$	$I_B = 0$	(see Notes 4 and 5)			-3.5	V

NOTES: 4. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

5. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1	$^\circ\text{C/W}$
$R_{\theta JA}$ Junction to free air thermal resistance			35.7	$^\circ\text{C/W}$

TYPICAL CHARACTERISTICS

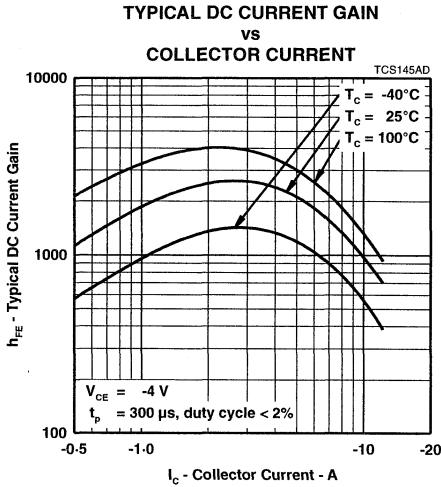


Figure 1.

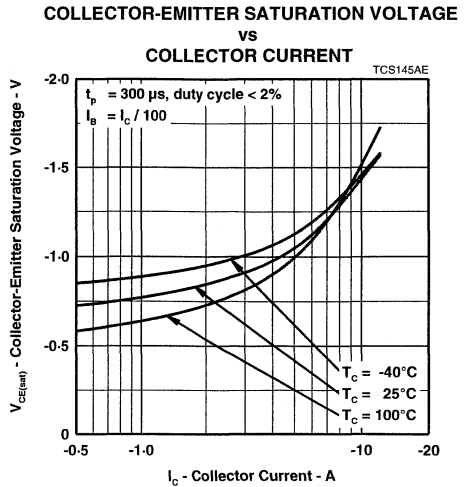


Figure 2.

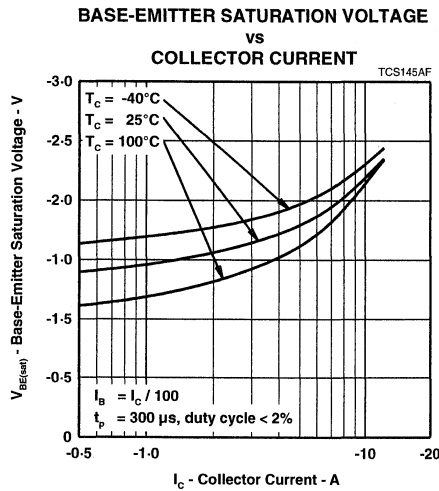


Figure 3.

BDV64, BDV64A, BDV64B, BDV64C
PNP SILICON POWER DARLINGTONS

JUNE 1993 - REVISED MAY 1995

THERMAL INFORMATION

MAXIMUM POWER DISSIPATION
VS
CASE TEMPERATURE

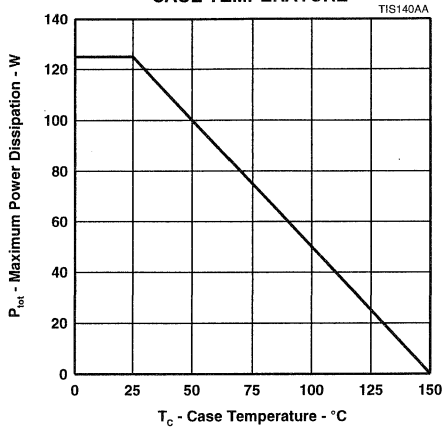
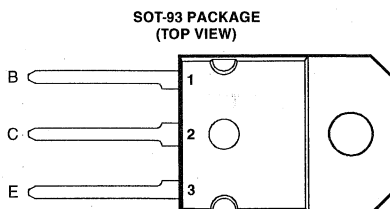


Figure 4.

BDV65, BDV65A, BDV65B, BDV65C NPN SILICON POWER DARLINGTONS

JUNE 1993 - REVISED MAY 1995

- Designed for Complementary Use with BDV64, BDV64A, BDV64B and BDV64C
- 125 W at 25°C Case Temperature
- 12 A Continuous Collector Current
- Minimum h_{FE} of 1000 at 4 V, 5 A



Pin 2 is in electrical contact with the mounting base.

MDTRAA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BDV65	V_{CBO}	60	V
	BDV65A		80	
	BDV65B		100	
	BDV65C		120	
Collector-emitter voltage ($I_B = 0$)	BDV65	V_{CEO}	60	V
	BDV65A		80	
	BDV65B		100	
	BDV65C		120	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	12	A
Peak collector current (see Note 1)		I_{CM}	15	A
Continuous base current		I_B	0.5	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	125	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	3.5	W
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

- NOTES: 1. This value applies for $t_b \leq 0.1$ ms, duty cycle $\leq 10\%$
 2. Derate linearly to 150°C case temperature at the rate of 0.56 W/°C.
 3. Derate linearly to 150°C free air temperature at the rate of 28 mW/°C.

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BDV65, BDV65A, BDV65B, BDV65C

NPN SILICON POWER DARLINGTONS

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electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$	$I_B = 0$	(see Note 4)	BDV65			V
					BDV65A	60		
					BDV65B	80		
					BDV65C	100		
I_{CEO}	Collector-emitter cut-off current	$V_{CB} = 30 \text{ V}$	$I_B = 0$		BDV65		2	mA
					BDV65A		2	
					BDV65B		2	
					BDV65C		2	
I_{CBO}	Collector cut-off current	$V_{CB} = 60 \text{ V}$	$I_E = 0$		BDV65		0.4	mA
					BDV65A		0.4	
					BDV65B		0.4	
					BDV65C		0.4	
					BDV65		2	
					BDV65A	$T_C = 150^\circ\text{C}$	2	
					BDV65B	$T_C = 150^\circ\text{C}$	2	
					BDV65C	$T_C = 150^\circ\text{C}$	2	
I_{EBO}	Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$				5	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = 4 \text{ V}$	$I_C = 5 \text{ A}$	(see Notes 4 and 5)	1000			
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = 20 \text{ mA}$	$I_C = 5 \text{ A}$	(see Notes 4 and 5)			2	V
V_{BE}	Base-emitter voltage	$V_{CE} = 4 \text{ V}$	$I_C = 5 \text{ A}$	(see Notes 4 and 5)			2.5	V
V_{EC}	Parallel diode forward voltage	$I_E = 10 \text{ A}$	$I_B = 0$	(see Notes 4 and 5)			3.5	V

NOTES: 4. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

5. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1	$^\circ\text{C/W}$
$R_{\theta JA}$	Junction to free air thermal resistance			35.7	$^\circ\text{C/W}$

TYPICAL CHARACTERISTICS

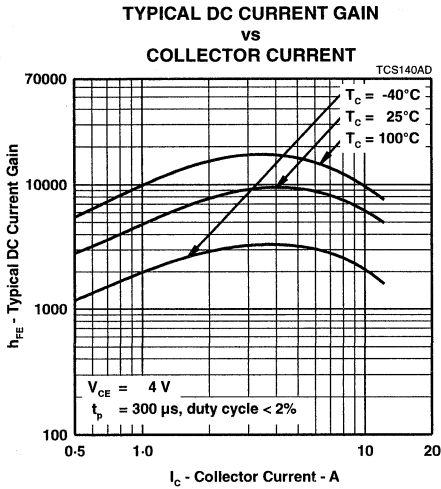


Figure 1.

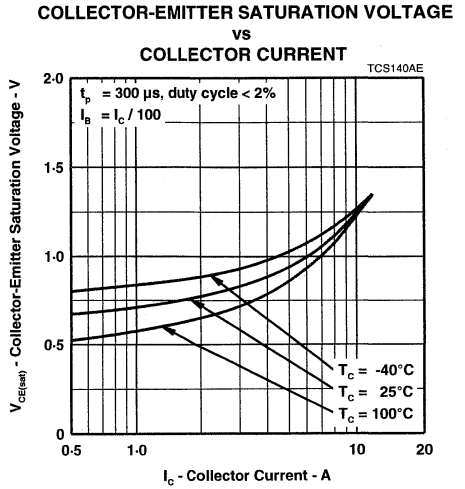


Figure 2.

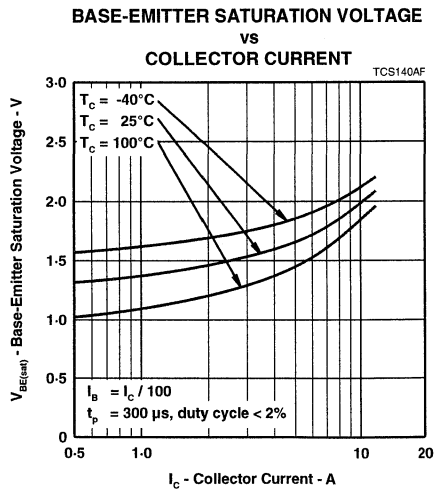


Figure 3.

BDV65, BDV65A, BDV65B, BDV65C
NPN SILICON POWER DARLINGTONS

JUNE 1993 - REVISED MAY 1995

THERMAL INFORMATION

MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE

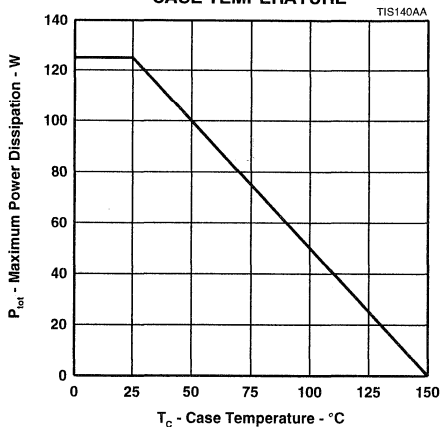
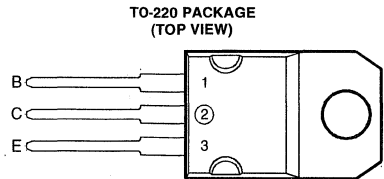


Figure 4.

BDW23, BDW23A, BDW23B, BDW23C NPN SILICON POWER DARLINGTONS

AUGUST 1993 - REVISED MAY 1995

- Designed for Complementary Use with BDW24, BDW24A, BDW24B and BDW24C
- 50 W at 25°C Case Temperature
- 6 A Continuous Collector Current
- Minimum h_{FE} of 750 at 3 V, 2 A



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BDW23	V_{CBO}	45	V
	BDW23A		60	
	BDW23B		80	
	BDW23C		100	
Collector-emitter voltage ($I_B = 0$)	BDW23	V_{CEO}	45	V
	BDW23A		60	
	BDW23B		80	
	BDW23C		100	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	6	A
Continuous base current		I_B	0.2	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 1)		P_{tot}	50	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 2)		P_{tot}	2	W
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Operating free-air temperature range		T_A	-65 to +150	°C

- NOTES: 1. Derate linearly to 150°C case temperature at the rate of 0.4 W/°C.
2. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

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BDW23, BDW23A, BDW23B, BDW23C

NPN SILICON POWER DARLINGTONS

AUGUST 1993 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = 100 \text{ mA}$	$I_B = 0$	(see Note 3)	BDW23	45		V
					BDW23A	60		
					BDW23B	80		
					BDW23C	100		
I_{CEO}	Collector-emitter cut-off current	$V_{CE} = 30 \text{ V}$	$I_B = 0$		BDW23		0.5	mA
					BDW23A		0.5	
					BDW23B		0.5	
					BDW23C		0.5	
I_{CBO}	Collector cut-off current	$V_{CB} = 45 \text{ V}$	$I_E = 0$		BDW23		0.2	mA
					BDW23A		0.2	
					BDW23B		0.2	
					BDW23C		0.2	
I_{EBO}	Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$			2	mA	
h_{FE}	Forward current transfer ratio	$V_{CE} = 3 \text{ V}$	$I_C = 1 \text{ A}$	(see Notes 3 and 4)	1000		20000	
		$V_{CE} = 3 \text{ V}$	$I_C = 2 \text{ A}$		750			
		$V_{CE} = 3 \text{ V}$	$I_C = 6 \text{ A}$		100			
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = 8 \text{ mA}$	$I_C = 2 \text{ A}$	(see Notes 3 and 4)		2	V	
		$I_B = 60 \text{ mA}$	$I_C = 6 \text{ A}$		3			
$V_{BE(sat)}$	Base-emitter saturation voltage	$I_B = 8 \text{ mA}$	$I_C = 2 \text{ A}$	(see Notes 3 and 4)		2.5		
$V_{BE(on)}$	Base-emitter voltage	$V_{CE} = 3 \text{ V}$	$I_C = 1 \text{ A}$	(see Notes 3 and 4)		2.5	V	
		$V_{CE} = 3 \text{ V}$	$I_C = 6 \text{ A}$		3			
V_{EC}	Parallel diode forward voltage	$I_E = 2 \text{ A}$	$I_B = 0$			1.8	V	

NOTES: 3. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			2.5	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = 3 \text{ A}$	$I_{B(on)} = 12 \text{ mA}$		1		μs
t_{off}	Turn-off time	$V_{BE(off)} = -4.5 \text{ V}$	$R_L = 10 \Omega$		5		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
vs
COLLECTOR CURRENT

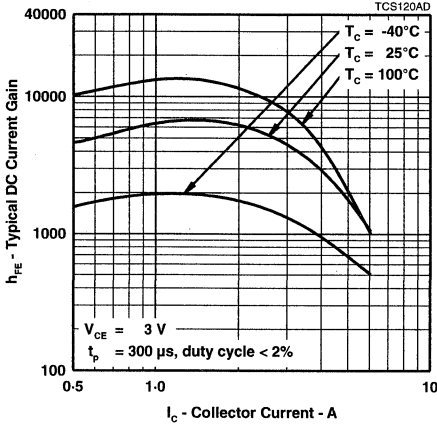


Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE
vs
COLLECTOR CURRENT

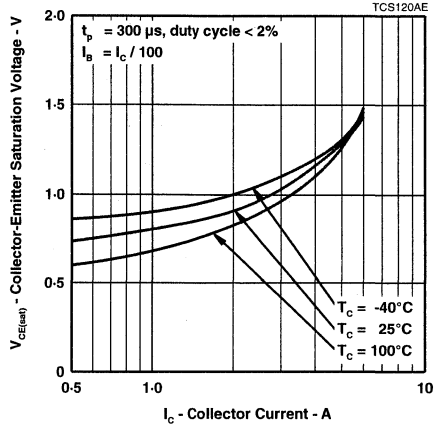


Figure 2.

BASE-EMITTER SATURATION VOLTAGE
vs
COLLECTOR CURRENT

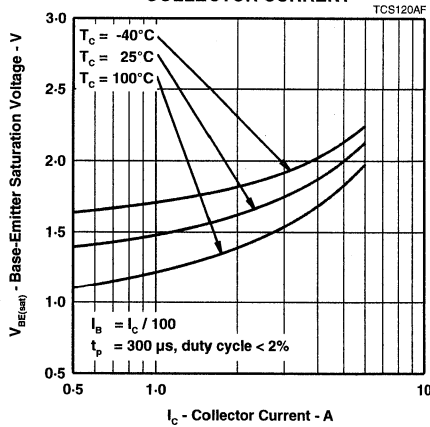


Figure 3.

**BDW23, BDW23A, BDW23B, BDW23C
NPN SILICON POWER DARLINGTONS**

AUGUST 1993 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

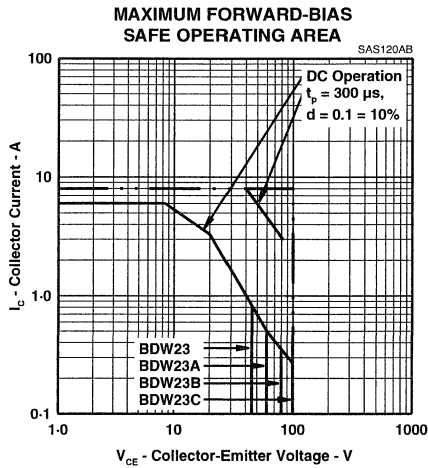


Figure 4.

THERMAL INFORMATION

**MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE**

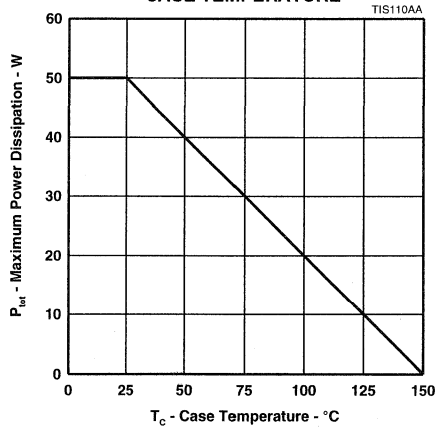
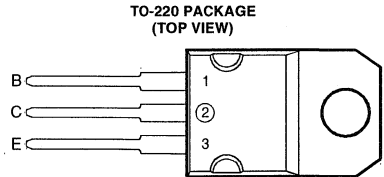


Figure 5.

BDW24, BDW24A, BDW24B, BDW24C PNP SILICON POWER DARLINGTONS

MAY 1989 - REVISED MAY 1995

- Designed for Complementary Use with BDW23, BDW23A, BDW23B and BDW23C
- 50 W at 25°C Case Temperature
- 6 A Continuous Collector Current
- Minimum h_{FE} of 750 at 2 A, 3 V



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BDW24	V_{CBO}	-45	V
	BDW24A		-60	
	BDW24B		-80	
	BDW24C		-100	
Collector-emitter voltage ($I_B = 0$)	BDW24	V_{CEO}	-45	V
	BDW24A		-60	
	BDW24B		-80	
	BDW24C		-100	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-6	A
Continuous base current		I_B	-0.2	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 1)		P_{tot}	50	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 2)		P_{tot}	2	W
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Operating free-air temperature range		T_A	-65 to +150	°C

- NOTES: 1. Derate linearly to 150°C case temperature at the rate of 0.4 W/°C.
2. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

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BDW24, BDW24A, BDW24B, BDW24C PNP SILICON POWER DARLINGTONS

MAY 1989 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT	
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = -100 \text{ mA}$	$I_B = 0$	(see Note 3)	BDW24			-45	
					BDW24A			-60	
					BDW24B			-80	
					BDW24C			-100	
I_{CEO}	Collector-emitter cut-off current	$V_{CE} = -30 \text{ V}$	$I_B = 0$		BDW24			-0.5	
					BDW24A			-0.5	
					BDW24B			-0.5	
					BDW24C			-0.5	
I_{CBO}	Collector cut-off current	$V_{CB} = -45 \text{ V}$	$I_E = 0$		BDW24			-0.2	
					BDW24A			-0.2	
					BDW24B			-0.2	
					BDW24C			-0.2	
I_{EBO}	Emitter cut-off current	$V_{EB} = -5 \text{ V}$	$I_C = 0$				-2	mA	
h_{FE}	Forward current transfer ratio	$V_{CE} = -3 \text{ V}$	$I_C = -1 \text{ A}$	(see Notes 3 and 4)				1000	
								750	
								100	
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = -8 \text{ mA}$	$I_C = -2 \text{ A}$	(see Notes 3 and 4)				-2	
								-3	
$V_{BE(sat)}$	Base-emitter saturation voltage	$I_B = -8 \text{ mA}$	$I_C = -2 \text{ A}$	(see Notes 3 and 4)				-2.5	V
$V_{BE(on)}$	Base-emitter voltage	$V_{CE} = -3 \text{ V}$	$I_C = -1 \text{ A}$	(see Notes 3 and 4)				-2.5	
								-3	
V_{EC}	Parallel diode forward voltage	$I_E = -2 \text{ A}$	$I_B = 0$					-1.8	V

NOTES: 3. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			2.5	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = -3 \text{ A}$	$I_{B(on)} = -12 \text{ mA}$	$I_{B(off)} = 12 \text{ mA}$		1		μs
t_{off}	Turn-off time	$V_{BE(off)} = 4.5 \text{ V}$	$R_L = 10 \Omega$	$t_p = 20 \mu\text{s}$, $d_c \leq 2\%$		5		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

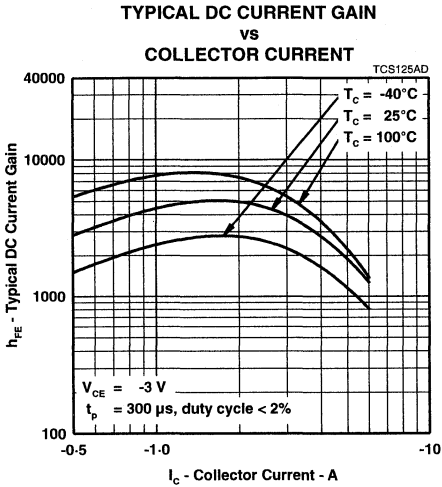


Figure 1.

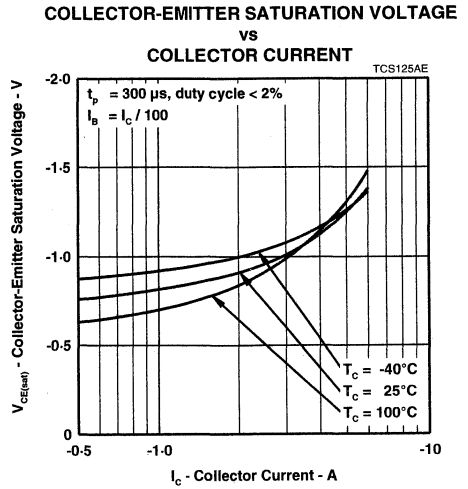


Figure 2.

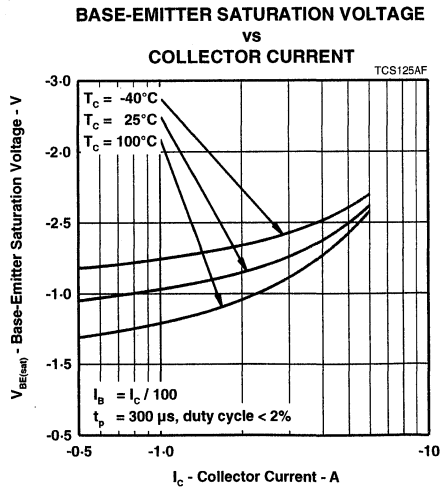


Figure 3.

BDW24, BDW24A, BDW24B, BDW24C
PNP SILICON POWER DARLINGTONS

MAY 1989 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

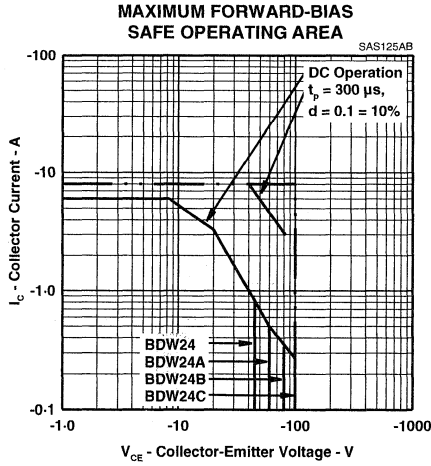


Figure 4.

THERMAL INFORMATION

**MAXIMUM POWER DISSIPATION
VS
CASE TEMPERATURE**

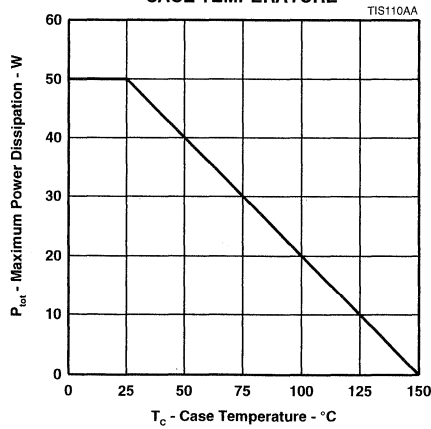


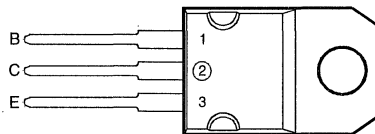
Figure 5.

BDW53, BDW53A, BDW53B, BDW53C, BDW53D NPN SILICON POWER DARLINGTONS

AUGUST 1978 - REVISED MAY 1995

- Designed for Complementary Use with BDW54, BDW54A, BDW54B, BDW54C and BDW54D
- 40 W at 25°C Case Temperature
- 4 A Continuous Collector Current
- Minimum h_{FE} of 750 at 3 V, 1.5 A

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BDW53	V_{CBO}	45	V
	BDW53A		60	
	BDW53B		80	
	BDW53C		100	
	BDW53D		120	
Collector-emitter voltage ($I_B = 0$) (see Note 1)	BDW53	V_{CEO}	45	V
	BDW53A		60	
	BDW53B		80	
	BDW53C		100	
	BDW53D		120	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	4	A
Continuous base current		I_B	50	mA
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	40	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	25	mJ
Operating junction temperature range		T_j	-65 to +150	°C
Operating temperature range		T_{stg}	-65 to +150	°C
Operating free-air temperature range		T_A	-65 to +150	°C

NOTES: 1. These values apply when the base-emitter diode is open circuited.

2. Derate linearly to 150°C case temperature at the rate of 0.32 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = 5$ mA, $R_{BE} = 100 \Omega$,

$V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = 20$ V.

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 **TEXAS
INSTRUMENTS**

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BDW53, BDW53A, BDW53B, BDW53C, BDW53D

NPN SILICON POWER DARLINGTONS

AUGUST 1978 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$	$I_B = 0$	(see Note 5)	BDW53	45		V
					BDW53A	60		
					BDW53B	80		
					BDW53C	100		
					BDW53D	120		
I_{CEO}	Collector-emitter cut-off current	$V_{CE} = 30 \text{ V}$	$I_B = 0$		BDW53		0.5	mA
					BDW53A		0.5	
					BDW53B		0.5	
					BDW53C		0.5	
					BDW53D		0.5	
I_{CBO}	Collector cut-off current	$V_{CB} = 45 \text{ V}$	$I_E = 0$		BDW53		0.2	mA
					BDW53A		0.2	
					BDW53B		0.2	
					BDW53C		0.2	
					BDW53D		0.2	
					BDW53		5	
					BDW53A		5	
					BDW53B		5	
					BDW53C		5	
					BDW53D		5	
					I_{EBO}	Emitter cut-off current	$V_{EB} = 5 \text{ V}$	
h_{FE}	Forward current transfer ratio	$V_{CE} = 3 \text{ V}$	$I_C = 1.5 \text{ A}$	(see Notes 5 and 6)	750	20000		
		$V_{CE} = 3 \text{ V}$	$I_C = 4 \text{ A}$		100			
$V_{BE(on)}$	Base-emitter voltage	$V_{CE} = 3 \text{ V}$	$I_C = 1.5 \text{ A}$	(see Notes 5 and 6)		2.5	V	
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = 30 \text{ mA}$	$I_C = 1.5 \text{ A}$	(see Notes 5 and 6)		2.5	V	
			$I_C = 4 \text{ A}$			4		
V_{EC}	Parallel diode forward voltage	$I_E = 4 \text{ A}$	$I_B = 0$			3.5	V	

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			3.125	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = 2 \text{ A}$	$I_{R(on)} = 8 \text{ mA}$	$I_{R(off)} = -8 \text{ mA}$		1		μs
t_{off}	Turn-off time	$V_{BE(off)} = -5 \text{ V}$	$R_L = 15 \Omega$	$t_p = 20 \mu\text{s}$, $dc \leq 2\%$		4.5		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

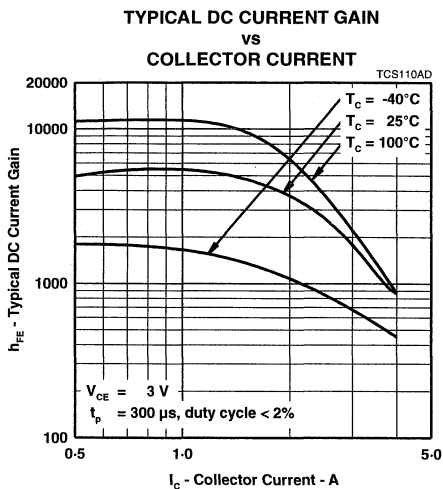


Figure 1.

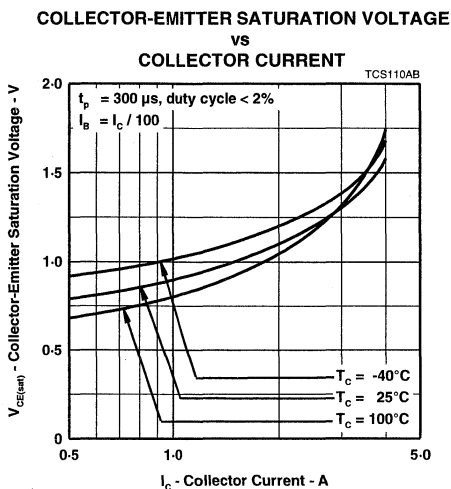


Figure 2.

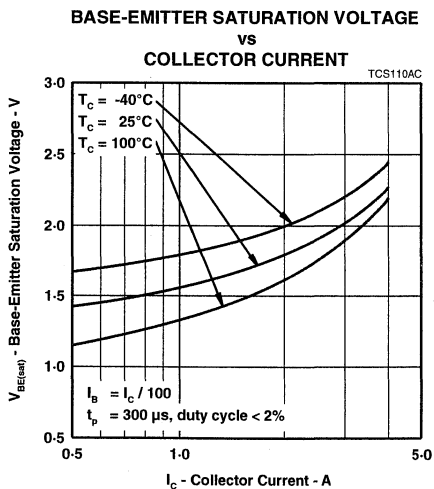


Figure 3.

BDW53, BDW53A, BDW53B, BDW53C, BDW53D NPN SILICON POWER DARLINGTONS

AUGUST 1978 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

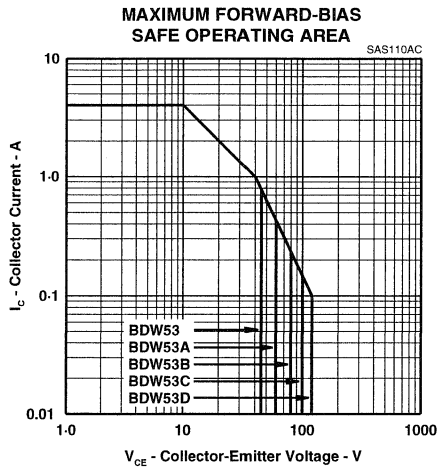


Figure 4.

THERMAL INFORMATION

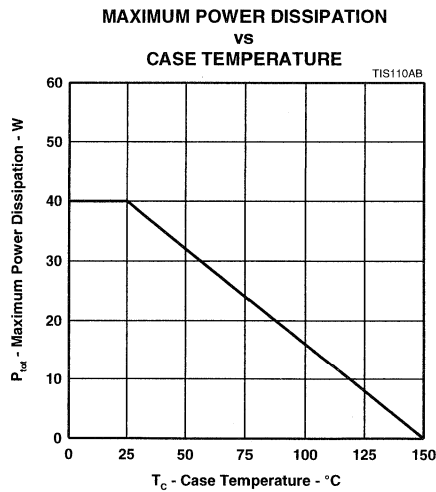


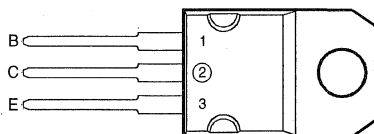
Figure 5.

BDW54, BDW54A, BDW54B, BDW54C, BDW54D PNP SILICON POWER DARLINGTONS

AUGUST 1978 - REVISED MAY 1995

- Designed for Complementary Use with BDW53, BDW53A, BDW53B, BDW53C and BDW53D
- 40 W at 25°C Case Temperature
- 4 A Continuous Collector Current
- Minimum h_{FE} of 750 at 3 V, 1.5 A

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BDW54	V_{CBO}	-45	V
	BDW54A		-60	
	BDW54B		-80	
	BDW54C		-100	
	BDW54D		-120	
Collector-emitter voltage ($I_B = 0$) (see Note 1)	BDW54	V_{CEO}	-45	V
	BDW54A		-60	
	BDW54B		-80	
	BDW54C		-100	
	BDW54D		-120	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-4	A
Continuous base current		I_B	-50	mA
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	40	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	25	mJ
Operating junction temperature range		T_J	-65 to +150	°C
Operating temperature range		T_{stg}	-65 to +150	°C
Operating free-air temperature range		T_A	-65 to +150	°C

NOTES: 1. These values apply when the base-emitter diode is open circuited.

2. Derate linearly to 150°C case temperature at the rate of 0.32 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = -5$ mA, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = -20$ V.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all the parameters.

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BDW54, BDW54A, BDW54B, BDW54C, BDW54D

PNP SILICON POWER DARLINGTONS

AUGUST 1978 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$ Collector-emitter breakdown voltage	$I_C = -30 \text{ mA}$ $I_B = 0$ (see Note 5)	BDW54 BDW54A BDW54B BDW54C BDW54D	-45 -60 -80 -100 -120		V
I_{CEO} Collector-emitter cut-off current	$V_{CE} = -30 \text{ V}$ $I_B = 0$ $V_{CE} = -30 \text{ V}$ $I_B = 0$ $V_{CE} = -40 \text{ V}$ $I_B = 0$ $V_{CE} = -50 \text{ V}$ $I_B = 0$ $V_{CE} = -60 \text{ V}$ $I_B = 0$	BDW54 BDW54A BDW54B BDW54C BDW54D		-0.5 -0.5 -0.5 -0.5 -0.5	mA
I_{CBO} Collector cut-off current	$V_{CB} = -45 \text{ V}$ $I_E = 0$ $V_{CB} = -60 \text{ V}$ $I_E = 0$ $V_{CB} = -80 \text{ V}$ $I_E = 0$ $V_{CB} = -100 \text{ V}$ $I_E = 0$ $V_{CB} = -120 \text{ V}$ $I_E = 0$ $V_{CB} = -45 \text{ V}$ $I_E = 0$ $T_C = 150^\circ\text{C}$ $V_{CB} = -60 \text{ V}$ $I_E = 0$ $T_C = 150^\circ\text{C}$ $V_{CB} = -80 \text{ V}$ $I_E = 0$ $T_C = 150^\circ\text{C}$ $V_{CB} = -100 \text{ V}$ $I_E = 0$ $T_C = 150^\circ\text{C}$ $V_{CB} = -120 \text{ V}$ $I_E = 0$ $T_C = 150^\circ\text{C}$	BDW54 BDW54A BDW54B BDW54C BDW54D BDW54 BDW54A BDW54B BDW54C BDW54D		-0.2 -0.2 -0.2 -0.2 -0.2 -5 -5 -5 -5 -5	mA
I_{EBO} Emitter cut-off current	$V_{EB} = -5 \text{ V}$ $I_C = 0$			-2	mA
h_{FE} Forward current transfer ratio	$V_{CE} = -3 \text{ V}$ $I_C = -1.5 \text{ A}$ (see Notes 5 and 6) $V_{CE} = -3 \text{ V}$ $I_C = -4 \text{ A}$ (see Notes 5 and 6)		750 100	20000	
$V_{BE(on)}$ Base-emitter voltage	$V_{CE} = -3 \text{ V}$ $I_C = -1.5 \text{ A}$ (see Notes 5 and 6)			-2.5	V
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = -30 \text{ mA}$ $I_C = -1.5 \text{ A}$ (see Notes 5 and 6) $I_B = -40 \text{ mA}$ $I_C = -4 \text{ A}$ (see Notes 5 and 6)			-2.5 -4	V
V_{EC} Parallel diode forward voltage	$I_E = -4 \text{ A}$ $I_B = 0$			-3.5	V

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			3.125	°C/W
$R_{\theta JA}$ Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †	MIN	TYP	MAX	UNIT
t_{on} Turn-on time	$I_C = -2 \text{ A}$ $I_{B(on)} = -8 \text{ mA}$ $I_{B(off)} = 8 \text{ mA}$		1		μs
t_{off} Turn-off time	$V_{BE(off)} = 5 \text{ V}$ $R_L = 15 \Omega$ $t_p = 20 \mu\text{s}$, $d_c \leq 2\%$		4.5		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.



TYPICAL CHARACTERISTICS

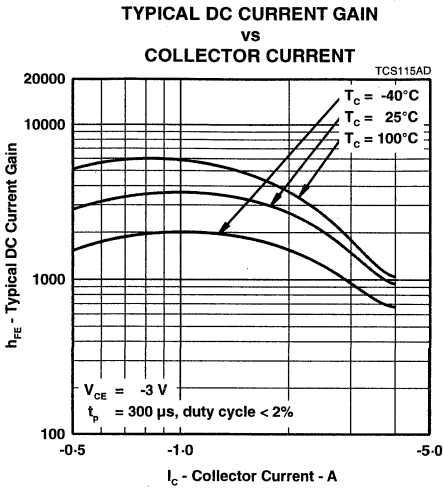


Figure 1.

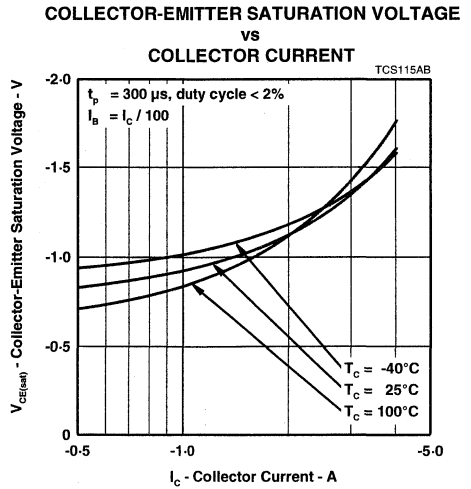


Figure 2.

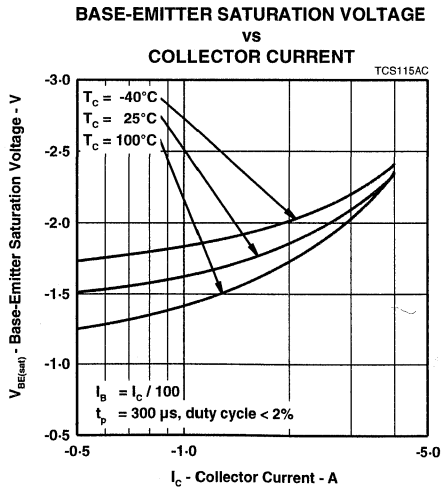


Figure 3.

BDW54, BDW54A, BDW54B, BDW54C, BDW54D PNP SILICON POWER DARLINGTONS

AUGUST 1978 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

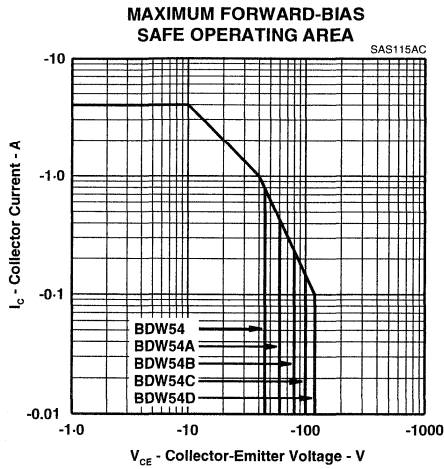


Figure 4.

THERMAL INFORMATION

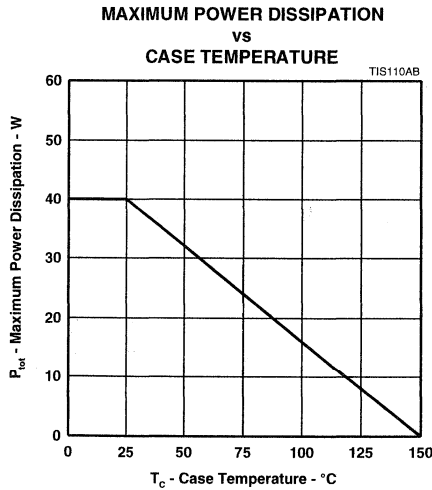
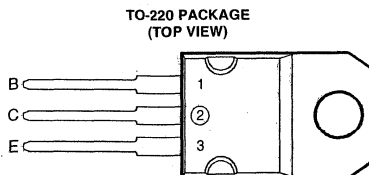


Figure 5.

BDW63, BDW63A, BDW63B, BDW63C, BDW63D NPN SILICON POWER DARLINGTONS

AUGUST 1978 - REVISED MAY 1995

- Designed for Complementary Use with BDW64, BDW64A, BDW64B, BDW64C and BDW64D
- 60 W at 25°C Case Temperature
- 6 A Continuous Collector Current
- Minimum h_{FE} of 750 at 3 V, 2 A



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BDW63	V_{CBO}	45	V
	BDW63A		60	
	BDW63B		80	
	BDW63C		100	
	BDW63D		120	
Collector-emitter voltage ($I_B = 0$) (see Note 1)	BDW63	V_{CEO}	45	V
	BDW63A		60	
	BDW63B		80	
	BDW63C		100	
	BDW63D		120	
Emitter-base voltage		V_{EB}	5	V
Continuous collector current		I_C	6	A
Continuous base current		I_B	0.1	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	60	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	50	mJ
Operating junction temperature range		T_J	-65 to +150	°C
Operating temperature range		T_{stg}	-65 to +150	°C
Operating free-air temperature range		T_A	-65 to +150	°C

NOTES: 1. These values apply when the base-emitter diode is open circuited.

2. Derate linearly to 150°C case temperature at the rate of 0.48 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = 5$ mA, $R_{BE} = 100 \Omega$, $V_{BE(eff)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = 20$ V.

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BDW63, BDW63A, BDW63B, BDW63C, BDW63D

NPN SILICON POWER DARLINGTONS

AUGUST 1978 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT		
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$	$I_B = 0$	(see Note 5)	BDW63	45	V		
					BDW63A	60			
					BDW63B	80			
					BDW63C	100			
					BDW63D	120			
I_{CEO}	Collector-emitter cut-off current	$V_{CE} = 30 \text{ V}$	$I_B = 0$	BDW63	0.5	mA			
				BDW63A	0.5				
				BDW63B	0.5				
				BDW63C	0.5				
				BDW63D	0.5				
I_{CBO}	Collector cut-off current	$V_{CB} = 45 \text{ V}$	$I_E = 0$	BDW63	0.2	mA			
				BDW63A	0.2				
				BDW63B	0.2				
				BDW63C	0.2				
				BDW63D	0.2				
				$V_{CB} = 45 \text{ V}$	$I_E = 0$		$T_C = 150^\circ\text{C}$	BDW63	5
				$V_{CB} = 60 \text{ V}$	$I_E = 0$		$T_C = 150^\circ\text{C}$	BDW63A	5
				$V_{CB} = 80 \text{ V}$	$I_E = 0$		$T_C = 150^\circ\text{C}$	BDW63B	5
				$V_{CB} = 100 \text{ V}$	$I_E = 0$		$T_C = 150^\circ\text{C}$	BDW63C	5
				$V_{CB} = 120 \text{ V}$	$I_E = 0$		$T_C = 150^\circ\text{C}$	BDW63D	5
				I_{EBO}	Emitter cut-off current		$V_{EB} = 5 \text{ V}$	$I_C = 0$	
h_{FE}	Forward current transfer ratio	$V_{CE} = 3 \text{ V}$	$I_C = 2 \text{ A}$	(see Notes 5 and 6)	750	20000			
		$V_{CE} = 3 \text{ V}$	$I_C = 6 \text{ A}$		100				
$V_{BE(on)}$	Base-emitter voltage	$V_{CE} = 3 \text{ V}$	$I_C = 2 \text{ A}$	(see Notes 5 and 6)		2.5	V		
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = 12 \text{ mA}$	$I_C = 2 \text{ A}$	(see Notes 5 and 6)		2.5	V		
			$I_C = 6 \text{ A}$			4			
V_{EC}	Parallel diode forward voltage	$I_E = 6 \text{ A}$	$I_B = 0$			3.5	V		

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

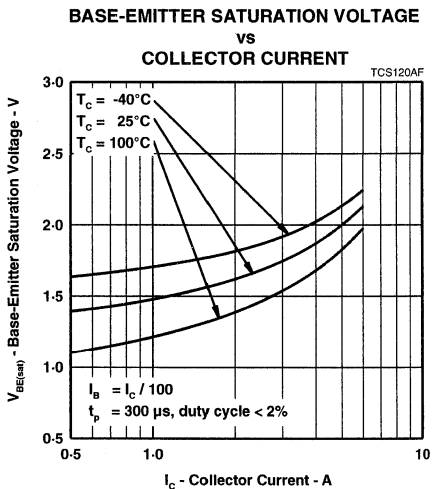
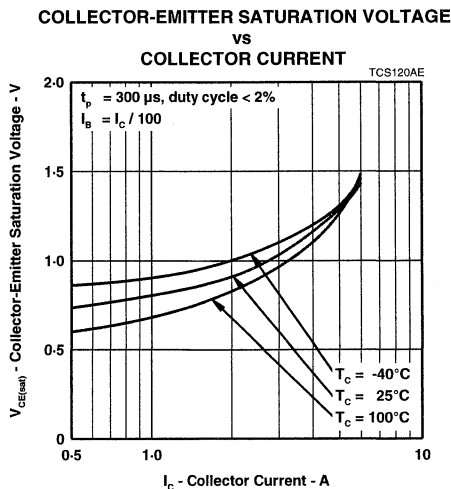
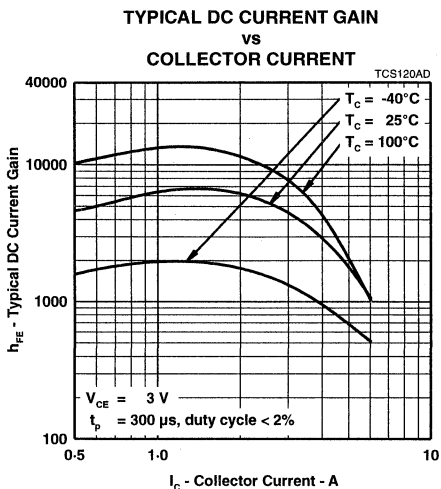
PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			2.08	$^\circ\text{C/W}$
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	$^\circ\text{C/W}$

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = 3 \text{ A}$	$I_{B(on)} = 12 \text{ mA}$	$I_{B(off)} = -12 \text{ mA}$		1		μs
t_{off}	Turn-off time		$V_{BE(off)} = -4.5 \text{ V}$	$R_L = 10 \Omega$	$t_p = 20 \mu\text{s}$, dc $\leq 2\%$		5	

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS



BDW63, BDW63A, BDW63B, BDW63C, BDW63D NPN SILICON POWER DARLINGTONS

AUGUST 1978 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

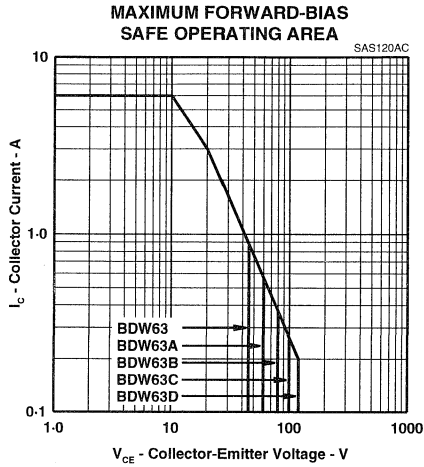


Figure 4.

THERMAL INFORMATION

MAXIMUM POWER DISSIPATION vs CASE TEMPERATURE

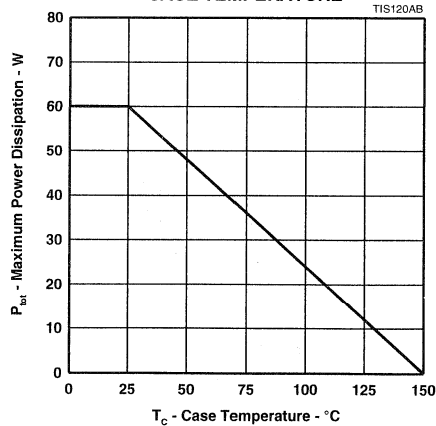
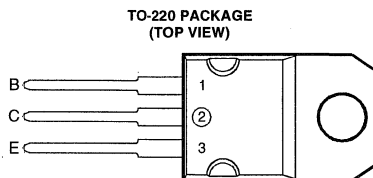


Figure 5.

BDW64, BDW64A, BDW64B, BDW64C, BDW64D PNP SILICON POWER DARLINGTONS

AUGUST 1978 - REVISED MAY 1995

- Designed for Complementary Use with BDW63, BDW63A, BDW63B, BDW63C and BDW63D
- 60 W at 25°C Case Temperature
- 6 A Continuous Collector Current
- Minimum h_{FE} of 750 at 3 V, 2 A



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BDW64	V_{CBO}	-45	V
	BDW64A		-60	
	BDW64B		-80	
	BDW64C		-100	
	BDW64D		-120	
Collector-emitter voltage ($I_B = 0$) (see Note 1)	BDW64	V_{CEO}	-45	V
	BDW64A		-60	
	BDW64B		-80	
	BDW64C		-100	
	BDW64D		-120	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-6	A
Continuous base current		I_B	-0.1	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	60	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	50	mJ
Operating junction temperature range		T_j	-65 to +150	°C
Operating temperature range		T_{stg}	-65 to +150	°C
Operating free-air temperature range		T_A	-65 to +150	°C

NOTES: 1. These values apply when the base-emitter diode is open circuited.

2. Derate linearly to 150°C case temperature at the rate of 0.48 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = -5$ mA, $R_{BE} = 100$ Ω , $V_{BE(off)} = 0$, $R_S = 0.1$ Ω , $V_{CC} = -20$ V.

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BDW64, BDW64A, BDW64B, BDW64C, BDW64D

PNP SILICON POWER DARLINGTONS

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electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = -30 \text{ mA}$	$I_B = 0$	(see Note 5)	BDW64		-45	V
					BDW64A		-60	
					BDW64B		-80	
					BDW64C		-100	
					BDW64D		-120	
I_{CEO}	Collector-emitter cut-off current	$V_{CE} = -30 \text{ V}$	$I_B = 0$		BDW64		-0.5	mA
					BDW64A		-0.5	
					BDW64B		-0.5	
					BDW64C		-0.5	
					BDW64D		-0.5	
I_{CBO}	Collector cut-off current	$V_{CB} = -45 \text{ V}$	$I_E = 0$		BDW64		-0.2	mA
					BDW64A		-0.2	
					BDW64B		-0.2	
					BDW64C		-0.2	
					BDW64D		-0.2	
					BDW64		-0.2	
					BDW64	$T_C = 150^\circ\text{C}$	-5	
					BDW64A	$T_C = 150^\circ\text{C}$	-5	
					BDW64B	$T_C = 150^\circ\text{C}$	-5	
					BDW64C	$T_C = 150^\circ\text{C}$	-5	
					BDW64D	$T_C = 150^\circ\text{C}$	-5	
I_{EBO}	Emitter cut-off current	$V_{EB} = -5 \text{ V}$	$I_C = 0$				-2	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = -3 \text{ V}$	$I_C = -2 \text{ A}$	(see Notes 5 and 6)		750	20000	
						100		
$V_{BE(on)}$	Base-emitter voltage	$V_{CE} = -3 \text{ V}$	$I_C = -2 \text{ A}$	(see Notes 5 and 6)			-2.5	V
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = -12 \text{ mA}$	$I_C = -2 \text{ A}$	(see Notes 5 and 6)			-2.5	V
		$I_B = -60 \text{ mA}$	$I_C = -6 \text{ A}$				-4	
V_{EC}	Parallel diode forward voltage	$I_E = -6 \text{ A}$	$I_B = 0$				-3.5	V

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			2.08	$^\circ\text{C/W}$
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	$^\circ\text{C/W}$

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = -3 \text{ A}$	$I_{B(on)} = -12 \text{ mA}$	$I_{B(off)} = 12 \text{ mA}$		1		μs
t_{off}	Turn-off time	$V_{BE(off)} = 4.5 \text{ V}$	$R_L = 10 \Omega$	$t_p = 20 \mu\text{s}$, $dc \leq 2\%$		5		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
vs
COLLECTOR CURRENT

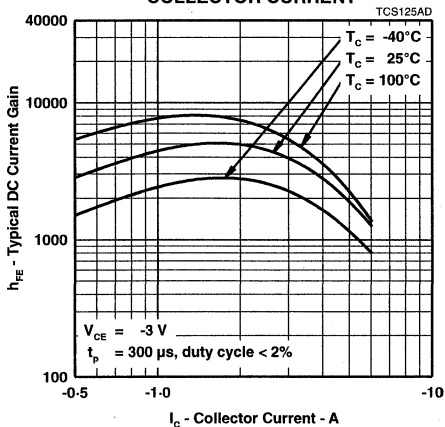


Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE
vs
COLLECTOR CURRENT

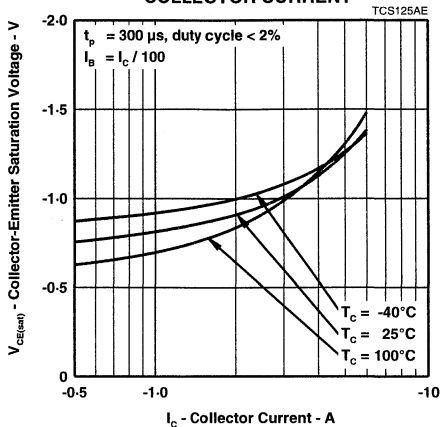


Figure 2.

BASE-EMITTER SATURATION VOLTAGE
vs
COLLECTOR CURRENT

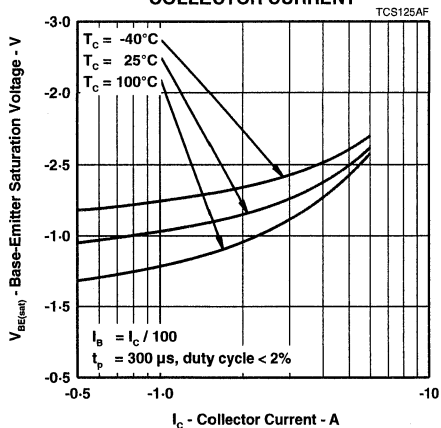


Figure 3.

BDW64, BDW64A, BDW64B, BDW64C, BDW64D PNP SILICON POWER DARLINGTONS

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MAXIMUM SAFE OPERATING REGIONS

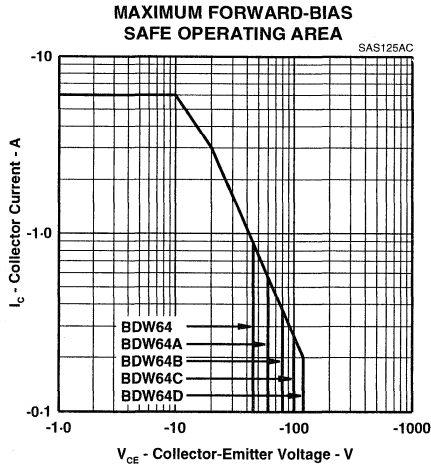


Figure 4.

THERMAL INFORMATION

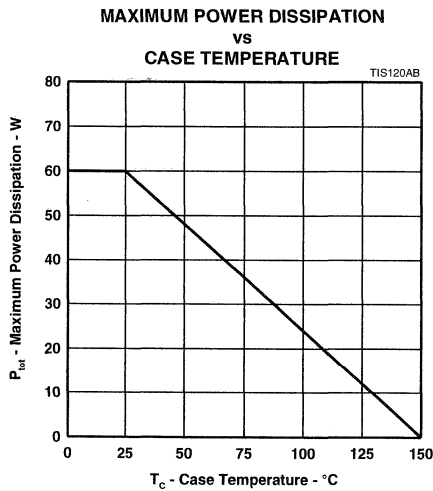
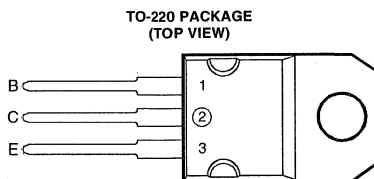


Figure 5.

BDW73, BDW73A, BDW73B, BDW73C, BDW73D NPN SILICON POWER DARLINGTONS

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- Designed for Complementary Use with BDW74, BDW74A, BDW74B, BDW74C and BDW74D
- 80 W at 25°C Case Temperature
- 8 A Continuous Collector Current
- Minimum h_{FE} of 750 at 3 V, 3 A



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BDW73	V_{CBO}	45	V
	BDW73A		60	
	BDW73B		80	
	BDW73C		100	
	BDW73D		120	
Collector-emitter voltage ($I_B = 0$) (see Note 1)	BDW73	V_{CEO}	45	V
	BDW73A		60	
	BDW73B		80	
	BDW73C		100	
	BDW73D		120	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	8	A
Continuous base current		I_B	0.3	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	80	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	75	mJ
Operating junction temperature range		T_J	-65 to +150	°C
Operating temperature range		T_{slg}	-65 to +150	°C
Operating free-air temperature range		T_A	-65 to +150	°C

NOTES: 1. These values apply when the base-emitter diode is open circuited.

2. Derate linearly to 150°C case temperature at the rate of 0.64 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = 5$ mA, $R_{BE} = 100 \Omega$.

$V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = 20$ V.

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BDW73, BDW73A, BDW73B, BDW73C, BDW73D

NPN SILICON POWER DARLINGTONS

AUGUST 1978 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$ Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$	$I_B = 0$	(see Note 5)	BDW73			45
				BDW73A			60
				BDW73B			80
				BDW73C			100
				BDW73D			120
I_{CEO} Collector-emitter cut-off current	$V_{CE} = 30 \text{ V}$	$I_B = 0$		BDW73			0.5
				BDW73A			0.5
				BDW73B			0.5
				BDW73C			0.5
				BDW73D			0.5
I_{CBO} Collector cut-off current	$V_{CB} = 45 \text{ V}$	$I_E = 0$		BDW73			0.2
				BDW73A			0.2
				BDW73B			0.2
				BDW73C			0.2
				BDW73D			0.2
				BDW73		$T_C = 150^\circ\text{C}$	5
				BDW73A		$T_C = 150^\circ\text{C}$	5
				BDW73B		$T_C = 150^\circ\text{C}$	5
				BDW73C		$T_C = 150^\circ\text{C}$	5
				BDW73D		$T_C = 150^\circ\text{C}$	5
				I_{EBO} Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$	
h_{FE} Forward current transfer ratio	$V_{CE} = 3 \text{ V}$	$I_C = 3 \text{ A}$	(see Notes 5 and 6)	750		20000	
	$V_{CE} = 3 \text{ V}$	$I_C = 8 \text{ A}$		100			
$V_{BE(on)}$ Base-emitter voltage	$V_{CE} = 3 \text{ V}$	$I_C = 3 \text{ A}$	(see Notes 5 and 6)			2.5	V
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 12 \text{ mA}$	$I_C = 3 \text{ A}$	(see Notes 5 and 6)			2.5	V
		$I_C = 8 \text{ A}$				4	V
V_{EC} Parallel diode forward voltage	$I_E = 8 \text{ A}$	$I_B = 0$				3.5	V

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1.56	$^\circ\text{C/W}$
$R_{\theta JA}$ Junction to free air thermal resistance			62.5	$^\circ\text{C/W}$

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on} Turn-on time	$I_C = 3 \text{ A}$	$I_{B(on)} = 12 \text{ mA}$	$I_{B(off)} = -12 \text{ mA}$		1		μs
t_{off} Turn-off time				$V_{BE(off)} = -3.5 \text{ V}$	$R_L = 10 \Omega$	$t_p = 20 \mu\text{s}$, dc $\leq 2\%$	5

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

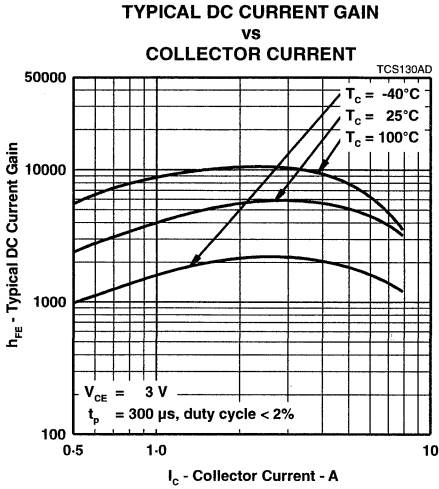


Figure 1.

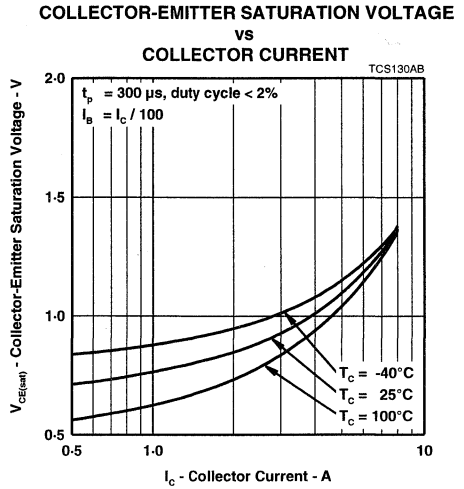


Figure 2.

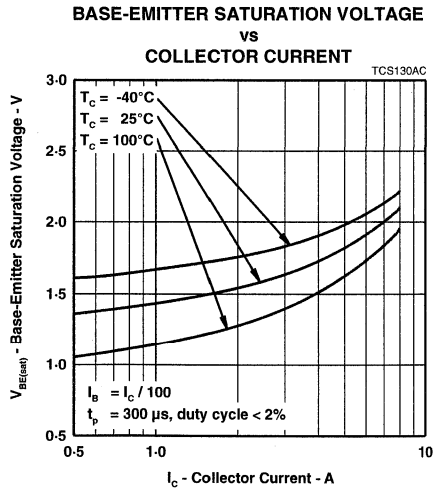


Figure 3.

BDW73, BDW73A, BDW73B, BDW73C, BDW73D
NPN SILICON POWER DARLINGTONS

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MAXIMUM SAFE OPERATING REGIONS

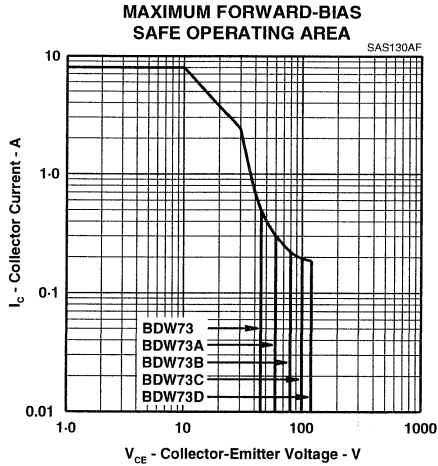


Figure 4.

THERMAL INFORMATION

**MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE**

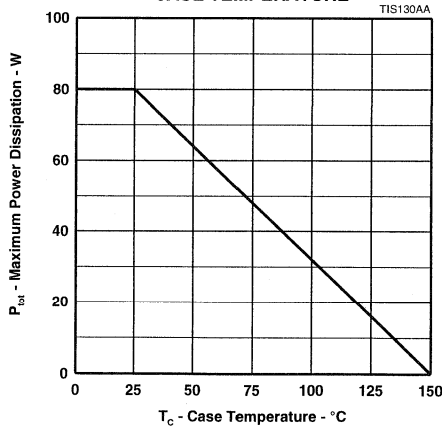


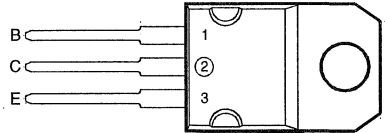
Figure 5.

BDW74, BDW74A, BDW74B, BDW74C, BDW74D PNP SILICON POWER DARLINGTONS

AUGUST 1978 - REVISED MAY 1995

- Designed for Complementary Use with BDW73, BDW73A, BDW73B, BDW73C and BDW73D
- 80 W at 25°C Case Temperature
- 8 A Continuous Collector Current
- Minimum h_{FE} of 750 at 3 V, 3 A

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BDW74	V_{CBO}	-45	V
	BDW74A		-60	
	BDW74B		-80	
	BDW74C		-100	
	BDW74D		-120	
Collector-emitter voltage ($I_B = 0$) (see Note 1)	BDW74	V_{CEO}	-45	V
	BDW74A		-60	
	BDW74B		-80	
	BDW74C		-100	
	BDW74D		-120	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-8	A
Continuous base current		I_B	-0.3	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	80	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	75	mJ
Operating junction temperature range		T_J	-65 to +150	°C
Operating temperature range		T_{stg}	-65 to +150	°C
Operating free-air temperature range		T_A	-65 to +150	°C

NOTES: 1. These values apply when the base-emitter diode is open circuited.

2. Derate linearly to 150°C case temperature at the rate of 0.64 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = -5$ mA, $R_{BE} = 100$ Ω , $V_{BE(off)} = 0$, $R_S = 0.1$ Ω , $V_{CC} = -20$ V.

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BDW74, BDW74A, BDW74B, BDW74C, BDW74D

PNP SILICON POWER DARLINGTONS

AUGUST 1978 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = -30 \text{ mA}$	$I_B = 0$	(see Note 5)	BDW74	-45		V
					BDW74A	-60		
					BDW74B	-80		
					BDW74C	-100		
					BDW74D	-120		
I_{CEO}	Collector-emitter cut-off current	$V_{CE} = -30 \text{ V}$	$I_B = 0$		BDW74		-0.5	mA
					BDW74A		-0.5	
					BDW74B		-0.5	
					BDW74C		-0.5	
					BDW74D		-0.5	
I_{CBO}	Collector cut-off current	$V_{CB} = -45 \text{ V}$	$I_E = 0$		BDW74		-0.2	mA
					BDW74A		-0.2	
					BDW74B		-0.2	
					BDW74C		-0.2	
					BDW74D		-0.2	
					BDW74		-5	
					BDW74A		-5	
					BDW74B		-5	
					BDW74C		-5	
					BDW74D		-5	
					I_{EBO}	Emitter cut-off current	$V_{EB} = -5 \text{ V}$	
h_{FE}	Forward current transfer ratio	$V_{CE} = -3 \text{ V}$	$I_C = -3 \text{ A}$	(see Notes 5 and 6)	750	20000		
		$V_{CE} = -3 \text{ V}$	$I_C = -8 \text{ A}$		100			
$V_{BE(on)}$	Base-emitter voltage	$V_{CE} = -3 \text{ V}$	$I_C = -3 \text{ A}$	(see Notes 5 and 6)			-2.5	V
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = -12 \text{ mA}$	$I_C = -3 \text{ A}$	(see Notes 5 and 6)			-2.5	V
			$I_C = -8 \text{ A}$				-4	
V_{EC}	Parallel diode forward voltage	$I_E = -8 \text{ A}$	$I_B = 0$				-3.5	V

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.56	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = -3 \text{ A}$	$I_{B(on)} = -12 \text{ mA}$	$I_{B(off)} = 12 \text{ mA}$		1		μs
t_{off}	Turn-off time					$V_{BE(off)} = 3.5 \text{ V}$	$R_L = 10 \Omega$	$t_p = 20 \mu\text{s}$, $d_c \leq 2\%$

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.



TYPICAL CHARACTERISTICS

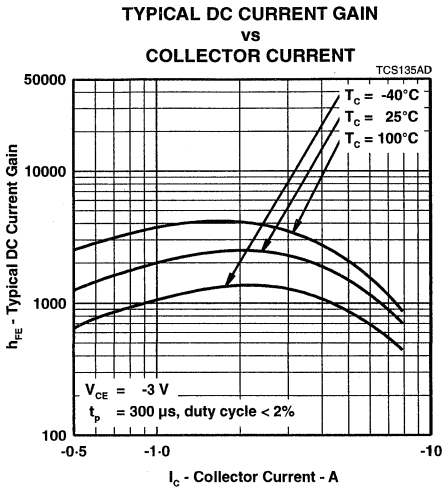


Figure 1.

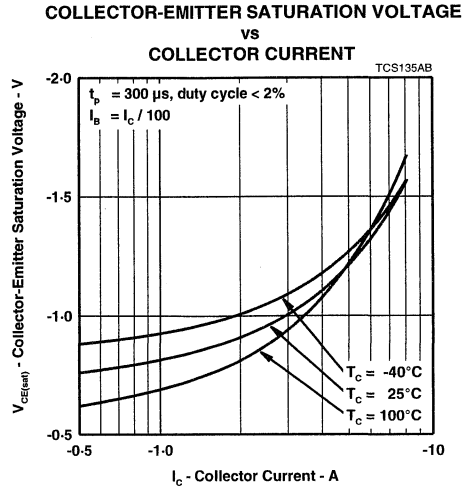


Figure 2.

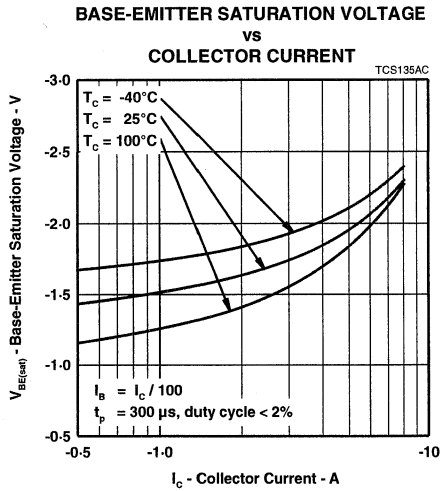


Figure 3.

BDW74, BDW74A, BDW74B, BDW74C, BDW74D PNP SILICON POWER DARLINGTONS

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MAXIMUM SAFE OPERATING REGIONS

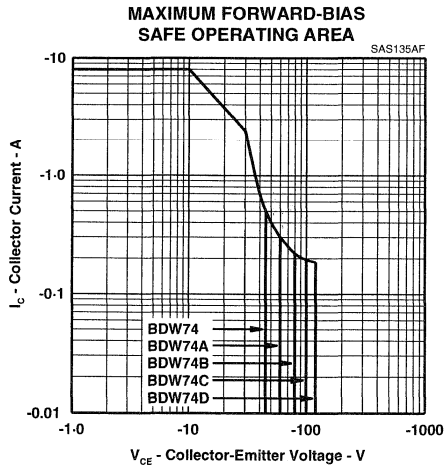


Figure 4.

THERMAL INFORMATION

MAXIMUM POWER DISSIPATION vs CASE TEMPERATURE

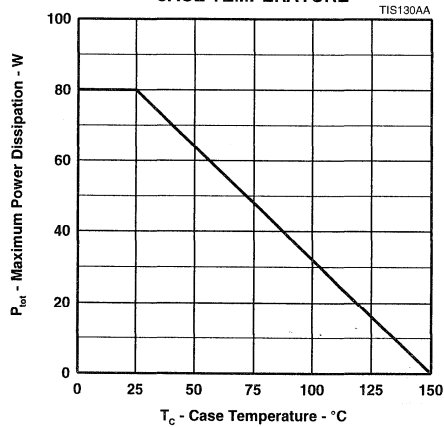


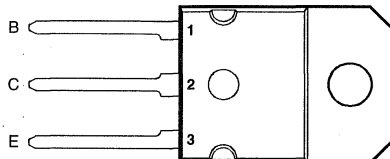
Figure 5.

BDW83, BDW83A, BDW83B, BDW83C, BDW83D NPN SILICON POWER DARLINGTONS

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- Designed for Complementary Use with BDW84, BDW84A, BDW84B, BDW84C and BDW84D
- 150 W at 25°C Case Temperature
- 15 A Continuous Collector Current
- Minimum h_{FE} of 750 at 3 V, 6 A

SOT-93 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BDW83	V_{CBO}	45	V
	BDW83A		60	
	BDW83B		80	
	BDW83C		100	
	BDW83D		120	
Collector-emitter voltage ($I_B = 0$) (see Note 1)	BDW83	V_{CEO}	45	V
	BDW83A		60	
	BDW83B		80	
	BDW83C		100	
	BDW83D		120	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	15	A
Continuous base current		I_B	0.5	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	150	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	3.5	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	100	mJ
Operating junction temperature range		T_j	-65 to +150	°C
Operating temperature range		T_{stg}	-65 to +150	°C
Operating free-air temperature range		T_A	-65 to +150	°C

NOTES: 1. These values apply when the base-emitter diode is open circuited.

2. Derate linearly to 150°C case temperature at the rate of 1.2 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 28 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = 5$ mA, $R_{BE} = 100$ Ω , $V_{BE(off)} = 0$, $R_S = 0.1$ Ω , $V_{CC} = 20$ V.

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 **TEXAS
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BDW83, BDW83A, BDW83B, BDW83C, BDW83D

NPN SILICON POWER DARLINGTONS

AUGUST 1978 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$	$I_B = 0$	(see Note 5)	BDW83			45
					BDW83A			60
					BDW83B			80
					BDW83C			100
					BDW83D			120
I_{CEO}	Collector-emitter cut-off current				BDW83			1
					BDW83A			1
					BDW83B			1
					BDW83C			1
					BDW83D			1
I_{CBO}	Collector cut-off current				BDW83			0.5
					BDW83A			0.5
					BDW83B			0.5
					BDW83C			0.5
					BDW83D			0.5
					BDW83		$T_C = 150^\circ\text{C}$	5
					BDW83A		$T_C = 150^\circ\text{C}$	5
					BDW83B		$T_C = 150^\circ\text{C}$	5
					BDW83C		$T_C = 150^\circ\text{C}$	5
					BDW83D		$T_C = 150^\circ\text{C}$	5
I_{EBO}	Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$				2	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = 3 \text{ V}$	$I_C = 6 \text{ A}$	(see Notes 5 and 6)	750		20000	
			$I_C = 15 \text{ A}$		100			
$V_{BE(on)}$	Base-emitter voltage	$V_{CE} = 3 \text{ V}$	$I_C = 6 \text{ A}$	(see Notes 5 and 6)			2.5	V
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = 12 \text{ mA}$	$I_C = 6 \text{ A}$	(see Notes 5 and 6)			2.5	
			$I_C = 15 \text{ A}$				4	V
V_{EC}	Parallel diode forward voltage	$I_E = 15 \text{ A}$	$I_B = 0$				3.5	V

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			0.83	$^\circ\text{C/W}$
$R_{\theta JA}$	Junction to free air thermal resistance			35.7	$^\circ\text{C/W}$

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = 10 \text{ A}$	$I_{B(on)} = 40 \text{ mA}$	$I_{B(off)} = -40 \text{ mA}$		0.9		μs
t_{off}	Turn-off time				$V_{BE(off)} = -4.2 \text{ V}$			

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

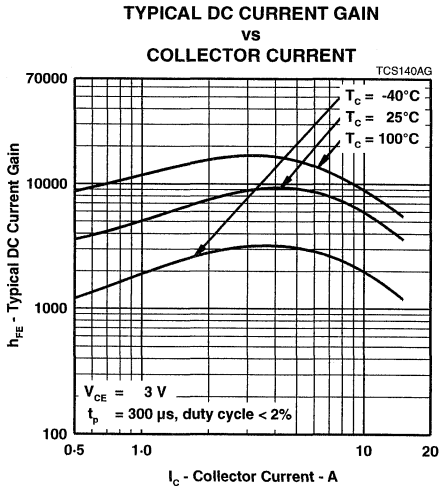


Figure 1.

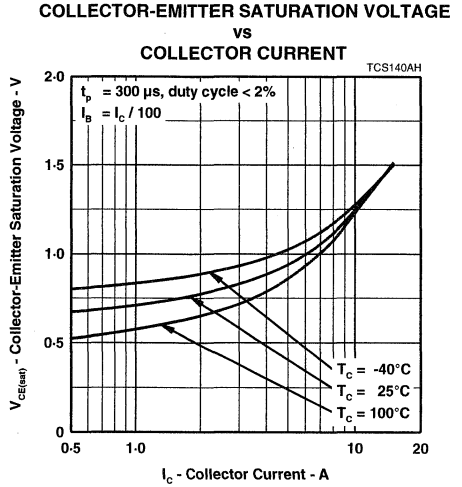


Figure 2.

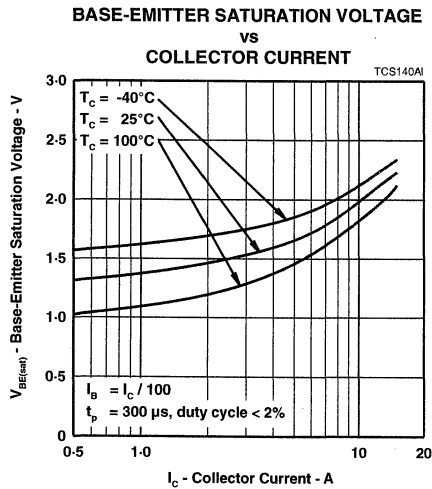


Figure 3.

BDW83, BDW83A, BDW83B, BDW83C, BDW83D NPN SILICON POWER DARLINGTONS

AUGUST 1978 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

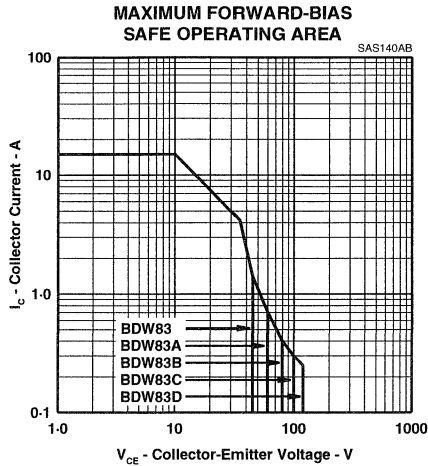


Figure 4.

THERMAL INFORMATION

MAXIMUM POWER DISSIPATION vs CASE TEMPERATURE

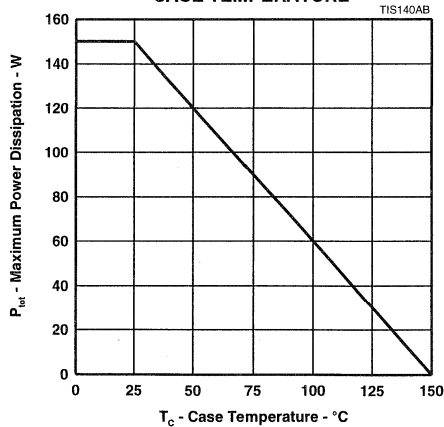
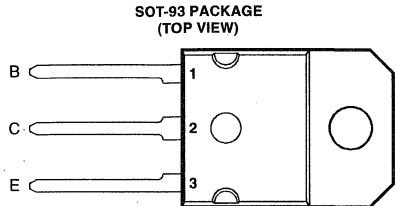


Figure 5.

BDW84, BDW84A, BDW84B, BDW84C, BDW84D PNP SILICON POWER DARLINGTONS

AUGUST 1978 - REVISED MAY 1995

- Designed for Complementary Use with BDW83, BDW83A, BDW83B, BDW83C and BDW83D
- 150 W at 25°C Case Temperature
- 15 A Continuous Collector Current
- Minimum h_{FE} of 750 at 3 V, 6 A



Pin 2 is in electrical contact with the mounting base.

MDTRAA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BDW84	V_{CBO}	-45	V
	BDW84A		-60	
	BDW84B		-80	
	BDW84C		-100	
	BDW84D		-120	
Collector-emitter voltage ($I_B = 0$) (see Note 1)	BDW84	V_{CEO}	-45	V
	BDW84A		-60	
	BDW84B		-80	
	BDW84C		-100	
	BDW84D		-120	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-15	A
Continuous base current		I_B	-0.5	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	150	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	3.5	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	100	mJ
Operating junction temperature range		T_j	-65 to +150	°C
Operating temperature range		T_{stg}	-65 to +150	°C
Operating free-air temperature range		T_A	-65 to +150	°C

NOTES: 1. These values apply when the base-emitter diode is open circuited.

2. Derate linearly to 150°C case temperature at the rate of 1.2 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 28 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = -5$ mA, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = -20$ V.

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BDW84, BDW84A, BDW84B, BDW84C, BDW84D

PNP SILICON POWER DARLINGTONS

AUGUST 1978 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
$V_{(BR)CEO}$ Collector-emitter breakdown voltage	$I_C = -30\text{ mA}$ $I_B = 0$ (see Note 5)	BDW84		-45	V	
		BDW84A		-60		
		BDW84B		-80		
		BDW84C		-100		
		BDW84D		-120		
I_{CEO} Collector-emitter cut-off current	$V_{CE} = -30\text{ V}$ $I_B = 0$	BDW84		-1	mA	
		BDW84A		-1		
		BDW84B		-1		
		BDW84C		-1		
		BDW84D		-1		
I_{CBO} Collector cut-off current	$V_{CB} = -45\text{ V}$ $I_E = 0$	BDW84		-0.5	mA	
		BDW84A		-0.5		
		BDW84B		-0.5		
		BDW84C		-0.5		
		BDW84D		-0.5		
		$V_{CB} = -100\text{ V}$ $I_E = 0$	BDW84			-5
			BDW84A			-5
		$V_{CB} = -80\text{ V}$ $I_E = 0$	BDW84B			-5
			BDW84C			-5
		$V_{CB} = -120\text{ V}$ $I_E = 0$	BDW84D			-5
BDW84	$T_C = 150^\circ\text{C}$		-5			
$V_{CB} = -60\text{ V}$ $I_E = 0$	BDW84A	$T_C = 150^\circ\text{C}$	-5			
	BDW84B	$T_C = 150^\circ\text{C}$	-5			
$V_{CB} = -100\text{ V}$ $I_E = 0$	BDW84C	$T_C = 150^\circ\text{C}$	-5			
	BDW84D	$T_C = 150^\circ\text{C}$	-5			
I_{EBO} Emitter cut-off current	$V_{EB} = -5\text{ V}$ $I_C = 0$			-2	mA	
h_{FE} Forward current transfer ratio	$V_{CE} = -3\text{ V}$ $I_C = -6\text{ A}$ (see Notes 5 and 6)		750	20000		
			100			
$V_{BE(on)}$ Base-emitter voltage	$V_{CE} = -3\text{ V}$ $I_C = -6\text{ A}$ (see Notes 5 and 6)			-2.5	V	
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = -12\text{ mA}$ $I_C = -6\text{ A}$ (see Notes 5 and 6)			-2.5	V	
				-4		
V_{EC} Parallel diode forward voltage	$I_E = -15\text{ A}$ $I_B = 0$			-3.5	V	

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			0.83	$^\circ\text{C/W}$
$R_{\theta JA}$ Junction to free air thermal resistance			35.7	$^\circ\text{C/W}$

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †	MIN	TYP	MAX	UNIT
t_{on} Turn-on time	$I_C = -10\text{ A}$ $I_{B(on)} = -40\text{ mA}$ $I_{B(off)} = 40\text{ mA}$ $V_{BE(off)} = 4.2\text{ V}$ $R_L = 3\text{ }\Omega$ $t_p = 20\text{ }\mu\text{s}$, dc $\leq 2\%$		0.9		μs
t_{off} Turn-off time			7		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

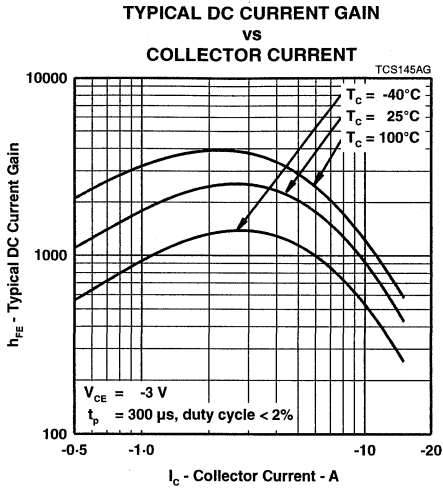


Figure 1.

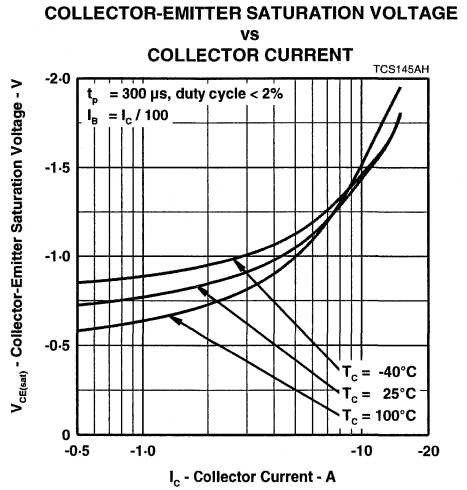


Figure 2.

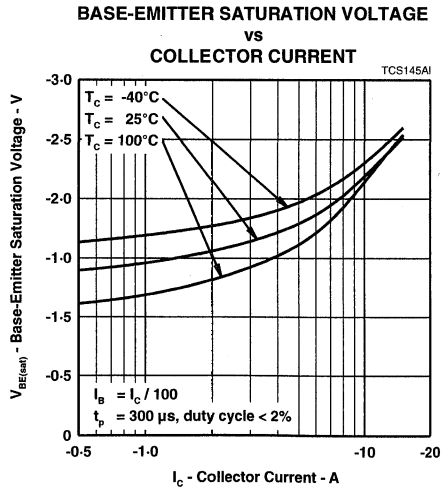


Figure 3.

BDW84, BDW84A, BDW84B, BDW84C, BDW84D PNP SILICON POWER DARLINGTONS

AUGUST 1978 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

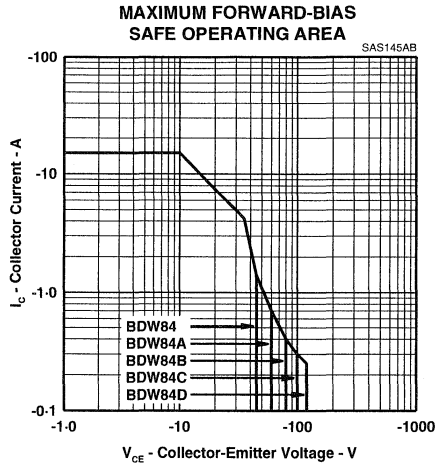


Figure 4.

THERMAL INFORMATION

MAXIMUM POWER DISSIPATION vs CASE TEMPERATURE

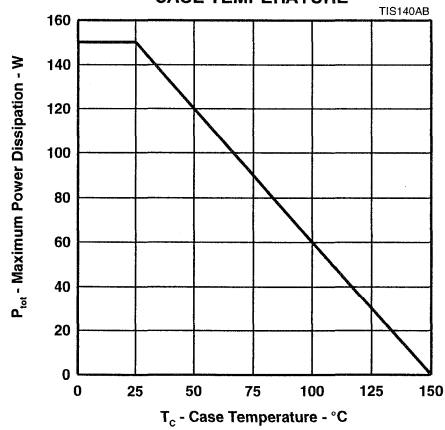


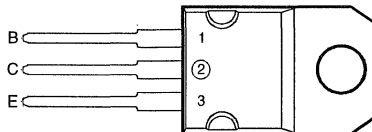
Figure 5.

BDW93, BDW93A, BDW93B, BDW93C NPN SILICON POWER DARLINGTONS

SEPTEMBER 1993 - REVISED MAY 1995

- Designed for Complementary Use with BDW94, BDW94A, BDW94B and BDW94C
- 80 W at 25°C Case Temperature
- 12 A Continuous Collector Current
- Minimum h_{FE} of 750 at 3 V, 5 A

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BDW93	V_{CBO}	45	V
	BDW93A		60	
	BDW93B		80	
	BDW93C		100	
Collector-emitter voltage ($I_B = 0$)	BDW93	V_{CEO}	45	V
	BDW93A		60	
	BDW93B		80	
	BDW93C		100	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	12	A
Continuous base current		I_B	0.3	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 1)		P_{tot}	80	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 2)		P_{tot}	2	W
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Operating free-air temperature range		T_A	-65 to +150	°C

- NOTES: 1. Derate linearly to 150°C case temperature at the rate of 0.64 W/°C.
2. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

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BDW93, BDW93A, BDW93B, BDW93C NPN SILICON POWER DARLINGTONS

SEPTEMBER 1993 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT	
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = 100 \text{ mA}$	$I_B = 0$	(see Note 3)	BDW93	45	V	
					BDW93A	60		
					BDW93B	80		
					BDW93C	100		
I_{CEO}	Collector-emitter cut-off current	$V_{CB} = 40 \text{ V}$	$I_B = 0$	BDW93		1	mA	
					BDW93A			1
					BDW93B			1
					BDW93C			1
I_{CBO}	Collector cut-off current	$V_{CB} = 45 \text{ V}$	$I_E = 0$	BDW93		0.1	mA	
					BDW93A			0.1
					BDW93B			0.1
					BDW93C			0.1
					BDW93	$T_C = 150^\circ\text{C}$		5
					BDW93A	$T_C = 150^\circ\text{C}$		5
					BDW93B	$T_C = 150^\circ\text{C}$		5
					BDW93C	$T_C = 150^\circ\text{C}$		5
I_{EBO}	Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$			2	mA	
h_{FE}	Forward current transfer ratio	$V_{CE} = 3 \text{ V}$	$I_C = 3 \text{ A}$	(see Notes 3 and 4)	1000			
					100			
					750	20000		
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = 20 \text{ mA}$	$I_C = 5 \text{ A}$	(see Notes 3 and 4)		2	V	
					$I_B = 100 \text{ mA}$	$I_C = 10 \text{ A}$		
$V_{BE(sat)}$	Base-emitter saturation voltage	$I_B = 20 \text{ mA}$	$I_C = 5 \text{ A}$	(see Notes 3 and 4)		2.5	V	
					$I_B = 100 \text{ mA}$	$I_C = 10 \text{ A}$		
V_{EC}	Parallel diode forward voltage	$I_E = 5 \text{ A}$	$I_B = 0$			2	V	
				$I_E = 10 \text{ A}$	$I_B = 0$			4

NOTES: 3. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.56	$^\circ\text{C/W}$
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	$^\circ\text{C/W}$

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
vs
COLLECTOR CURRENT

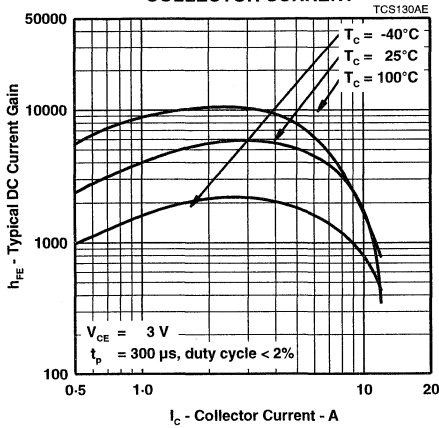


Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE
vs
COLLECTOR CURRENT

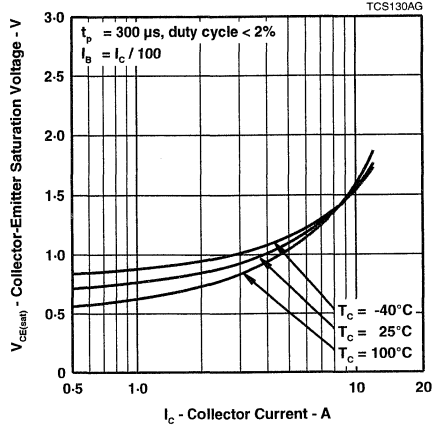


Figure 2.

BASE-EMITTER SATURATION VOLTAGE
vs
COLLECTOR CURRENT

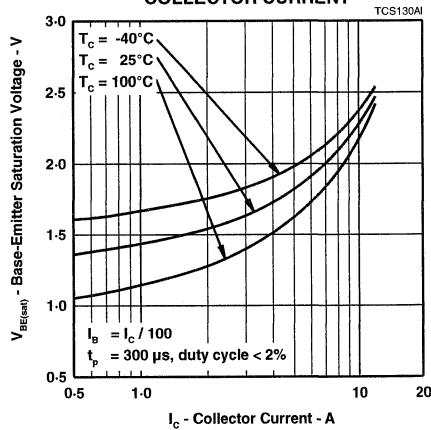


Figure 3.

**BDW93, BDW93A, BDW93B, BDW93C
NPN SILICON POWER DARLINGTONS**

SEPTEMBER 1993 - REVISED MAY 1995

THERMAL INFORMATION

**MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE**

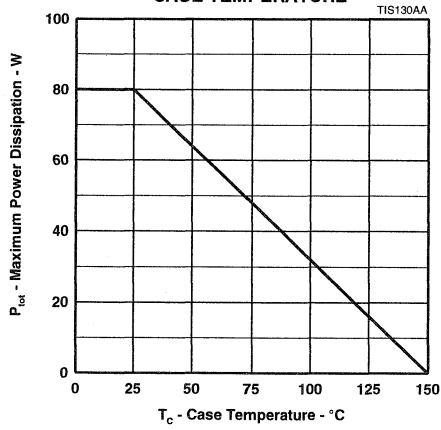


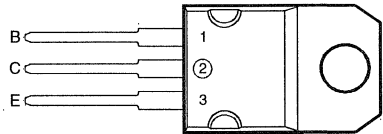
Figure 4.

BDW94, BDW94A, BDW94B, BDW94C PNP SILICON POWER DARLINGTONS

SEPTEMBER 1993 - REVISED MAY 1995

- Designed for Complementary Use with BDW93, BDW93A, BDW93B and BDW93C
- 80 W at 25°C Case Temperature
- 12 A Continuous Collector Current
- Minimum h_{FE} of 750 at 3 V, 5 A

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BDW94	V_{CBO}	-45	V
	BDW94A		-60	
	BDW94B		-80	
	BDW94C		-100	
Collector-emitter voltage ($I_B = 0$)	BDW94	V_{CEO}	-45	V
	BDW94A		-60	
	BDW94B		-80	
	BDW94C		-100	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-12	A
Continuous base current		I_B	-0.3	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 1)		P_{tot}	80	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 2)		P_{tot}	2	W
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Operating free-air temperature range		T_A	-65 to +150	°C

NOTES: 1. Derate linearly to 150°C case temperature at the rate of 0.64 W/°C.
2. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

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BDW94, BDW94A, BDW94B, BDW94C

PNP SILICON POWER DARLINGTONS

SEPTEMBER 1993 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = -100 \text{ mA}$	$I_B = 0$	(see Note 3)	BDW94	-45	V
					BDW94A	-60	
					BDW94B	-80	
					BDW94C	-100	
I_{CEO}	Collector-emitter cut-off current	$V_{CB} = -40 \text{ V}$	$I_B = 0$		BDW94	-1	mA
					BDW94A	-1	
					BDW94B	-1	
					BDW94C	-1	
I_{CBO}	Collector cut-off current	$V_{CB} = -45 \text{ V}$	$I_E = 0$		BDW94	-0.1	mA
					BDW94A	-0.1	
					BDW94B	-0.1	
					BDW94C	-0.1	
					BDW94	-5	
					BDW94A	-5	
					BDW94B	-5	
					BDW94C	-5	
I_{EBO}	Emitter cut-off current	$V_{EB} = -5 \text{ V}$	$I_C = 0$			-2	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = -3 \text{ V}$	$I_C = -3 \text{ A}$	(see Notes 3 and 4)	1000		
					100		
					750	20000	
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = -20 \text{ mA}$	$I_C = -5 \text{ A}$	(see Notes 3 and 4)		-2	V
					$I_B = -100 \text{ mA}$	$I_C = -10 \text{ A}$	
$V_{BE(sat)}$	Base-emitter saturation voltage	$I_B = -20 \text{ mA}$	$I_C = -5 \text{ A}$	(see Notes 3 and 4)		-2.5	V
					$I_B = -100 \text{ mA}$	$I_C = -10 \text{ A}$	
V_{EC}	Parallel diode forward voltage	$I_E = -5 \text{ A}$	$I_B = 0$			-2	V
					$I_E = -10 \text{ A}$	$I_B = 0$	

NOTES: 3. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.56	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

TYPICAL CHARACTERISTICS

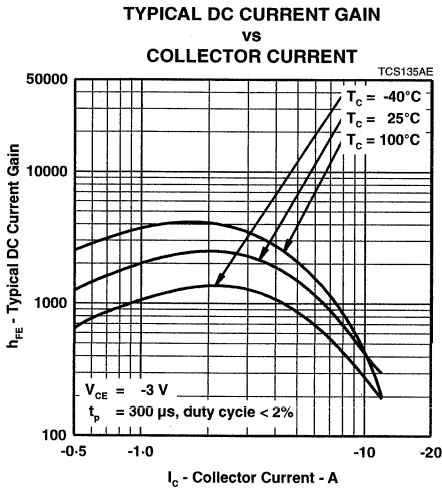


Figure 1.

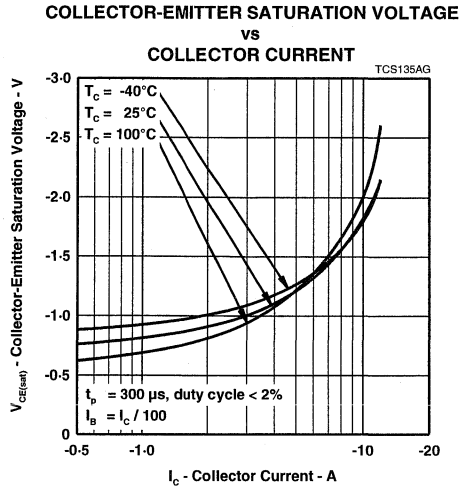


Figure 2.

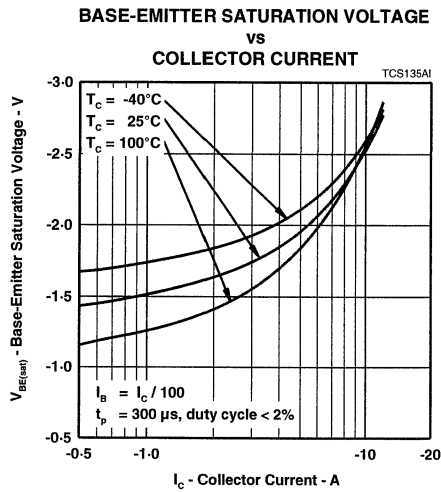


Figure 3.

BDW94, BDW94A, BDW94B, BDW94C
PNP SILICON POWER DARLINGTONS

SEPTEMBER 1993 - REVISED MAY 1995

THERMAL INFORMATION

MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE

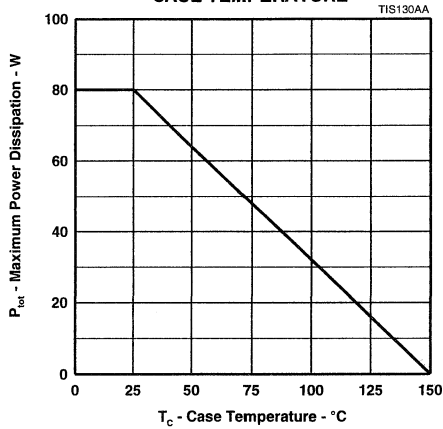
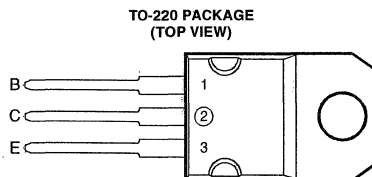


Figure 4.

BDX33, BDX33A, BDX33B, BDX33C, BDX33D NPN SILICON POWER DARLINGTONS

AUGUST 1993 - REVISED MAY 1995

- Designed for Complementary Use with BDX34, BDX34A, BDX34B, BDX34C and BDX34D
- 70 W at 25°C Case Temperature
- 10 A Continuous Collector Current
- Minimum h_{FE} of 750 at 3 V, 3 A



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BDX33	V_{CBO}	45	V
	BDX33A		60	
	BDX33B		80	
	BDX33C		100	
	BDX33D		120	
Collector-emitter voltage ($I_B = 0$)	BDX33	V_{CEO}	45	V
	BDX33A		60	
	BDX33B		80	
	BDX33C		100	
	BDX33D		120	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	10	A
Continuous base current		I_B	0.3	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 1)		P_{tot}	70	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 2)		P_{tot}	2	W
Operating free air temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Operating free-air temperature range		T_A	-65 to +150	°C

NOTES: 1. Derate linearly to 150°C case temperature at the rate of 0.56 W/°C.

2. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

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BDX33, BDX33A, BDX33B, BDX33C, BDX33D

NPN SILICON POWER DARLINGTONS

AUGUST 1993 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$ Collector-emitter breakdown voltage	$I_C = 100\text{ mA}$ $I_B = 0$ (see Note 3)	BDX33	45		V
		BDX33A	60		
		BDX33B	80		
		BDX33C	100		
		BDX33D	120		
I_{CEO} Collector-emitter cut-off current	$V_{CE} = 30\text{ V}$ $I_B = 0$	BDX33		0.5	mA
	$V_{CE} = 30\text{ V}$ $I_B = 0$	BDX33A		0.5	
	$V_{CE} = 40\text{ V}$ $I_B = 0$	BDX33B		0.5	
	$V_{CE} = 50\text{ V}$ $I_B = 0$	BDX33C		0.5	
	$V_{CE} = 60\text{ V}$ $I_B = 0$	BDX33D		0.5	
	$V_{CE} = 30\text{ V}$ $I_B = 0$ $T_C = 100^\circ\text{C}$	BDX33		10	
	$V_{CE} = 30\text{ V}$ $I_B = 0$ $T_C = 100^\circ\text{C}$	BDX33A		10	
	$V_{CE} = 40\text{ V}$ $I_B = 0$ $T_C = 100^\circ\text{C}$	BDX33B		10	
	$V_{CE} = 50\text{ V}$ $I_B = 0$ $T_C = 100^\circ\text{C}$	BDX33C		10	
	$V_{CE} = 60\text{ V}$ $I_B = 0$ $T_C = 100^\circ\text{C}$	BDX33D		10	
I_{CBO} Collector cut-off current	$V_{CB} = 45\text{ V}$ $I_E = 0$	BDX33		1	mA
	$V_{CB} = 60\text{ V}$ $I_E = 0$	BDX33A		1	
	$V_{CB} = 80\text{ V}$ $I_E = 0$	BDX33B		1	
	$V_{CB} = 100\text{ V}$ $I_E = 0$	BDX33C		1	
	$V_{CB} = 120\text{ V}$ $I_E = 0$	BDX33D		1	
	$V_{CB} = 45\text{ V}$ $I_E = 0$ $T_C = 100^\circ\text{C}$	BDX33		5	
	$V_{CB} = 60\text{ V}$ $I_E = 0$ $T_C = 100^\circ\text{C}$	BDX33A		5	
	$V_{CB} = 80\text{ V}$ $I_E = 0$ $T_C = 100^\circ\text{C}$	BDX33B		5	
	$V_{CB} = 100\text{ V}$ $I_E = 0$ $T_C = 100^\circ\text{C}$	BDX33C		5	
	$V_{CB} = 120\text{ V}$ $I_E = 0$ $T_C = 100^\circ\text{C}$	BDX33D		5	
I_{EBO} Emitter cut-off current	$V_{EB} = 5\text{ V}$ $I_C = 0$			10	mA
h_{FE} Forward current transfer ratio	$V_{CE} = 3\text{ V}$ $I_C = 4\text{ A}$	BDX33	750		
	$V_{CE} = 3\text{ V}$ $I_C = 4\text{ A}$	BDX33A	750		
	$V_{CE} = 3\text{ V}$ $I_C = 3\text{ A}$ (see Notes 3 and 4)	BDX33B	750		
	$V_{CE} = 3\text{ V}$ $I_C = 3\text{ A}$	BDX33C	750		
	$V_{CE} = 3\text{ V}$ $I_C = 3\text{ A}$	BDX33D	750		
$V_{BE(on)}$ Base-emitter voltage	$V_{CE} = 3\text{ V}$ $I_C = 4\text{ A}$	BDX33		2.5	V
	$V_{CE} = 3\text{ V}$ $I_C = 4\text{ A}$	BDX33A		2.5	
	$V_{CE} = 3\text{ V}$ $I_C = 3\text{ A}$ (see Notes 3 and 4)	BDX33B		2.5	
	$V_{CE} = 3\text{ V}$ $I_C = 3\text{ A}$	BDX33C		2.5	
	$V_{CE} = 3\text{ V}$ $I_C = 3\text{ A}$	BDX33D		2.5	
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 8\text{ mA}$ $I_C = 4\text{ A}$	BDX33		2.5	V
	$I_B = 8\text{ mA}$ $I_C = 4\text{ A}$	BDX33A		2.5	
	$I_B = 6\text{ mA}$ $I_C = 3\text{ A}$ (see Notes 3 and 4)	BDX33B		2.5	
	$I_B = 6\text{ mA}$ $I_C = 3\text{ A}$	BDX33C		2.5	
	$I_B = 6\text{ mA}$ $I_C = 3\text{ A}$	BDX33D		2.5	
V_{EC} Parallel diode forward voltage	$I_E = 8\text{ A}$ $I_B = 0$			4	V

NOTES: 3. These parameters must be measured using pulse techniques, $t_p = 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

BDX33, BDX33A, BDX33B, BDX33C, BDX33D NPN SILICON POWER DARLINGTONS

AUGUST 1993 - REVISED MAY 1995

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.78	$^{\circ}\text{C}/\text{W}$
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	$^{\circ}\text{C}/\text{W}$

resistive-load-switching characteristics at 25 $^{\circ}\text{C}$ case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = 3\text{ A}$	$I_{B(on)} = 12\text{ mA}$	$I_{B(off)} = -12\text{ mA}$		1		μs
t_{off}	Turn-off time	$V_{BE(off)} = -3.5\text{ V}$	$R_L = 10\ \Omega$	$t_p = 20\ \mu\text{s}$, dc $\leq 2\%$		5		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

BDX33, BDX33A, BDX33B, BDX33C, BDX33D
NPN SILICON POWER DARLINGTONS

AUGUST 1993 - REVISED MAY 1995

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
VS
COLLECTOR CURRENT

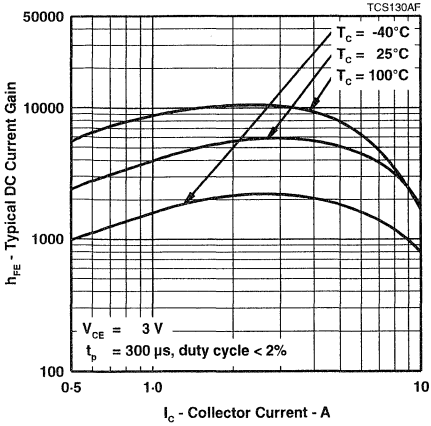


Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE
VS
COLLECTOR CURRENT

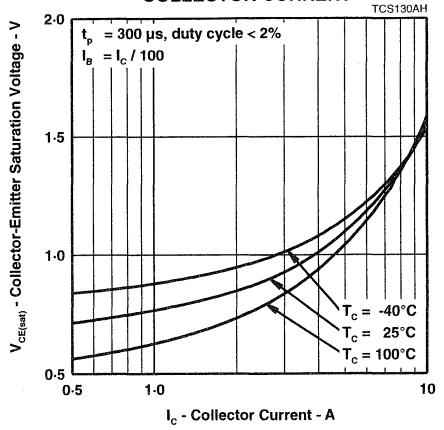


Figure 2.

BASE-EMITTER SATURATION VOLTAGE
VS
COLLECTOR CURRENT

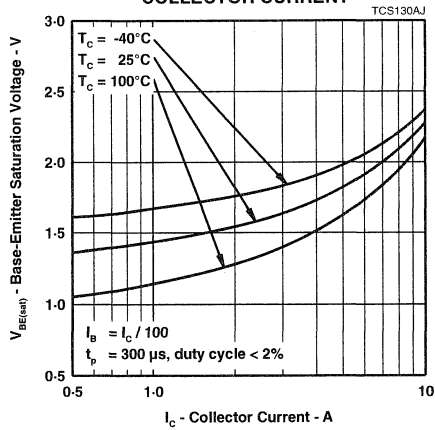


Figure 3.

THERMAL INFORMATION

**MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE**

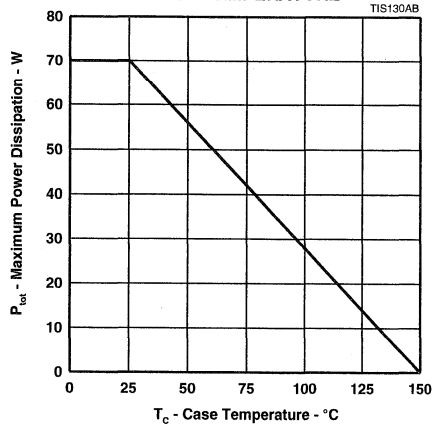


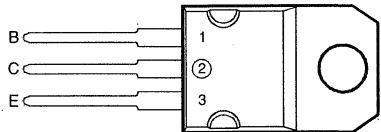
Figure 4.

BDX34, BDX34A, BDX34B, BDX34C, BDX34D PNP SILICON POWER DARLINGTONS

AUGUST 1993 - REVISED MAY 1995

- Designed for Complementary Use with BDX33, BDX33A, BDX33B, BDX33C and BDX33D
- 70 W at 25°C Case Temperature
- 10 A Continuous Collector Current
- Minimum h_{FE} of 750 at 3 V, 3 A

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BDX34	V_{CBO}	-45	V
	BDX34A		-60	
	BDX34B		-80	
	BDX34C		-100	
	BDX34D		-120	
Collector-emitter voltage ($I_B = 0$)	BDX34	V_{CEO}	-45	V
	BDX34A		-60	
	BDX34B		-80	
	BDX34C		-100	
	BDX34D		-120	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-10	A
Continuous base current		I_B	-0.3	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 1)		P_{tot}	70	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 2)		P_{tot}	2	W
Operating free air temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Operating free-air temperature range		T_A	-65 to +150	°C

- NOTES: 1. Derate linearly to 150°C case temperature at the rate of 0.56 W/°C.
2. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

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 **TEXAS
INSTRUMENTS**

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BDX34, BDX34A, BDX34B, BDX34C, BDX34D

PNP SILICON POWER DARLINGTONS

AUGUST 1993 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT	
$V_{(BR)CEO}$ Collector-emitter breakdown voltage	$I_C = -100 \text{ mA}$	$I_B = 0$	(see Note 3)	BDX34 BDX34A BDX34B BDX34C BDX34D	-45 -60 -80 -100 -120		V	
I_{CEO} Collector-emitter cut-off current	$V_{CE} = -30 \text{ V}$ $V_{CE} = -30 \text{ V}$ $V_{CE} = -40 \text{ V}$ $V_{CE} = -50 \text{ V}$ $V_{CE} = -60 \text{ V}$ $V_{CE} = -30 \text{ V}$ $V_{CE} = -30 \text{ V}$ $V_{CE} = -40 \text{ V}$ $V_{CE} = -50 \text{ V}$ $V_{CE} = -60 \text{ V}$	$I_B = 0$ $I_B = 0$ $I_B = 0$ $I_B = 0$ $I_B = 0$ $I_B = 0$ $I_B = 0$ $I_B = 0$ $I_B = 0$ $I_B = 0$	$T_C = 100^\circ\text{C}$ $T_C = 100^\circ\text{C}$ $T_C = 100^\circ\text{C}$ $T_C = 100^\circ\text{C}$ $T_C = 100^\circ\text{C}$	BDX34 BDX34A BDX34B BDX34C BDX34D BDX34 BDX34A BDX34B BDX34C BDX34D			-0.5 -0.5 -0.5 -0.5 -0.5 -10 -10 -10 -10 -10	mA
I_{CBO} Collector cut-off current	$V_{CB} = -45 \text{ V}$ $V_{CB} = -60 \text{ V}$ $V_{CB} = -80 \text{ V}$ $V_{CB} = -100 \text{ V}$ $V_{CB} = -120 \text{ V}$ $V_{CB} = -45 \text{ V}$ $V_{CB} = -60 \text{ V}$ $V_{CB} = -80 \text{ V}$ $V_{CB} = -100 \text{ V}$ $V_{CB} = -120 \text{ V}$	$I_E = 0$ $I_E = 0$ $I_E = 0$ $I_E = 0$ $I_E = 0$ $I_E = 0$ $I_E = 0$ $I_E = 0$ $I_E = 0$ $I_E = 0$	$T_C = 100^\circ\text{C}$ $T_C = 100^\circ\text{C}$ $T_C = 100^\circ\text{C}$ $T_C = 100^\circ\text{C}$ $T_C = 100^\circ\text{C}$	BDX34 BDX34A BDX34B BDX34C BDX34D BDX34 BDX34A BDX34B BDX34C BDX34D			-1 -1 -1 -1 -1 -5 -5 -5 -5 -5	mA
I_{EBO} Emitter cut-off current	$V_{EB} = -5 \text{ V}$	$I_C = 0$					-10	mA
η_{FE} Forward current transfer ratio	$V_{CE} = -3 \text{ V}$ $V_{CE} = -3 \text{ V}$ $V_{CE} = -3 \text{ V}$ $V_{CE} = -3 \text{ V}$ $V_{CE} = -3 \text{ V}$	$I_C = -4 \text{ A}$ $I_C = -4 \text{ A}$ $I_C = -3 \text{ A}$ $I_C = -3 \text{ A}$ $I_C = -3 \text{ A}$	(see Notes 3 and 4)	BDX34 BDX34A BDX34B BDX34C BDX34D	750 750 750 750 750			
$V_{BE(on)}$ Base-emitter voltage	$V_{CE} = -3 \text{ V}$ $V_{CE} = -3 \text{ V}$ $V_{CE} = -3 \text{ V}$ $V_{CE} = -3 \text{ V}$ $V_{CE} = -3 \text{ V}$	$I_C = -4 \text{ A}$ $I_C = -4 \text{ A}$ $I_C = -3 \text{ A}$ $I_C = -3 \text{ A}$ $I_C = -3 \text{ A}$	(see Notes 3 and 4)	BDX34 BDX34A BDX34B BDX34C BDX34D			-2.5 -2.5 -2.5 -2.5 -2.5	V
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = -8 \text{ mA}$ $I_B = -8 \text{ mA}$ $I_B = -6 \text{ mA}$ $I_B = -6 \text{ mA}$	$I_C = -4 \text{ A}$ $I_C = -4 \text{ A}$ $I_C = -3 \text{ A}$ $I_C = -3 \text{ A}$	(see Notes 3 and 4)	BDX34 BDX34A BDX34B BDX34C BDX34D			-2.5 -2.5 -2.5 -2.5	V
V_{EC} Parallel diode forward voltage	$I_E = -8 \text{ A}$	$I_B = 0$					-4	V

NOTES: 3. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

BDX34, BDX34A, BDX34B, BDX34C, BDX34D PNP SILICON POWER DARLINGTONS

AUGUST 1993 - REVISED MAY 1995

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.78	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = -3 \text{ A}$	$I_{B(on)} = -12 \text{ mA}$	$I_{B(off)} = 12 \text{ mA}$		1		μs
t_{off}	Turn-off time	$V_{BE(off)} = 3.5 \text{ V}$	$R_L = 10 \Omega$	$t_p = 20 \mu\text{s}, dc \leq 2\%$		5		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

BDX34, BDX34A, BDX34B, BDX34C, BDX34D
PNP SILICON POWER DARLINGTONS

AUGUST 1993 - REVISED MAY 1995

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
vs
COLLECTOR CURRENT

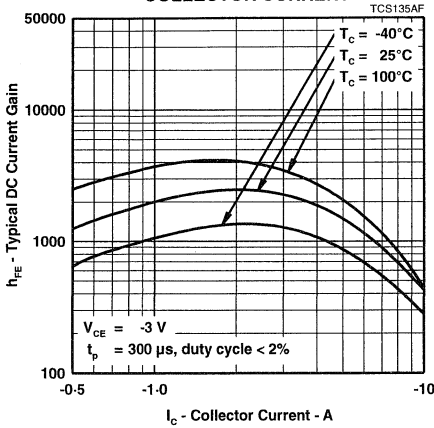


Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE
vs
COLLECTOR CURRENT

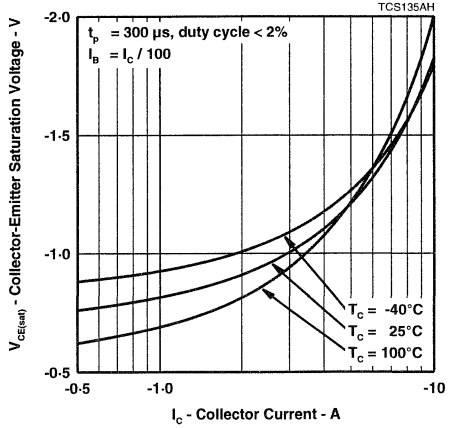


Figure 2.

BASE-EMITTER SATURATION VOLTAGE
vs
COLLECTOR CURRENT

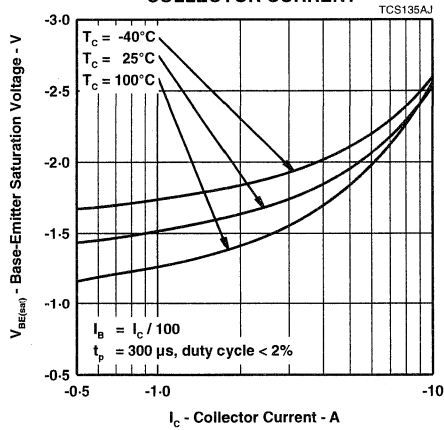


Figure 3.

HERMAL INFORMATION

MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE

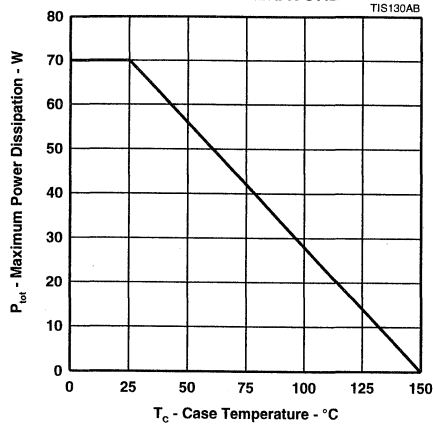


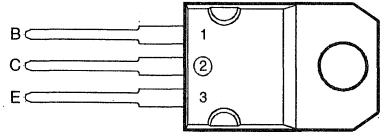
Figure 4.

BDX53, BDX53A, BDX53B, BDX53C NPN SILICON POWER DARLINGTONS

MAY 1989 - REVISED MAY 1995

- Designed for Complementary Use with BDX54, BDX54A, BDX54B and BDX54C
- 60 W at 25°C Case Temperature
- 8 A Continuous Collector Current
- Minimum h_{FE} of 750 at 3 V, 3 A

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BDX53	V_{CBO}	45	V
	BDX53A		60	
	BDX53B		80	
	BDX53C		100	
Collector-emitter voltage ($I_B = 0$)	BDX53	V_{CEO}	45	V
	BDX53A		60	
	BDX53B		80	
	BDX53C		100	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	8	A
Continuous base current		I_B	0.2	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 1)		P_{tot}	60	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 2)		P_{tot}	2	W
Operating junction temperature range		T_J	-65 to +150	°C
Operating temperature range		T_{stg}	-65 to +150	°C
Operating free-air temperature range		T_A	-65 to +150	°C

- NOTES: 1. Derate linearly to 150°C case temperature at the rate of 0.48 W/°C.
2. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

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 **TEXAS
INSTRUMENTS**

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BDX53, BDX53A, BDX53B, BDX53C

NPN SILICON POWER DARLINGTONS

MAY 1989 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = 100 \text{ mA}$	$I_B = 0$	(see Note 3)	BDX53	45		V
					BDX53A	60		
					BDX53B	80		
					BDX53C	100		
I_{CEO}	Collector-emitter cut-off current	$V_{CE} = 30 \text{ V}$	$I_B = 0$		BDX53		0.5	mA
					BDX53A		0.5	
					BDX53B		0.5	
					BDX53C		0.5	
I_{CBO}	Collector cut-off current	$V_{CB} = 45 \text{ V}$	$I_E = 0$		BDX53		0.2	mA
					BDX53A		0.2	
					BDX53B		0.2	
					BDX53C		0.2	
I_{EBO}	Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$			2	mA	
h_{FE}	Forward current transfer ratio	$V_{CE} = 3 \text{ V}$	$I_C = 3 \text{ A}$	(see Notes 3 and 4)	750			
$V_{BE(sat)}$	Base-emitter saturation voltage	$I_B = 12 \text{ mA}$	$I_C = 3 \text{ A}$	(see Notes 3 and 4)			2.5	V
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = 12 \text{ mA}$	$I_C = 3 \text{ A}$	(see Notes 3 and 4)			2	V
V_{EC}	Parallel diode forward voltage	$I_E = 3 \text{ A}$	$I_B = 0$				2.5	V

NOTES: 3. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

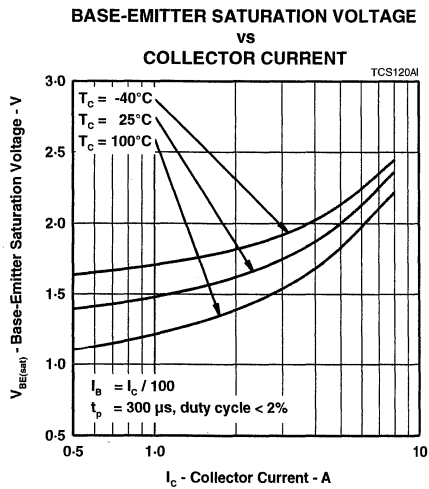
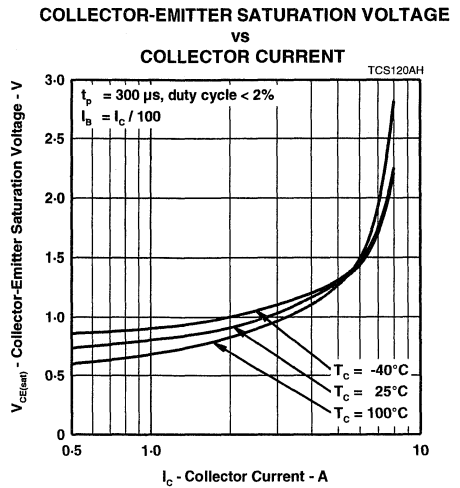
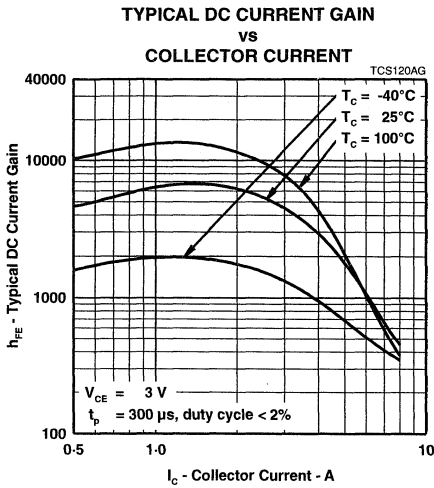
PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			2.08	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = 3 \text{ A}$	$I_{B(on)} = 12 \text{ mA}$	$I_{B(off)} = -12 \text{ mA}$		1		μs
t_{off}	Turn-off time	$V_{BE(off)} = -4.5 \text{ V}$	$R_L = 10 \Omega$	$t_p = 20 \mu\text{s}$, dc $\leq 2\%$		5		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS



BDX53, BDX53A, BDX53B, BDX53C
NPN SILICON POWER DARLINGTONS

MAY 1989 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

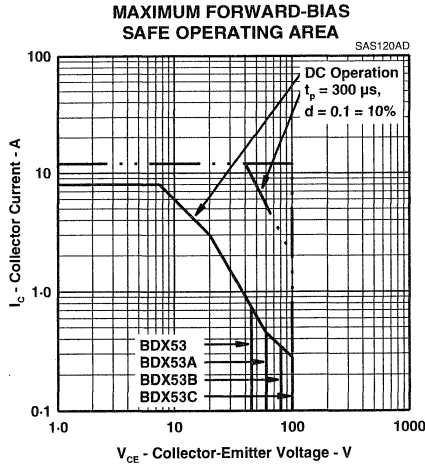


Figure 4.

THERMAL INFORMATION

**MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE**

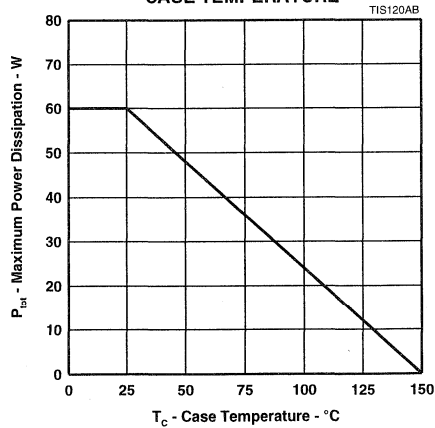


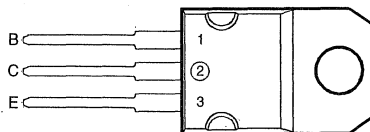
Figure 5.

BDX54, BDX54A, BDX54B, BDX54C PNP SILICON POWER DARLINGTONS

MAY 1989 - REVISED MAY 1995

- Designed for Complementary Use with BDX53, BDX53A, BDX53B and BDX53C
- 60 W at 25°C Case Temperature
- 8 A Continuous Collector Current
- Minimum h_{FE} of 750 at 3 V, 3 A

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BDX54	V_{CBO}	-45	V
	BDX54A		-60	
	BDX54B		-80	
	BDX54C		-100	
Collector-emitter voltage ($I_B = 0$)	BDX54	V_{CEO}	-45	V
	BDX54A		-60	
	BDX54B		-80	
	BDX54C		-100	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-8	A
Continuous base current		I_B	-0.2	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 1)		P_{tot}	60	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 2)		P_{tot}	2	W
Operating junction temperature range		T_j	-65 to +150	°C
Operating temperature range		T_{stg}	-65 to +150	°C
Operating free-air temperature range		T_A	-65 to +150	°C

- NOTES: 1. Derate linearly to 150°C case temperature at the rate of 0.48 W/°C.
2. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

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 **TEXAS
INSTRUMENTS**

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BDX54, BDX54A, BDX54B, BDX54C

PNP SILICON POWER DARLINGTONS

MAY 1989 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = -100 \text{ mA}$	$I_B = 0$	(see Note 3)	BDX54			-45
					BDX54A			-60
					BDX54B			-80
					BDX54C			-100
I_{CEO}	Collector-emitter cut-off current				BDX54			-0.5
					BDX54A			-0.5
					BDX54B			-0.5
					BDX54C			-0.5
I_{CBO}	Collector cut-off current				BDX54			-0.2
					BDX54A			-0.2
					BDX54B			-0.2
					BDX54C			-0.2
I_{EBO}	Emitter cut-off current	$V_{EB} = -5 \text{ V}$	$I_C = 0$				-2	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = -3 \text{ V}$	$I_C = -3 \text{ A}$	(see Notes 3 and 4)	750			
$V_{BE(sat)}$	Base-emitter saturation voltage	$I_B = -12 \text{ mA}$	$I_C = -3 \text{ A}$	(see Notes 3 and 4)			-2.5	V
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = -12 \text{ mA}$	$I_C = -3 \text{ A}$	(see Notes 3 and 4)			-2	V
V_{EC}	Parallel diode forward voltage	$I_E = -3 \text{ A}$	$I_B = 0$				-2.5	V

NOTES: 3. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			2.08	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = -3 \text{ A}$	$I_{B(on)} = -12 \text{ mA}$	$I_{B(off)} = 12 \text{ mA}$		1		μs
t_{off}	Turn-off time	$V_{BE(off)} = 4.2 \text{ V}$	$R_L = 10 \Omega$	$t_p = 20 \mu\text{s}$, $d_c \leq 2\%$		5		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
vs
COLLECTOR CURRENT

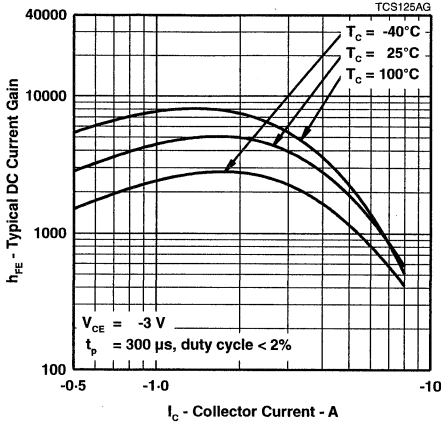


Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE
vs
COLLECTOR CURRENT

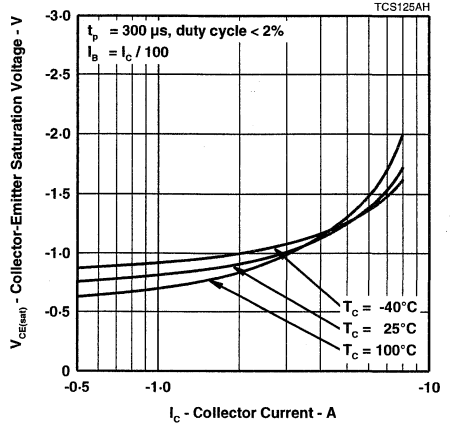


Figure 2.

BASE-EMITTER SATURATION VOLTAGE
vs
COLLECTOR CURRENT

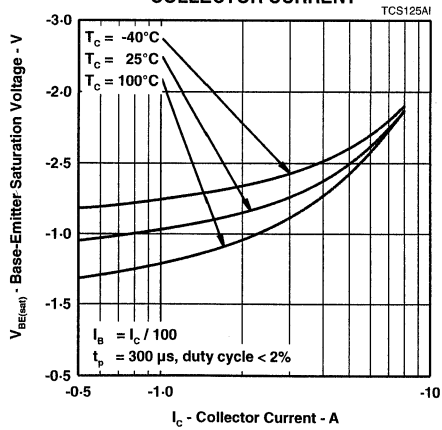


Figure 3.

BDX54, BDX54A, BDX54B, BDX54C
PNP SILICON POWER DARLINGTONS

MAY 1989 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

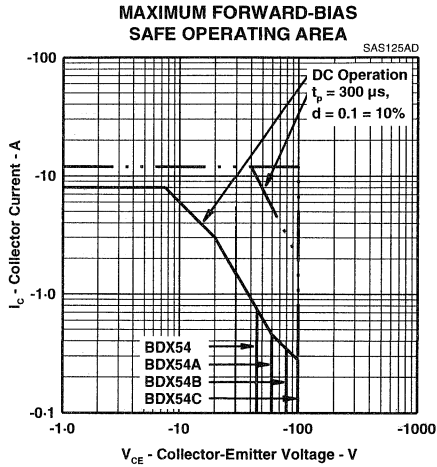


Figure 4.

THERMAL INFORMATION

**MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE**

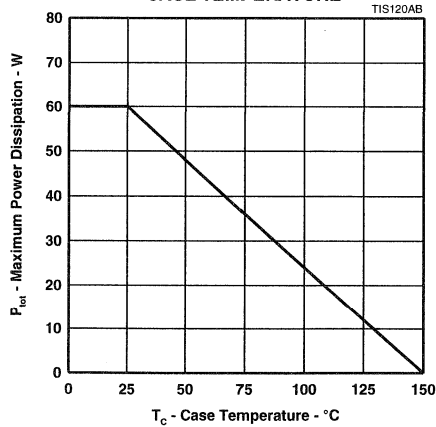


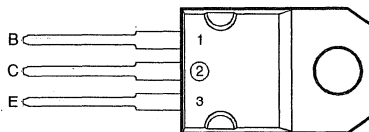
Figure 5.

TIP100, TIP101, TIP102 NPN SILICON POWER DARLINGTONS

AUGUST 1978 - REVISED MAY 1995

- Designed for Complementary Use with TIP105, TIP106 and TIP107
- 80 W at 25°C Case Temperature
- 8 A Continuous Collector Current
- Maximum $V_{CE(sat)}$ of 2.5 V at $I_C = 8$ A

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIP100	V_{CBO}	60	V
	TIP101		80	
	TIP102		100	
Collector-emitter voltage ($I_B = 0$)	TIP100	V_{CEO}	60	V
	TIP101		80	
	TIP102		100	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	8	A
Peak collector current (see Note 1)		I_{CM}	15	A
Continuous base current		I_B	1	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	80	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	10	mJ
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

- NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.
 2. Derate linearly to 150°C case temperature at the rate of 0.64 W/°C.
 3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.
 4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = 5$ mA, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = 20$ V.

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 **TEXAS
INSTRUMENTS**

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TIP100, TIP101, TIP102

NPN SILICON POWER DARLINGTONS

AUGUST 1978 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$ Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$ (see Note 5)	$I_B = 0$	TIP100	60			V
			TIP101	80			
			TIP102	100			
I_{CEO} Collector-emitter cut-off current	$V_{CE} = 30 \text{ V}$ $V_{CE} = 40 \text{ V}$ $V_{CE} = 50 \text{ V}$	$I_B = 0$	TIP100			50	μA
		$I_B = 0$	TIP101			50	
		$I_B = 0$	TIP102			50	
I_{CBO} Collector cut-off current	$V_{CB} = 60 \text{ V}$ $V_{CB} = 80 \text{ V}$ $V_{CB} = 100 \text{ V}$	$I_E = 0$	TIP100			50	μA
		$I_E = 0$	TIP101			50	
		$I_E = 0$	TIP102			50	
I_{EBO} Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$				8	mA
h_{FE} Forward current transfer ratio	$V_{CE} = 4 \text{ V}$	$I_C = 3 \text{ A}$	(see Notes 5 and 6)	1000		20000	
	$V_{CE} = 4 \text{ V}$	$I_C = 8 \text{ A}$		200			
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 6 \text{ mA}$ $I_B = 80 \text{ mA}$	$I_C = 3 \text{ A}$	(see Notes 5 and 6)			2	V
		$I_C = 8 \text{ A}$				2.5	
V_{BE} Base-emitter voltage	$V_{CE} = 4 \text{ V}$	$I_C = 8 \text{ A}$	(see Notes 5 and 6)			2.8	V
V_{EC} Parallel diode forward voltage	$I_E = 8 \text{ A}$	$I_B = 0$	(see Notes 5 and 6)			3.5	V

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1.56	$^{\circ}\text{C}/\text{W}$
$R_{\theta JA}$ Junction to free air thermal resistance			62.5	$^{\circ}\text{C}/\text{W}$
$C_{\theta C}$ Thermal capacitance of case		0.9		$\text{J}/^{\circ}\text{C}$

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_d Delay time	$I_C = 8 \text{ A}$ $V_{BE(off)} = -5 \text{ V}$	$I_{B(on)} = 80 \text{ mA}$ $R_L = 5 \Omega$	$I_{B(off)} = -80 \text{ mA}$ $t_p = 20 \mu\text{s}$, $dc \leq 2\%$		35		ns
t_r Rise time					350		ns
t_s Storage time					1.8		μs
t_f Fall time					2.45		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

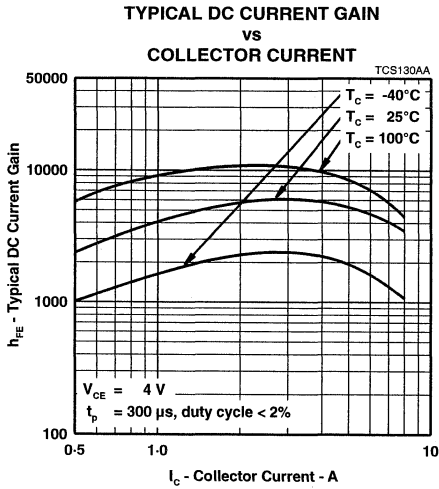


Figure 1.

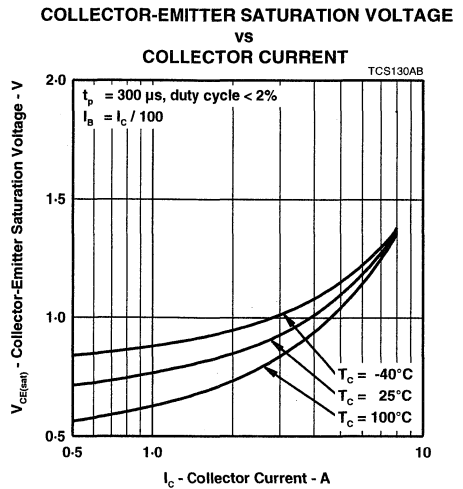


Figure 2.

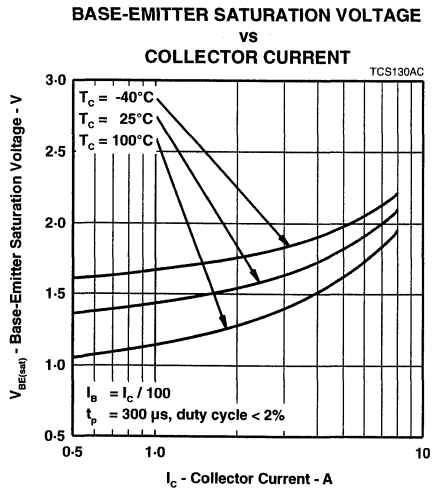


Figure 3.

TIP100, TIP101, TIP102
NPN SILICON POWER DARLINGTONS

AUGUST 1978 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

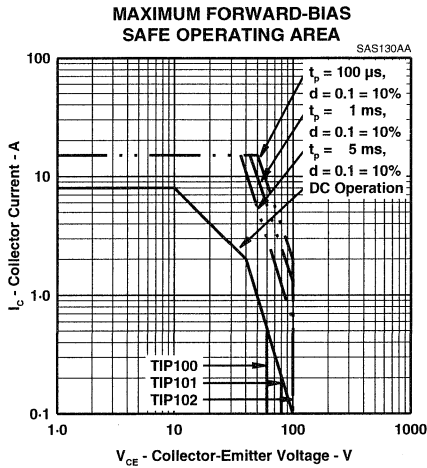


Figure 4.

THERMAL INFORMATION

MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE

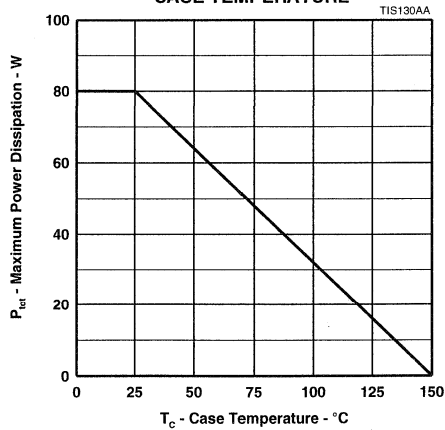


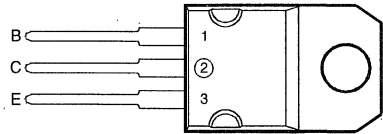
Figure 5.

TIP105, TIP106, TIP107 PNP SILICON POWER DARLINGTONS

AUGUST 1978 - REVISED MAY 1995

- Designed for Complementary Use with TIP100, TIP101 and TIP102
- 80 W at 25°C Case Temperature
- 8 A Continuous Collector Current
- Maximum $V_{CE(sat)}$ of 2.5 V at $I_C = 8$ A

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIP105	V_{CBO}	-60	V
	TIP106		-80	
	TIP107		-100	
Collector-emitter voltage ($I_B = 0$)	TIP105	V_{CEO}	-60	V
	TIP106		-80	
	TIP107		-100	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-8	A
Peak collector current (see Note 1)		I_{CM}	-15	A
Continuous base current		I_B	-1	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	80	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	10	mJ
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.

2. Derate linearly to 150°C case temperature at the rate of 0.64 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = -5$ mA, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = -20$ V.

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 **TEXAS
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TIP105, TIP106, TIP107

PNP SILICON POWER DARLINGTONS

AUGUST 1978 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$ Collector-emitter breakdown voltage	$I_C = -30 \text{ mA}$ (see Note 5)	$I_B = 0$	TIP105 TIP106 TIP107	-60 -80 -100			V
I_{CEO} Collector-emitter cut-off current	$V_{CE} = -30 \text{ V}$ $V_{CE} = -40 \text{ V}$ $V_{CE} = -50 \text{ V}$	$I_B = 0$ $I_B = 0$ $I_B = 0$	TIP105 TIP106 TIP107			-50 -50 -50	μA
I_{CBO} Collector cut-off current	$V_{CB} = -60 \text{ V}$ $V_{CB} = -80 \text{ V}$ $V_{CB} = -100 \text{ V}$	$I_E = 0$ $I_E = 0$ $I_E = 0$	TIP105 TIP106 TIP107			-50 -50 -50	μA
I_{EBO} Emitter cut-off current	$V_{EB} = -5 \text{ V}$	$I_C = 0$				-8	mA
h_{FE} Forward current transfer ratio	$V_{CE} = -4 \text{ V}$ $V_{CE} = -4 \text{ V}$	$I_C = -3 \text{ A}$ $I_C = -8 \text{ A}$	(see Notes 5 and 6)	1000 200		20000	
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = -6 \text{ mA}$ $I_B = -80 \text{ mA}$	$I_C = -3 \text{ A}$ $I_C = -8 \text{ A}$	(see Notes 5 and 6)			-2 -2.5	V
V_{BE} Base-emitter voltage	$V_{CE} = -4 \text{ V}$	$I_C = -8 \text{ A}$	(see Notes 5 and 6)			-2.8	V
V_{EC} Parallel diode forward voltage	$I_E = -8 \text{ A}$	$I_B = 0$	(see Notes 5 and 6)			-3.5	V

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1.56	$^{\circ}\text{C/W}$
$R_{\theta JA}$ Junction to free air thermal resistance			62.5	$^{\circ}\text{C/W}$
$C_{\theta C}$ Thermal capacitance of case		0.9		$\text{J}/^{\circ}\text{C}$

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_d Delay time					35		ns
t_r Rise time	$I_C = -8 \text{ A}$	$I_{B(on)} = -80 \text{ mA}$	$I_{B(off)} = 80 \text{ mA}$		300		ns
t_s Storage time	$V_{BE(off)} = 5 \text{ V}$	$R_L = 5 \Omega$	$t_p = 20 \mu\text{s}$, dc $\leq 2\%$		900		ns
t_f Fall time					1.3		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

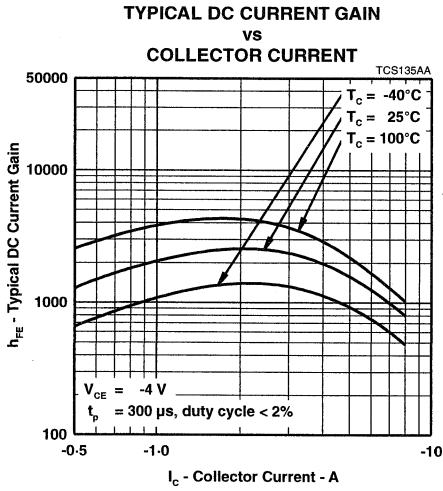


Figure 1.

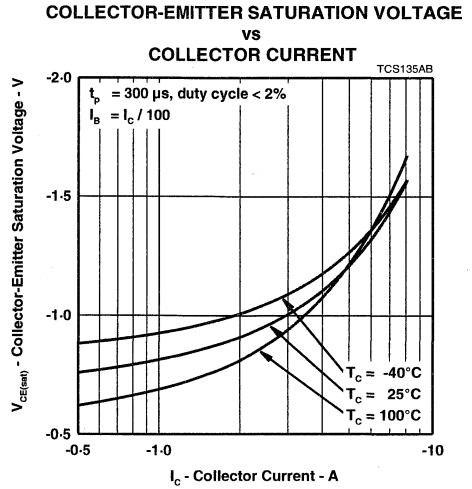


Figure 2.

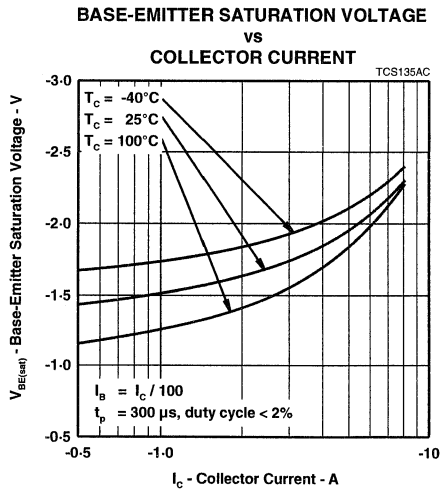


Figure 3.

TIP105, TIP106, TIP107
PNP SILICON POWER DARLINGTONS

AUGUST 1978 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

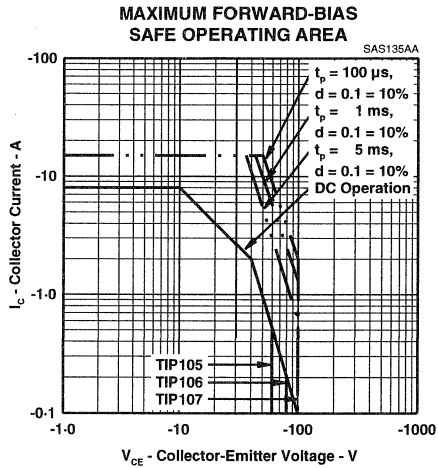


Figure 4.

THERMAL INFORMATION

MAXIMUM POWER DISSIPATION
VS
CASE TEMPERATURE

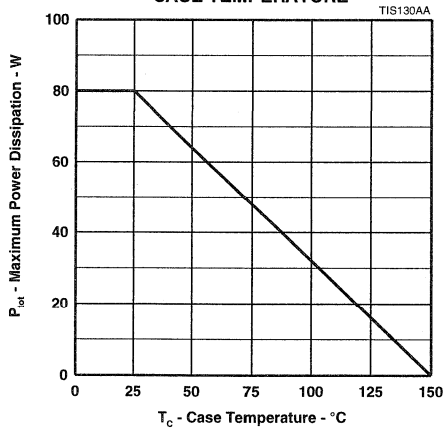
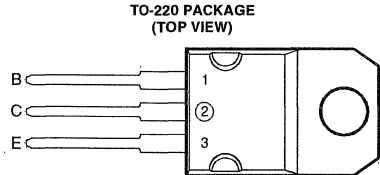


Figure 5.

TIP110, TIP111, TIP112 NPN SILICON POWER DARLINGTONS

DECEMBER 1971 - REVISED MAY 1995

- Designed for Complementary Use with TIP115, TIP116 and TIP117
- 50 W at 25°C Case Temperature
- 4 A Continuous Collector Current
- Minimum h_{FE} of 500 at 4 V, 2 A



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIP110	V_{CBO}	60	V
	TIP111		80	
	TIP112		100	
Collector-emitter voltage ($I_B = 0$)	TIP110	V_{CEO}	60	V
	TIP111		80	
	TIP112		100	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	4	A
Peak collector current (see Note 1)		I_{CM}	6	A
Continuous base current		I_B	50	mA
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	50	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	25	mJ
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.

2. Derate linearly to 150°C case temperature at the rate of 0.4 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = 5$ mA, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = 20$ V.

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 **TEXAS
INSTRUMENTS**

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TIP110, TIP111, TIP112

NPN SILICON POWER DARLINGTONS

DECEMBER 1971 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$ (see Note 5)	$I_B = 0$	TIP110	60			V
				TIP111	80			
				TIP112	100			
I_{CEO}	Collector-emitter cut-off current	$V_{CE} = 30 \text{ V}$ $V_{CE} = 40 \text{ V}$ $V_{CE} = 50 \text{ V}$	$I_B = 0$ $I_B = 0$ $I_B = 0$	TIP110			2	mA
				TIP111			2	
				TIP112			2	
I_{CBO}	Collector cut-off current	$V_{CB} = 60 \text{ V}$ $V_{CB} = 80 \text{ V}$ $V_{CB} = 100 \text{ V}$	$I_E = 0$ $I_E = 0$ $I_E = 0$	TIP110			1	mA
				TIP111			1	
				TIP112			1	
I_{EBO}	Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$				2	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = 4 \text{ V}$	$I_C = 1 \text{ A}$	(see Notes 5 and 6)	1000			
		$V_{CE} = 4 \text{ V}$	$I_C = 2 \text{ A}$		500			
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = 8 \text{ mA}$	$I_C = 2 \text{ A}$	(see Notes 5 and 6)			2.5	V
V_{BE}	Base-emitter voltage	$V_{CE} = 4 \text{ V}$	$I_C = 2 \text{ A}$	(see Notes 5 and 6)			2.8	V
V_{EC}	Parallel diode forward voltage	$I_E = 4 \text{ A}$	$I_B = 0$	(see Notes 5 and 6)			3.5	V

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = 2 \text{ A}$ $V_{BE(off)} = -5 \text{ V}$	$I_{B(on)} = 8 \text{ mA}$ $R_L = 15 \Omega$	$I_{B(off)} = -8 \text{ mA}$ $t_p = 20 \mu\text{s}$, $dc \leq 2\%$		2.6		μs
t_{off}	Turn-off time					4.5		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

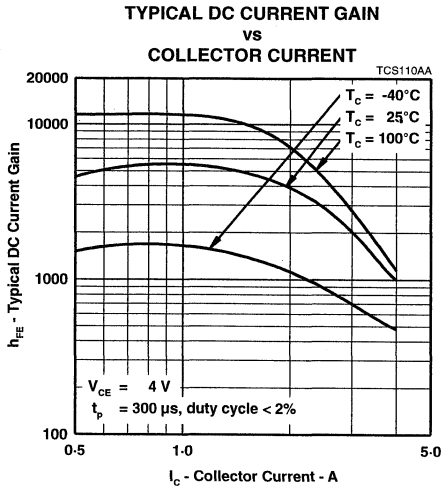


Figure 1.

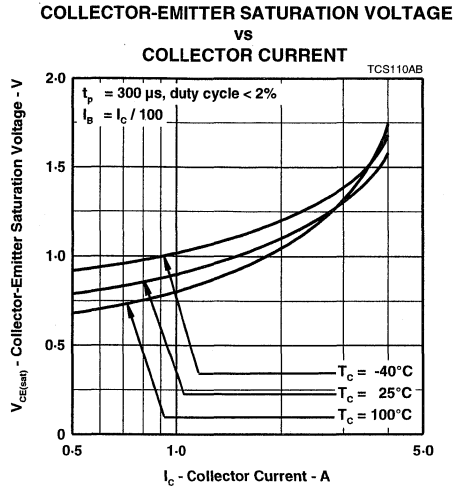


Figure 2.

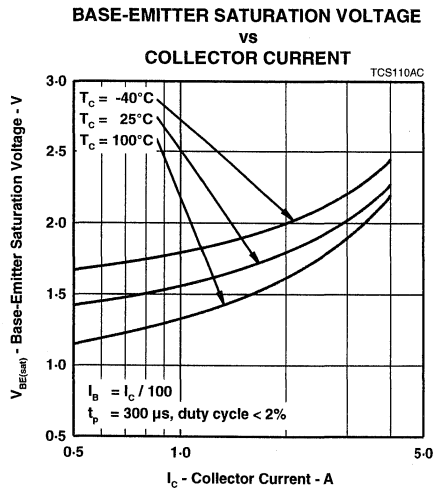


Figure 3.

TIP110, TIP111, TIP112 NPN SILICON POWER DARLINGTONS

DECEMBER 1971 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

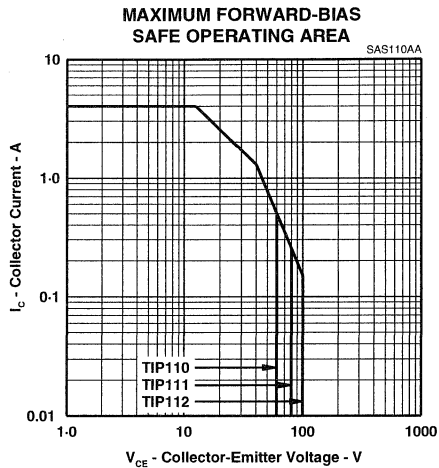


Figure 4.

THERMAL INFORMATION

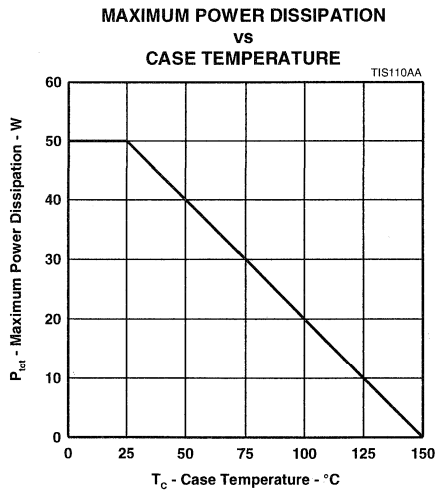
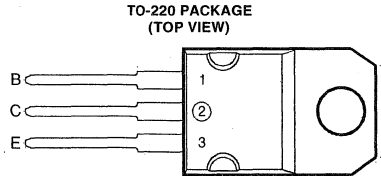


Figure 5.

TIP115, TIP116, TIP117 PNP SILICON POWER DARLINGTONS

DECEMBER 1971 - REVISED MAY 1995

- Designed for Complementary Use with TIP110, TIP111 and TIP112
- 50 W at 25°C Case Temperature
- 4 A Continuous Collector Current
- Minimum h_{FE} of 500 at 4 V, 2 A



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIP115	V_{CBO}	-60	V
	TIP116		-80	
	TIP117		-100	
Collector-emitter voltage ($I_B = 0$)	TIP115	V_{CEO}	-60	V
	TIP116		-80	
	TIP117		-100	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-4	A
Peak collector current (see Note 1)		I_{CM}	-6	A
Continuous base current		I_B	-50	mA
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	50	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	25	mJ
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.

2. Derate linearly to 150°C case temperature at the rate of 0.4 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = -5$ mA, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = -20$ V.

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 **TEXAS
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TIP115, TIP116, TIP117

PNP SILICON POWER DARLINGTONS

DECEMBER 1971 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = -30 \text{ mA}$ (see Note 5)	$I_B = 0$	TIP115	-60			V
				TIP116	-80			
				TIP117	-100			
I_{CEO}	Collector-emitter cut-off current	$V_{CE} = -30 \text{ V}$ $V_{CE} = -40 \text{ V}$ $V_{CE} = -50 \text{ V}$	$I_B = 0$	TIP115			-2	mA
			$I_B = 0$	TIP116			-2	
			$I_B = 0$	TIP117			-2	
I_{CBO}	Collector cut-off current	$V_{CB} = -60 \text{ V}$ $V_{CB} = -80 \text{ V}$ $V_{CB} = -100 \text{ V}$	$I_E = 0$	TIP115			-1	mA
			$I_E = 0$	TIP116			-1	
			$I_E = 0$	TIP117			-1	
I_{EBO}	Emitter cut-off current	$V_{EB} = -5 \text{ V}$	$I_C = 0$				-2	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = -4 \text{ V}$	$I_C = -1 \text{ A}$	(see Notes 5 and 6)	1000			
		$V_{CE} = -4 \text{ V}$	$I_C = -2 \text{ A}$		500			
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = -8 \text{ mA}$	$I_C = -2 \text{ A}$	(see Notes 5 and 6)			-2.5	V
V_{BE}	Base-emitter voltage	$V_{CE} = -4 \text{ V}$	$I_C = -2 \text{ A}$	(see Notes 5 and 6)			-2.8	V
V_{EC}	Parallel diode forward voltage	$I_E = -5 \text{ A}$	$I_B = 0$	(see Notes 5 and 6)			-3.5	V

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = -2 \text{ A}$ $V_{BE(off)} = 5 \text{ V}$	$I_{B(on)} = -8 \text{ mA}$ $R_L = 15 \Omega$	$I_{B(off)} = 8 \text{ mA}$ $t_p = 20 \mu\text{s}$, dc $\leq 2\%$		2.6		μs
t_{off}	Turn-off time					4.5		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

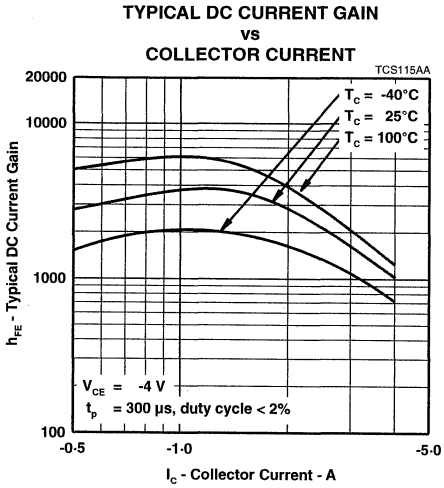


Figure 1.

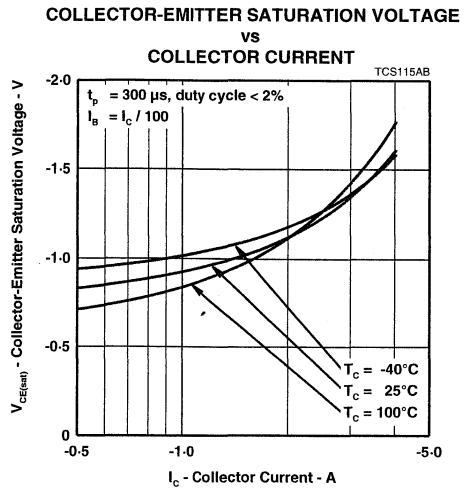


Figure 2.

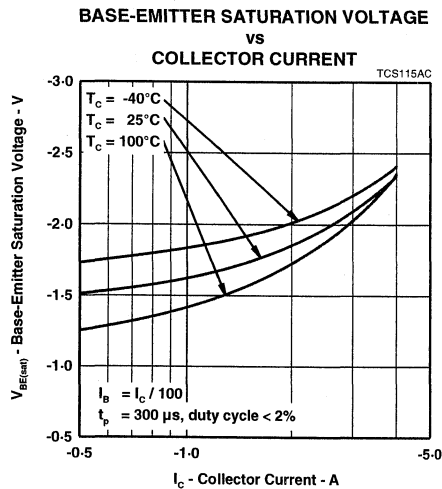


Figure 3.

TIP115, TIP116, TIP117 PNP SILICON POWER DARLINGTONS

DECEMBER 1971 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

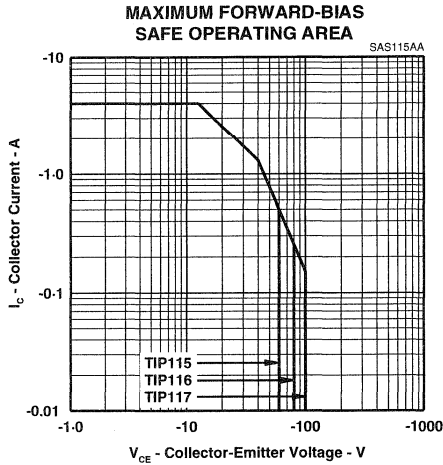


Figure 4.

THERMAL INFORMATION

MAXIMUM POWER DISSIPATION VS CASE TEMPERATURE

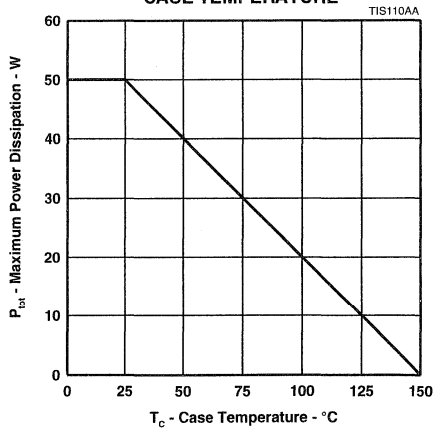


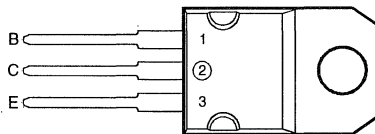
Figure 5.

TIP120, TIP121, TIP122 NPN SILICON POWER DARLINGTONS

DECEMBER 1971 - REVISED MAY 1995

- Designed for Complementary Use with TIP125, TIP126 and TIP127
- 65 W at 25°C Case Temperature
- 5 A Continuous Collector Current
- Minimum h_{FE} of 1000 at 3 V, 3 A

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIP120	V_{CBO}	60	V
	TIP121		80	
	TIP122		100	
Collector-emitter voltage ($I_B = 0$)	TIP120	V_{CEO}	60	V
	TIP121		80	
	TIP122		100	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	5	A
Peak collector current (see Note 1)		I_{CM}	8	A
Continuous base current		I_B	0.1	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	65	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}L I_C^2$	50	mJ
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.

2. Derate linearly to 150°C case temperature at the rate of 0.52 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = 5$ mA, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = 20$ V.

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 **TEXAS
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TIP120, TIP121, TIP122

NPN SILICON POWER DARLINGTONS

DECEMBER 1971 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$ (see Note 5)	$I_B = 0$	TIP120	60			V
				TIP121	80			
				TIP122	100			
I_{CEO}	Collector-emitter cut-off current	$V_{CE} = 30 \text{ V}$ $V_{CE} = 40 \text{ V}$ $V_{CE} = 50 \text{ V}$	$I_B = 0$	TIP120			0.5	mA
			$I_B = 0$	TIP121			0.5	
			$I_B = 0$	TIP122			0.5	
I_{CBO}	Collector cut-off current	$V_{CB} = 60 \text{ V}$ $V_{CB} = 80 \text{ V}$ $V_{CB} = 100 \text{ V}$	$I_E = 0$	TIP120			0.2	mA
			$I_E = 0$	TIP121			0.2	
			$I_E = 0$	TIP122			0.2	
I_{EBO}	Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$				2	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = 3 \text{ V}$	$I_C = 0.5 \text{ A}$	(see Notes 5 and 6)	1000			
		$V_{CE} = 3 \text{ V}$	$I_C = 3 \text{ A}$		1000			
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = 12 \text{ mA}$ $I_B = 20 \text{ mA}$	$I_C = 3 \text{ A}$	(see Notes 5 and 6)			2	V
			$I_C = 5 \text{ A}$				4	
V_{BE}	Base-emitter voltage	$V_{CE} = 3 \text{ V}$	$I_C = 3 \text{ A}$	(see Notes 5 and 6)			2.5	V
V_{EC}	Parallel diode forward voltage	$I_E = 5 \text{ A}$	$I_B = 0$	(see Notes 5 and 6)			3.5	V

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.92	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = 3 \text{ A}$	$I_{B(on)} = 12 \text{ mA}$	$I_{B(off)} = -12 \text{ mA}$		1.5	μs
t_{off}	Turn-off time	$V_{BE(off)} = -5 \text{ V}$	$R_L = 10 \Omega$	$t_p = 20 \mu\text{s}$, dc $\leq 2\%$		8.5	μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

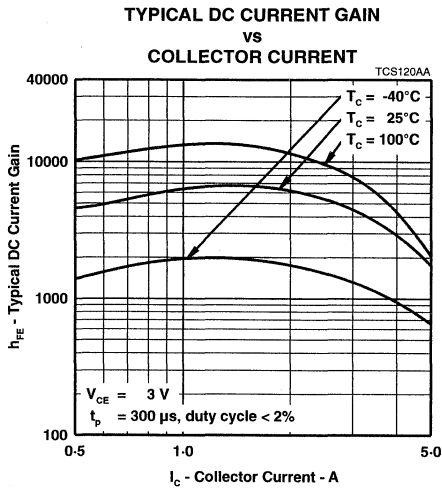


Figure 1.

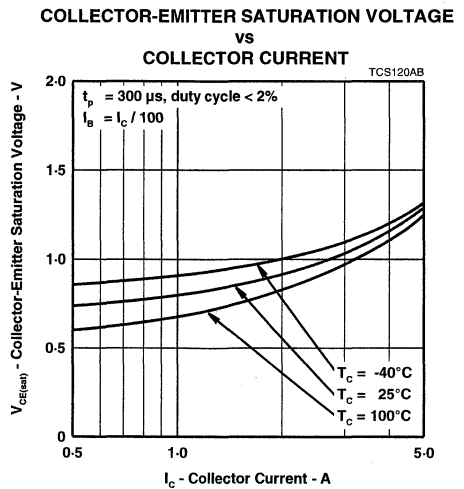


Figure 2.

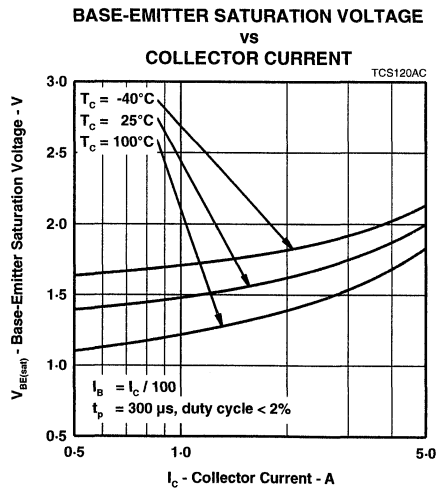
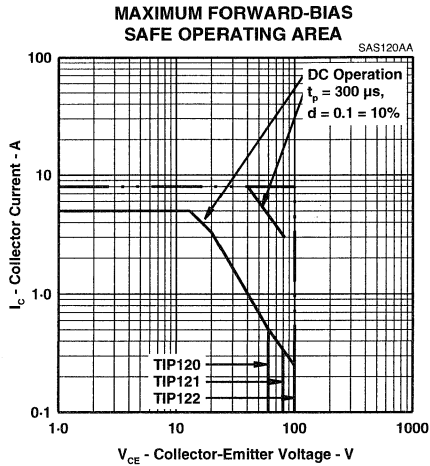


Figure 3.

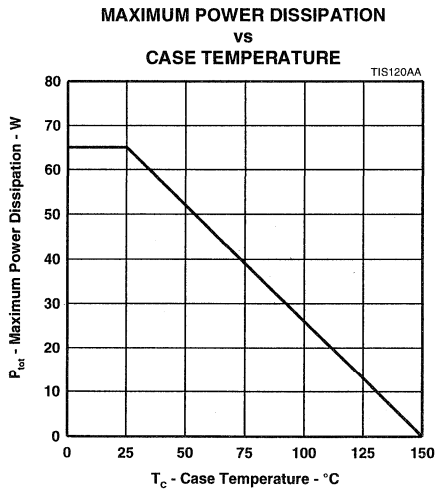
TIP120, TIP121, TIP122
 NPN SILICON POWER DARLINGTONS

DECEMBER 1971 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS



THERMAL INFORMATION

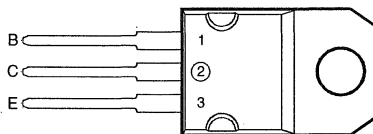


TIP125, TIP126, TIP127 PNP SILICON POWER DARLINGTONS

DECEMBER 1971 - REVISED MAY 1995

- Designed for Complementary Use with TIP120, TIP121 and TIP122
- 65 W at 25°C Case Temperature
- 5 A Continuous Collector Current
- Minimum h_{FE} of 1000 at 3 V, 3 A

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIP125	V_{CBO}	-60	V
	TIP126		-80	
	TIP127		-100	
Collector-emitter voltage ($I_B = 0$)	TIP125	V_{CEO}	-60	V
	TIP126		-80	
	TIP127		-100	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-5	A
Peak collector current (see Note 1)		I_{CM}	-8	A
Continuous base current		I_B	-0.1	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	65	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	50	mJ
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

- NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.
2. Derate linearly to 150°C case temperature at the rate of 0.52 W/°C.
3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.
4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = -5$ mA, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = -20$ V.

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TIP125, TIP126, TIP127

PNP SILICON POWER DARLINGTONS

DECEMBER 1971 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$ Collector-emitter breakdown voltage	TIP125 $I_C = -30 \text{ mA}$ $I_B = 0$	-60			V
	TIP126	-80			
	TIP127	-100			
I_{CEO} Collector-emitter cut-off current	$V_{CE} = -30 \text{ V}$ $V_{CE} = -40 \text{ V}$ $V_{CE} = -50 \text{ V}$				mA
	$I_B = 0$ $I_B = 0$ $I_B = 0$				
	TIP125 TIP126 TIP127			-0.5 -0.5 -0.5	
I_{CBO} Collector cut-off current	$V_{CB} = -60 \text{ V}$ $V_{CB} = -80 \text{ V}$ $V_{CB} = -100 \text{ V}$				mA
	$I_E = 0$ $I_E = 0$ $I_E = 0$				
	TIP125 TIP126 TIP127			-0.2 -0.2 -0.2	
I_{EBO} Emitter cut-off current	$V_{EB} = -5 \text{ V}$ $I_C = 0$				-2 mA
h_{FE} Forward current transfer ratio	$V_{CE} = -3 \text{ V}$ $V_{CE} = -3 \text{ V}$				
	$I_C = -0.5 \text{ A}$ $I_C = -3 \text{ A}$				(see Notes 5 and 6) 1000 1000
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = -12 \text{ mA}$ $I_B = -20 \text{ mA}$				
	$I_C = -3 \text{ A}$ $I_C = -5 \text{ A}$				-2 -4 V
V_{BE} Base-emitter voltage	$V_{CE} = -3 \text{ V}$ $I_C = -3 \text{ A}$				-2.5 V
V_{EC} Parallel diode forward voltage	$I_E = -5 \text{ A}$ $I_B = 0$				-3.5 V

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1.92	°C/W
$R_{\theta JA}$ Junction to free air thermal resistance			62.5	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †	MIN	TYP	MAX	UNIT
t_{on} Turn-on time	$I_C = -3 \text{ A}$ $I_{B(on)} = -12 \text{ mA}$ $I_{B(off)} = 12 \text{ mA}$		1.5		μs
t_{off} Turn-off time	$V_{BE(off)} = 5 \text{ V}$ $R_L = 10 \Omega$ $t_p = 20 \mu\text{s}$, dc $\leq 2\%$		8.5		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

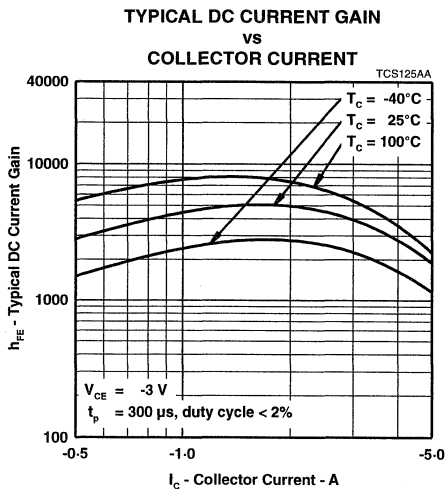


Figure 1.

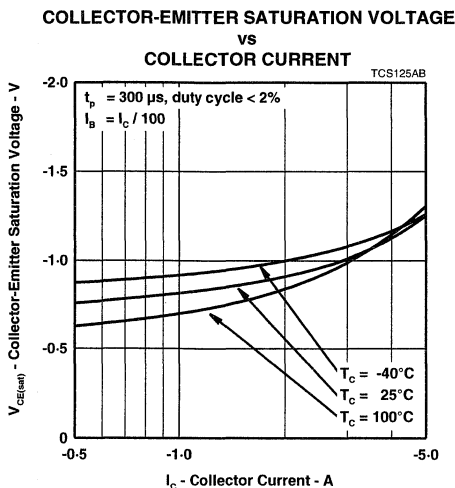


Figure 2.

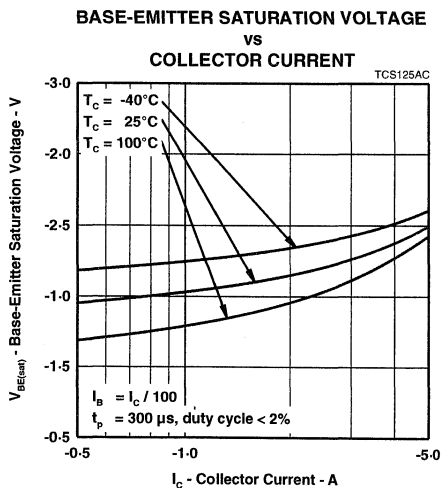


Figure 3.

TIP125, TIP126, TIP127
PNP SILICON POWER DARLINGTONS

DECEMBER 1971 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

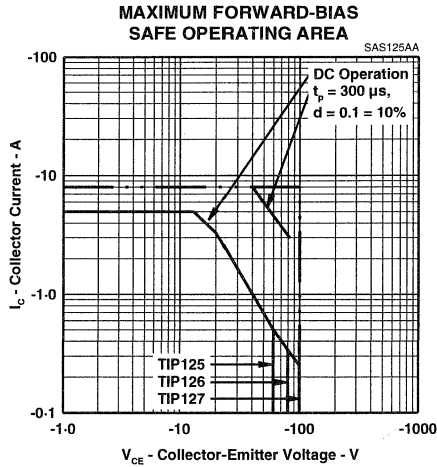


Figure 4.

THERMAL INFORMATION

MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE

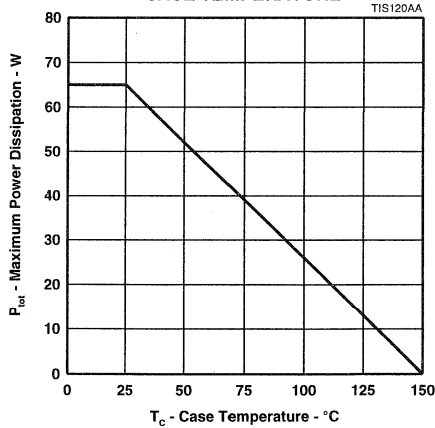


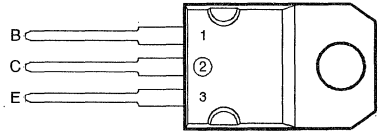
Figure 5.

TIP130, TIP131, TIP132 NPN SILICON POWER DARLINGTONS

JUNE 1973 - REVISED MAY 1995

- Designed for Complementary Use with TIP135, TIP136 and TIP137
- 70 W at 25°C Case Temperature
- 8 A Continuous Collector Current
- Minimum h_{FE} of 1000 at 4 V, 4 A

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIP130	V_{CBO}	60	V
	TIP131		80	
	TIP132		100	
Collector-emitter voltage ($I_B = 0$)	TIP130	V_{CEO}	60	V
	TIP131		80	
	TIP132		100	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	8	A
Peak collector current (see Note 1)		I_{CM}	12	A
Continuous base current		I_B	0.3	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	70	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	75	mJ
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

- NOTES: 1. This value applies for $t_b \leq 0.3$ ms, duty cycle $\leq 10\%$.
 2. Derate linearly to 150°C case temperature at the rate of 0.56 W/°C.
 3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.
 4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = 5$ mA, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = 20$ V.

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TIP130, TIP131, TIP132

NPN SILICON POWER DARLINGTONS

JUNE 1973 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$ Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$ $I_B = 0$ (see Note 5)	TIP130	60		V
		TIP131	80		
		TIP132	100		
I_{CEO} Collector-emitter cut-off current	$V_{CE} = 30 \text{ V}$ $I_B = 0$ $V_{CE} = 40 \text{ V}$ $I_B = 0$ $V_{CE} = 50 \text{ V}$ $I_B = 0$	TIP130		0.5	mA
		TIP131		0.5	
		TIP132		0.5	
I_{CBO} Collector cut-off current	$V_{CB} = 60 \text{ V}$ $I_E = 0$ $V_{CB} = 80 \text{ V}$ $I_E = 0$ $V_{CB} = 100 \text{ V}$ $I_E = 0$ $V_{CB} = 60 \text{ V}$ $I_E = 0$ $T_C = 100^\circ\text{C}$ $V_{CB} = 80 \text{ V}$ $I_E = 0$ $T_C = 100^\circ\text{C}$ $V_{CB} = 100 \text{ V}$ $I_E = 0$ $T_C = 100^\circ\text{C}$	TIP130		0.2	mA
		TIP131		0.2	
		TIP132		0.2	
		TIP130		1	
		TIP131		1	
		TIP132		1	
I_{EBO} Emitter cut-off current	$V_{EB} = 5 \text{ V}$ $I_C = 0$			5	mA
h_{FE} Forward current transfer ratio	$V_{CE} = 4 \text{ V}$ $I_C = 1 \text{ A}$ $V_{CE} = 4 \text{ V}$ $I_C = 4 \text{ A}$ (see Notes 5 and 6)	500		15000	
		1000			
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 16 \text{ mA}$ $I_C = 4 \text{ A}$ $I_B = 30 \text{ mA}$ $I_C = 6 \text{ A}$ (see Notes 5 and 6)			2	V
				3	
V_{BE} Base-emitter voltage	$V_{CE} = 4 \text{ V}$ $I_C = 4 \text{ A}$ (see Notes 5 and 6)			2.5	V
C_{obo} Output capacitance	$V_{CB} = 10 \text{ V}$ $I_E = 0$			200	pF
V_{EC} Parallel diode forward voltage	$I_E = 8 \text{ A}$ $I_B = 0$ (see Notes 5 and 6)			3.5	V

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1.78	$^\circ\text{C/W}$
$R_{\theta JA}$ Junction to free air thermal resistance			62.5	$^\circ\text{C/W}$

TYPICAL CHARACTERISTICS

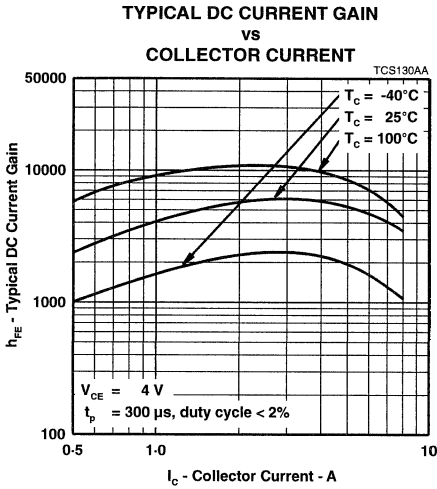


Figure 1.

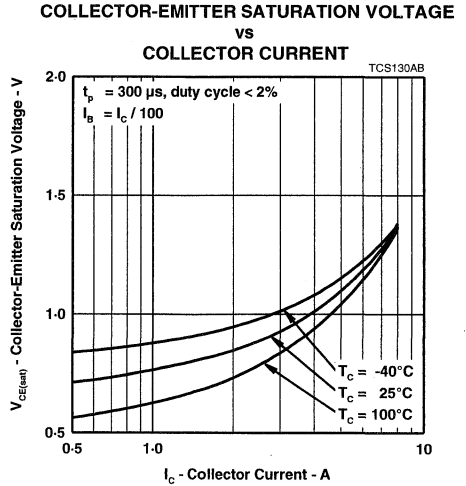


Figure 2.

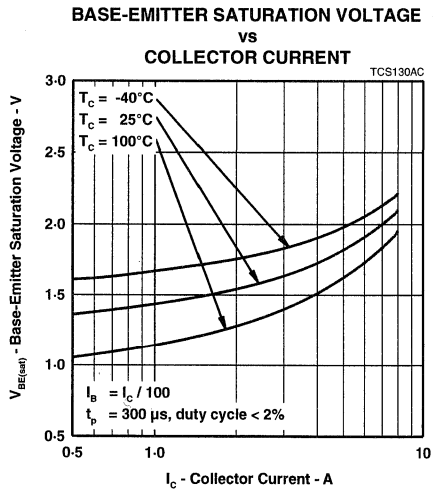


Figure 3.

TIP130, TIP131, TIP132 NPN SILICON POWER DARLINGTONS

JUNE 1973 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

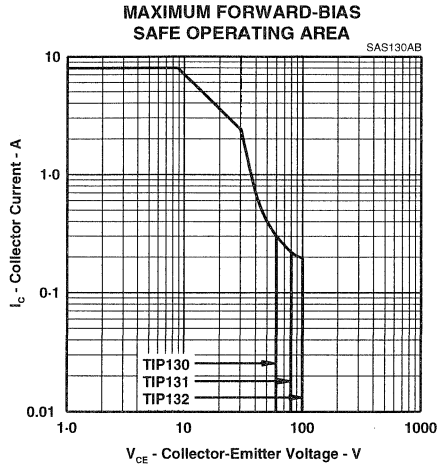


Figure 4.

THERMAL INFORMATION

MAXIMUM POWER DISSIPATION vs CASE TEMPERATURE

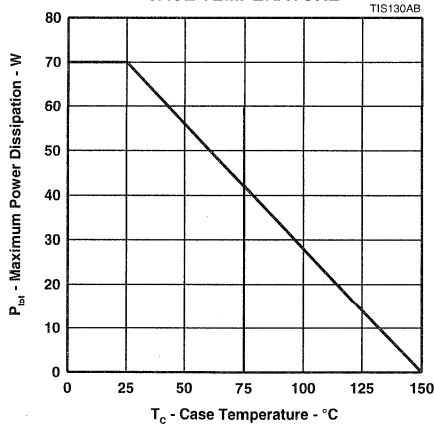
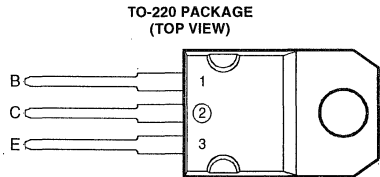


Figure 5.

TIP135, TIP136, TIP137 PNP SILICON POWER DARLINGTONS

JUNE 1973 - REVISED MAY 1995

- Designed for Complementary Use with TIP130, TIP131 and TIP132
- 70 W at 25°C Case Temperature
- 8 A Continuous Collector Current
- Minimum h_{FE} of 1000 at 4 V, 4 A



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIP135	V_{CBO}	-60	V
	TIP136		-80	
	TIP137		-100	
Collector-emitter voltage ($I_B = 0$)	TIP135	V_{CEO}	-60	V
	TIP136		-80	
	TIP137		-100	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-8	A
Peak collector current (see Note 1)		I_{CM}	-12	A
Continuous base current		I_B	-0.3	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	70	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	75	mJ
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

- NOTES: 1. This value applies for $I_p \leq 0.3$ ms, duty cycle $\leq 10\%$.
2. Derate linearly to 150°C case temperature at the rate of 0.56 W/°C.
3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.
4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = -5$ mA, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = -20$ V.

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TIP135, TIP136, TIP137

PNP SILICON POWER DARLINGTONS

JUNE 1973 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$ Collector-emitter breakdown voltage	$I_C = -30 \text{ mA}$ $I_B = 0$ (see Note 5)	TIP135 -60 TIP136 -80 TIP137 -100			V
I_{CEO} Collector-emitter cut-off current	$V_{CE} = -30 \text{ V}$ $I_B = 0$ $V_{CE} = -40 \text{ V}$ $I_B = 0$ $V_{CE} = -50 \text{ V}$ $I_B = 0$	TIP135 TIP136 TIP137		-0.5 -0.5 -0.5	mA
I_{CBO} Collector cut-off current	$V_{CB} = -60 \text{ V}$ $I_E = 0$ $V_{CB} = -80 \text{ V}$ $I_E = 0$ $V_{CB} = -100 \text{ V}$ $I_E = 0$ $V_{CB} = -60 \text{ V}$ $I_E = 0$ $T_C = 100^\circ\text{C}$ $V_{CB} = -80 \text{ V}$ $I_E = 0$ $T_C = 100^\circ\text{C}$ $V_{CB} = -100 \text{ V}$ $I_E = 0$ $T_C = 100^\circ\text{C}$	TIP135 TIP136 TIP137 TIP135 TIP136 TIP137		-0.2 -0.2 -0.2 -1 -1 -1	mA
I_{EBO} Emitter cut-off current	$V_{EB} = -5 \text{ V}$ $I_C = 0$			-5	mA
h_{FE} Forward current transfer ratio	$V_{CE} = -4 \text{ V}$ $I_C = -1 \text{ A}$ $V_{CE} = -4 \text{ V}$ $I_C = -4 \text{ A}$ (see Notes 5 and 6)	500 1000		15000	
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = -16 \text{ mA}$ $I_C = -4 \text{ A}$ $I_B = -30 \text{ mA}$ $I_C = -6 \text{ A}$ (see Notes 5 and 6)			-2 -3	V
V_{BE} Base-emitter voltage	$V_{CE} = -4 \text{ V}$ $I_C = -4 \text{ A}$ (see Notes 5 and 6)			-2.5	V
C_{obo} Output capacitance	$V_{CB} = -10 \text{ V}$ $I_E = 0$			200	pF
V_{EC} Parallel diode forward voltage	$I_E = -8 \text{ A}$ $I_B = 0$ (see Notes 5 and 6)			-3.5	V

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1.78	$^\circ\text{C/W}$
$R_{\theta JA}$ Junction to free air thermal resistance			62.5	$^\circ\text{C/W}$

TYPICAL CHARACTERISTICS

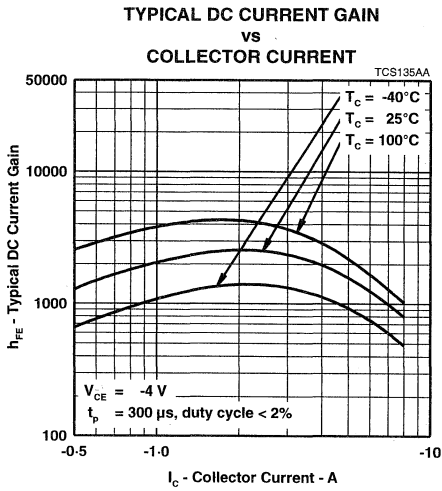


Figure 1.

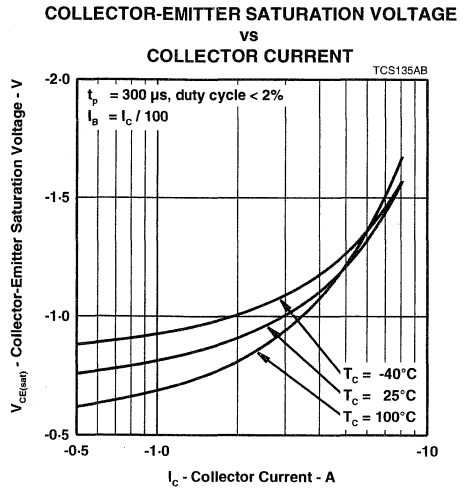


Figure 2.

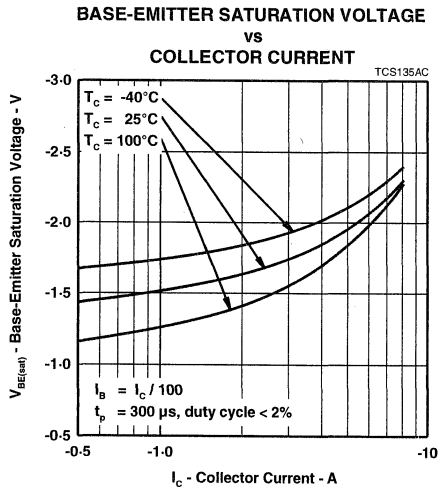
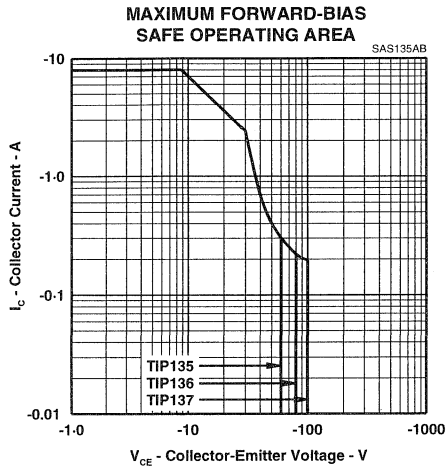


Figure 3.

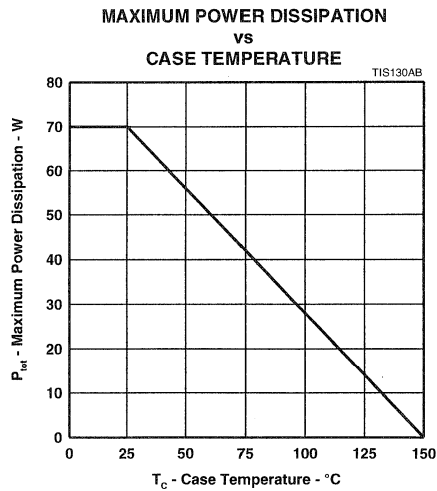
TIP135, TIP136, TIP137
PNP SILICON POWER DARLINGTONS

JUNE 1973 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS



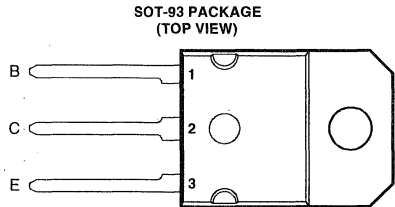
THERMAL INFORMATION



TIP140, TIP141, TIP142 NPN SILICON POWER DARLINGTONS

DECEMBER 1971 - REVISED MAY 1995

- Designed for Complementary Use with TIP145, TIP146 and TIP147
- 125 W at 25°C Case Temperature
- 10 A Continuous Collector Current
- Minimum h_{FE} of 1000 at 4 V, 5 A



Pin 2 is in electrical contact with the mounting base.

MDTRAA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIP140	V_{CBO}	60	V
	TIP141		80	
	TIP142		100	
Collector-emitter voltage ($I_B = 0$)	TIP140	V_{CEO}	60	V
	TIP141		80	
	TIP142		100	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	10	A
Peak collector current (see Note 1)		I_{CM}	15	A
Continuous base current		I_B	0.5	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	125	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	3.5	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	100	mJ
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

- NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.
2. Derate linearly to 150°C case temperature at the rate of 1 W/°C.
3. Derate linearly to 150°C free air temperature at the rate of 28 mW/°C.
4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = 5$ mA, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = 20$ V.

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TIP140, TIP141, TIP142

NPN SILICON POWER DARLINGTONS

DECEMBER 1971 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$ Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$ (see Note 5)	$I_B = 0$	TIP140	60			V
			TIP141	80			
			TIP142	100			
I_{CEO} Collector-emitter cut-off current	$V_{CE} = 30 \text{ V}$ $V_{CE} = 40 \text{ V}$ $V_{CE} = 50 \text{ V}$	$I_B = 0$ $I_B = 0$ $I_B = 0$	TIP140			2	mA
			TIP141			2	
			TIP142			2	
I_{CBO} Collector cut-off current	$V_{CB} = 60 \text{ V}$ $V_{CB} = 80 \text{ V}$ $V_{CB} = 100 \text{ V}$	$I_E = 0$ $I_E = 0$ $I_E = 0$	TIP140			1	mA
			TIP141			1	
			TIP142			1	
I_{EBO} Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$				2	mA
h_{FE} Forward current transfer ratio	$V_{CE} = 4 \text{ V}$ $V_{CE} = 4 \text{ V}$	$I_C = 5 \text{ A}$ $I_C = 10 \text{ A}$	(see Notes 5 and 6)	1000			
				500			
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 10 \text{ mA}$ $I_B = 40 \text{ mA}$	$I_C = 5 \text{ A}$ $I_C = 10 \text{ A}$	(see Notes 5 and 6)			2	V
						3	
V_{BE} Base-emitter voltage	$V_{CE} = 4 \text{ V}$	$I_C = 10 \text{ A}$	(see Notes 5 and 6)			3	V
V_{EC} Parallel diode forward voltage	$I_E = 10 \text{ A}$	$I_B = 0$	(see Notes 5 and 6)			3.5	V

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on} Turn-on time	$I_C = 10 \text{ A}$ $V_{BE(off)} = -4.2 \text{ V}$	$I_{B(on)} = 40 \text{ mA}$ $R_L = 3 \Omega$	$I_{B(off)} = -40 \text{ mA}$ $t_p = 20 \mu\text{s}$, $d_c \leq 2\%$		0.9		μs
t_{off} Turn-off time					11		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

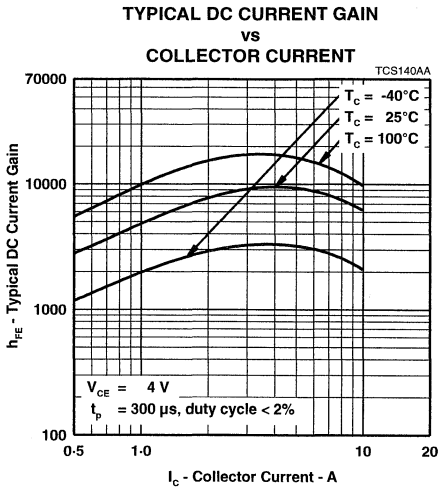


Figure 1.

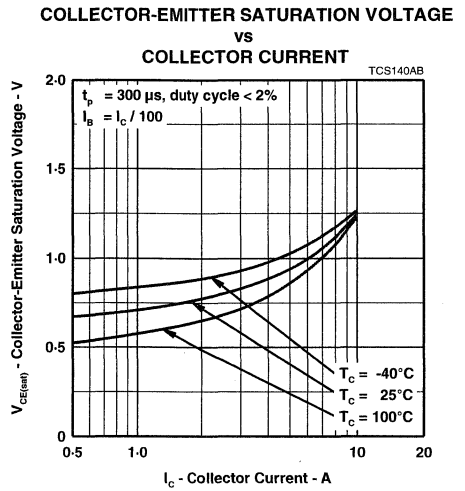


Figure 2.

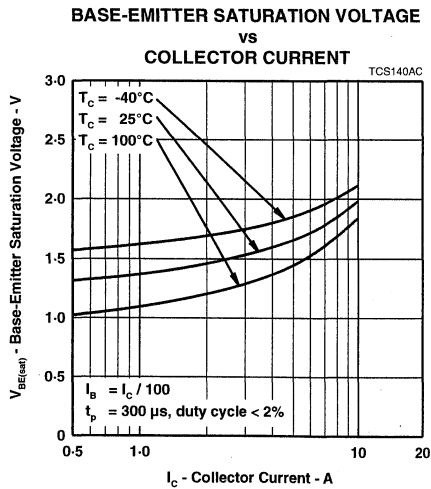


Figure 3.

TIP140, TIP141, TIP142 NPN SILICON POWER DARLINGTONS

DECEMBER 1971 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

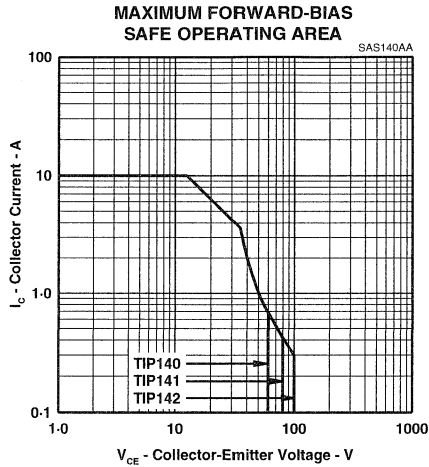


Figure 4.

THERMAL INFORMATION

MAXIMUM POWER DISSIPATION vs CASE TEMPERATURE

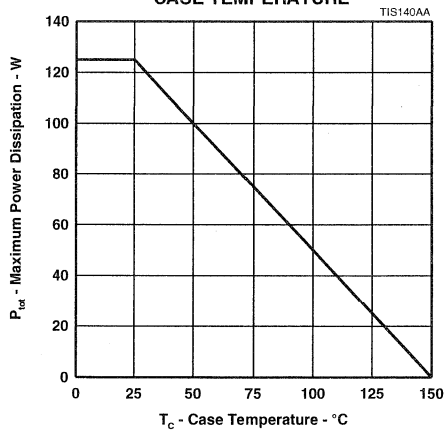
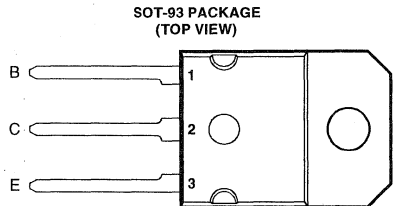


Figure 5.

TIP145, TIP146, TIP147 PNP SILICON POWER DARLINGTONS

DECEMBER 1971 - REVISED MAY 1995

- Designed for Complementary Use with TIP140, TIP141 and TIP142
- 125 W at 25°C Case Temperature
- 10 A Continuous Collector Current
- Minimum h_{FE} of 1000 at 4 V, 5 A



Pin 2 is in electrical contact with the mounting base.

MDTRA4

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIP145	V_{CBO}	-60	V
	TIP146		-80	
	TIP147		-100	
Collector-emitter voltage ($I_B = 0$)	TIP145	V_{CEO}	-60	V
	TIP146		-80	
	TIP147		-100	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-10	A
Peak collector current (see Note 1)		I_{CM}	-15	A
Continuous base current		I_B	-0.5	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	125	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	3.5	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	100	mJ
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.

2. Derate linearly to 150°C case temperature at the rate of 1 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 28 mW/°C.

4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = -5$ mA, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = -20$ V.

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TIP145, TIP146, TIP147

PNP SILICON POWER DARLINGTONS

DECEMBER 1971 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = -30 \text{ mA}$ (see Note 5)	$I_B = 0$	TIP145	-60			V
				TIP146	-80			
				TIP147	-100			
I_{CEO}	Collector-emitter cut-off current	$V_{CE} = -30 \text{ V}$ $V_{CE} = -40 \text{ V}$ $V_{CE} = -50 \text{ V}$	$I_B = 0$	TIP145			-2	mA
			$I_B = 0$	TIP146			-2	
			$I_B = 0$	TIP147			-2	
I_{CBO}	Collector cut-off current	$V_{CB} = -60 \text{ V}$ $V_{CB} = -80 \text{ V}$ $V_{CB} = -100 \text{ V}$	$I_E = 0$	TIP145			-1	mA
			$I_E = 0$	TIP146			-1	
			$I_E = 0$	TIP147			-1	
I_{EBO}	Emitter cut-off current	$V_{EB} = -5 \text{ V}$	$I_C = 0$				-2	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = -4 \text{ V}$ $V_{CE} = -4 \text{ V}$	$I_C = -5 \text{ A}$	(see Notes 5 and 6)	1000			
			$I_C = -10 \text{ A}$		500			
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = -10 \text{ mA}$ $I_B = -40 \text{ mA}$	$I_C = -5 \text{ A}$ $I_C = -10 \text{ A}$	(see Notes 5 and 6)			-2 -3	V
V_{BE}	Base-emitter voltage	$V_{CE} = -4 \text{ V}$	$I_C = -10 \text{ A}$	(see Notes 5 and 6)			-3	V
V_{EC}	Parallel diode forward voltage	$I_E = -10 \text{ A}$	$I_B = 0$	(see Notes 5 and 6)			-3.5	V

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

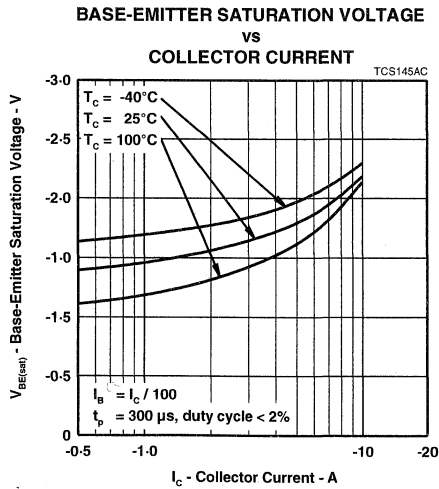
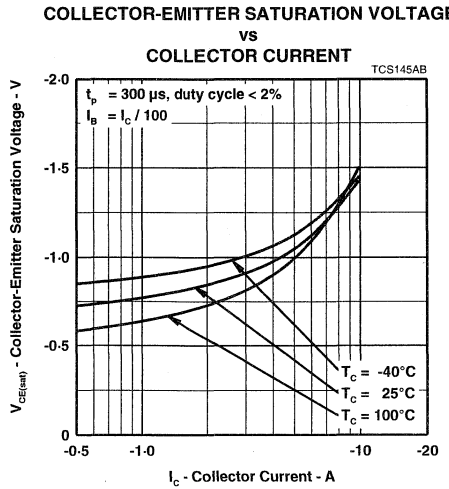
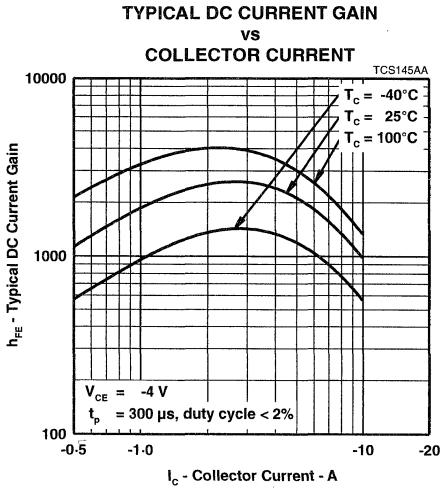
6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn-on time	$I_C = -10 \text{ A}$ $V_{BE(off)} = 4.2 \text{ V}$	$I_{B(on)} = -40 \text{ mA}$	$I_{B(off)} = 40 \text{ mA}$		0.9		μs
t_{off}	Turn-off time		$R_L = 3 \Omega$	$t_p = 20 \mu\text{s}$, $d_c \leq 2\%$			11	

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

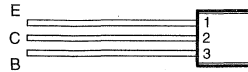


TIPP110, TIPP111, TIPP112 NPN SILICON POWER DARLINGTONS

MAY 1989 - REVISED APRIL 1995

- 20 W Pulsed Power Dissipation
- 100 V Capability
- 2 A Continuous Collector Current
- 4 A Peak Collector Current

LP PACKAGE
(TOP VIEW)



MDTRAB

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIPP110	V_{CBO}	60	V
	TIPP111		80	
	TIPP112		100	
Collector-emitter voltage ($I_B = 0$)	TIPP110	V_{CEO}	60	V
	TIPP111		80	
	TIPP112		100	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	2	A
Peak collector current (see Note 1)		I_{CM}	4	A
Continuous base current		I_B	50	mA
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	0.8	W
Pulsed power dissipation (see Note 3)		P_T	20	W
Operating junction temperature range		T_j	-55 to +150	°C
Storage temperature range		T_{stg}	-55 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

- NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.
 2. Derate linearly to 150°C case temperature at the rate of 0.32 W/°C.
 3. $V_{CE} = 20$ V, $I_C = 1$ A, $P_W = 10$ ms, duty cycle $\leq 2\%$.

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 **TEXAS
INSTRUMENTS**

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TIPP110, TIPP111, TIPP112

NPN SILICON POWER DARLINGTONS

MAY 1989 - REVISED APRIL 1995

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = 10 \text{ mA}$ (see Note 4)	$I_B = 0$	TIPP110 TIPP111 TIPP112	60 80 100			V
I_{CEO}	Collector-emitter cut-off current	$V_{CE} = 30 \text{ V}$ $V_{CE} = 40 \text{ V}$ $V_{CE} = 50 \text{ V}$	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	TIPP110 TIPP111 TIPP112			2 2 2	mA
I_{CBO}	Collector-base cut-off current	$V_{CE} = 60 \text{ V}$ $V_{CE} = 80 \text{ V}$ $V_{CE} = 100 \text{ V}$	$I_B = 0$ $I_B = 0$ $I_B = 0$	TIPP110 TIPP111 TIPP112			1 1 1	mA
I_{EBO}	Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$				2	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = 4 \text{ V}$ $V_{CE} = 4 \text{ V}$	$I_C = 1 \text{ A}$ $I_C = 2 \text{ A}$	(see Notes 4 and 5)	1000 500			
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = 8 \text{ mA}$	$I_C = 2 \text{ A}$	(see Notes 4 and 5)			2.5	V
V_{BE}	Base-emitter voltage	$V_{CE} = 4 \text{ V}$	$I_C = 2 \text{ A}$	(see Notes 4 and 5)			2.8	V
V_{EC}	Parallel diode forward voltage	$I_E = 4 \text{ A}$	$I_B = 0$	(see Notes 4 and 5)			3.5	V

NOTES: 4. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

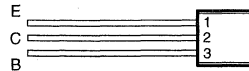
5. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts and located within 3.2 mm from device body.

TIPP115, TIPP116, TIPP117 PNP SILICON POWER DARLINGTONS

MAY 1989 - REVISED APRIL 1995

- 20 W Pulsed Power Dissipation
- 100 V Capability
- 2 A Continuous Collector Current
- 4 A Peak Collector Current

LP PACKAGE
(TOP VIEW)



MDTRAB

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIPP115	V_{CBO}	-60	V
	TIPP116		-80	
	TIPP117		-100	
Collector-emitter voltage ($I_B = 0$)	TIPP115	V_{CEO}	-60	V
	TIPP116		-80	
	TIPP117		-100	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-2	A
Peak collector current (see Note 1)		I_{CM}	-4	A
Continuous base current		I_B	-50	mA
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	0.8	W
Pulsed power dissipation (see Note 3)		P_T	20	W
Operating junction temperature range		T_J	-55 to +150	°C
Storage temperature range		T_{stg}	-55 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

- NOTES: 1. This value applies for $I_B \leq 0.3$ ms, duty cycle $\leq 10\%$.
 2. Derate linearly to 150°C case temperature at the rate of 0.32 W/°C.
 3. $V_{CE} = 20$ V, $I_C = 1$ A, $P_W = 10$ ms, duty cycle $\leq 2\%$.

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TIPP115, TIPP116, TIPP117

PNP SILICON POWER DARLINGTONS

MAY 1989 - REVISED APRIL 1995

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = -10 \text{ mA}$ (see Note 4)	$I_B = 0$	TIPP115 TIPP116 TIPP117	-60 -80 -100			V
I_{CEO}	Collector-emitter cut-off current	$V_{CE} = -30 \text{ V}$ $V_{CE} = -40 \text{ V}$ $V_{CE} = -50 \text{ V}$	$V_{BE} = 0$ $V_{BE} = 0$ $V_{BE} = 0$	TIPP115 TIPP116 TIPP117			-2 -2 -2	mA
I_{CBO}	Collector-base cut-off current	$V_{CE} = -60 \text{ V}$ $V_{CE} = -80 \text{ V}$ $V_{CE} = -100 \text{ V}$	$I_B = 0$ $I_B = 0$ $I_B = 0$	TIPP115 TIPP116 TIPP117			-1 -1 -1	mA
I_{EBO}	Emitter cut-off current	$V_{EB} = -5 \text{ V}$	$I_C = 0$				-2	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = -4 \text{ V}$ $V_{CE} = -4 \text{ V}$	$I_C = -1 \text{ A}$ $I_C = -2 \text{ A}$	(see Notes 4 and 5)	1000 500			
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = -8 \text{ mA}$	$I_C = -2 \text{ A}$	(see Notes 4 and 5)			-2.5	V
V_{BE}	Base-emitter voltage	$V_{CE} = -4 \text{ V}$	$I_C = -2 \text{ A}$	(see Notes 4 and 5)			-2.8	V
V_{EC}	Parallel diode forward voltage	$I_E = -4 \text{ A}$	$I_B = 0$	(see Notes 4 and 5)			-3.5	V

NOTES: 4. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

5. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

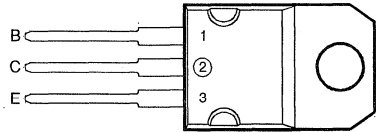
Alphanumeric Index	1
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Mechanical Data	7

BU406, BU407 NPN SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

- 7 A Continuous Collector Current
- 15 A Peak Collector Current
- 60 W at 25°C Case Temperature

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BU406	V_{CBO}	400	V
	BU407		330	
Collector-emitter voltage ($V_{BE} = -2$ V)	BU406	V_{CEX}	400	V
	BU407		330	
Collector-emitter voltage ($I_B = 0$)	BU406	V_{CEO}	200	V
	BU407		150	
Emitter-base voltage		V_{EB}	6	V
Continuous collector current		I_C	7	A
Peak collector current (see Note 1)		I_{CM}	15	A
Continuous base current		I_B	4	A
Continuous device dissipation at (or below) 25°C case temperature		P_{tot}	60	W
Operating junction temperature range		T_J	-55 to +150	°C
Storage temperature range		T_{sig}	-55 to +150	°C

NOTE 1: This value applies for $t_p \leq 10$ ms, duty cycle $\leq 2\%$.

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BU406, BU407

NPN SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$	$I_B = 0$		140			V
I_{CES}	Collector-emitter cut-off current	$V_{CE} = 400 \text{ V}$	$V_{BE} = 0$	BU406			5	mA
		$V_{CE} = 330 \text{ V}$	$V_{BE} = 0$	BU407			5	
		$V_{CE} = 250 \text{ V}$	$V_{BE} = 0$	BU406			0.1	
		$V_{CE} = 200 \text{ V}$	$V_{BE} = 0$	BU407			0.1	
		$V_{CE} = 250 \text{ V}$	$V_{BE} = 0$	BU406	$T_C = 150^\circ\text{C}$			
$V_{CE} = 200 \text{ V}$	$V_{BE} = 0$	BU407	$T_C = 150^\circ\text{C}$			1		
I_{EBO}	Emitter cut-off current	$V_{EB} = 6 \text{ V}$	$I_C = 0$				1	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 4 \text{ A}$	(see Notes 2 and 3)	12			
		$V_{CE} = 10 \text{ V}$	$I_C = 0.5 \text{ A}$		20			
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = 0.5 \text{ A}$	$I_C = 5 \text{ A}$	(see Notes 2 and 3)			1	V
$V_{BE(sat)}$	Base-emitter saturation voltage	$I_B = 0.5 \text{ A}$	$I_C = 5 \text{ A}$	(see Notes 2 and 3)			1.2	V
f_t	Current gain bandwidth product	$V_{CE} = 5 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ MHz}$		6		MHz
C_{ob}	Output capacitance	$V_{CB} = 20 \text{ V}$	$I_E = 0$	$f = 1 \text{ MHz}$		60		pF

NOTES: 2. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

3. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

4. To obtain f_t , the $[h_{FE}]$ response is extrapolated at the rate of -6 dB per octave from $f = 1 \text{ MHz}$ to the frequency at which $[h_{FE}] = 1$.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			2.08	$^\circ\text{C/W}$
$R_{\theta JA}$	Junction to free air thermal resistance			70	$^\circ\text{C/W}$

inductive-load-switching characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_s	Storage time	$I_C = 5 \text{ A}$	$I_{B(end)} = 0.5 \text{ A}$	(see Figures 1 and 2)		2.7		μs
$t_{(off)}$	Turn off time						750	

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

BU406, BU407
NPN SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

TYPICAL CHARACTERISTICS

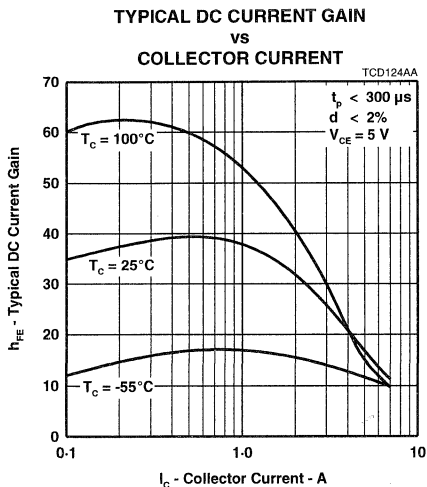


Figure 3.

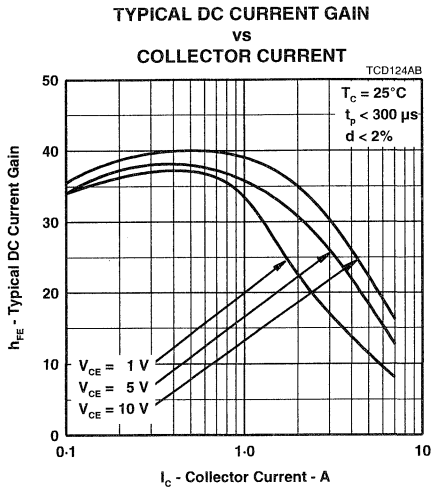


Figure 4.

**COLLECTOR-EMITTER SATURATION VOLTAGE
 vs
 CASE TEMPERATURE**

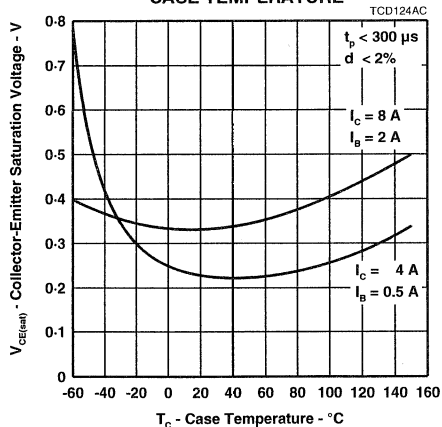


Figure 5.

MAXIMUM SAFE OPERATING REGIONS

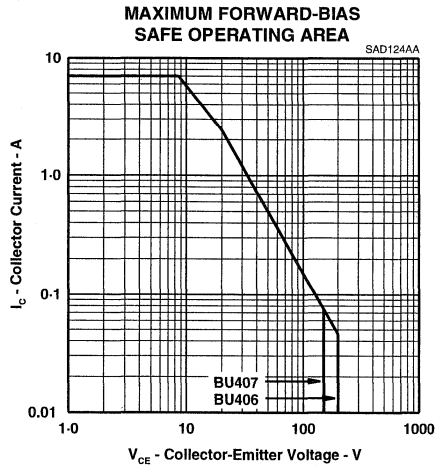


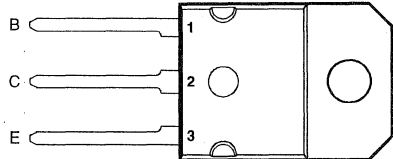
Figure 6.

BU426, BU426A NPN SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

- Rugged Triple-Diffused Planar Construction
- 900 Volt Blocking Capability

SOT-93 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	BU426	V_{CBO}	800	V
	BU426A		900	
Collector-emitter voltage ($V_{BE} = 0$)	BU426	V_{CES}	800	V
	BU426A		900	
Collector-emitter voltage ($I_B = 0$)	BU426	V_{CEO}	375	V
	BU426A		400	
Continuous collector current		I_C	6	A
Peak collector current (see Note 1)		I_{CM}	10	A
Continuous base current		I_B	+2, -0.1	A
Peak base current (see Note 1)		I_{BM}	± 3	A
Continuous device dissipation at (or below) 50°C case temperature		P_{tot}	70	W
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C

NOTE 1: This value applies for $t_p \leq 2$ ms, duty cycle $\leq 2\%$.

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BU426, BU426A

NPN SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$V_{CE(sus)}$ Collector-emitter sustaining voltage	$I_C = 100\text{ mA}$ $L = 25\text{ mH}$ (see Note 2)	375 400			V
I_{CES} Collector-emitter cut-off current	$V_{CE} = 800\text{ V}$ $V_{BE} = 0$			1	mA
	$V_{CE} = 900\text{ V}$ $V_{BE} = 0$			1	
	$V_{CE} = 800\text{ V}$ $V_{BE} = 0$ $T_C = 125^\circ\text{C}$			2	
	$V_{CE} = 900\text{ V}$ $V_{BE} = 0$ $T_C = 125^\circ\text{C}$			2	
I_{EBO} Emitter cut-off current	$V_{EB} = 10\text{ V}$ $I_C = 0$			10	mA
h_{FE} Forward current transfer ratio	$V_{CE} = 5\text{ V}$ $I_C = 0.6\text{ A}$ (see Notes 3 and 4)		30	60	
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 0.5\text{ A}$ $I_C = 2.5\text{ A}$			1.5	V
	$I_B = 1.25\text{ A}$ $I_C = 4\text{ A}$ (see Notes 3 and 4)			3	
$V_{BE(sat)}$ Base-emitter saturation voltage	$I_B = 0.5\text{ A}$ $I_C = 2.5\text{ A}$			1.4	V
	$I_B = 1.25\text{ A}$ $I_C = 4\text{ A}$ (see Notes 3 and 4)			1.6	

NOTES: 2. Inductive loop switching measurement.

3. These parameters must be measured using pulse techniques, $t_p = 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1.1	$^\circ\text{C/W}$

resistive-load-switching characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS †	MIN	TYP	MAX	UNIT
t_{on} Turn on time	$I_C = 2.5\text{ A}$ $I_{B(on)} = 0.5\text{ A}$ $I_{B(off)} = -1\text{ A}$ $V_{CC} = 250\text{ V}$ (see Figures 1 and 2)		0.3	0.6	μs
t_s Storage time			2	3.5	μs
t_f Fall time				0.15	μs
t_f Fall time	$I_C = 2.5\text{ A}$ $I_{B(on)} = 0.5\text{ A}$ $I_{B(off)} = -1\text{ A}$ $V_{CC} = 250\text{ V}$ $T_C = 95^\circ\text{C}$		0.2	0.75	μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

PARAMETER MEASUREMENT INFORMATION

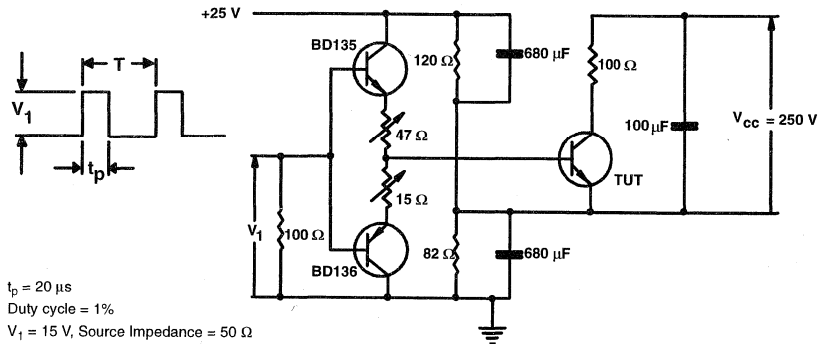


Figure 1. Resistive-Load Switching Test Circuit

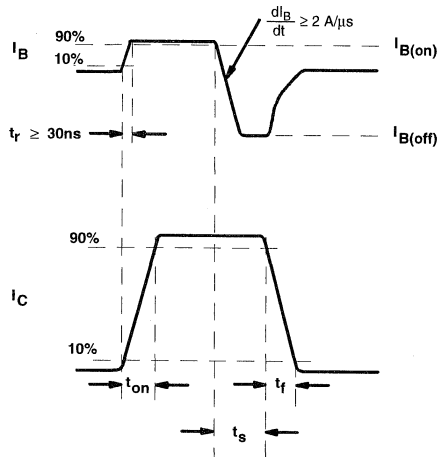


Figure 2. Resistive-Load Switching Waveforms

TYPICAL CHARACTERISTICS

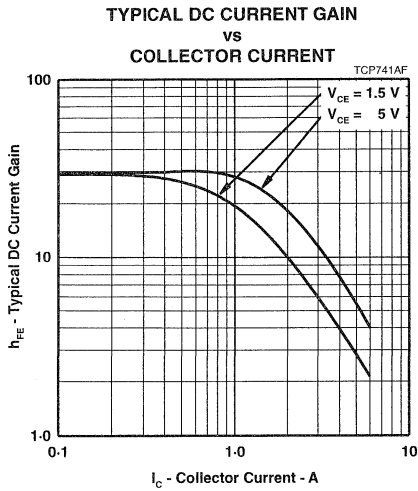


Figure 3.

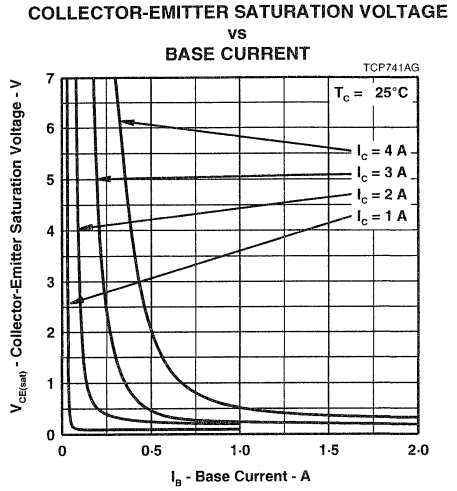


Figure 4.

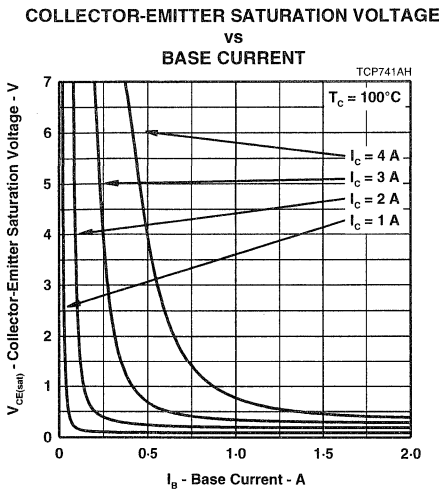


Figure 5.

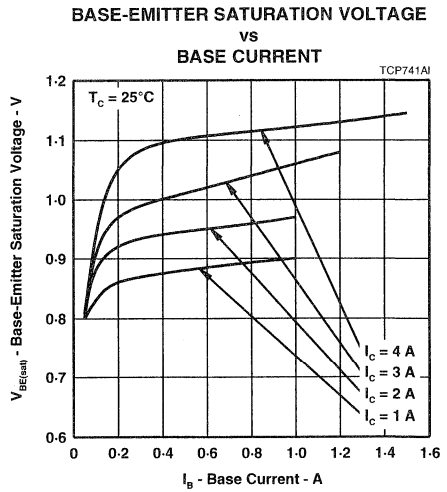


Figure 6.

MAXIMUM SAFE OPERATING REGIONS

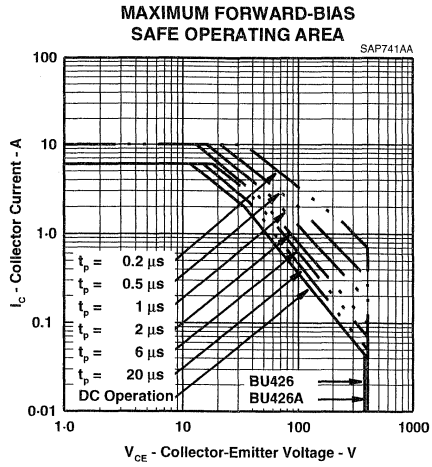


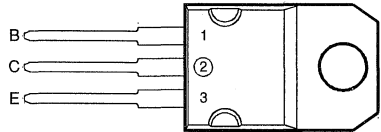
Figure 7.

BUT11 NPN SILICON POWER TRANSISTOR

MAY 1989 - REVISED MAY 1995

- Rugged Triple-Diffused Planar Construction
- 100 W at 25°C Case Temperature
- 5 A Continuous Collector Current

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING	SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	V_{CBO}	850	V
Collector-emitter voltage ($V_{BE} = 0$)	V_{CES}	850	V
Collector-emitter voltage ($I_B = 0$)	V_{CEO}	400	V
Emitter-base voltage	V_{EBO}	10	V
Continuous collector current	I_C	5	A
Peak collector current (see Note 1)	I_{CM}	10	A
Continuous device dissipation at (or below) 25°C case temperature	P_{tot}	100	W
Operating junction temperature range	T_J	-65 to +150	°C
Storage temperature range	T_{stg}	-65 to +150	°C

NOTE 1: This value applies for $t_p \leq 10$ ms, duty cycle $\leq 2\%$.

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BUT11

NPN SILICON POWER TRANSISTOR

MAY 1989 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$V_{CE0(sus)}$ Collector-emitter sustaining voltage	$I_C = 0.1\text{ A}$ $L = 25\text{ mH}$ (see Note 2)	400			V
I_{CES} Collector-emitter cut-off current	$V_{CE} = 850\text{ V}$ $V_{BE} = 0$ $V_{CE} = 850\text{ V}$ $V_{BE} = 0$ $T_C = 125^\circ\text{C}$			50 500	μA
I_{EBO} Emitter cut-off current	$V_{EB} = 10\text{ V}$ $I_C = 0$			1	mA
h_{FE} Forward current transfer ratio	$V_{CE} = 5\text{ V}$ $I_C = 0.5\text{ A}$ (see Notes 3 and 4)	20		60	
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 0.6\text{ A}$ $I_C = 3\text{ A}$ (see Notes 3 and 4)			1.5	V
$V_{BE(sat)}$ Base-emitter saturation voltage	$I_B = 0.6\text{ A}$ $I_C = 3\text{ A}$ (see Notes 3 and 4)			1.3	V
f_t Current gain bandwidth product	$V_{CE} = 10\text{ V}$ $I_C = 0.5\text{ A}$ $f = 1\text{ MHz}$		12		MHz
C_{ob} Output capacitance	$V_{CB} = 20\text{ V}$ $I_E = 0$ $f = 0.1\text{ MHz}$		110		pF

NOTES: 2. Inductive loop switching measurement.

3. These parameters must be measured using pulse techniques, $t_p = 300\ \mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1.25	$^\circ\text{C/W}$

inductive-load-switching characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS †	MIN	TYP	MAX	UNIT
t_{sv} Voltage storage time	$I_C = 3\text{ A}$ $I_{B(on)} = 0.6\text{ A}$ $V_{BE(off)} = -5\text{ V}$			1.4	μs
t_{fi} Current fall time	$V_{CC} = 50\text{ V}$ (see Figures 1 and 2)			150	ns
t_{sv} Voltage storage time	$I_C = 3\text{ A}$ $I_{B(on)} = 0.6\text{ A}$ $V_{BE(off)} = -5\text{ V}$			1.5	μs
t_{fi} Current fall time	$V_{CC} = 50\text{ V}$ $T_C = 100^\circ\text{C}$			300	ns

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

PARAMETER MEASUREMENT INFORMATION

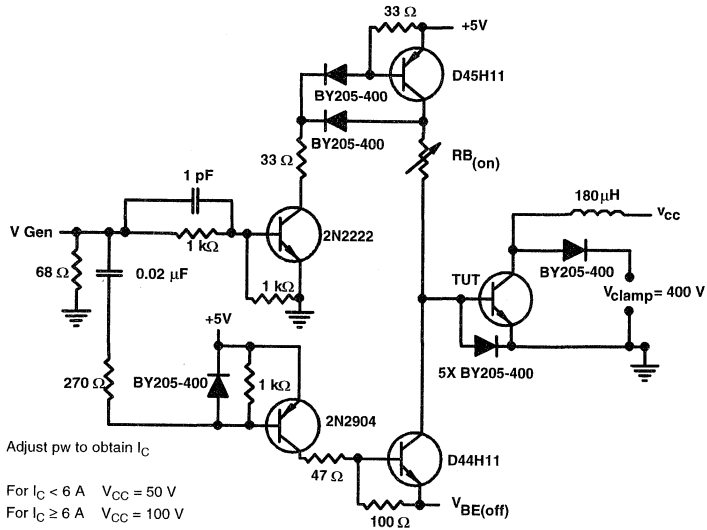
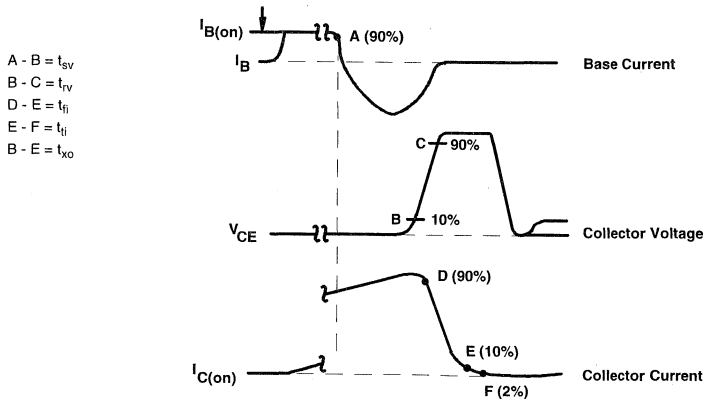


Figure 1. Inductive-Load Switching Test Circuit



NOTES: A. Waveforms are monitored on an oscilloscope with the following characteristics: $t_r < 15$ ns, $R_{in} > 10 \Omega$, $C_{in} < 11.5$ pF.
B. Resistors must be noninductive types.

Figure 2. Inductive-Load Switching Waveforms

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NPN SILICON POWER TRANSISTOR

MAY 1989 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

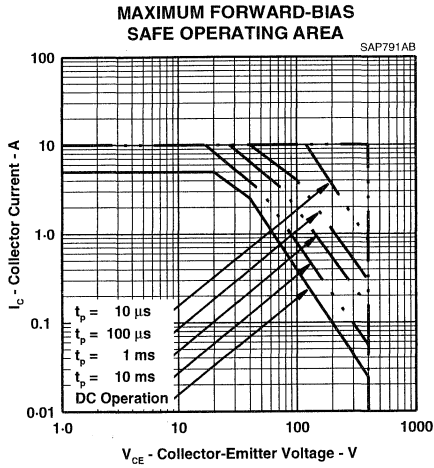


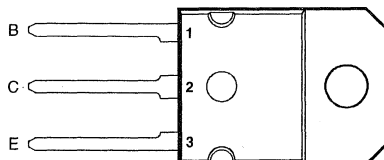
Figure 3.

BUV47, BUV47A NPN SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

- Rugged Triple-Diffused Planar Construction
- 9 A Continuous Collector Current
- 1000 Volt Blocking Capability

SOT-93 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-emitter voltage ($V_{BE} = -2.5$ V)	BUV47	V_{CEX}	850	V
	BUV47A		1000	
Collector-emitter voltage ($R_{BE} = 10 \Omega$)	BUV47	V_{CER}	850	V
	BUV47A		1000	
Collector-emitter voltage ($I_B = 0$)	BUV47	V_{CEO}	400	V
	BUV47A		450	
Continuous collector current		I_C	9	A
Peak collector current (see Note 1)		I_{CM}	15	A
Continuous base current		I_B	3	A
Peak base current		I_{BM}	6	A
Continuous device dissipation at (or below) 25°C case temperature		P_{tot}	120	W
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C

NOTE 1: This value applies for $t_p \leq 5$ ms, duty cycle $\leq 2\%$.

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 **TEXAS
INSTRUMENTS**

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BUV47, BUV47A

NPN SILICON POWER TRANSISTORS

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electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{CE(sus)}$ Collector-emitter sustaining voltage	$I_C = 200 \text{ mA}$	$L = 25 \text{ mH}$	(see Note 2) BUV47 BUV47A	400 450			V
$V_{(BR)EBO}$ Base-emitter breakdown voltage	$I_E = 50 \text{ mA}$	$I_C = 0$	(see Note 3)	7		30	V
I_{CES} Collector-emitter cut-off current	$V_{CE} = 850 \text{ V}$	$V_{BE} = 0$	BUV47			0.15	mA
	$V_{CE} = 1000 \text{ V}$	$V_{BE} = 0$	BUV47A			0.15	
	$V_{CE} = 850 \text{ V}$	$V_{BE} = 0$	BUV47	$T_C = 125^\circ\text{C}$		1.5	
	$V_{CE} = 1000 \text{ V}$	$V_{BE} = 0$	BUV47A	$T_C = 125^\circ\text{C}$		1.5	
I_{CER} Collector-emitter cut-off current	$V_{CE} = 850 \text{ V}$	$R_{BE} = 10 \Omega$	BUV47			0.4	mA
	$V_{CE} = 1000 \text{ V}$	$R_{BE} = 10 \Omega$	BUV47A			0.4	
	$V_{CE} = 850 \text{ V}$	$R_{BE} = 10 \Omega$	BUV47	$T_C = 125^\circ\text{C}$		3.0	
	$V_{CE} = 1000 \text{ V}$	$R_{BE} = 10 \Omega$	BUV47A	$T_C = 125^\circ\text{C}$		3.0	
I_{EBO} Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$				1	mA
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 1 \text{ A}$	$I_C = 5 \text{ A}$	(see Notes 3 and 4)			1.5	V
	$I_B = 2.5 \text{ A}$	$I_C = 8 \text{ A}$				3.0	
$V_{BE(sat)}$ Base-emitter saturation voltage	$I_B = 1 \text{ A}$	$I_C = 5 \text{ A}$	(see Notes 3 and 4)			1.6	V
f_t Current gain bandwidth product	$V_{CE} = 10 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ MHz}$		8		MHz
C_{ob} Output capacitance	$V_{CB} = 20 \text{ V}$	$I_C = 0$	$f = 0.1 \text{ MHz}$		105		pF

NOTES: 2. Inductive loop switching measurement.

3. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1	$^\circ\text{C/W}$

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on} Turn on time	$I_C = 5 \text{ A}$ $V_{CC} = 150 \text{ V}$	$I_{B(on)} = 1 \text{ A}$ (see Figures 1 and 2)	$I_{B(off)} = -1 \text{ A}$			1.0	μs
t_s Storage time						3.0	μs
t_f Fall time						0.8	μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

inductive-load-switching characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{sv} Voltage storage time	$I_C = 5 \text{ A}$ $T_C = 100^\circ\text{C}$	$I_{B(on)} = 1 \text{ A}$ (see Figures 3 and 4)	$V_{BE(off)} = -5 \text{ V}$			4.0	μs
t_{fr} Current fall time						0.4	μs

PARAMETER MEASUREMENT INFORMATION

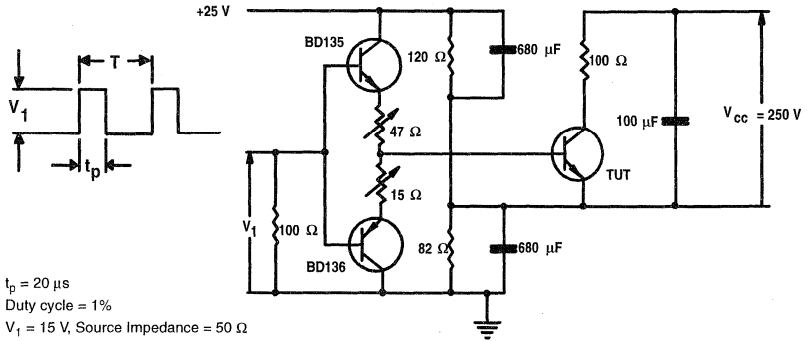


Figure 1. Resistive-Load Switching Test Circuit

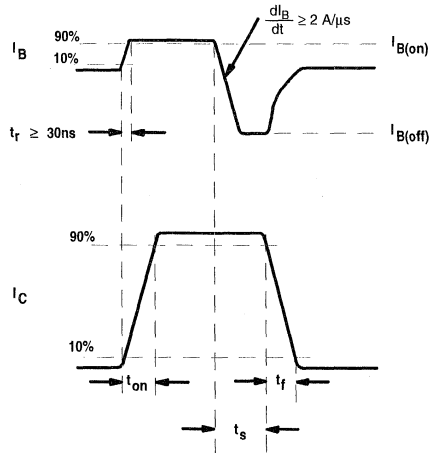
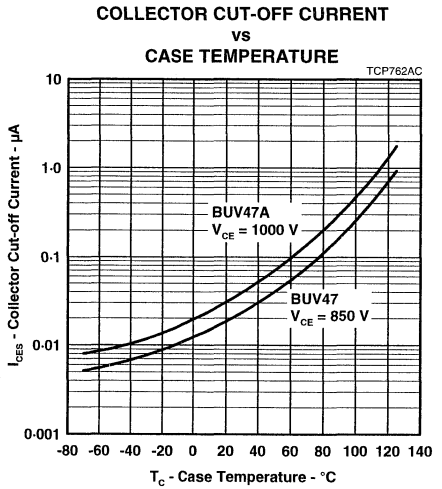
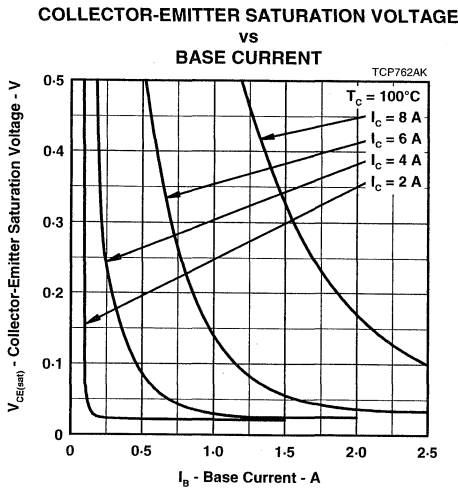
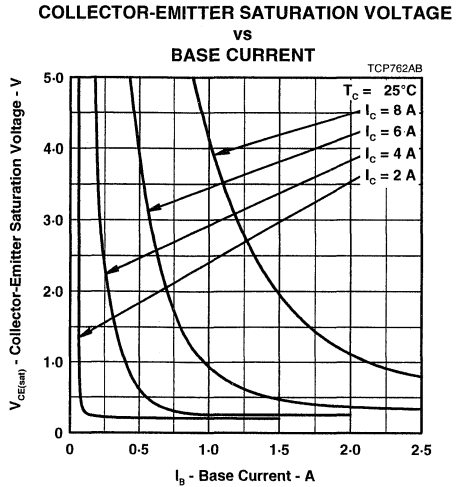
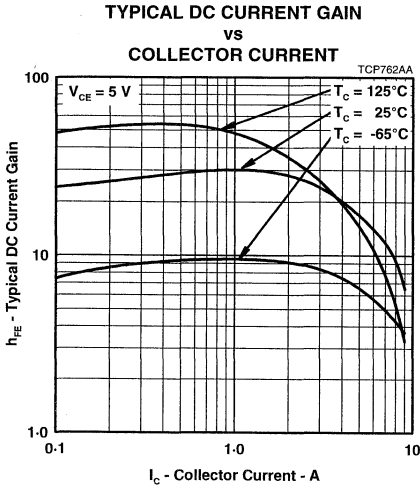


Figure 2. Resistive-Load Switching Waveforms

TYPICAL CHARACTERISTICS



BUV47, BUV47A
NPN SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

MAXIMUM SAFE OPERATING REGIONS

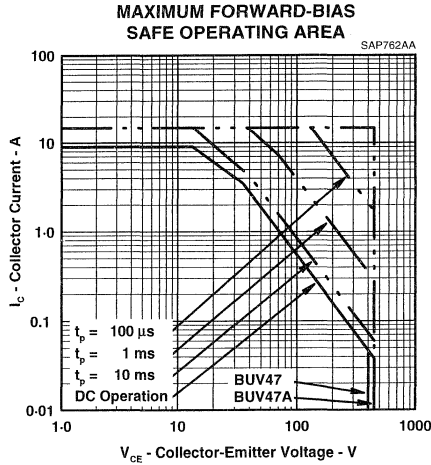


Figure 8.

THERMAL INFORMATION

**THERMAL RESPONSE JUNCTION TO CASE
 VS
 POWER PULSE DURATION**

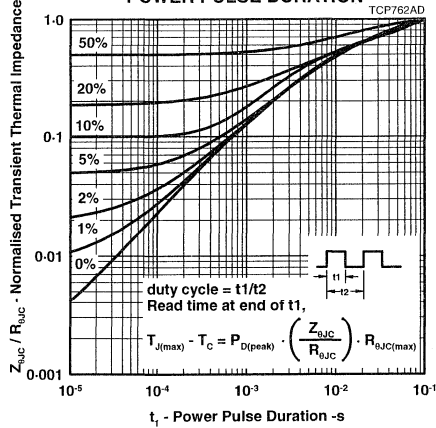


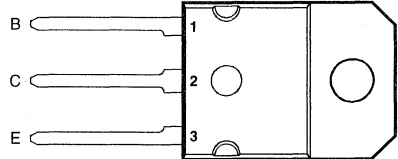
Figure 9.

BUV48, BUV48A NPN SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

- Rugged Triple-Diffused Planar Construction
- 15 A Continuous Collector Current
- 1000 Volt Blocking Capability

SOT-93 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-emitter voltage ($V_{BE} = 0$ V)	BUV48	V_{CES}	850	V
	BUV48A		1000	
Collector-emitter voltage ($R_{BE} = 10 \Omega$)	BUV48	V_{CER}	850	V
	BUV48A		1000	
Collector-emitter voltage ($I_B = 0$)	BUV48	V_{CEO}	400	V
	BUV48A		450	
Continuous collector current		I_C	15	A
Peak collector current (see Note 1)		I_{CM}	30	A
Continuous base current		I_B	4	A
Peak base current		I_{BM}	20	A
Non repetitive accidental peak surge current		I_{CSM}	55	A
Continuous device dissipation at (or below) 25°C case temperature		P_{tot}	125	W
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C

NOTE 1: This value applies for $t_p \leq 2$ ms, duty cycle $\leq 2\%$.

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BUV48, BUV48A

NPN SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{CE(sus)}$ Collector-emitter sustaining voltage	$I_C = 200 \text{ mA}$	$L = 25 \text{ mH}$	(see Note 2)	BUV48 400 BUV48A 450			V
I_{CES} Collector-emitter cut-off current	$V_{CE} = 850 \text{ V}$	$V_{BE} = 0$		BUV48		0.2	mA
	$V_{CE} = 1000 \text{ V}$	$V_{BE} = 0$		BUV48A		0.2	
	$V_{CE} = 850 \text{ V}$	$V_{BE} = 0$	$T_C = 125^\circ\text{C}$	BUV48		2.0	
	$V_{CE} = 1000 \text{ V}$	$V_{BE} = 0$	$T_C = 125^\circ\text{C}$	BUV48A		2.0	
I_{CER} Collector-emitter cut-off current	$V_{CE} = 850 \text{ V}$	$R_{BE} = 10 \Omega$		BUV48		0.5	mA
	$V_{CE} = 1000 \text{ V}$	$R_{BE} = 10 \Omega$		BUV48A		0.5	
	$V_{CE} = 850 \text{ V}$	$R_{BE} = 10 \Omega$	$T_C = 125^\circ\text{C}$	BUV48		4.0	
	$V_{CE} = 1000 \text{ V}$	$R_{BE} = 10 \Omega$	$T_C = 125^\circ\text{C}$	BUV48A		4.0	
I_{EBO} Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$				1	mA
V_{EBO} Emitter-base breakdown voltage	$I_E = 50 \text{ mA}$	$I_C = 0$		7		30	V
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 2 \text{ A}$	$I_C = 10 \text{ A}$		BUV48		1.5	V
	$I_B = 3 \text{ A}$	$I_C = 15 \text{ A}$		BUV48		5.0	
	$I_B = 1.6 \text{ A}$	$I_C = 8 \text{ A}$	(see Notes 3 and 4)	BUV48A		1.5	
	$I_B = 2.4 \text{ A}$	$I_C = 12 \text{ A}$		BUV48A		5.0	
$V_{BE(sat)}$ Base-emitter saturation voltage	$I_B = 2 \text{ A}$	$I_C = 10 \text{ A}$	(see Notes 3 and 4)	BUV48		1.6	V
	$I_B = 1.6 \text{ A}$	$I_C = 8 \text{ A}$		BUV48A		1.6	
f_t Current gain bandwidth product	$V_{CE} = 10 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ MHz}$		10		MHz
C_{ob} Output capacitance	$V_{CB} = 20 \text{ V}$	$I_C = 0$	$f = 1 \text{ MHz}$		150		pF

NOTES: 2. Inductive loop switching measurement.

3. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1	$^\circ\text{C/W}$

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on} Turn on time	$I_C = 10 \text{ A}$	$V_{CC} = 150 \text{ V}$	BUV48			1.0	μs
t_s Storage time						3.0	μs
t_f Fall time	$I_{B(on)} = 2 \text{ A}$	$I_{B(off)} = -2 \text{ A}$	(see Figures 1 and 2)			0.8	μs
t_{on} Turn on time	$I_C = 8 \text{ A}$	$V_{CC} = 150 \text{ V}$	BUV48A			1.0	μs
t_s Storage time						3.0	μs
t_f Fall time	$I_{B(on)} = 1.6 \text{ A}$	$I_{B(off)} = -1.6 \text{ A}$	(see Figures 1 and 2)			0.8	μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

inductive-load-switching characteristics at 100°C case temperature

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{sv} Voltage storage time	$I_C = 10 \text{ A}$	$I_{B(on)} = 2 \text{ A}$	BUV48			4.0	μs
t_{fi} Current fall time	$V_{BE(off)} = -5 \text{ V}$	(see Figures 3 and 4)				0.4	μs
t_{sv} Voltage storage time	$I_C = 8 \text{ A}$	$I_{B(on)} = 1.6 \text{ A}$	BUV48A			4.0	μs
t_{fi} Current fall time	$V_{BE(off)} = -5 \text{ V}$	(see Figures 3 and 4)				0.4	μs

PARAMETER MEASUREMENT INFORMATION

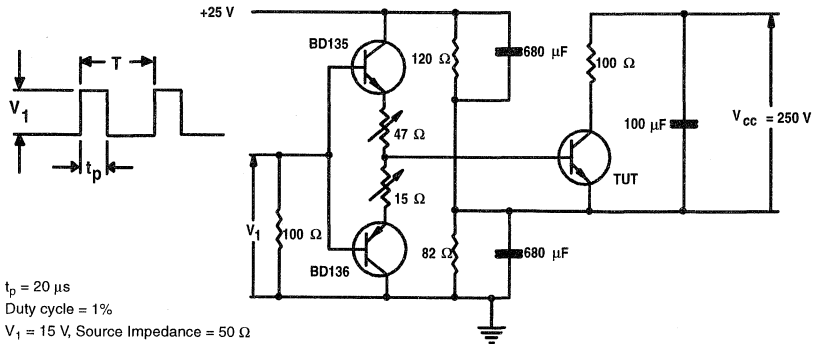


Figure 1. Resistive-Load Switching Test Circuit

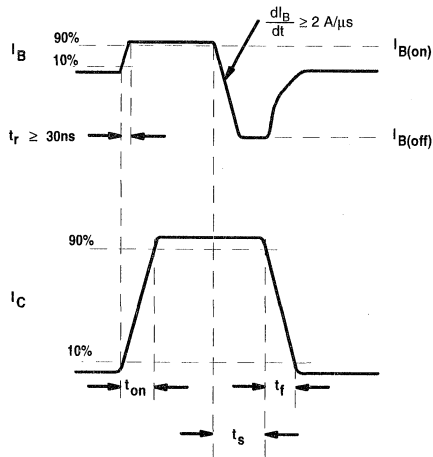


Figure 2. Resistive-Load Switching Waveforms

TYPICAL CHARACTERISTICS

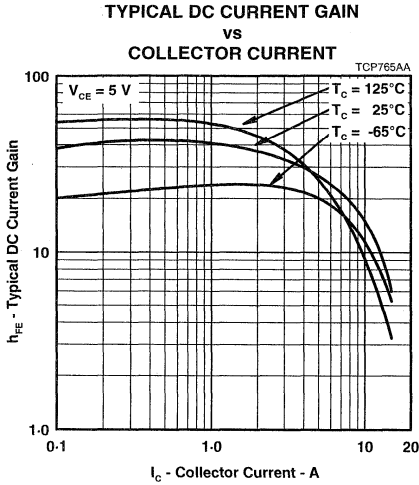


Figure 5.

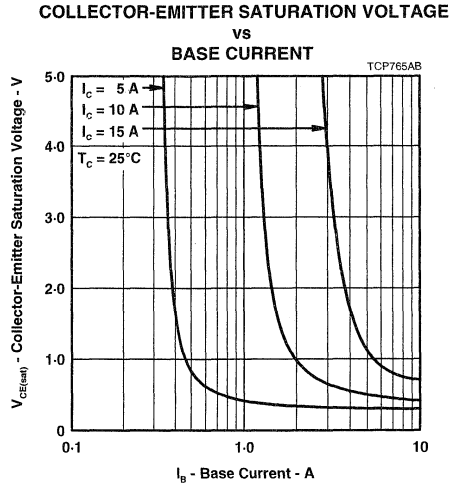


Figure 6.

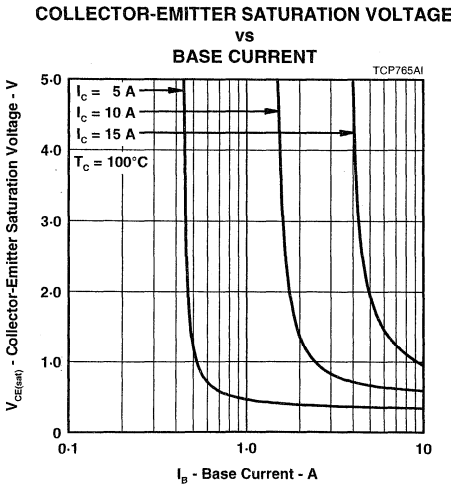


Figure 7.

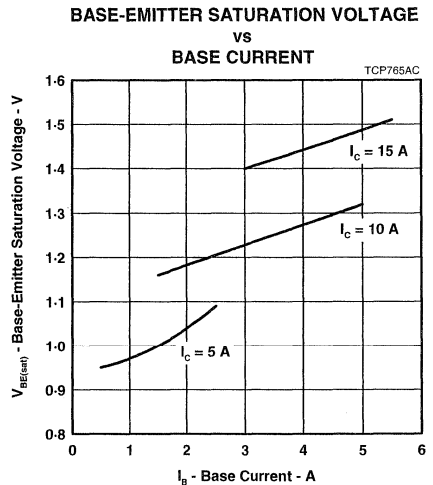


Figure 8.

BUV48, BUV48A
NPN SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

TYPICAL CHARACTERISTICS

COLLECTOR CUT-OFF CURRENT
VS
CASE TEMPERATURE

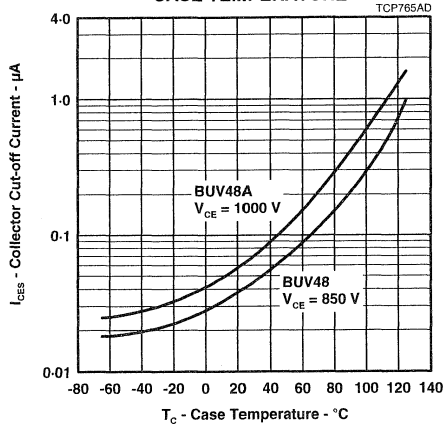


Figure 9.

MAXIMUM SAFE OPERATING REGIONS

MAXIMUM FORWARD-BIAS
SAFE OPERATING AREA

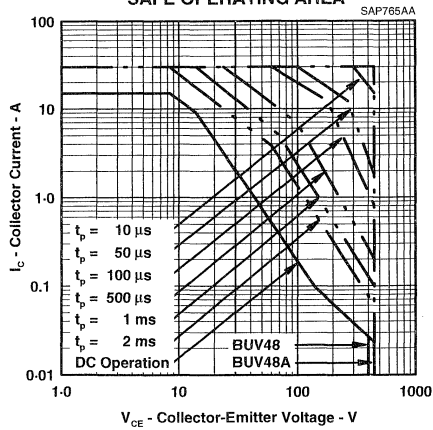


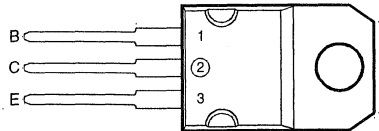
Figure 10.

BUX84 NPN SILICON POWER TRANSISTOR

AUGUST 1978 - REVISED MAY 1995

- 40 W at 25°C Case Temperature
- 2 A Continuous Collector Current
- 3 A Peak Collector Current
- Typical $t_f = 200$ ns at 25°C

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING	SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	V_{CBO}	800	V
Collector-emitter voltage ($V_{BE} = 0$)	V_{CES}	800	V
Collector-emitter voltage ($I_B = 0$)	V_{CEO}	400	V
Continuous collector current	I_C	2	A
Peak collector current (see Note 1)	I_{CM}	3	A
Continuous device dissipation at (or below) 25°C case temperature	P_{tot}	40	W
Operating junction temperature range	T_j	-65 to +150	°C
Storage temperature range	T_{stg}	-65 to +150	°C

NOTE 1: This value applies for $t_p \leq 2$ ms, duty cycle $\leq 2\%$.

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BUX84

NPN SILICON POWER TRANSISTOR

AUGUST 1978 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$V_{CEO(sus)}$ Collector-emitter sustaining voltage	$I_C = 0.1\text{ A}$ $L = 25\text{ mH}$ (see Note 2)	400			V
I_{CES} Collector-emitter cut-off current	$V_{CE} = 800\text{ V}$ $V_{BE} = 0$ $V_{CE} = 800\text{ V}$ $V_{BE} = 0$ $T_C = 125^\circ\text{C}$			0.2 1	mA
I_{EBO} Emitter cut-off current	$V_{EB} = 5\text{ V}$ $I_C = 0$			1	mA
h_{FE} Forward current transfer ratio	$V_{CE} = 5\text{ V}$ $I_C = 0.1\text{ A}$ (see Notes 3 and 4)		35		
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 0.03\text{ A}$ $I_C = 0.3\text{ A}$ $I_B = 0.2\text{ A}$ $I_C = 1\text{ A}$ (see Notes 3 and 4)			0.8 1	V
$V_{BE(sat)}$ Base-emitter saturation voltage	$I_B = 0.2\text{ A}$ $I_C = 1\text{ A}$ (see Notes 3 and 4)			1.1	V
f_t Current gain bandwidth product	$V_{CE} = 10\text{ V}$ $I_C = 0.2\text{ A}$		12		MHz
C_{ob} Output capacitance	$V_{CB} = 20\text{ V}$ $I_E = 0$ $f = 0.1\text{ MHz}$		60		pF

NOTES: 2. Inductive loop switching measurement.

3. These parameters must be measured using pulse techniques, $t_p = 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

5. To obtain f_t the $[h_{FE}]$ response is extrapolated at the rate of -6 dB per octave from $f = 1\text{ MHz}$ to the frequency at which $[h_{FE}] = 1$.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			2.5	$^\circ\text{C/W}$

resistive-load-switching characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS †	MIN	TYP	MAX	UNIT
t_{on} Turn on time	$I_C = 1\text{ A}$ $I_{B(on)} = 0.2\text{ A}$ $I_{B(off)} = -0.4\text{ A}$ $V_{CC} = 250\text{ V}$ (see Figures 1 and 2)		0.25	0.5	μs
t_s Storage time			1.8		μs
t_f Fall time			0.2		μs
t_f Fall time	$I_C = 1\text{ A}$ $I_{B(on)} = 0.2\text{ A}$ $I_{B(off)} = -0.4\text{ A}$ $V_{CC} = 250\text{ V}$ $T_C = 95^\circ\text{C}$			0.4	μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

PARAMETER MEASUREMENT INFORMATION

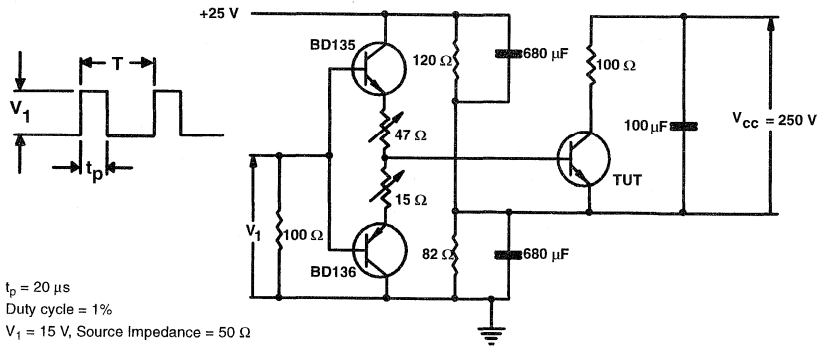


Figure 1. Resistive-Load Switching Test Circuit

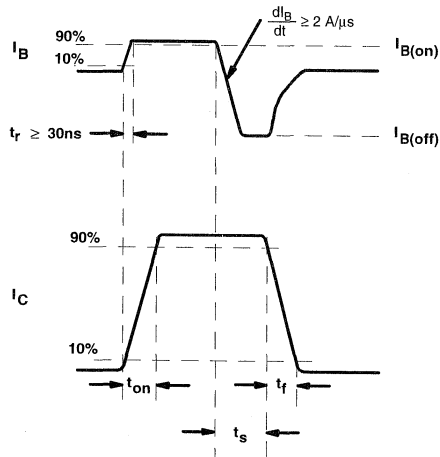


Figure 2. Resistive-Load Switching Waveforms

BUX84
NPN SILICON POWER TRANSISTOR

AUGUST 1978 - REVISED MAY 1995

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
vs
COLLECTOR CURRENT

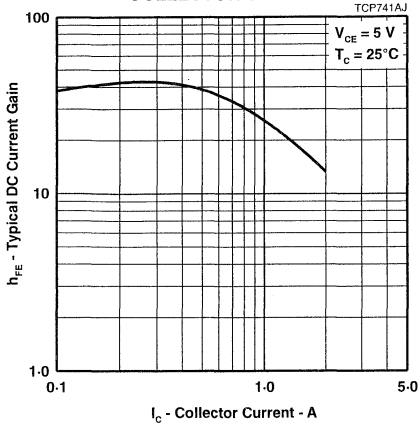


Figure 3.

COLLECTOR CUT-OFF CURRENT
vs
CASE TEMPERATURE

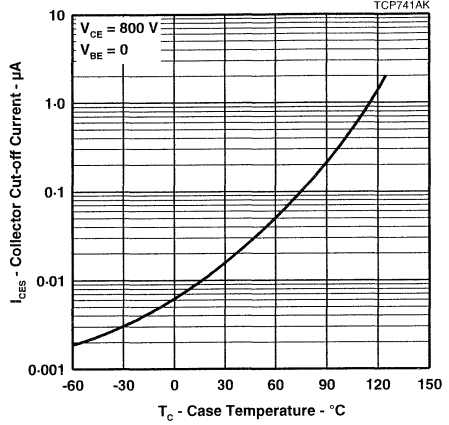


Figure 4.

MAXIMUM SAFE OPERATING REGIONS

MAXIMUM FORWARD-BIAS
SAFE OPERATING AREA

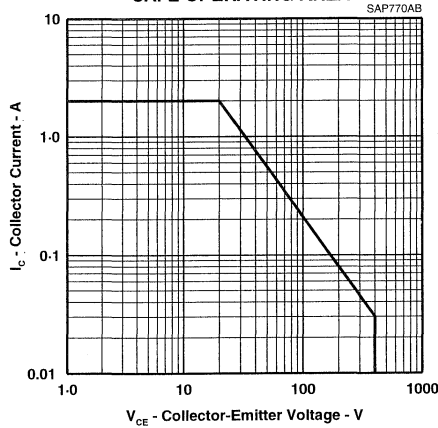


Figure 5.

THERMAL INFORMATION

THERMAL RESPONSE JUNCTION TO CASE
VS
POWER PULSE DURATION

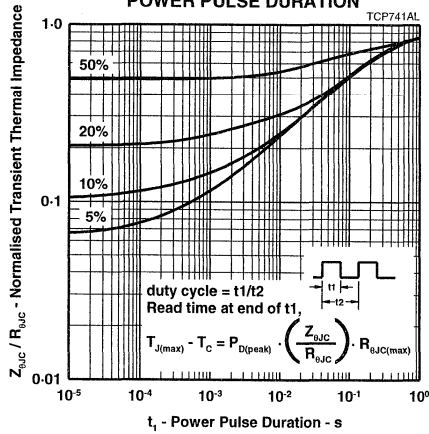


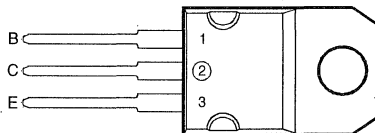
Figure 6.

BUX85 NPN SILICON POWER TRANSISTOR

AUGUST 1978 - REVISED MAY 1995

- 40 W at 25°C Case Temperature
- 2 A Continuous Collector Current
- 3 A Peak Collector Current
- Typical $t_f = 200$ ns at 25°C

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING	SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	V_{CBO}	1000	V
Collector-emitter voltage ($V_{BE} = 0$)	V_{CES}	1000	V
Collector-emitter voltage ($I_B = 0$)	V_{CEO}	450	V
Continuous collector current	I_C	2	A
Peak collector current (see Note 1)	I_{CM}	3	A
Continuous device dissipation at (or below) 25°C case temperature	P_{tot}	40	W
Operating junction temperature range	T_j	-65 to +150	°C
Storage temperature range	T_{stg}	-65 to +150	°C

NOTE 1: This value applies for $t_p \leq 2$ ms, duty cycle $\leq 2\%$.

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BUX85

NPN SILICON POWER TRANSISTOR

AUGUST 1978 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$V_{CE(sus)}$ Collector-emitter sustaining voltage	$I_C = 0.1 \text{ A}$ $L = 25 \text{ mH}$ (see Note 2)	450			V
I_{CES} Collector-emitter cut-off current	$V_{CE} = 1000 \text{ V}$ $V_{BE} = 0$ $V_{CE} = 1000 \text{ V}$ $V_{BE} = 0$ $T_C = 125^\circ\text{C}$			0.2 1	mA
I_{EBO} Emitter cut-off current	$V_{EB} = 5 \text{ V}$ $I_C = 0$			1	mA
h_{FE} Forward current transfer ratio	$V_{CE} = 5 \text{ V}$ $I_C = 0.1 \text{ A}$ (see Notes 3 and 4)		35		
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 0.03 \text{ A}$ $I_C = 0.3 \text{ A}$ (see Notes 3 and 4) $I_B = 0.2 \text{ A}$ $I_C = 1 \text{ A}$			0.8 1	V
$V_{BE(sat)}$ Base-emitter saturation voltage	$I_B = 0.2 \text{ A}$ $I_C = 1 \text{ A}$ (see Notes 3 and 4)			1.1	V
f_t Current gain bandwidth product	$V_{CE} = 10 \text{ V}$ $I_C = 0.2 \text{ A}$		12		MHz
C_{ob} Output capacitance	$V_{CB} = 20 \text{ V}$ $I_E = 0$ $f = 0.1 \text{ MHz}$		60		pF

NOTES: 2. Inductive loop switching measurement.

3. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

5. To obtain f_t the $[h_{FE}]$ response is extrapolated at the rate of -6 dB per octave from $f = 1 \text{ MHz}$ to the frequency at which $[h_{FE}] = 1$.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			2.5	$^\circ\text{C/W}$

resistive-load-switching characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS †	MIN	TYP	MAX	UNIT
t_{on} Turn on time	$I_C = 1 \text{ A}$ $I_{B(on)} = 0.2 \text{ A}$ $I_{B(off)} = -0.4 \text{ A}$ $V_{CC} = 250 \text{ V}$ (see Figures 1 and 2)		0.25	0.5	μs
t_s Storage time			1.8		μs
t_f Fall time			0.2		μs
t_f Fall time	$I_C = 1 \text{ A}$ $I_{B(on)} = 0.2 \text{ A}$ $I_{B(off)} = -0.4 \text{ A}$ $V_{CC} = 250 \text{ V}$ $T_C = 95^\circ\text{C}$			0.4	μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

PARAMETER MEASUREMENT INFORMATION

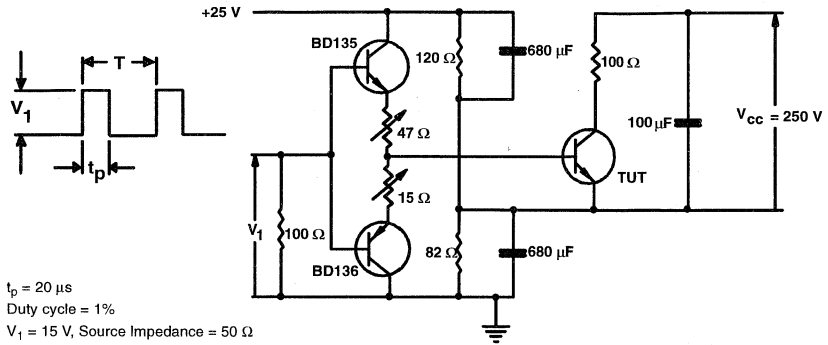


Figure 1. Resistive-Load Switching Test Circuit

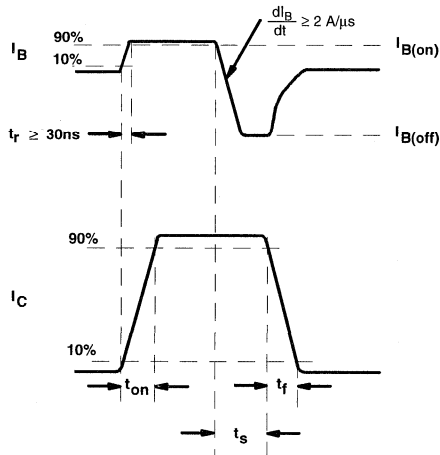


Figure 2. Resistive-Load Switching Waveforms

BUX85
NPN SILICON POWER TRANSISTOR

AUGUST 1978 - REVISED MAY 1995

TYPICAL CHARACTERISTICS

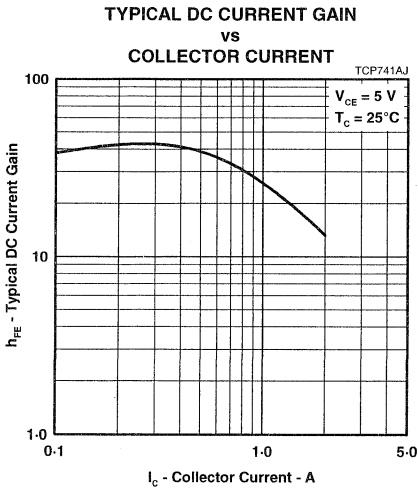


Figure 3.

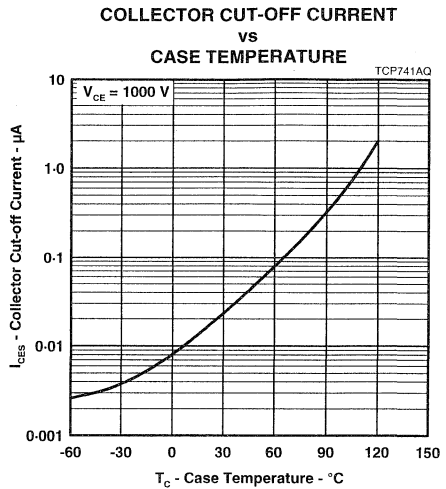


Figure 4.

MAXIMUM SAFE OPERATING REGIONS

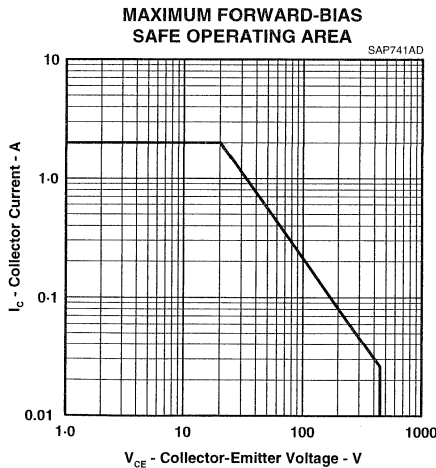


Figure 5.

THERMAL INFORMATION

THERMAL RESPONSE JUNCTION TO CASE
VS
POWER PULSE DURATION

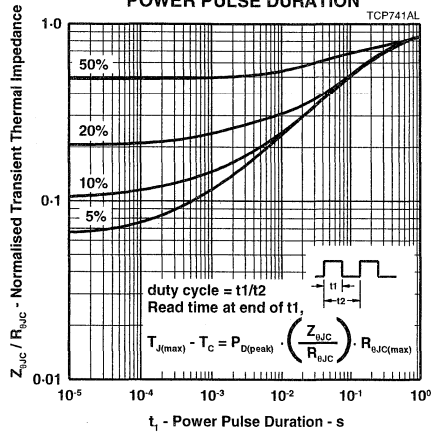


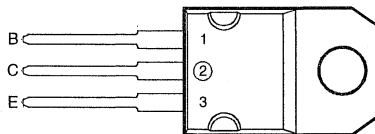
Figure 6.

TIP47, TIP48, TIP49, TIP50 NPN SILICON POWER TRANSISTORS

DECEMBER 1971 - REVISED MAY 1995

- 40 W at 25°C Case Temperature
- 1 A Continuous Collector Current
- 2 A Peak Collector Current
- 20 mJ Reverse-Energy Rating

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIP47	V_{CBO}	350	V
	TIP48		400	
	TIP49		450	
	TIP50		500	
Collector-emitter voltage ($I_B = 0$)	TIP47	V_{CEO}	250	V
	TIP48		300	
	TIP49		350	
	TIP50		400	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	1	A
Peak collector current (see Note 1)		I_{CM}	2	A
Continuous base current		I_B	0.6	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	40	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	20	mJ
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

- NOTE 1: This value applies for $t_p \leq 1$ ms, duty cycle $\leq 2\%$.
2. Derate linearly to 150°C case temperature at the rate of 0.32 W/°C.
3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.
4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = 0.4$ A, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = 20$ V.

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 **TEXAS
INSTRUMENTS**

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TIP47, TIP48, TIP49, TIP50 NPN SILICON POWER TRANSISTORS

DECEMBER 1971 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$ Collector-emitter breakdown voltage	$I_C = 30 \text{ mA}$ $I_B = 0$ (see Note 5)		TIP47	250			V
			TIP48	300			
			TIP49	350			
			TIP50	400			
I_{CES} Collector-emitter cut-off current	$V_{CE} = 350 \text{ V}$	$V_{BE} = 0$	TIP47			1	mA
	$V_{CE} = 400 \text{ V}$	$V_{BE} = 0$	TIP48			1	
	$V_{CE} = 450 \text{ V}$	$V_{BE} = 0$	TIP49			1	
	$V_{CE} = 500 \text{ V}$	$V_{BE} = 0$	TIP50			1	
I_{CEO} Collector cut-off current	$V_{CE} = 150 \text{ V}$	$I_B = 0$	TIP47			1	mA
	$V_{CE} = 200 \text{ V}$	$I_B = 0$	TIP48			1	
	$V_{CE} = 250 \text{ V}$	$I_B = 0$	TIP49			1	
	$V_{CE} = 300 \text{ V}$	$I_B = 0$	TIP50			1	
I_{EBO} Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$				1	mA
h_{FE} Forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.3 \text{ A}$	(see Notes 5 and 6)	30		150	
	$V_{CE} = 10 \text{ V}$	$I_C = 1 \text{ A}$		10			
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 0.2 \text{ A}$	$I_C = 1 \text{ A}$	(see Notes 5 and 6)			1	V
V_{BE} Base-emitter voltage	$V_{CE} = 10 \text{ V}$	$I_C = 1 \text{ A}$	(see Notes 5 and 6)			1.5	V
h_{fe} Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.2 \text{ A}$	$f = 1 \text{ kHz}$	25			
$ h_{fe} $ Small signal forward current transfer ratio	$V_{CE} = 10 \text{ V}$	$I_C = 0.2 \text{ A}$	$f = 2 \text{ MHz}$	5			

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on} Turn on time	$I_C = 1 \text{ A}$	$I_{B(on)} = 0.1 \text{ A}$	$I_{B(off)} = -0.1 \text{ A}$		0.2		μs
t_{off} Turn off time	$V_{BE(off)} = -5 \text{ V}$	$R_L = 200 \Omega$	(see Figures 1 and 2)		2		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

PARAMETER MEASUREMENT INFORMATION

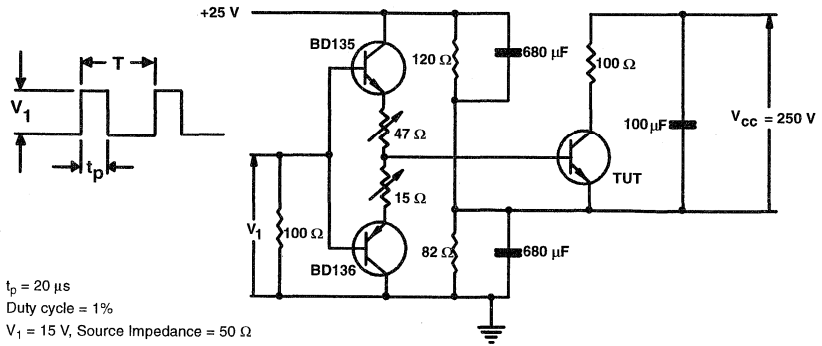


Figure 1. Resistive-Load Switching Test Circuit

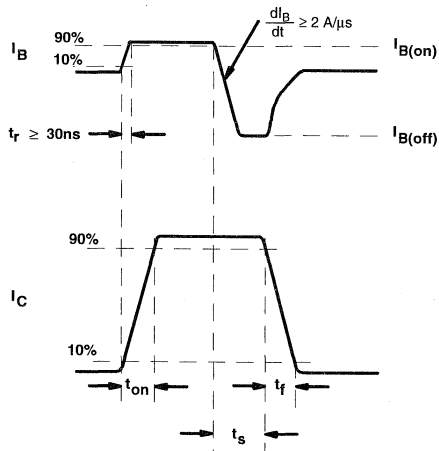


Figure 2. Resistive-Load Switching Waveforms

TIP47, TIP48, TIP49, TIP50
NPN SILICON POWER TRANSISTORS

DECEMBER 1971 - REVISED MAY 1995

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
VS
COLLECTOR CURRENT

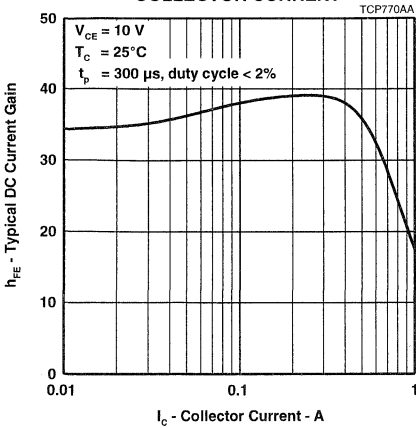


Figure 3.

COLLECTOR-EMITTER SATURATION VOLTAGE
VS
COLLECTOR CURRENT

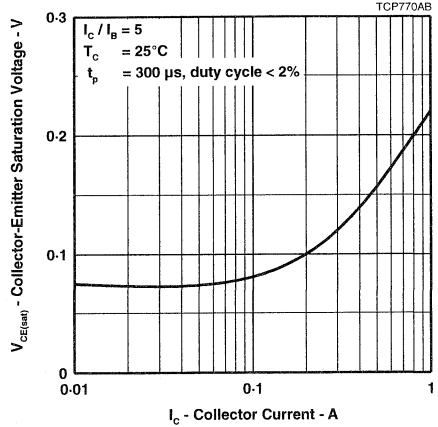


Figure 4.

BASE-EMITTER SATURATION VOLTAGE
VS
COLLECTOR CURRENT

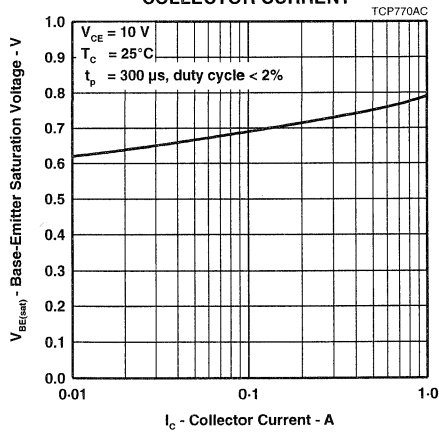


Figure 5.



MAXIMUM SAFE OPERATING REGIONS

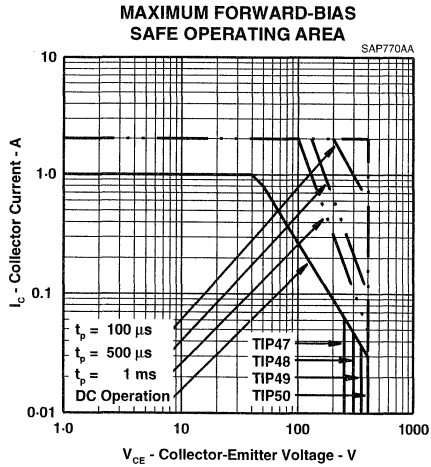
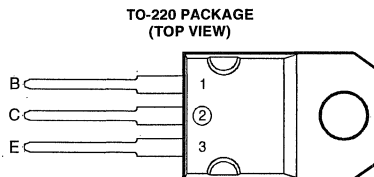


Figure 6.

TIP150, TIP151, TIP152 NPN SILICON POWER DARLINGTONS

JUNE 1973 - REVISED MAY 1995

- 80 W at 25°C Case Temperature
- 7 A Continuous Collector Current
- 10 A Peak Collector Current
- Maximum $V_{CE(sat)}$ of 2 V at $I_C = 5$ A
- $I_{CEX(sus)}$ 7 A at rated $V_{(BR)CEO}$



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIP150	V_{CBO}	300	V
	TIP151		350	
	TIP152		400	
Collector-emitter voltage ($I_B = 0$)	TIP150	V_{CEO}	300	V
	TIP151		350	
	TIP152		400	
Emitter-base voltage		V_{EBO}	8	V
Continuous collector current		I_C	7	A
Peak collector current (see Note 1)		I_{CM}	10	A
Continuous base current		I_B	1.5	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	80	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

NOTES: 1. This value applies for $t_p \leq 5$ ms, duty cycle $\leq 10\%$.

2. Derate linearly to 150°C case temperature at the rate of 0.64 W/°C.

3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

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 **TEXAS
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TIP150, TIP151, TIP152

NPN SILICON POWER DARLINGTONS

JUNE 1973 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CBO}$ Collector-base breakdown voltage	$I_C = 1 \text{ mA}$	$I_E = 0$	TIP150 TIP151 TIP152	300 350 400			V
$V_{(BR)CEO}$ Collector-emitter breakdown voltage	$I_C = 10 \text{ mA}$ (see Note 4)	$I_B = 0$	TIP150 TIP151 TIP152	300 350 400			V
I_{CEO} Collector-emitter cut-off current	$V_{CE} = 300 \text{ V}$ $V_{CE} = 350 \text{ V}$ $V_{CE} = 400 \text{ V}$	$I_B = 0$ $I_B = 0$ $I_B = 0$	TIP150 TIP151 TIP152			250 250 250	μA
$I_{CEX(sus)}$ Collector-emitter sustaining current	$V_{CLAMP} = V_{(BR)CEO}$			7			A
I_{EBO} Emitter cut-off current	$V_{EB} = 8 \text{ V}$	$I_C = 0$				15	mA
h_{FE} Forward current transfer ratio	$V_{CE} = 5 \text{ V}$ $V_{CE} = 5 \text{ V}$ $V_{CE} = 5 \text{ V}$	$I_C = 2.5 \text{ A}$ $I_C = 5 \text{ A}$ $I_C = 7 \text{ A}$	(see Notes 4 and 5)	150 50 15			
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 10 \text{ mA}$ $I_B = 100 \text{ mA}$ $I_B = 250 \text{ mA}$	$I_C = 1 \text{ A}$ $I_C = 2 \text{ A}$ $I_C = 5 \text{ A}$	(see Notes 4 and 5)			1.5 1.5 2	V
$V_{BE(sat)}$ Base-emitter saturation voltage	$I_B = 100 \text{ mA}$ $I_B = 250 \text{ mA}$	$I_C = 2 \text{ A}$ $I_C = 5 \text{ A}$	(see Notes 4 and 5)			2.2 2.3	V
V_{EC} Parallel diode forward voltage	$I_E = 7 \text{ A}$	$I_B = 0$	(see Notes 4 and 5)			3.5	V
h_{fe} Small signal forward current transfer ratio	$V_{CE} = 5 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ kHz}$	200			
$ h_{fe} $ Small signal forward current transfer ratio	$V_{CE} = 5 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ MHz}$	10			
C_{ob} Output capacitance	$V_{CB} = 10 \text{ V}$	$I_E = 0$	$f = 1 \text{ MHz}$			100	pF

NOTES: 4. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

5. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1.56	$^{\circ}\text{C/W}$
$R_{\theta JA}$ Junction to free air thermal resistance			62.5	$^{\circ}\text{C/W}$
$C_{\theta C}$ Thermal capacitance of case		0.9		$\text{J}/^{\circ}\text{C}$

inductive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{sv} Voltage storage time	$I_C = 5 \text{ A}$ $V_{(clamp)} = V_{(BR)CEO}$	$I_{B(on)} = 250 \text{ mA}$	$R_{BE} = 47 \Omega$		3.9		μs
t_{si} Current storage time					4.7		μs
t_{rv} Voltage transition time					1.2		μs
t_{fi} Current transition time					1.2		μs
t_{xo} Cross-over time					2.0		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

PARAMETER MEASUREMENT INFORMATION

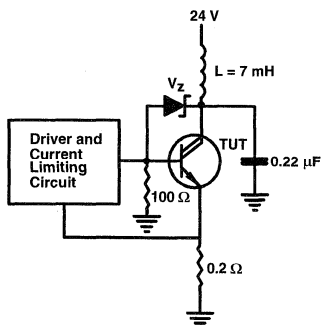


Figure 1. Functional Test Circuit

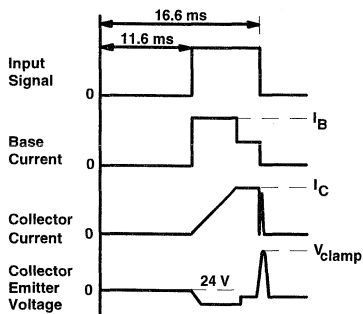


Figure 2. Functional Test Waveforms

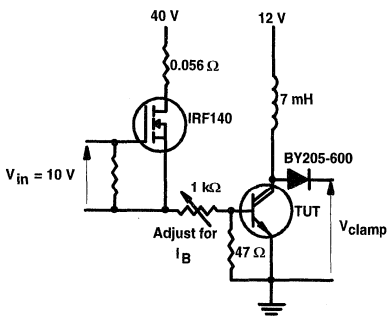


Figure 3. Switching Test Circuit

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
vs
COLLECTOR CURRENT

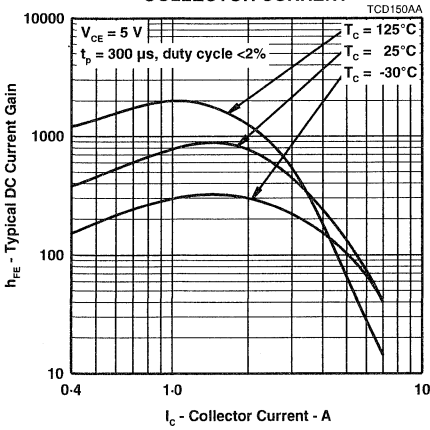


Figure 4.

COLLECTOR-EMITTER SATURATION VOLTAGE
vs
COLLECTOR CURRENT

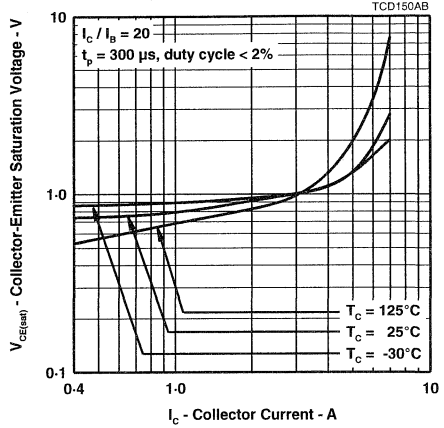


Figure 5.

BASE-EMITTER SATURATION VOLTAGE
vs
COLLECTOR CURRENT

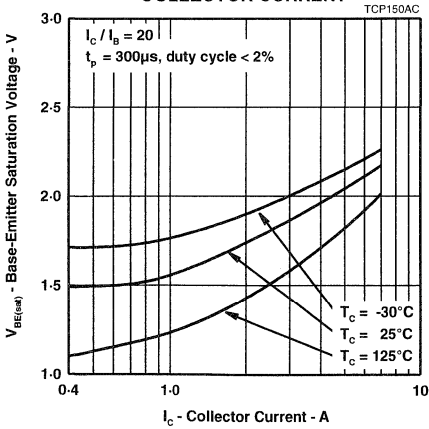


Figure 6.

COLLECTOR CUT-OFF CURRENT
vs
CASE TEMPERATURE

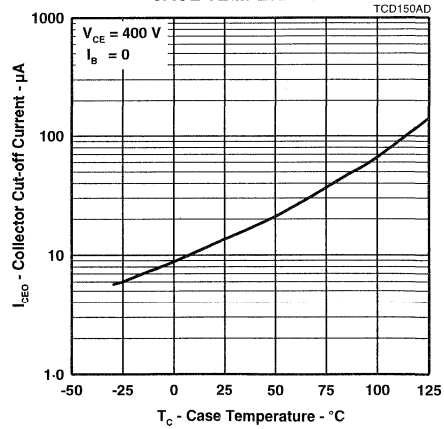


Figure 7.

MAXIMUM SAFE OPERATING REGIONS

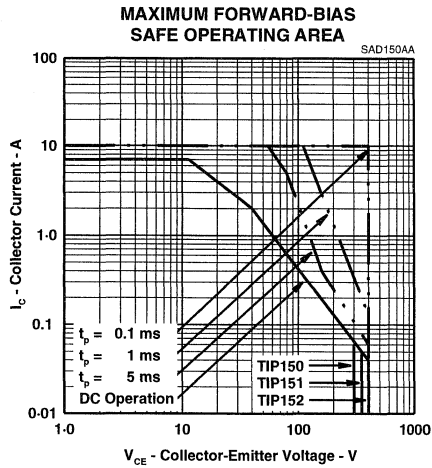


Figure 8.

THERMAL INFORMATION

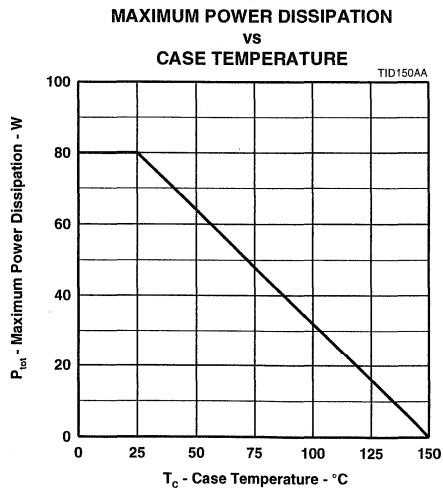
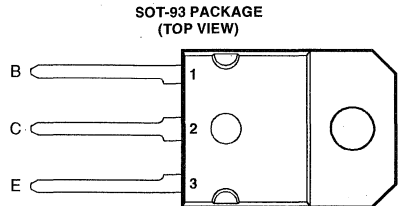


Figure 9.

TIP160, TIP161, TIP162 NPN SILICON POWER DARLINGTONS

JUNE 1973 - REVISED MAY 1995

- 50 W at 25°C Case Temperature
- 10 A Continuous Collector Current
- 15 A Peak Collector Current
- Maximum $V_{CE(sat)}$ of 2.8 V at $I_C = 6.5$ A
- $I_{CEX(sus)}$ 7 A at rated $V_{(BR)CEO}$



Pin 2 is in electrical contact with the mounting base.

MDTRAA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIP160	V_{CBO}	320	V
	TIP161		350	
	TIP162		380	
Collector-emitter voltage ($I_B = 0$)	TIP160	V_{CEO}	320	V
	TIP161		350	
	TIP162		380	
Emitter-base voltage		V_{EBO}	5	V
Continuous collector current		I_C	10	A
Peak collector current (see Note 1)		I_{CM}	15	A
Peak commutating anti-parallel diode current ($I_B = 0$) (see Note 2)		I_{EM}	10	A
Continuous base current		I_B	1	A
Continuous device dissipation at (or below) 100°C case temperature (see Note 3)		P_{tot}	50	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 4)		P_{tot}	3	W
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

- NOTES: 1. This value applies for $t_p \leq 10$ ms, duty cycle $\leq 10\%$.
 2. This value applies to the total collector-terminal current when the collector is at negative potential with respect to the emitter.
 3. Derate linearly to 150°C case temperature at the rate of 0.4 W/°C.
 4. Derate linearly to 150°C free air temperature at the rate of 24 mW/°C.

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 **TEXAS
INSTRUMENTS**

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TIP160, TIP161, TIP162

NPN SILICON POWER DARLINGTONS

JUNE 1973 - REVISED MAY 1995

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
I_{CEO}	Collector-emitter cut-off current	$V_{CE} = 320\text{ V}$	$I_B = 0$	TIP160			1	mA
		$V_{CE} = 350\text{ V}$	$I_B = 0$	TIP161				
		$V_{CE} = 380\text{ V}$	$I_B = 0$	TIP162				
$I_{CEX(sus)}$	Collector-emitter sustaining current	$V_{CLAMP} = V_{(BR)CEO}$			7			A
I_{EBO}	Emitter cut-off current	$V_{EB} = 5\text{ V}$	$I_C = 0$			100		mA
h_{FE}	Forward current transfer ratio	$V_{CE} = 2.2\text{ V}$	$I_C = 4\text{ A}$	(see Notes 5 and 6)	200			
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = 0.1\text{ A}$	$I_C = 6.5\text{ A}$	(see Notes 5 and 6)			2.8	V
		$I_B = 1\text{ A}$	$I_C = 10\text{ A}$					
$V_{BE(sat)}$	Base-emitter saturation voltage	$I_B = 0.1\text{ A}$	$I_C = 6.5\text{ A}$	(see Notes 5 and 6)			2.2	V
V_{EC}	Parallel diode forward voltage	$I_E = 10\text{ A}$	$I_B = 0$	(see Notes 5 and 6)			3.5	V

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			41.7	°C/W
$C_{\theta C}$	Thermal capacitance of case		1.4		J/°C

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_d	Delay time	$I_C = 6.5\text{ A}$ $V_{BE(off)} = -5\text{ V}$	$I_{B(on)} = 100\text{ mA}$ $R_L = 5\text{ }\Omega$	$I_{B(off)} = -100\text{ mA}$		40		ns
t_r	Rise time					1.5		μs
t_s	Storage time					2.2		μs
t_f	Fall time					2.6		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

PARAMETER MEASUREMENT INFORMATION

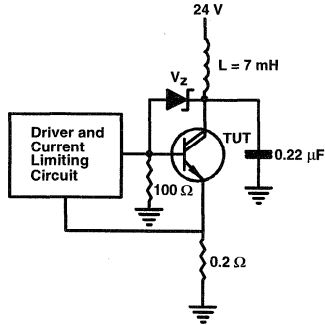


Figure 1. Functional Test Circuit

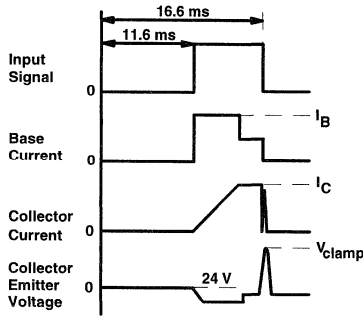


Figure 2. Functional Test Waveforms

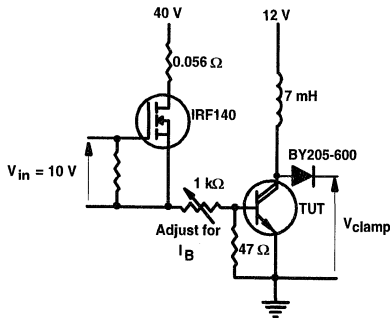


Figure 3. Switching Test Circuit

TIP160, TIP161, TIP162
NPN SILICON POWER DARLINGTONS

JUNE 1973 - REVISED MAY 1995

TYPICAL CHARACTERISTICS

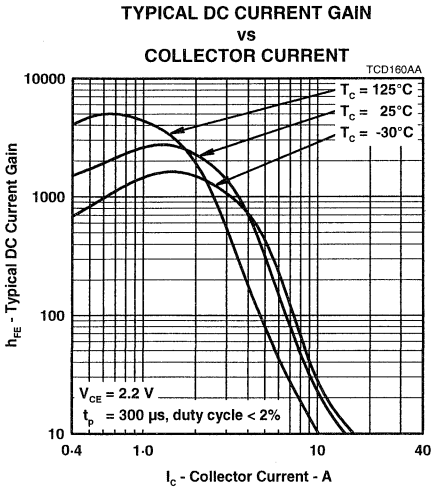


Figure 4.

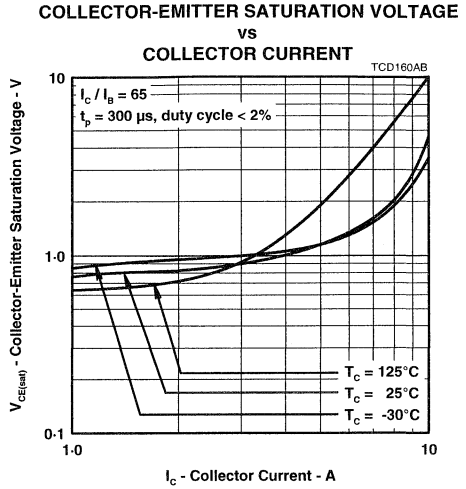


Figure 5.

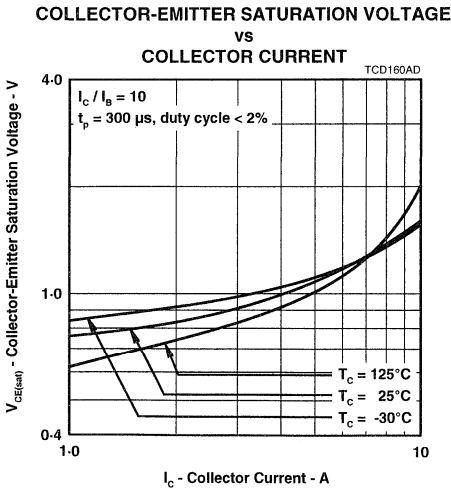


Figure 6.

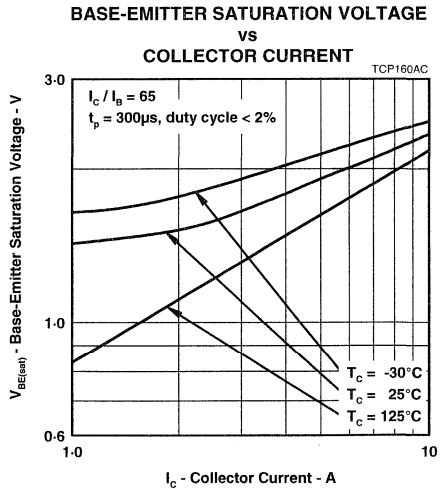


Figure 7.

MAXIMUM SAFE OPERATING REGIONS

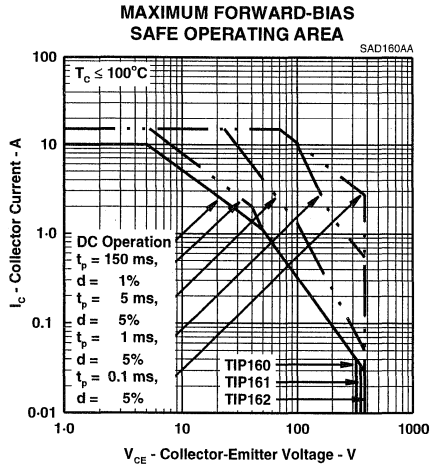


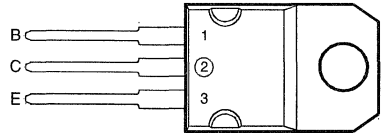
Figure 8.

TIPL760, TIPL760A NPN SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

- Rugged Triple-Diffused Planar Construction
- 4 A Continuous Collector Current
- Operating Characteristics Fully Guaranteed at 100°C
- 1000 Volt Blocking Capability
- 75 W at 25°C Case Temperature

TO-220 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIPL760	V_{CBO}	850	V
	TIPL760A		1000	
Collector-emitter voltage ($V_{BE} = 0$)	TIPL760	V_{CES}	850	V
	TIPL760A		1000	
Collector-emitter voltage ($I_B = 0$)	TIPL760	V_{CEO}	400	V
	TIPL760A		450	
Emitter-base voltage		V_{EBO}	10	V
Continuous collector current		I_C	4	A
Peak collector current (see Note 1)		I_{CM}	8	A
Continuous device dissipation at (or below) 25°C case temperature		P_{tot}	75	W
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C

NOTE 1: This value applies for $t_p \leq 10$ ms, duty cycle $\leq 2\%$.

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 **TEXAS
INSTRUMENTS**

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TIPL760, TIPL760A

NPN SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$V_{CEO(sus)}$ Collector-emitter sustaining voltage	$I_C = 10 \text{ mA}$ $L = 25 \text{ mH}$ (see Note 2) TIPL760 TIPL760A	400 450			V
I_{CES} Collector-emitter cut-off current	$V_{CE} = 850 \text{ V}$ $V_{BE} = 0$ TIPL760			50	μA
	$V_{CE} = 1000 \text{ V}$ $V_{BE} = 0$ TIPL760A			50	
	$V_{CE} = 850 \text{ V}$ $V_{BE} = 0$ $T_C = 100^\circ\text{C}$ TIPL760			200	
	$V_{CE} = 1000 \text{ V}$ $V_{BE} = 0$ $T_C = 100^\circ\text{C}$ TIPL760A			200	
I_{CEO} Collector cut-off current	$V_{CE} = 400 \text{ V}$ $I_B = 0$ TIPL760			50	μA
	$V_{CE} = 450 \text{ V}$ $I_B = 0$ TIPL760A			50	
I_{EBO} Emitter cut-off current	$V_{EB} = 10 \text{ V}$ $I_C = 0$			1	mA
h_{FE} Forward current transfer ratio	$V_{CE} = 5 \text{ V}$ $I_C = 0.5 \text{ A}$ (see Notes 3 and 4)	20		60	
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 0.5 \text{ A}$ $I_C = 2.5 \text{ A}$			1.0	V
	$I_B = 0.8 \text{ A}$ $I_C = 4 \text{ A}$ (see Notes 3 and 4)			2.5	
	$I_B = 0.8 \text{ A}$ $I_C = 4 \text{ A}$ $T_C = 100^\circ\text{C}$			5.0	
$V_{BE(sat)}$ Base-emitter saturation voltage	$I_B = 0.5 \text{ A}$ $I_C = 2.5 \text{ A}$			1.2	V
	$I_B = 0.8 \text{ A}$ $I_C = 4 \text{ A}$ (see Notes 3 and 4)			1.4	
	$I_B = 0.8 \text{ A}$ $I_C = 4 \text{ A}$ $T_C = 100^\circ\text{C}$			1.3	
f_t Current gain bandwidth product	$V_{CE} = 10 \text{ V}$ $I_C = 0.5 \text{ A}$ $f = 1 \text{ MHz}$		12		MHz
C_{ob} Output capacitance	$V_{CB} = 20 \text{ V}$ $I_E = 0$ $f = 0.1 \text{ MHz}$		110		pF

NOTES: 2. Inductive loop switching measurement.

3. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1.56	$^\circ\text{C/W}$

inductive-load-switching characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS †	MIN	TYP	MAX	UNIT
t_{sv} Voltage storage time	$I_C = 4 \text{ A}$ $I_{B(on)} = 0.8 \text{ A}$ (see Figures 1 and 2) $V_{BE(0\#)} = -5 \text{ V}$			2.5	μs
t_{rv} Voltage rise time				300	ns
t_{fl} Current fall time				250	ns
t_{tl} Current tail time				150	ns
t_{xo} Cross over time				400	ns
t_{sv} Voltage storage time	$I_C = 4 \text{ A}$ $I_{B(on)} = 0.8 \text{ A}$ (see Figures 1 and 2) $V_{BE(0\#)} = -5 \text{ V}$ $T_C = 100^\circ\text{C}$			3	μs
t_{rv} Voltage rise time				500	ns
t_{fl} Current fall time				250	ns
t_{tl} Current tail time				150	ns
t_{xo} Cross over time				750	ns

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

PARAMETER MEASUREMENT INFORMATION

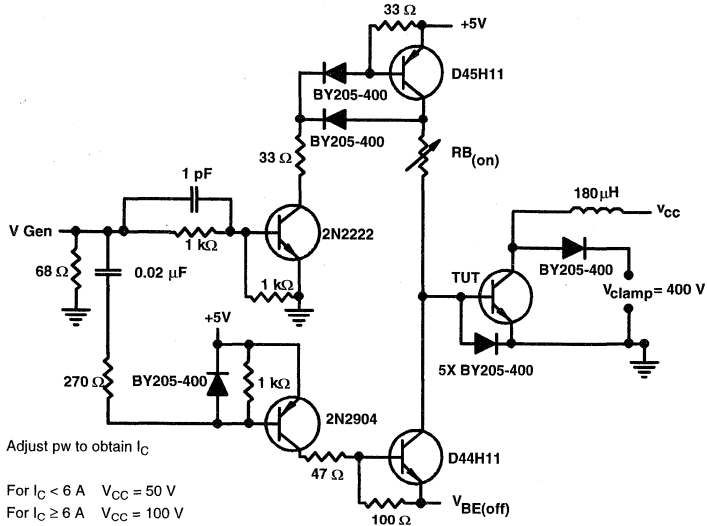
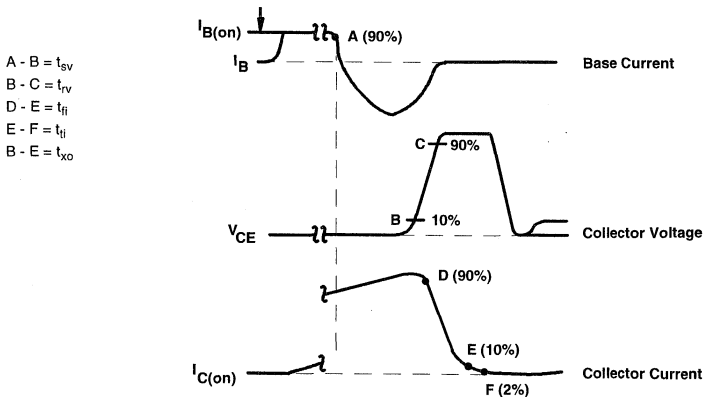


Figure 1. Inductive-Load Switching Test Circuit



NOTES: A. Waveforms are monitored on an oscilloscope with the following characteristics: $t_r < 15\text{ ns}$, $R_{in} > 10\ \Omega$, $C_{in} < 11.5\text{ pF}$.
B. Resistors must be noninductive types.

Figure 2. Inductive-Load Switching Waveforms

TIPL760, TIPL760A
NPN SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
vs
COLLECTOR CURRENT

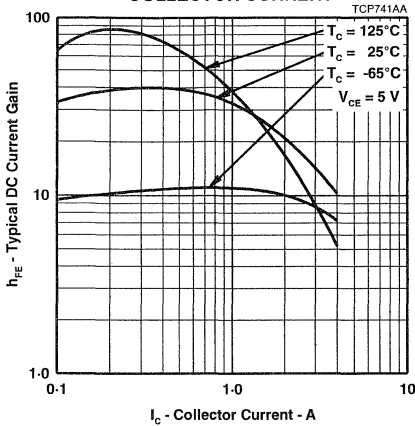


Figure 3.

COLLECTOR-EMITTER SATURATION VOLTAGE
vs
BASE CURRENT

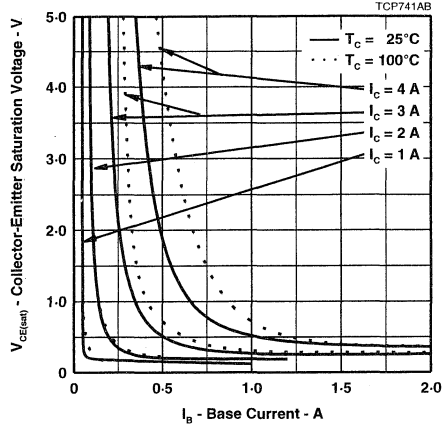


Figure 4.

BASE-EMITTER SATURATION VOLTAGE
vs
BASE CURRENT

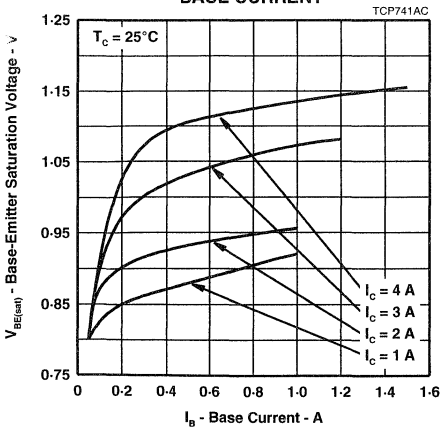


Figure 5.

COLLECTOR CUT-OFF CURRENT
vs
CASE TEMPERATURE

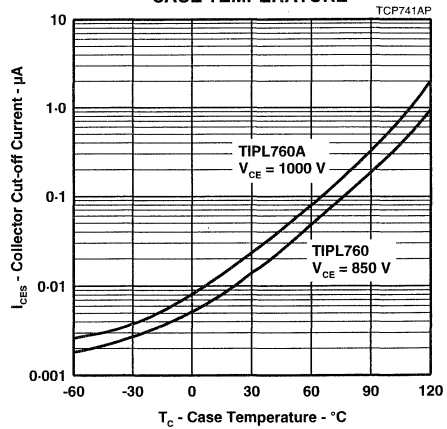


Figure 6.

MAXIMUM SAFE OPERATING REGIONS

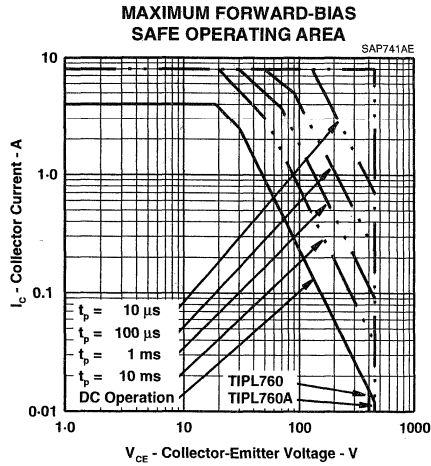


Figure 7.

THERMAL INFORMATION

THERMAL RESPONSE JUNCTION TO CASE
VS
POWER PULSE DURATION

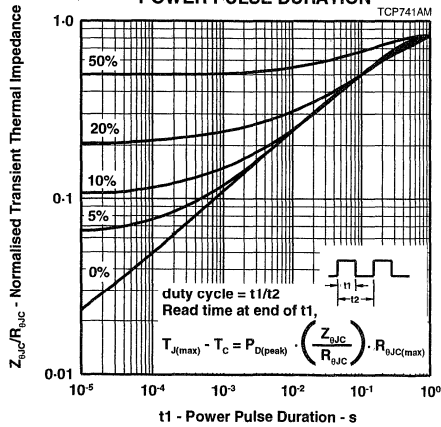
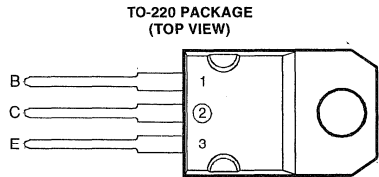


Figure 8.

TIPL760B, TIPL760C NPN SILICON POWER TRANSISTORS

MAY 1989 - REVISED MAY 1995

- Rugged Triple-Diffused Planar Construction
- 4 A Continuous Collector Current
- Operating Characteristics Fully Guaranteed at 100°C
- 1200 Volt Blocking Capability
- 75 W at 25°C Case Temperature



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIPL760B	V_{CBO}	1100	V
	TIPL760C		1200	
Collector-emitter voltage ($V_{BE} = 0$)	TIPL760B	V_{CES}	1100	V
	TIPL760C		1200	
Collector-emitter voltage ($I_B = 0$)	TIPL760B	V_{CEO}	500	V
	TIPL760C		550	
Emitter-base voltage		V_{EBO}	10	V
Continuous collector current		I_C	4	A
Peak collector current (see Note 1)		I_{CM}	8	A
Continuous device dissipation at (or below) 25°C case temperature		P_{tot}	75	W
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C

NOTE 1: This value applies for $t_p \leq 10$ ms, duty cycle $\leq 2\%$.

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TIPL760B, TIPL760C

NPN SILICON POWER TRANSISTORS

MAY 1989 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$V_{CEO(sus)}$ Collector-emitter sustaining voltage	$I_C = 10\text{ mA}$ $L = 25\text{ mH}$ (see Note 2)	TIPL760B 500 TIPL760C 550			V
I_{CES} Collector-emitter cut-off current	$V_{CE} = 1100\text{ V}$ $V_{BE} = 0$	TIPL760B		50	μA
	$V_{CE} = 1200\text{ V}$ $V_{BE} = 0$	TIPL760C		50	
	$V_{CE} = 1100\text{ V}$ $V_{BE} = 0$ $T_C = 100^\circ\text{C}$	TIPL760B		200	
	$V_{CE} = 1200\text{ V}$ $V_{BE} = 0$ $T_C = 100^\circ\text{C}$	TIPL760C		200	
I_{CEO} Collector cut-off current	$V_{CE} = 500\text{ V}$ $I_B = 0$	TIPL760B		50	μA
	$V_{CE} = 550\text{ V}$ $I_B = 0$	TIPL760C		50	
I_{EBO} Emitter cut-off current	$V_{EB} = 10\text{ V}$ $I_C = 0$			1	mA
h_{FE} Forward current transfer ratio	$V_{CE} = 5\text{ V}$ $I_C = 0.5\text{ A}$ (see Notes 3 and 4)		20	60	
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 0.4\text{ A}$ $I_C = 2\text{ A}$			1.0	V
	$I_B = 0.6\text{ A}$ $I_C = 3\text{ A}$ (see Notes 3 and 4)			2.5	
	$I_B = 0.6\text{ A}$ $I_C = 3\text{ A}$ $T_C = 100^\circ\text{C}$			5.0	
$V_{BE(sat)}$ Base-emitter saturation voltage	$I_B = 0.4\text{ A}$ $I_C = 2\text{ A}$			1.2	V
	$I_B = 0.6\text{ A}$ $I_C = 3\text{ A}$ (see Notes 3 and 4)			1.4	
	$I_B = 0.6\text{ A}$ $I_C = 3\text{ A}$ $T_C = 100^\circ\text{C}$			1.3	
f_t Current gain bandwidth product	$V_{CE} = 10\text{ V}$ $I_C = 0.5\text{ A}$ $f = 1\text{ MHz}$		12		MHz
C_{ob} Output capacitance	$V_{CB} = 20\text{ V}$ $I_E = 0$ $f = 0.1\text{ MHz}$		110		pF

NOTES: 2. Inductive loop switching measurement.

3. These parameters must be measured using pulse techniques, $t_p = 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1.56	$^\circ\text{C/W}$

inductive-load-switching characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS †	MIN	TYP	MAX	UNIT
t_{SV} Voltage storage time	$I_C = 3\text{ A}$ $I_{B(on)} = 0.6\text{ A}$ (see Figures 1 and 2) $V_{BE(off)} = -5\text{ V}$			2.5	μs
t_{rV} Voltage rise time				300	ns
t_{fI} Current fall time				250	ns
t_{tI} Current tail time				150	ns
t_{xO} Cross over time				400	ns
t_{SV} Voltage storage time	$I_C = 3\text{ A}$ $I_{B(on)} = 0.6\text{ A}$ (see Figures 1 and 2) $V_{BE(off)} = -5\text{ V}$ $T_C = 100^\circ\text{C}$			3	μs
t_{rV} Voltage rise time				500	ns
t_{fI} Current fall time				250	ns
t_{tI} Current tail time				150	ns
t_{xO} Cross over time				750	ns

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.



TIPL760B, TIPL760C
NPN SILICON POWER TRANSISTORS

MAY 1989 - REVISED MAY 1995

TYPICAL CHARACTERISTICS

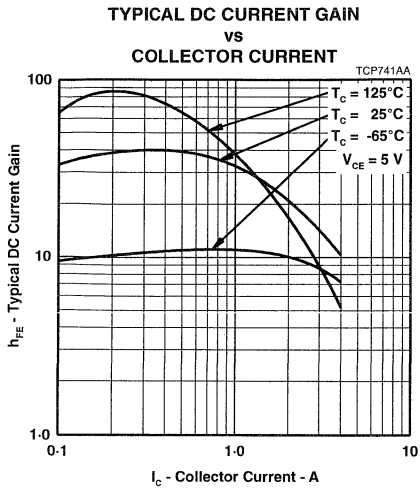


Figure 3.

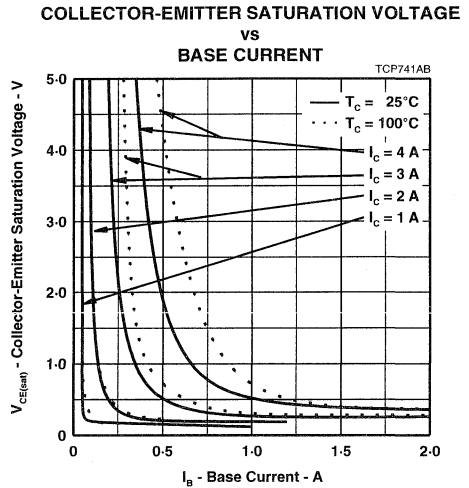


Figure 4.

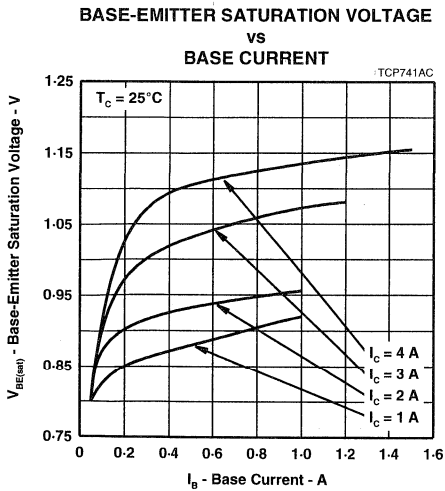


Figure 5.

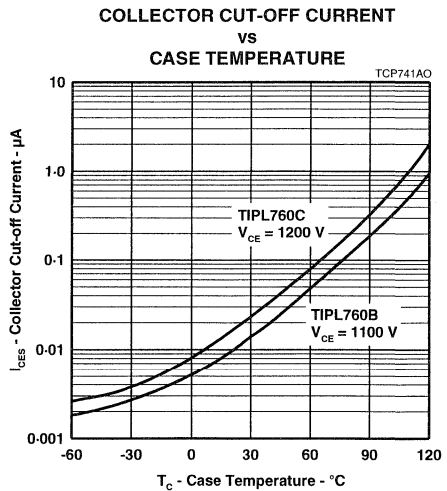


Figure 6.

MAXIMUM SAFE OPERATING REGIONS

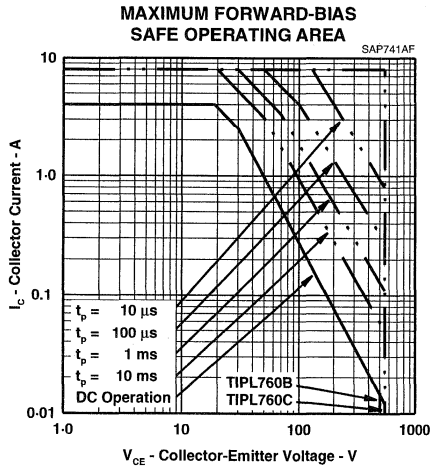


Figure 7.

THERMAL INFORMATION

**THERMAL RESPONSE JUNCTION TO CASE
VS
POWER PULSE DURATION**

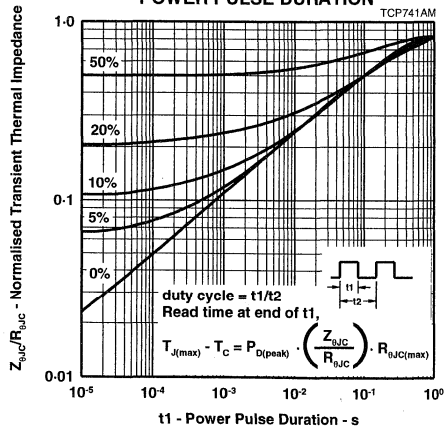
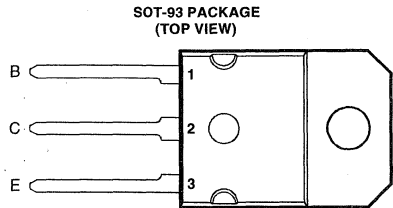


Figure 8.

TIPL761, TIPL761A NPN SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

- Rugged Triple-Diffused Planar Construction
- 4 A Continuous Collector Current
- Operating Characteristics Fully Guaranteed at 100°C
- 1000 Volt Blocking Capability
- 100 W at 25°C Case Temperature



Pin 2 is in electrical contact with the mounting base.

MDTRAA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIPL761	V_{CBO}	850	V
	TIPL761A		1000	
Collector-emitter voltage ($V_{BE} = 0$)	TIPL761	V_{CES}	850	V
	TIPL761A		1000	
Collector-emitter voltage ($I_B = 0$)	TIPL761	V_{CEO}	400	V
	TIPL761A		450	
Emitter-base voltage		V_{EBO}	10	V
Continuous collector current		I_C	4	A
Peak collector current (see Note 1)		I_{CM}	8	A
Continuous device dissipation at (or below) 25°C case temperature		P_{tot}	100	W
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C

NOTE 1: This value applies for $t_p \leq 10$ ms, duty cycle $\leq 2\%$.

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TIPL761, TIPL761A

NPN SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{CE(sus)}$	Collector-emitter sustaining voltage	$I_C = 10\text{ mA}$	$L = 25\text{ mH}$	(see Note 2)	TIPL761	400		V
					TIPL761A	450		
I_{CES}	Collector-emitter cut-off current	$V_{CE} = 850\text{ V}$	$V_{BE} = 0$	$T_C = 100^\circ\text{C}$	TIPL761		50	μA
					TIPL761A		50	
					TIPL761		200	
					TIPL761A		200	
I_{CEO}	Collector cut-off current	$V_{CE} = 400\text{ V}$	$I_B = 0$	$T_C = 100^\circ\text{C}$	TIPL761		50	μA
					TIPL761A		50	
I_{EBO}	Emitter cut-off current	$V_{EB} = 10\text{ V}$	$I_C = 0$			1	mA	
h_{FE}	Forward current transfer ratio	$V_{CE} = 5\text{ V}$	$I_C = 0.5\text{ A}$	(see Notes 3 and 4)	20		60	
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = 0.5\text{ A}$	$I_C = 2.5\text{ A}$	(see Notes 3 and 4)	$T_C = 100^\circ\text{C}$		1.0	V
							2.5	
							5.0	
$V_{BE(sat)}$	Base-emitter saturation voltage	$I_B = 0.5\text{ A}$	$I_C = 2.5\text{ A}$	(see Notes 3 and 4)	$T_C = 100^\circ\text{C}$		1.2	V
							1.4	
							1.3	
f_t	Current gain bandwidth product	$V_{CE} = 10\text{ V}$	$I_C = 0.5\text{ A}$	$f = 1\text{ MHz}$		12		MHz
C_{ob}	Output capacitance	$V_{CB} = 20\text{ V}$	$I_E = 0$	$f = 0.1\text{ MHz}$		110		pF

NOTES: 2. Inductive loop switching measurement.

3. These parameters must be measured using pulse techniques, $t_p = 300\ \mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.25	$^\circ\text{C/W}$

inductive-load-switching characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT	
t_{sv}	Voltage storage time	$I_C = 4\text{ A}$	$V_{BE(off)} = -5\text{ V}$	$I_{B(on)} = 0.8\text{ A}$				2.5	μs
t_{rv}	Voltage rise time							300	ns
t_{fl}	Current fall time							250	ns
t_{tl}	Current tail time							150	ns
t_{xo}	Cross over time							400	ns
t_{sv}	Voltage storage time	$I_C = 4\text{ A}$	$V_{BE(off)} = -5\text{ V}$	$I_{B(on)} = 0.8\text{ A}$	$T_C = 100^\circ\text{C}$			3	μs
t_{rv}	Voltage rise time							500	ns
t_{fl}	Current fall time							250	ns
t_{tl}	Current tail time							150	ns
t_{xo}	Cross over time							750	ns

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TIPL761, TIPL761A NPN SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

TYPICAL CHARACTERISTICS

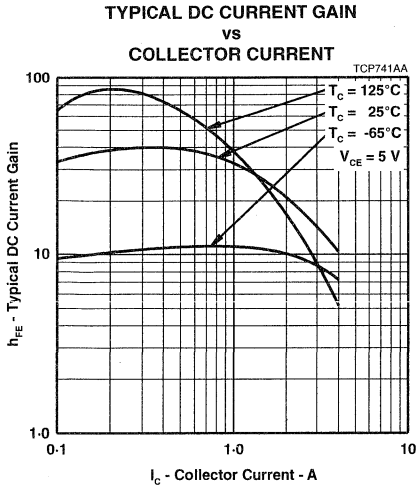


Figure 3.

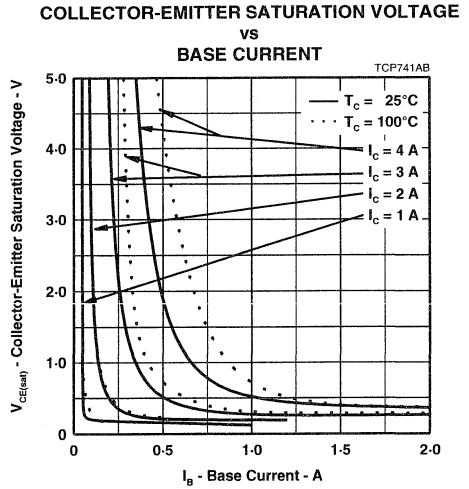


Figure 4.

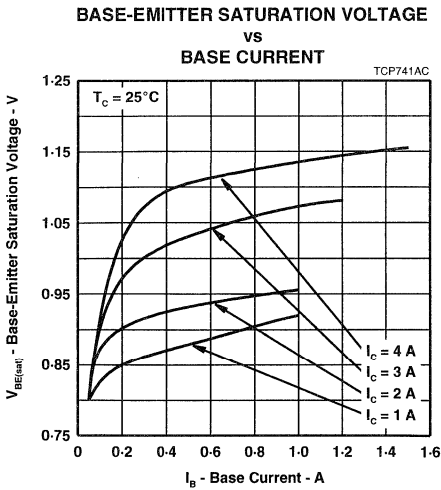


Figure 5.

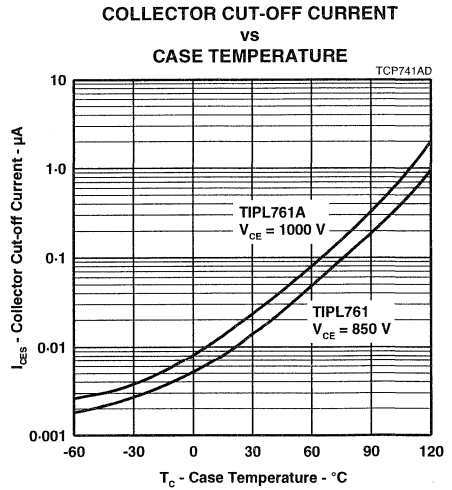


Figure 6.

MAXIMUM SAFE OPERATING REGIONS

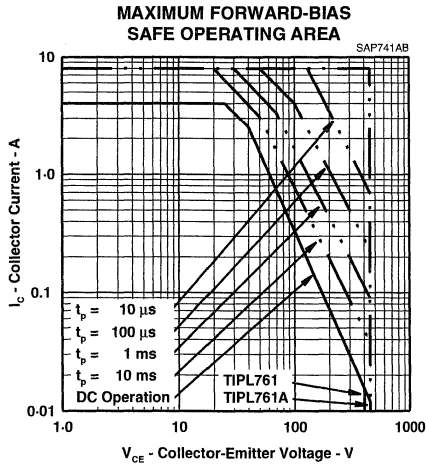


Figure 7.

THERMAL INFORMATION

THERMAL RESPONSE JUNCTION TO CASE
VS
POWER PULSE DURATION

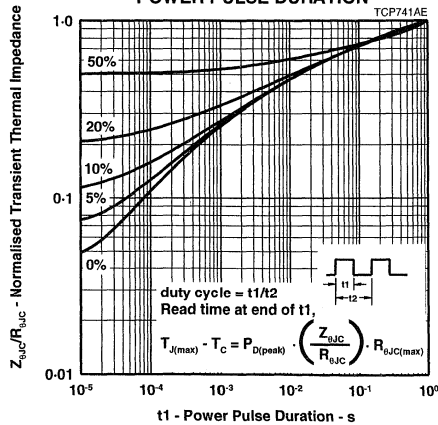


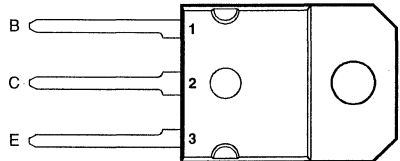
Figure 8.

TIPL761B, TIPL761C NPN SILICON POWER TRANSISTORS

MAY 1989 - REVISED MAY 1995

- Rugged Triple-Diffused Planar Construction
- 4 A Continuous Collector Current
- Operating Characteristics Fully Guaranteed at 100°C
- 1200 Volt Blocking Capability
- 100 W at 25°C Case Temperature

SOT-93 PACKAGE
(TOP VIEW)



Pin 2 is in electrical contact with the mounting base.

MDTRAA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIPL761B	V_{CB0}	1100	V
	TIPL761C		1200	
Collector-emitter voltage ($V_{BE} = 0$)	TIPL761B	V_{CES}	1100	V
	TIPL761C		1200	
Collector-emitter voltage ($I_B = 0$)	TIPL761B	V_{CEO}	500	V
	TIPL761C		550	
Emitter-base voltage		V_{EBO}	10	V
Continuous collector current		I_C	4	A
Peak collector current (see Note 1)		I_{CM}	8	A
Continuous device dissipation at (or below) 25°C case temperature		P_{tot}	100	W
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C

NOTE 1: This value applies for $t_p \leq 10$ ms, duty cycle $\leq 2\%$.

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TIPL761B, TIPL761C

NPN SILICON POWER TRANSISTORS

MAY 1989 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{CE0(sus)}$	Collector-emitter sustaining voltage	$I_C = 10\text{ mA}$	$L = 25\text{ mH}$	(see Note 2)	TIPL761B TIPL761C	500 550		V
I_{CES}	Collector-emitter cut-off current	$V_{CE} = 1100\text{ V}$	$V_{BE} = 0$		TIPL761B		50	μA
		$V_{CE} = 1200\text{ V}$	$V_{BE} = 0$		TIPL761C		50	
		$V_{CE} = 1100\text{ V}$	$V_{BE} = 0$	$T_C = 100^\circ\text{C}$	TIPL761B		200	
		$V_{CE} = 1200\text{ V}$	$V_{BE} = 0$	$T_C = 100^\circ\text{C}$	TIPL761C		200	
I_{CEO}	Collector cut-off current	$V_{CE} = 500\text{ V}$	$I_B = 0$		TIPL761B		50	μA
		$V_{CE} = 550\text{ V}$	$I_B = 0$		TIPL761C		50	
I_{EBO}	Emitter cut-off current	$V_{EB} = 10\text{ V}$	$I_C = 0$				1	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = 5\text{ V}$	$I_C = 0.5\text{ A}$	(see Notes 3 and 4)		20	60	
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = 0.4\text{ A}$	$I_C = 2\text{ A}$				1.0	V
		$I_B = 0.6\text{ A}$	$I_C = 3\text{ A}$	(see Notes 3 and 4)			2.5	
		$I_B = 0.6\text{ A}$	$I_C = 3\text{ A}$	$T_C = 100^\circ\text{C}$			5.0	
$V_{BE(sat)}$	Base-emitter saturation voltage	$I_B = 0.4\text{ A}$	$I_C = 2\text{ A}$				1.2	V
		$I_B = 0.6\text{ A}$	$I_C = 3\text{ A}$	(see Notes 3 and 4)			1.4	
		$I_B = 0.6\text{ A}$	$I_C = 3\text{ A}$	$T_C = 100^\circ\text{C}$			1.3	
f_t	Current gain bandwidth product	$V_{CE} = 10\text{ V}$	$I_C = 0.5\text{ A}$	$f = 1\text{ MHz}$		12		MHz
C_{ob}	Output capacitance	$V_{CB} = 20\text{ V}$	$I_E = 0$	$f = 0.1\text{ MHz}$		110		pF

NOTES: 2. Inductive loop switching measurement.

3. These parameters must be measured using pulse techniques, $t_p = 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.25	$^\circ\text{C/W}$

inductive-load-switching characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{sv}	Voltage storage time	$I_C = 3\text{ A}$	$I_{B(on)} = 0.6\text{ A}$	(see Figures 1 and 2)			2.5	μs
t_{rv}	Voltage rise time						300	ns
t_{fi}	Current fall time						250	ns
t_{ti}	Current tail time				$V_{BE(off)} = -5\text{ V}$		150	ns
t_{xo}	Cross over time						400	ns
t_{sv}	Voltage storage time	$I_C = 3\text{ A}$	$I_{B(on)} = 0.6\text{ A}$	(see Figures 1 and 2)			3	μs
t_{rv}	Voltage rise time						500	ns
t_{fi}	Current fall time				$V_{BE(off)} = -5\text{ V}$	$T_C = 100^\circ\text{C}$	250	ns
t_{ti}	Current tail time						150	ns
t_{xo}	Cross over time						750	ns

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

PARAMETER MEASUREMENT INFORMATION

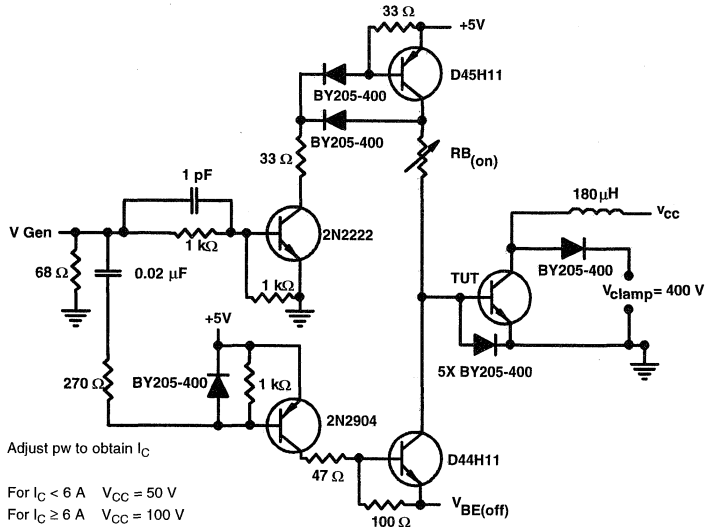
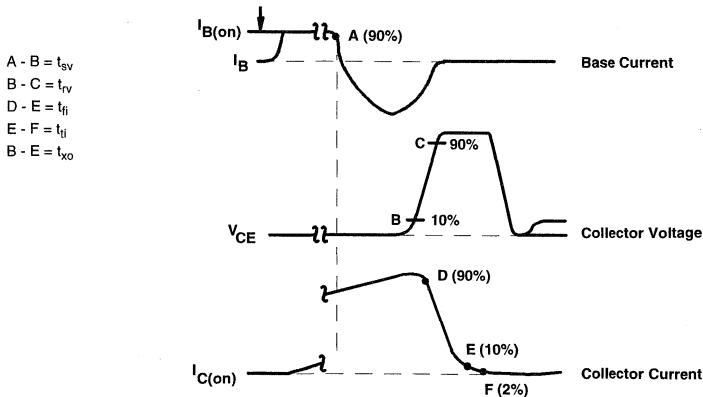


Figure 1. Inductive-Load Switching Test Circuit



NOTES: A. Waveforms are monitored on an oscilloscope with the following characteristics: $t_r < 15\text{ ns}$, $R_{in} > 10\ \Omega$, $C_{in} < 11.5\text{ pF}$.
B. Resistors must be noninductive types.

Figure 2. Inductive-Load Switching Waveforms

TIPL761B, TIPL761C
NPN SILICON POWER TRANSISTORS

MAY 1989 - REVISED MAY 1995

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
vs
COLLECTOR CURRENT

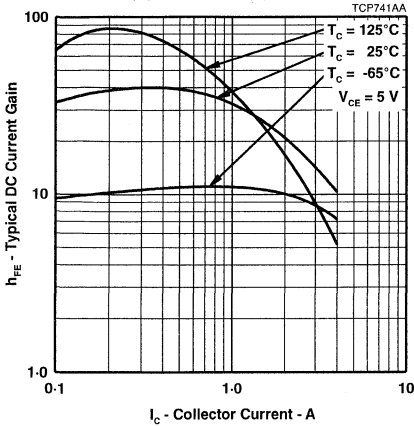


Figure 3.

COLLECTOR-EMITTER SATURATION VOLTAGE
vs
BASE CURRENT

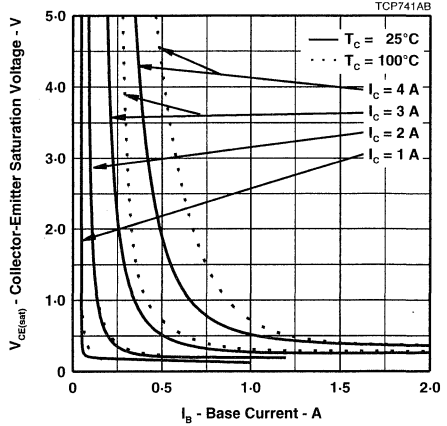


Figure 4.

BASE-EMITTER SATURATION VOLTAGE
vs
BASE CURRENT

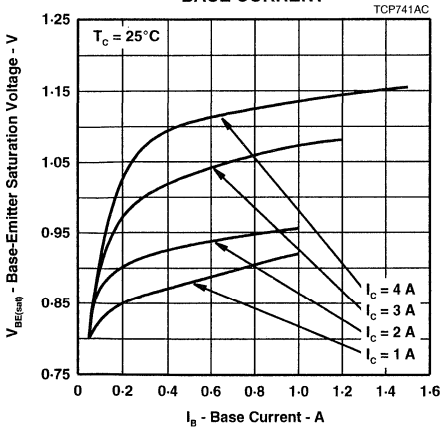


Figure 5.

COLLECTOR CUT-OFF CURRENT
vs
CASE TEMPERATURE

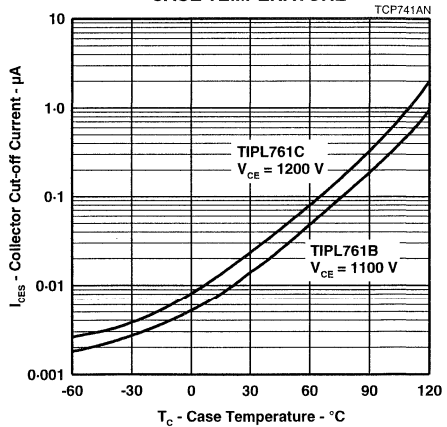


Figure 6.

MAXIMUM SAFE OPERATING REGIONS

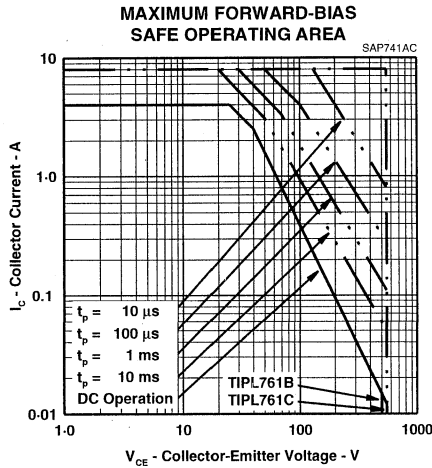


Figure 7.

THERMAL INFORMATION

THERMAL RESPONSE JUNCTION TO CASE
vs
POWER PULSE DURATION

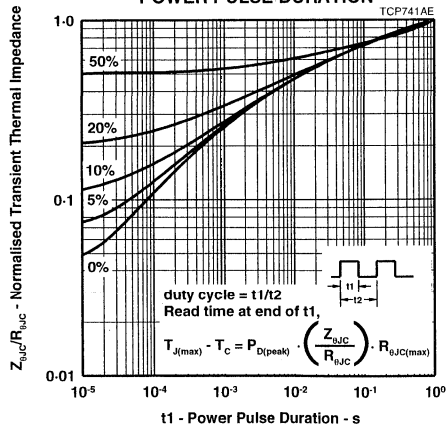
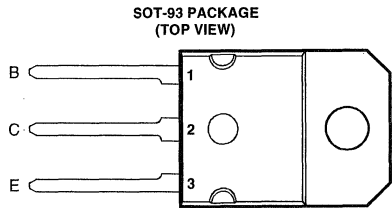


Figure 8.

TIPL762, TIPL762A NPN SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

- Rugged Triple-Diffused Planar Construction
- 6 A Continuous Collector Current
- Operating Characteristics Fully Guaranteed at 100°C
- 1000 Volt Blocking Capability
- 120 W at 25°C Case Temperature



Pin 2 is in electrical contact with the mounting base.

MDTRAA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIPL762	V_{CBO}	850	V
	TIPL762A		1000	
Collector-emitter voltage ($V_{BE} = 0$)	TIPL762	V_{CES}	850	V
	TIPL762A		1000	
Collector-emitter voltage ($I_B = 0$)	TIPL762	V_{CEO}	400	V
	TIPL762A		450	
Emitter-base voltage		V_{EBO}	10	V
Continuous collector current		I_C	6	A
Peak collector current (see Note 1)		I_{CM}	12	A
Continuous device dissipation at (or below) 25°C case temperature		P_{tot}	120	W
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C

NOTE 1: This value applies for $t_p \leq 10$ ms, duty cycle $\leq 2\%$.

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TIPL762, TIPL762A

NPN SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{CE(sus)}$ Collector-emitter sustaining voltage	$I_C = 100 \text{ mA}$	$L = 25 \text{ mH}$	(see Note 2)	TIPL762 400 TIPL762A 450			V
I_{CES} Collector-emitter cut-off current	$V_{CE} = 850 \text{ V}$	$V_{BE} = 0$		TIPL762		50	μA
	$V_{CE} = 1000 \text{ V}$	$V_{BE} = 0$		TIPL762A		50	
	$V_{CE} = 850 \text{ V}$	$V_{BE} = 0$	$T_C = 100^\circ\text{C}$	TIPL762		200	
	$V_{CE} = 1000 \text{ V}$	$V_{BE} = 0$	$T_C = 100^\circ\text{C}$	TIPL762A		200	
I_{CEO} Collector cut-off current	$V_{CE} = 400 \text{ V}$	$I_B = 0$		TIPL762		50	μA
	$V_{CE} = 450 \text{ V}$	$I_B = 0$		TIPL762A		50	
I_{EBO} Emitter cut-off current	$V_{EB} = 10 \text{ V}$	$I_C = 0$				1	mA
h_{FE} Forward current transfer ratio	$V_{CE} = 5 \text{ V}$	$I_C = 0.5 \text{ A}$	(see Notes 3 and 4)	20		60	
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 0.4 \text{ A}$	$I_C = 2 \text{ A}$				0.5	V
	$I_B = 0.8 \text{ A}$	$I_C = 4 \text{ A}$	(see Notes 3 and 4)			1.0	
	$I_B = 1.2 \text{ A}$	$I_C = 6 \text{ A}$				2.5	
	$I_B = 1.2 \text{ A}$	$I_C = 6 \text{ A}$	$T_C = 100^\circ\text{C}$			5.0	
$V_{BE(sat)}$ Base-emitter saturation voltage	$I_B = 0.4 \text{ A}$	$I_C = 2 \text{ A}$				1.1	V
	$I_B = 0.8 \text{ A}$	$I_C = 4 \text{ A}$	(see Notes 3 and 4)			1.3	
	$I_B = 1.2 \text{ A}$	$I_C = 6 \text{ A}$				1.5	
	$I_B = 1.2 \text{ A}$	$I_C = 6 \text{ A}$	$T_C = 100^\circ\text{C}$			1.4	
f_t Current gain bandwidth product	$V_{CE} = 10 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ MHz}$		6		MHz
C_{ob} Output capacitance	$V_{CB} = 20 \text{ V}$	$I_E = 0$	$f = 0.1 \text{ MHz}$		105		pF

NOTES: 2. Inductive loop switching measurement.

3. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1.25	$^\circ\text{C/W}$

inductive-load-switching characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{sv} Voltage storage time	$I_C = 6 \text{ A}$ $V_{BE(off)} = -10 \text{ V}$	$I_{B(on)} = 1.2 \text{ A}$	(see Figures 1 and 2)			2.5	μs
t_{rv} Voltage rise time						200	ns
t_{fi} Current fall time						150	ns
t_{ti} Current tail time						50	ns
t_{xo} Cross over time						300	ns
t_{sv} Voltage storage time	$I_C = 6 \text{ A}$ $V_{BE(off)} = -10 \text{ V}$	$I_{B(on)} = 1.2 \text{ A}$ $T_C = 100^\circ\text{C}$	(see Figures 1 and 2)			3	μs
t_{rv} Voltage rise time						300	ns
t_{fi} Current fall time						150	ns
t_{ti} Current tail time						50	ns
t_{xo} Cross over time						500	ns

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TIPL762, TIPL762A
NPN SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

TYPICAL CHARACTERISTICS

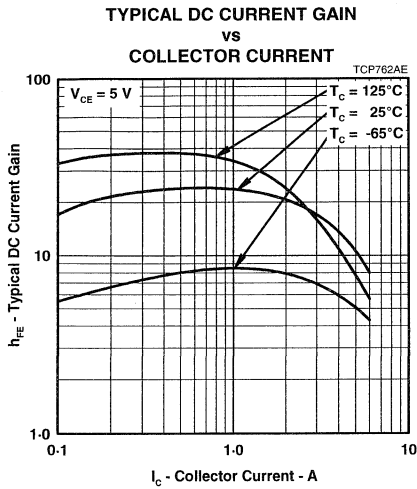


Figure 3.

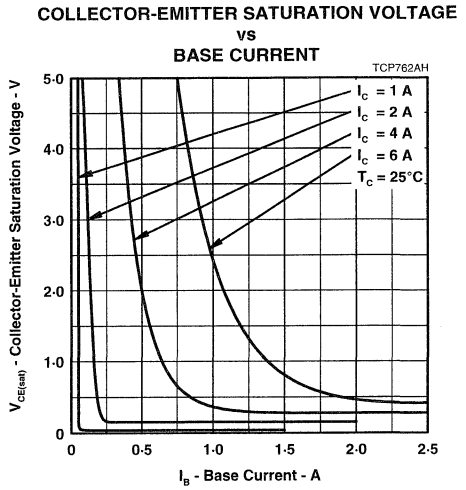


Figure 4.

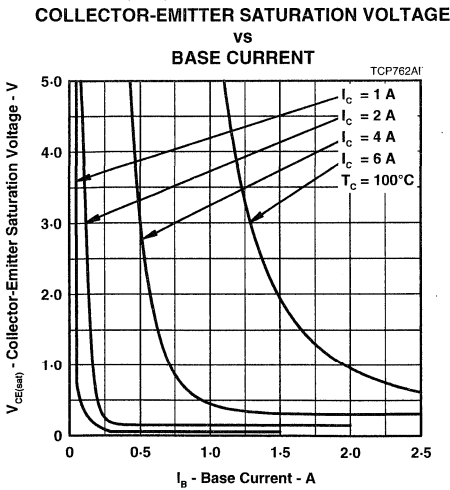


Figure 5.

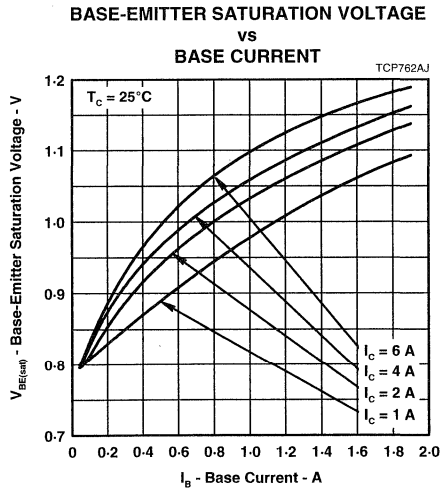


Figure 6.

TYPICAL CHARACTERISTICS

COLLECTOR CUT-OFF CURRENT
vs
CASE TEMPERATURE

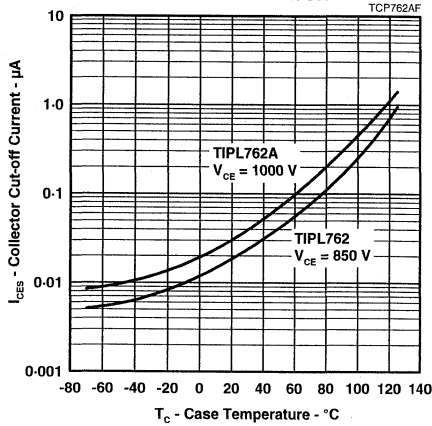


Figure 7.

MAXIMUM SAFE OPERATING REGIONS

MAXIMUM FORWARD-BIAS
SAFE OPERATING AREA

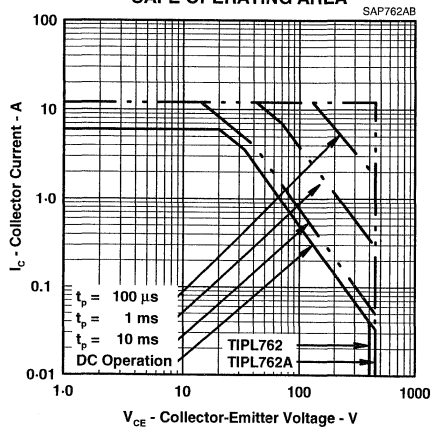


Figure 8.

THERMAL INFORMATION

THERMAL RESPONSE JUNCTION TO CASE
 vs
 POWER PULSE DURATION

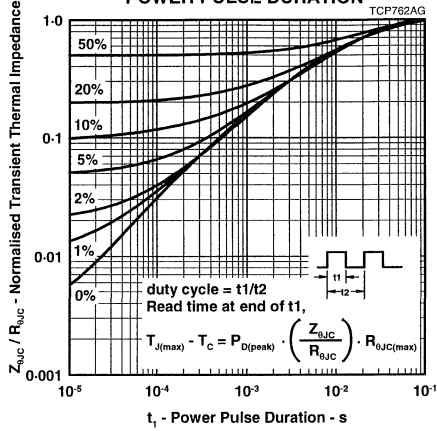
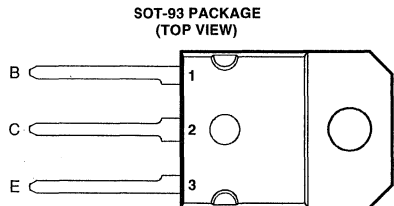


Figure 9.

TIPL765, TIPL765A NPN SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

- Rugged Triple-Diffused Planar Construction
- 10 A Continuous Collector Current
- Operating Characteristics Fully Guaranteed at 100°C
- 1000 Volt Blocking Capability
- 125 W at 25°C Case Temperature



Pin 2 is in electrical contact with the mounting base.

MDTRAA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIPL765 TIPL765A	V_{CBO}	850 1000	V
Collector-emitter voltage ($V_{BE} = 0$)	TIPL765 TIPL765A	V_{CES}	850 1000	V
Collector-emitter voltage ($I_B = 0$)	TIPL765 TIPL765A	V_{CEO}	400 450	V
Emitter-base voltage		V_{EBO}	10	V
Continuous collector current		I_C	10	A
Peak collector current (see Note 1)		I_{CM}	15	A
Continuous device dissipation at (or below) 25°C case temperature		P_{tot}	125	W
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C

NOTE 1: This value applies for $t_p \leq 10$ ms, duty cycle $\leq 2\%$.

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TIPL765, TIPL765A

NPN SILICON POWER TRANSISTORS

AUGUST 1978 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$V_{CE(sus)}$ Collector-emitter sustaining voltage	$I_C = 100 \text{ mA}$ $L = 25 \text{ mH}$ (see Note 2)	TIPL765 400 TIPL765A 450			V
I_{CES} Collector-emitter cut-off current	$V_{CE} = 850 \text{ V}$ $V_{BE} = 0$ $V_{CE} = 1000 \text{ V}$ $V_{BE} = 0$ $V_{CE} = 850 \text{ V}$ $V_{BE} = 0$ $T_C = 100^\circ\text{C}$ $V_{CE} = 1000 \text{ V}$ $V_{BE} = 0$ $T_C = 100^\circ\text{C}$			50 50 200 200	μA
I_{CEO} Collector cut-off current	$V_{CE} = 400 \text{ V}$ $I_B = 0$ $V_{CE} = 450 \text{ V}$ $I_B = 0$			50 50	μA
I_{EBO} Emitter cut-off current	$V_{EB} = 10 \text{ V}$ $I_C = 0$			1	mA
h_{FE} Forward current transfer ratio	$V_{CE} = 5 \text{ V}$ $I_C = 0.5 \text{ A}$ (see Notes 3 and 4)		15	60	
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 0.4 \text{ A}$ $I_C = 2 \text{ A}$ $I_B = 1 \text{ A}$ $I_C = 5 \text{ A}$ (see Notes 3 and 4) $I_B = 2 \text{ A}$ $I_C = 10 \text{ A}$ $I_B = 2 \text{ A}$ $I_C = 10 \text{ A}$ $T_C = 100^\circ\text{C}$			0.5 1.0 2.5 5.0	V
$V_{BE(sat)}$ Base-emitter saturation voltage	$I_B = 0.4 \text{ A}$ $I_C = 2 \text{ A}$ $I_B = 1 \text{ A}$ $I_C = 5 \text{ A}$ (see Notes 3 and 4) $I_B = 2 \text{ A}$ $I_C = 10 \text{ A}$ $I_B = 2 \text{ A}$ $I_C = 10 \text{ A}$ $T_C = 100^\circ\text{C}$			1.1 1.3 1.7 1.6	V
f_t Current gain bandwidth product	$V_{CE} = 10 \text{ V}$ $I_C = 0.5 \text{ A}$ $f = 1 \text{ MHz}$		8		MHz
C_{ob} Output capacitance	$V_{CB} = 20 \text{ V}$ $I_E = 0$ $f = 0.1 \text{ MHz}$		150		pF

NOTES: 2. Inductive loop switching measurement.

3. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1	$^\circ\text{C/W}$

inductive-load-switching characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS †	MIN	TYP	MAX	UNIT
t_{sv} Voltage storage time	$I_C = 10 \text{ A}$ $V_{BE(off)} = -5 \text{ V}$ $I_{B(on)} = 2 \text{ A}$ (see Figures 1 and 2)			2	μs
t_{rv} Voltage rise time				300	ns
t_{fi} Current fall time				200	ns
t_{tj} Current tail time				50	ns
t_{xo} Cross over time				400	ns
t_{sv} Voltage storage time	$I_C = 10 \text{ A}$ $V_{BE(off)} = -5 \text{ V}$ $I_{B(on)} = 2 \text{ A}$ $T_C = 100^\circ\text{C}$ (see Figures 1 and 2)			3.5	μs
t_{rv} Voltage rise time				400	ns
t_{fi} Current fall time				300	ns
t_{tj} Current tail time				80	ns
t_{xo} Cross over time				500	ns

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

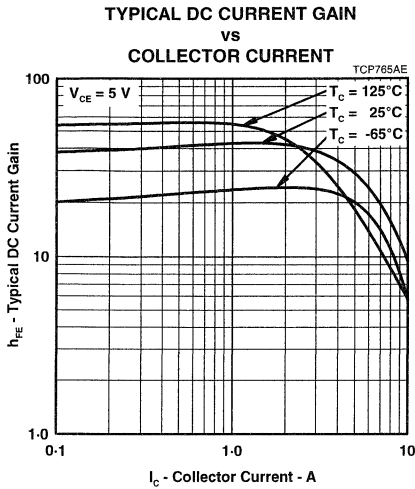


Figure 3.

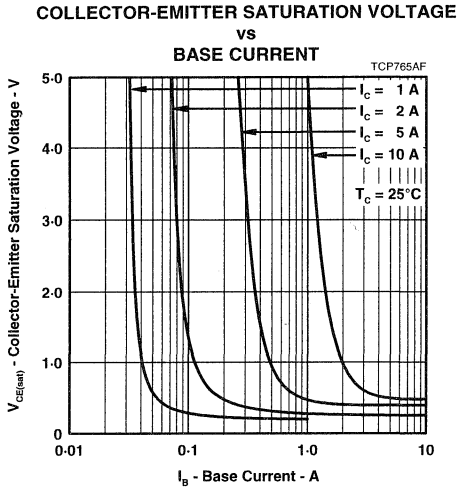


Figure 4.

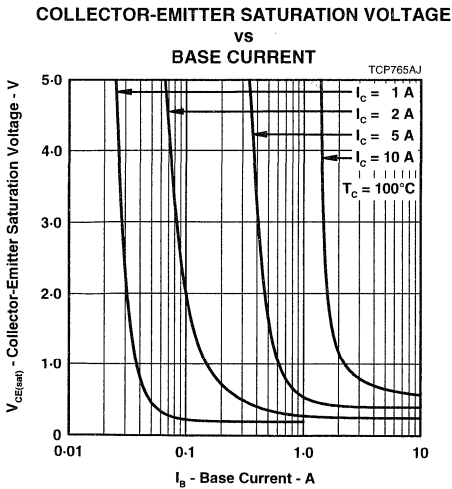


Figure 5.

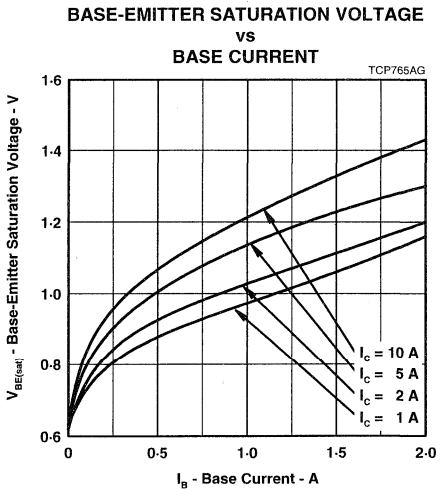


Figure 6.

TYPICAL CHARACTERISTICS

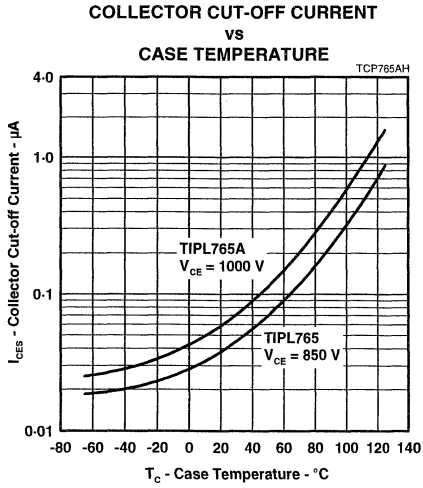


Figure 7.

MAXIMUM SAFE OPERATING REGIONS

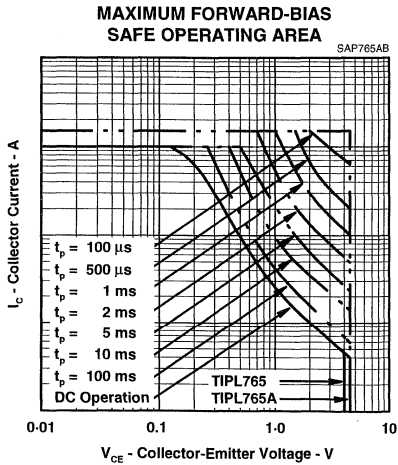


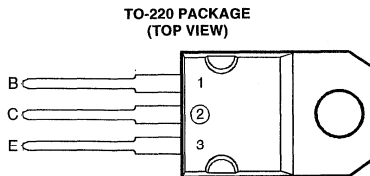
Figure 8.

TIPL770

NPN SILICON POWER TRANSISTOR

MARCH 1984 - REVISED MAY 1995

- Rugged Triple-Diffused Planar Construction
- 2.5 A Continuous Collector Current
- Operating Characteristics Fully Guaranteed at 100°C
- 850 Volt Blocking Capability
- 50 W at 25°C Case Temperature



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING	SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	V_{CBO}	850	V
Collector-emitter voltage ($V_{BE} = 0$)	V_{CES}	850	V
Collector-emitter voltage ($I_B = 0$)	V_{CEO}	400	V
Emitter-base voltage	V_{EBO}	10	V
Continuous collector current	I_C	2.5	A
Peak collector current (see Note 1)	I_{CM}	8	A
Continuous device dissipation at (or below) 25°C case temperature	P_{tot}	50	W
Operating junction temperature range	T_J	-65 to +150	°C
Storage temperature range	T_{stg}	-65 to +150	°C

NOTE 1: This value applies for $t_p \leq 10$ ms, duty cycle $\leq 2\%$.

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TIPL770

NPN SILICON POWER TRANSISTOR

MARCH 1984 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$V_{CE(sus)}$ Collector-emitter sustaining voltage	$I_C = 100 \text{ mA}$ $L = 25 \text{ mH}$ (see Note 2)	400			V
I_{CES} Collector-emitter cut-off current	$V_{CE} = 850 \text{ V}$ $V_{BE} = 0$ $V_{CE} = 850 \text{ V}$ $V_{BE} = 0$ $T_C = 100^\circ\text{C}$			5 200	μA
I_{CEO} Collector cut-off current	$V_{CE} = 400 \text{ V}$ $I_B = 0$			5	μA
I_{EBO} Emitter cut-off current	$V_{EB} = 10 \text{ V}$ $I_C = 0$			1	mA
h_{FE} Forward current transfer ratio	$V_{CE} = 5 \text{ V}$ $I_C = 0.5 \text{ A}$ (see Notes 3 and 4)	20		60	
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 0.2 \text{ A}$ $I_C = 1 \text{ A}$ (see Notes 3 and 4) $I_B = 0.5 \text{ A}$ $I_C = 2.5 \text{ A}$ $I_B = 0.5 \text{ A}$ $I_C = 2.5 \text{ A}$ $T_C = 100^\circ\text{C}$			1.0 2.5 5.0	V
$V_{BE(sat)}$ Base-emitter saturation voltage	$I_B = 0.2 \text{ A}$ $I_C = 1 \text{ A}$ (see Notes 3 and 4) $I_B = 0.5 \text{ A}$ $I_C = 2.5 \text{ A}$ $I_B = 0.5 \text{ A}$ $I_C = 2.5 \text{ A}$ $T_C = 100^\circ\text{C}$			1.0 1.2 1.3	V
f_t Current gain bandwidth product	$V_{CE} = 10 \text{ V}$ $I_C = 0.5 \text{ A}$ $f = 1 \text{ MHz}$		12		MHz
C_{ob} Output capacitance	$V_{CB} = 20 \text{ V}$ $I_E = 0$ $f = 0.1 \text{ MHz}$		55		pF

- NOTES: 2. Inductive loop switching measurement.
3. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.
4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			2.5	$^\circ\text{C/W}$

inductive-load-switching characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS †	MIN	TYP	MAX	UNIT
t_{sv} Voltage storage time	$I_C = 2.5 \text{ A}$ $I_{B(on)} = 0.5 \text{ A}$ (see Figures 1 and 2) $V_{BE(off)} = -5 \text{ V}$			2	μs
t_{rv} Voltage rise time				200	ns
t_{fi} Current fall time				200	ns
t_{tl} Current tail time				50	ns
t_{xo} Cross over time				300	ns
t_{sv} Voltage storage time	$I_C = 2.5 \text{ A}$ $I_{B(on)} = 0.5 \text{ A}$ (see Figures 1 and 2) $V_{BE(off)} = -5 \text{ V}$ $T_C = 100^\circ\text{C}$			2.5	μs
t_{rv} Voltage rise time				400	ns
t_{fi} Current fall time				250	ns
t_{tl} Current tail time				50	ns
t_{xo} Cross over time				500	ns

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

PARAMETER MEASUREMENT INFORMATION

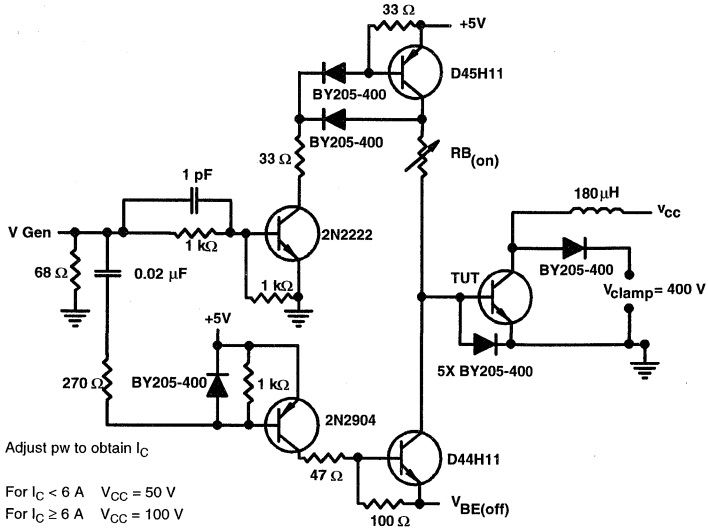
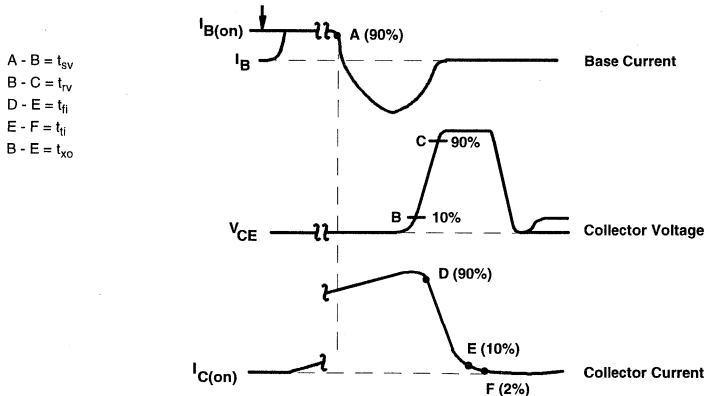


Figure 1. Inductive-Load Switching Test Circuit



NOTES: A. Waveforms are monitored on an oscilloscope with the following characteristics: $t_r < 15\text{ ns}$, $R_{in} > 10\ \Omega$, $C_{in} < 11.5\text{ pF}$.
 B. Resistors must be noninductive types.

Figure 2. Inductive-Load Switching Waveforms

TIPL770
NPN SILICON POWER TRANSISTOR

MARCH 1984 - REVISED MAY 1995

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
vs
COLLECTOR CURRENT

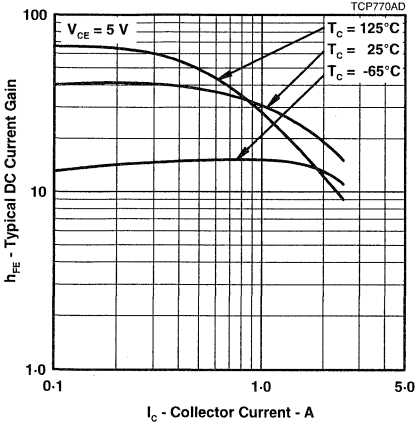


Figure 3.

COLLECTOR-EMITTER SATURATION VOLTAGE
vs
BASE CURRENT

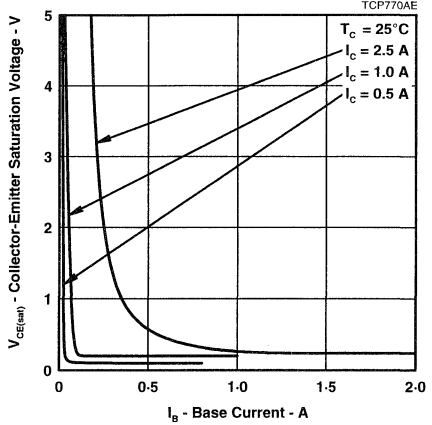


Figure 4.

COLLECTOR-EMITTER SATURATION VOLTAGE
vs
BASE CURRENT

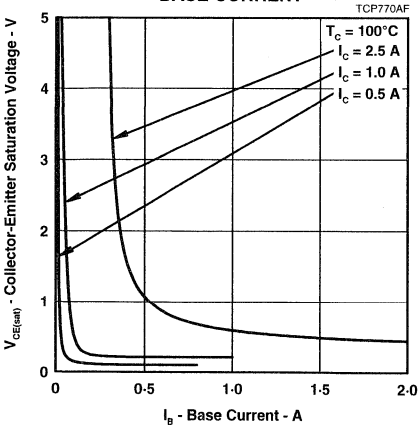


Figure 5.

BASE-EMITTER SATURATION VOLTAGE
vs
BASE CURRENT

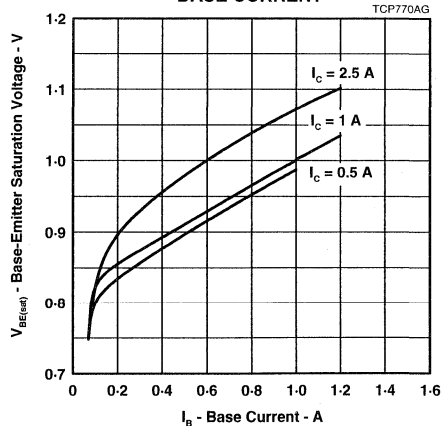


Figure 6.

MAXIMUM SAFE OPERATING REGIONS

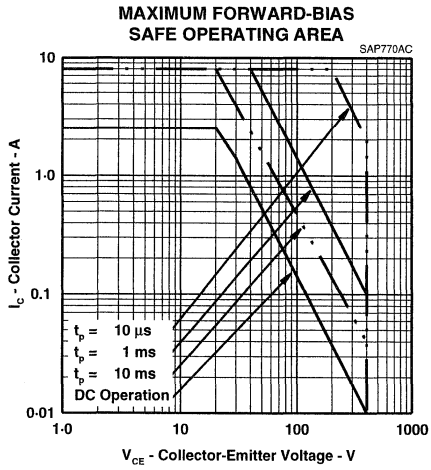
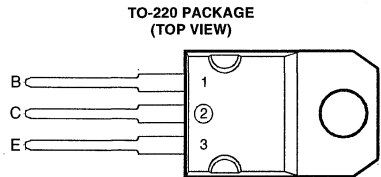


Figure 7.

TIPL790, TIPL790A NPN SILICON POWER DARLINGTONS

AUGUST 1978 - REVISED MAY 1995

- Rugged Epitaxial Planar Construction
- 10 A Continuous Collector Current
- Operating Characteristics Fully Guaranteed at 100°C
- t_{xo} typically 320 ns, $I_C = 10$ A



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIPL790	V_{CBO}	150	V
	TIPL790A		200	
Collector-emitter voltage ($V_{BE} = 0$)	TIPL790	V_{CES}	150	V
	TIPL790A		200	
Collector-emitter voltage ($I_B = 0$)	TIPL790	V_{CEO}	120	V
	TIPL790A		150	
Emitter-base voltage		V_{EBO}	8	V
Continuous collector current		I_C	10	A
Peak collector current (see Note 1)		I_{CM}	15	A
Continuous device dissipation at (or below) 25°C case temperature		P_{tot}	70	W
Operating junction temperature range		T_j	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C

NOTE 1: This value applies for $t_p \leq 10$ ms, duty cycle $\leq 2\%$.

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 **TEXAS
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TIPL790, TIPL790A

NPN SILICON POWER DARLINGTONS

AUGUST 1978 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{CEO(sus)}$ Collector-emitter sustaining voltage	$I_C = 100 \text{ mA}$	$L = 25 \text{ mH}$	(see Note 2)	TIPL790 120 TIPL790A 150			V
V_{CBO} Collector-base breakdown voltage	$I_C = 1 \text{ mA}$		(see Note 3)	TIPL790 150 TIPL790A 200			V
I_{CES} Collector-emitter cut-off current	$V_{CE} = 150 \text{ V}$	$V_{BE} = 0$		TIPL790		0.05	mA
	$V_{CE} = 200 \text{ V}$	$V_{BE} = 0$		TIPL790A		0.05	
	$V_{CE} = 150 \text{ V}$	$V_{BE} = 0$	$T_C = 100^\circ\text{C}$	TIPL790		1	
	$V_{CE} = 200 \text{ V}$	$V_{BE} = 0$	$T_C = 100^\circ\text{C}$	TIPL790A		1	
I_{CEV} Collector cut-off current	$V_{CE} = 150 \text{ V}$	$1.5 < V_{EB} < 8 \text{ V}$		TIPL790		50	μA
	$V_{CE} = 200 \text{ V}$		TIPL790A		50		
I_{CEO} Collector cut-off current	$V_{CE} = 120 \text{ V}$	$I_B = 0$		TIPL790		50	μA
	$V_{CE} = 150 \text{ V}$	$I_B = 0$		TIPL790A		50	
I_{EBO} Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$				4	mA
h_{FE} Forward current transfer ratio	$V_{CE} = 5 \text{ V}$	$I_C = 0.5 \text{ A}$	(see Notes 3 and 4)	60		500	
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 20 \text{ mA}$	$I_C = 4 \text{ A}$	(see Notes 3 and 4)			1.2	V
	$I_B = 30 \text{ mA}$	$I_C = 7 \text{ A}$				1.5	
	$I_B = 50 \text{ mA}$	$I_C = 10 \text{ A}$				2.0	
	$I_B = 50 \text{ mA}$	$I_C = 10 \text{ A}$		$T_C = 100^\circ\text{C}$			
$V_{BE(sat)}$ Base-emitter saturation voltage	$I_B = 20 \text{ mA}$	$I_C = 4 \text{ A}$	(see Notes 3 and 4)			1.8	V
	$I_B = 30 \text{ mA}$	$I_C = 7 \text{ A}$				1.9	
	$I_B = 50 \text{ mA}$	$I_C = 10 \text{ A}$				2.2	
	$I_B = 50 \text{ mA}$	$I_C = 10 \text{ A}$		$T_C = 100^\circ\text{C}$			
V_{EC} Parallel diode forward voltage	$I_E = 10 \text{ A}$	$I_B = 0$				3	V
f_t Current gain bandwidth product	$V_{CE} = 10 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ MHz}$	(see Note 5)	10		MHz
C_{ob} Output capacitance	$V_{CB} = 20 \text{ V}$	$I_E = 0$	$f = 0.1 \text{ MHz}$		90		pF

NOTES: 2. Inductive loop switching measurement.

3. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

5. To obtain f_t the $[h_{FE}]$ response is extrapolated at the rate of -6 dB per octave from $f = 1 \text{ MHz}$ to the frequency at which $[h_{FE}] = 1$.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1.79	$^\circ\text{C/W}$

inductive-load-switching characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{si} Current storage time	$I_C = 10 \text{ A}$ $I_{B(off)} = -2.5 \text{ A}$	$I_{B(on)} = 50 \text{ mA}$ $V_{BE(off)} = -5 \text{ V}$	(see Figures 1 and 2)		450	700	ns
t_{rv} Voltage rise time					160	750	ns
t_{fi} Current fall time					250	400	ns
t_{fj} Current tail time					280	450	ns
t_{xo} Cross over time					320	500	ns

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TIPL790, TIPL790A NPN SILICON POWER DARLINGTONS

AUGUST 1978 - REVISED MAY 1995

TYPICAL CHARACTERISTICS

**TYPICAL DC CURRENT GAIN
vs
COLLECTOR CURRENT**

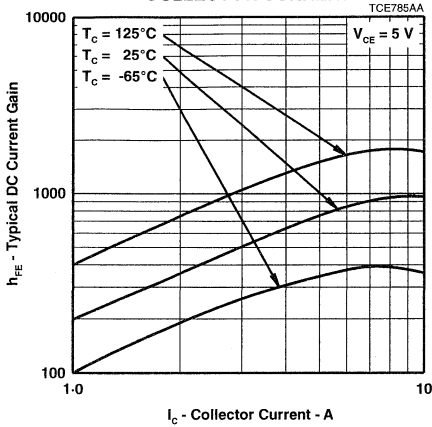


Figure 3.

**COLLECTOR-EMITTER SATURATION VOLTAGE
vs
BASE CURRENT**

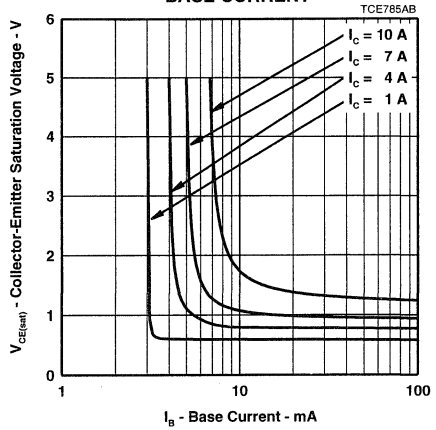


Figure 4.

**BASE-EMITTER SATURATION VOLTAGE
vs
BASE CURRENT**

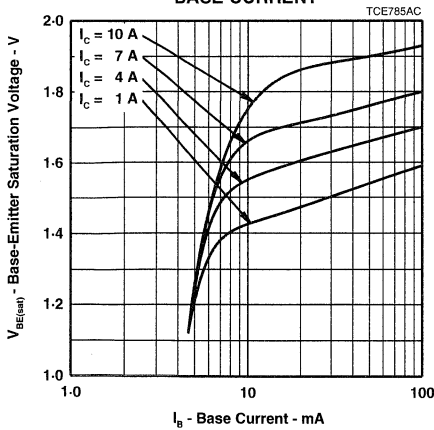


Figure 5.

**COLLECTOR CUT-OFF CURRENT
vs
CASE TEMPERATURE**

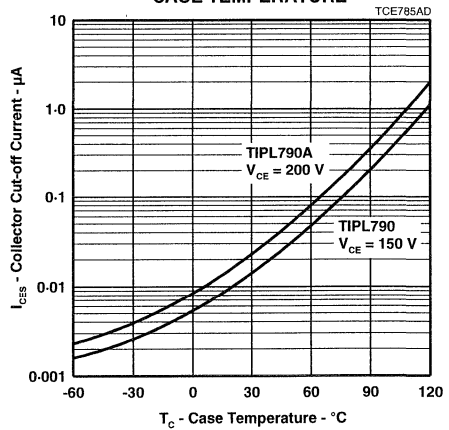


Figure 6.

MAXIMUM SAFE OPERATING REGIONS

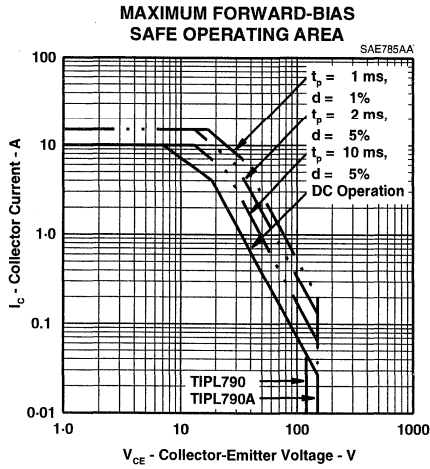
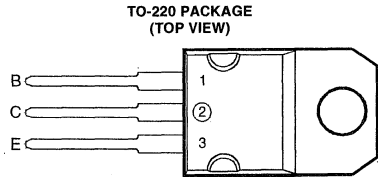


Figure 7.

TIPL791, TIPL791A NPN SILICON POWER TRANSISTORS

MAY 1989 - REVISED MAY 1995

- Rugged Triple-Diffused Planar Construction
- 4 A Continuous Collector Current
- Operating Characteristics Fully Guaranteed at 100°C
- 1000 Volt Blocking Capability



Pin 2 is in electrical contact with the mounting base.

MDTRAC

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIPL791	V_{CBO}	850	V
	TIPL791A		1000	
Collector-emitter voltage ($V_{BE} = 0$)	TIPL791	V_{CES}	850	V
	TIPL791A		1000	
Collector-emitter voltage ($I_B = 0$)	TIPL791	V_{CEO}	400	V
	TIPL791A		450	
Emitter-base voltage		V_{EBO}	10	V
Continuous collector current		I_C	4	A
Peak collector current (see Note 1)		I_{CM}	8	A
Continuous device dissipation at (or below) 25°C case temperature		P_{tot}	75	W
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C

NOTE 1: This value applies for $t_p \leq 10$ ms, duty cycle $\leq 2\%$.

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TIPL791, TIPL791A

NPN SILICON POWER TRANSISTORS

MAY 1989 - REVISED MAY 1995

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$V_{CEO(sus)}$ Collector-emitter sustaining voltage	$I_C = 100 \text{ mA}$ $L = 25 \text{ mH}$ (see Note 2) TIPL791 TIPL791A	400 450			V
I_{CES} Collector-emitter cut-off current	$V_{CE} = 850 \text{ V}$ $V_{BE} = 0$ $V_{CE} = 1000 \text{ V}$ $V_{BE} = 0$ $V_{CE} = 850 \text{ V}$ $V_{BE} = 0$ $T_C = 100^\circ\text{C}$ $V_{CE} = 1000 \text{ V}$ $V_{BE} = 0$ $T_C = 100^\circ\text{C}$ TIPL791 TIPL791A TIPL791 TIPL791A			5 5 200 200	μA
I_{CEO} Collector cut-off current	$V_{CE} = 400 \text{ V}$ $I_B = 0$ $V_{CE} = 450 \text{ V}$ $I_B = 0$ TIPL791 TIPL791A			5 5	μA
I_{EBO} Emitter cut-off current	$V_{EB} = 10 \text{ V}$ $I_C = 0$			1	mA
h_{FE} Forward current transfer ratio	$V_{CE} = 5 \text{ V}$ $I_C = 0.5 \text{ A}$ (see Notes 3 and 4)	20		60	
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = 0.2 \text{ A}$ $I_C = 1 \text{ A}$ $I_B = 0.5 \text{ A}$ $I_C = 2.5 \text{ A}$ (see Notes 3 and 4) $I_B = 1 \text{ A}$ $I_C = 4 \text{ A}$ $I_B = 1 \text{ A}$ $I_C = 4 \text{ A}$ $T_C = 100^\circ\text{C}$			0.5 1.0 2.5 5.0	V
$V_{BE(sat)}$ Base-emitter saturation voltage	$I_B = 0.2 \text{ A}$ $I_C = 1 \text{ A}$ $I_B = 0.5 \text{ A}$ $I_C = 2.5 \text{ A}$ (see Notes 3 and 4) $I_B = 1 \text{ A}$ $I_C = 4 \text{ A}$ $I_B = 1 \text{ A}$ $I_C = 4 \text{ A}$ $T_C = 100^\circ\text{C}$			1.0 1.2 1.4 1.3	V
f_t Current gain bandwidth product	$V_{CE} = 10 \text{ V}$ $I_C = 0.5 \text{ A}$ $f = 1 \text{ MHz}$		12		MHz
C_{ob} Output capacitance	$V_{CB} = 20 \text{ V}$ $I_E = 0$ $f = 0.1 \text{ MHz}$		110		pF

NOTES: 2. Inductive loop switching measurement.

3. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1.66	$^\circ\text{C/W}$

inductive-load-switching characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS †	MIN	TYP	MAX	UNIT
t_{SV} Voltage storage time	$I_C = 4 \text{ A}$ $V_{BE(off)} = -5 \text{ V}$ $I_{B(on)} = 0.8 \text{ A}$ (see Figures 1 and 2)			2	μs
t_{rV} Voltage rise time				200	ns
t_{fI} Current fall time				100	ns
t_{tI} Current tail time				50	ns
t_{xO} Cross over time				200	ns
t_{SV} Voltage storage time	$I_C = 4 \text{ A}$ $V_{BE(off)} = -5 \text{ V}$ $I_{B(on)} = 0.8 \text{ A}$ $T_C = 100^\circ\text{C}$ (see Figures 1 and 2)			2.5	μs
t_{rV} Voltage rise time				400	ns
t_{fI} Current fall time				200	ns
t_{tI} Current tail time				50	ns
t_{xO} Cross over time				600	ns

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.



TIPL791, TIPL791A
NPN SILICON POWER TRANSISTORS

MAY 1989 - REVISED MAY 1995

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN
VS
COLLECTOR CURRENT

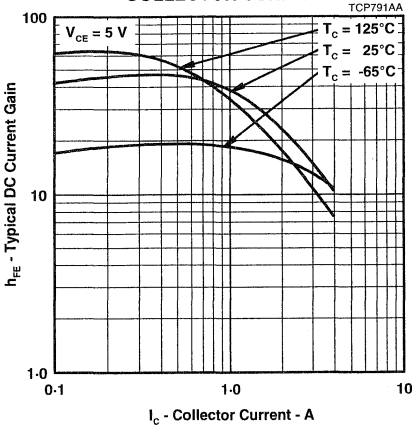


Figure 3.

COLLECTOR-EMITTER SATURATION VOLTAGE
VS
BASE CURRENT

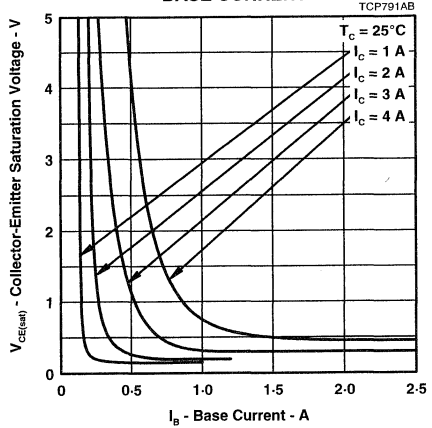


Figure 4.

MAXIMUM SAFE OPERATING REGIONS

MAXIMUM FORWARD-BIAS
SAFE OPERATING AREA

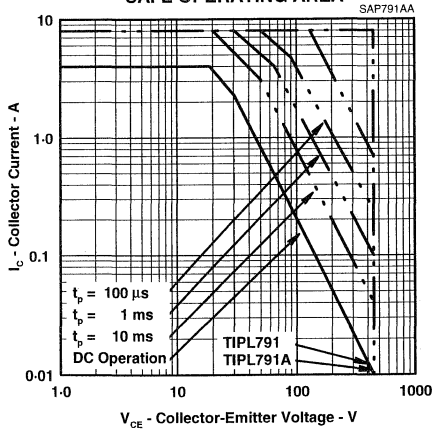


Figure 5.

THERMAL INFORMATION

THERMAL RESPONSE JUNCTION TO CASE
vs
POWER PULSE DURATION

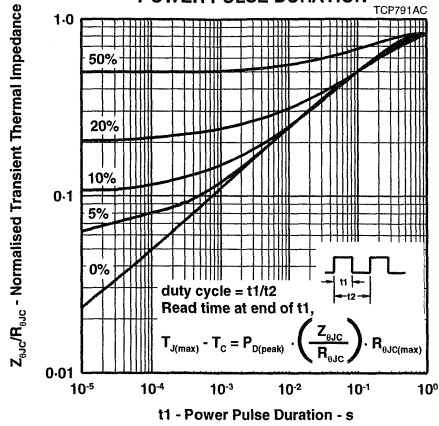


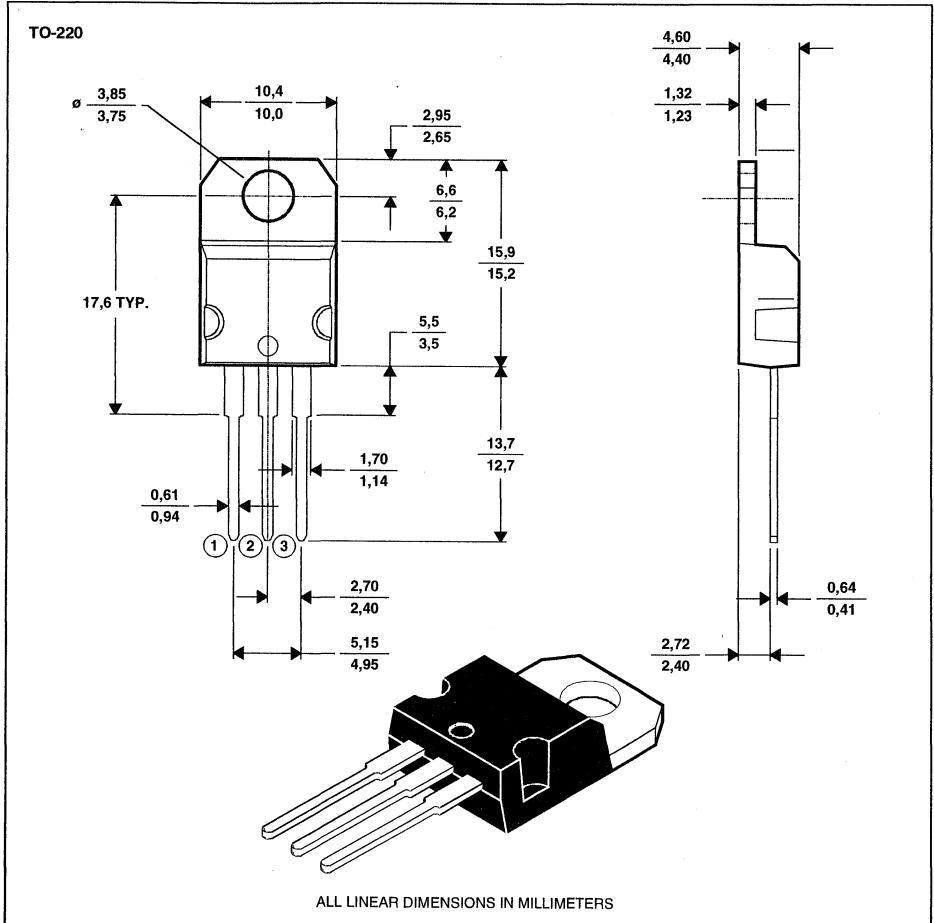
Figure 6.

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Mechanical Data	7

TO-220

3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



NOTE A: The centre pin is in electrical contact with the mounting tab.

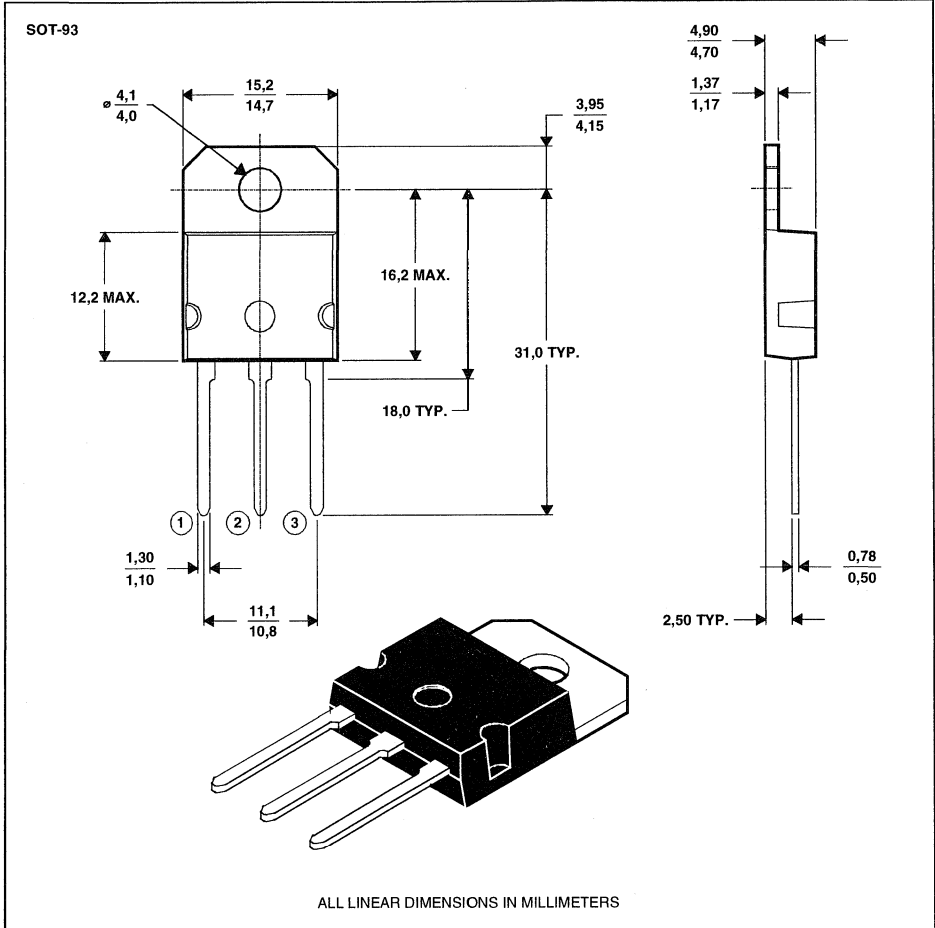
MDXXAP

MECHANICAL DATA

SOT-93

3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



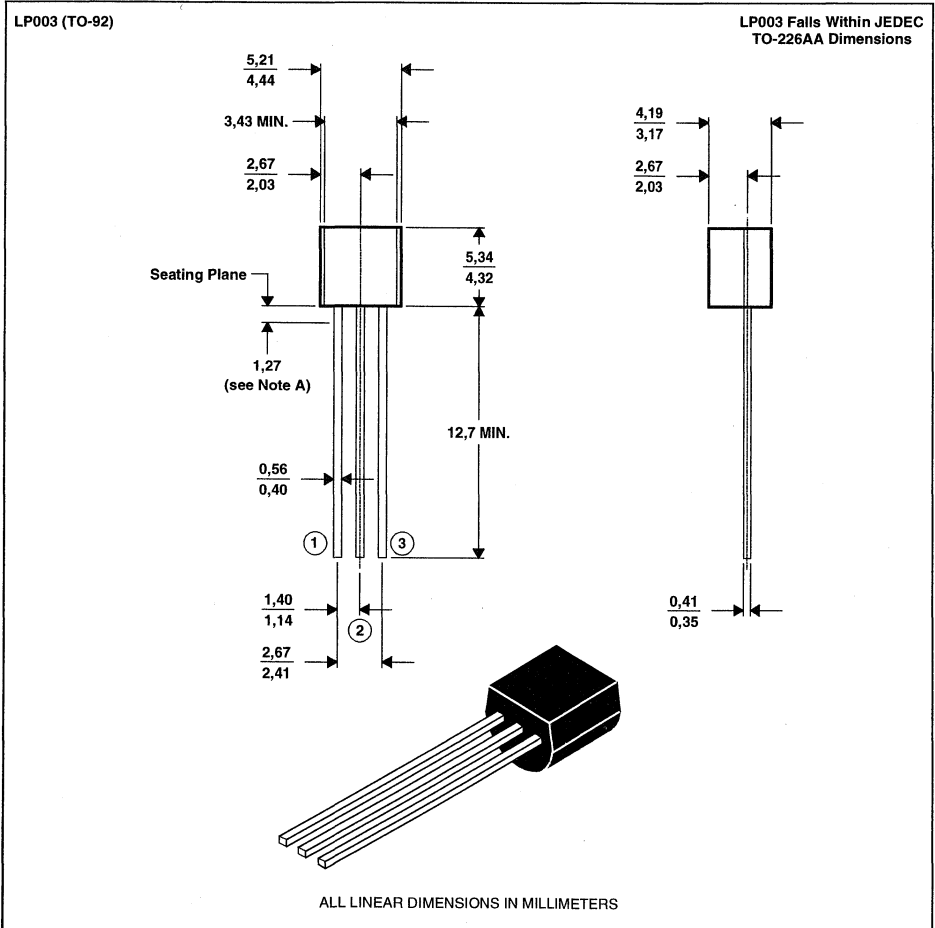
NOTE A: The centre pin is in electrical contact with the mounting tab.

MDXXAW

LP003 (TO-92)

3-pin cylindrical plastic package

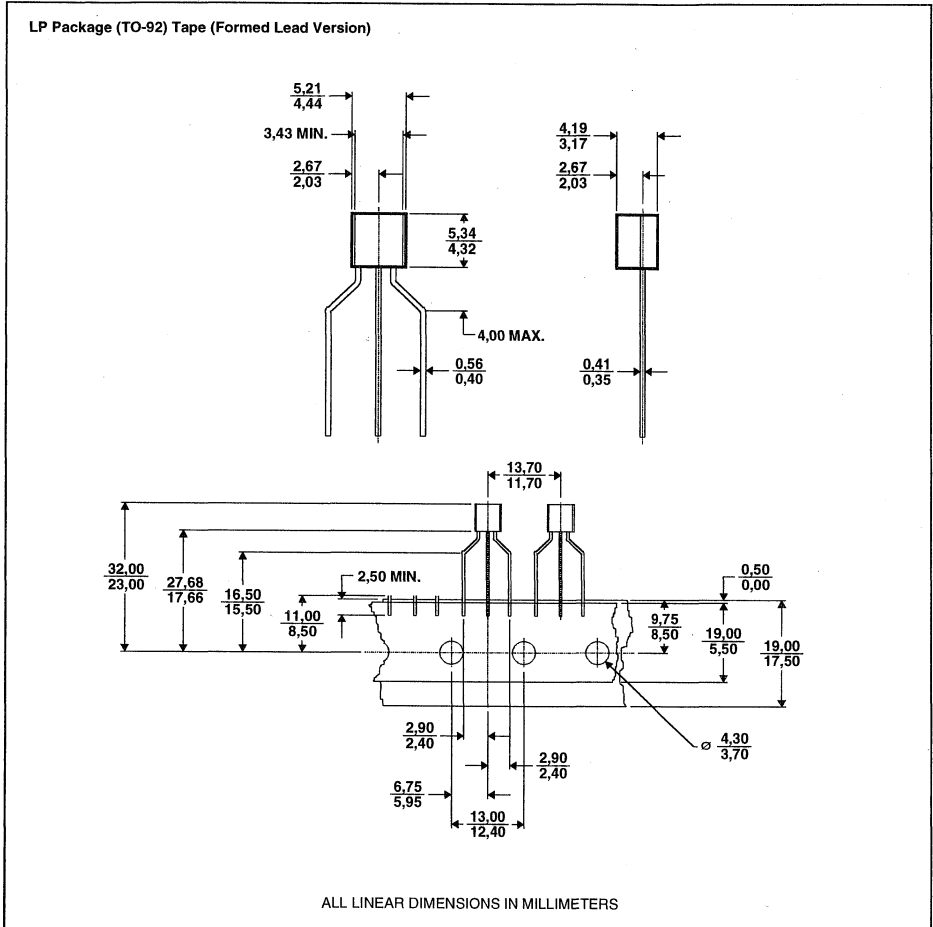
This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



NOTE A: Lead dimensions are not controlled in this area.

MDXXAX

LPR
Tape dimensions



MDXXAS

Notes

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 **TEXAS
INSTRUMENTS**

